

DATASHEET

Future Is In Control

FU6522_32_62_63
_65_72

Three-phase Motor Control
MCU

Copyright Notice

Copyright by Fortior Technology (Shenzhen) Co., Ltd. All Rights Reserved.

Right to make changes — Fortior Technology (Shenzhen) Co., Ltd. reserves the right to make changes in the products – including circuits, standard cells, and/or software – described or contained herein in order to improve design and/or performance. The information contained in this manual is provided for the general use by our customers. Our customers shall ensure that they take appropriate action so that their use of our products does not infringe upon any patents. It is the policy of Fortior Technology (Shenzhen) Co., Ltd. to respect the valid patent rights of third parties and not to infringe upon or assist others to infringe upon such rights.

This manual is copyrighted by Fortior Technology (Shenzhen) Co., Ltd. You may not reproduce, transmit, transcribe, store in a retrieval system, or translate into any language, in any form or by any means, electronic, mechanical, magnetic, optical, chemical, manual, or otherwise, any part of this publication without the expressly written permission from Fortior Technology (Shenzhen) Co., Ltd. You may not alter or remove any copyright or other notice from copies of this content.

If there are any differences between the Chinese and the English contents, please take the Chinese version as the standard.

Disclaimer

This document is the property of Fortior Technology (Shenzhen) Co., Ltd. and its subsidiaries (hereinafter referred to as "Fortior Technology").

This document is provided on an "AS IS" basis, without warranty of any kind, express or implied, including but not limited to the warranties of merchantability, fitness for a particular purpose and non-infringement of intellectual property rights of any third-party. Any and all information stated herein is for reference purpose only, and Fortior Technology hereby disclaims any and all warranties and liabilities of any kind. The customer has the full responsibility to design, program and test their applications, evaluate functionality and safety of their final products and accept all loss or damage, legal claim or lawsuit whatsoever arising from the use of the information, data or opinions contained herein, and agrees to defend, hold harmless and indemnify Fortior Technology from and against any and all claims, damages and liabilities. No license, express or implied, to any intellectual property rights of Fortior Technology is granted by this document. Fortior Technology reserves the rights to amend, revise or make changes to this document at any time without prior notice.

In the event of any inconsistency, conflict or ambiguity under this disclaimer, the final interpretation is at the sole discretion of Fortior Technology.

Contents

Copyright Notice	1
Disclaimer	2
Contents	3
Explanation of Symbols	30
Abbreviations	31
1 System Introduction	33
1.1 Features	33
1.2 Applications	37
1.3 Overview	37
1.4 Functional Block Diagram	39
1.4.1 FU6572L	39
1.4.2 FU6572N	40
1.4.3 FU6572T	41
1.4.4 FU6565N	42
1.4.5 FU6565T	43
1.4.6 FU6563N	44
1.4.7 FU6562L	45
1.4.8 FU6562LA	46
1.4.9 FU6562Q	47
1.4.10 FU6562S	48
1.4.11 FU6562T	49
1.4.12 FU6532N	50
1.4.13 FU6532T	51
1.4.14 FU6522L	52
1.4.15 FU6522N	53
1.4.16 FU6522T	54
1.5 Memory Organization	55
1.5.1 Program Memory	55

1.5.2 Data Memory.....	55
1.5.3 SFR.....	56
1.5.4 XSFR.....	57
2 Pin Definitions.....	60
2.1 FU6572L LQFP48 Pins.....	60
2.2 FU6572L LQFP48 Pinout Diagram.....	64
2.3 FU6572N QFN40 Pins.....	65
2.4 FU6572N QFN40 Pinout Diagram.....	68
2.5 FU6572T TSSOP28 Pins.....	69
2.6 FU6572T TSSOP28 Pinout Diagram.....	71
2.7 FU6565N QFN40 Pins.....	72
2.8 FU6565N QFN40 Pinout Diagram.....	75
2.9 FU6565T TSSOP28 Pins.....	76
2.10 FU6565T TSSOP28 Pinout Diagram.....	78
2.11 FU6563N QFN32 Pins.....	79
2.12 FU6563N QFN32 Pinout Diagram.....	82
2.13 FU6562L LQFP48 Pins.....	83
2.14 FU6562L LQFP48 Pinout Diagram.....	86
2.15 FU6562LA LQFP48 Pins.....	87
2.16 FU6562LA LQFP48 Pinout Diagram.....	90
2.17 FU6562Q QFN48-38 Pins.....	91
2.18 FU6562Q QFN48-38 Pinout Diagram.....	94
2.19 FU6562S TSSOP28 Pins.....	95
2.20 FU6562S TSSOP28 Pinout Diagram.....	97
2.21 FU6562T TSSOP28 Pins.....	98
2.22 FU6562T TSSOP28 Pinout Diagram.....	100
2.23 FU6532N QFN32 Pins.....	101
2.24 FU6532N QFN32 Pinout Diagram.....	104
2.25 FU6532T TSSOP28 Pins.....	105
2.26 FU6532T TSSOP28 Pinout Diagram.....	108
2.27 FU6522L LQFP48 Pins.....	109
2.28 FU6522L LQFP48 Pinout Diagram.....	113

2.29 FU6522N QFN32 Pins.....	114
2.30 FU6522N QFN32 Pinout Diagram	117
2.31 FU6522T TSSOP28 Pins.....	118
2.32 FU6522T TSSOP28 Pinout Diagram.....	121
3 Package Information	122
3.1 LQFP48_7X7 (for FU6572L / FU6562L / FU6562LA / FU6522L)	122
3.2 QFN48-38_7X7 (for FU6562Q)	123
3.3 QFN40_5X5 (for FU6565N / FU6572N).....	124
3.4 QFN32_4X4 (for FU6563N / FU6532N / FU6522N)	125
3.5 TSSOP28_9.7x4.4 (for FU6572T / FU6565T / FU6562S / FU6562T / FU6532T / FU6522T)	126
4 Ordering Information	127
5 Electrical Characteristics	130
5.1 Absolute Maximum Ratings.....	130
5.1.1 FU6572L	130
5.1.2 FU6572N.....	130
5.1.3 FU6572T	131
5.1.4 FU6565N.....	131
5.1.5 FU6565T	131
5.1.6 FU6563N.....	132
5.1.7 FU6562L	132
5.1.8 FU6562LA	133
5.1.9 FU6562Q.....	133
5.1.10 FU6562S.....	133
5.1.11 FU6562T.....	134
5.1.12 FU6532N.....	134
5.1.13 FU6532T	134
5.1.14 FU6522L.....	134
5.1.15 FU6522N.....	135
5.1.16 FU6522T	135
5.2 Global Electrical Characteristics.....	135
5.2.1 FU6572L	135

5.2.2 FU6572N.....	136
5.2.3 FU6572T	136
5.2.4 FU6565N.....	136
5.2.5 FU6565T	137
5.2.6 FU6563N.....	137
5.2.7 FU6562L	138
5.2.8 FU6562LA	138
5.2.9 FU6562Q.....	138
5.2.10 FU6562S.....	139
5.2.11 FU6562T	139
5.2.12 FU6532N.....	140
5.2.13 FU6532T	140
5.2.14 FU6522L.....	140
5.2.15 FU6522N.....	141
5.2.16 FU6522T.....	141
5.3 GPIO Electrical Characteristics	141
5.3.1 FU6572L	141
5.3.2 FU6572N.....	142
5.3.3 FU6572T	143
5.3.4 FU6565N.....	143
5.3.5 FU6565T	144
5.3.6 FU6563N.....	144
5.3.7 FU6562L	145
5.3.8 FU6562LA	146
5.3.9 FU6562Q.....	146
5.3.10 FU6562S.....	147
5.3.11 FU6562T	147
5.3.12 FU6532N.....	148
5.3.13 FU6532T	149
5.3.14 FU6522L.....	149
5.3.15 FU6522N.....	150
5.3.16 FU6522T.....	150

5.4 6N pre-driver Output IO Electrical Characteristics (for FU6572L / FU6572N / FU6572T / FU6565N / FU6565T / FU6563N / FU6562L / FU6562LA / FU6562Q / FU6562S / FU6562T)	151
5.4.1 FU6572L	151
5.4.2 FU6572N.....	152
5.4.3 FU6572T	152
5.4.4 FU6565N.....	153
5.4.5 FU6565T	153
5.4.6 FU6563N.....	154
5.4.7 FU6562L	154
5.4.8 FU6562LA	155
5.4.9 FU6562Q.....	155
5.4.10 FU6562S.....	155
5.4.11 FU6562T.....	156
5.5 3P3N Pre-driver IO Electrical Characteristics (for FU6532N / FU6532T)... ..	156
5.5.1 FU6532N.....	156
5.5.2 FU6532T	157
5.6 PWM IO Electrical Characteristics (for FU6522L / FU6522N / FU6522T).. ..	157
5.6.1 FU6522L	157
5.6.2 FU6522N.....	158
5.6.3 FU6522T	158
5.7 ADC Electrical Characteristics.....	158
5.7.1 FU6572L	158
5.7.2 FU6572N.....	159
5.7.3 FU6572T	159
5.7.4 FU6565N.....	160
5.7.5 FU6565T	160
5.7.6 FU6563N.....	161
5.7.7 FU6562L	161
5.7.8 FU6562LA	162
5.7.9 FU6562Q.....	162
5.7.10 FU6562S.....	163

5.7.11 FU6562T	163
5.7.12 FU6532N	164
5.7.13 FU6532T	164
5.7.14 FU6522L	165
5.7.15 FU6522N	165
5.7.16 FU6522T	166
5.8 VREF and VHALF Electrical Characteristics	166
5.8.1 FU6572L	166
5.8.2 FU6572N	167
5.8.3 FU6572T	167
5.8.4 FU6565N	167
5.8.5 FU6565T	168
5.8.6 FU6563N	168
5.8.7 FU6562L	168
5.8.8 FU6562LA	169
5.8.9 FU6562Q	169
5.8.10 FU6562S	170
5.8.11 FU6562T	170
5.8.12 FU6532N	170
5.8.13 FU6532T	171
5.8.14 FU6522L	171
5.8.15 FU6522N	172
5.8.16 FU6522T	172
5.9 Operational Amplifier Electrical Characteristics	172
5.9.1 FU6572L	172
5.9.2 FU6572N	173
5.9.3 FU6572T	173
5.9.4 FU6565N	173
5.9.5 FU6565T	174
5.9.6 FU6563N	174
5.9.7 FU6562L	175
5.9.8 FU6562LA	175

5.9.9 FU6562Q.....	175
5.9.10 FU6562S.....	176
5.9.11 FU6562T.....	176
5.9.12 FU6532N.....	177
5.9.13 FU6532T.....	177
5.9.14 FU6522L.....	177
5.9.15 FU6522N.....	178
5.9.16 FU6522T.....	178
5.10 BEMF Electrical Characteristics.....	179
5.10.1 FU6572L.....	179
5.10.2 FU6572N.....	179
5.10.3 FU6572T.....	179
5.10.4 FU6565N.....	179
5.10.5 FU6565T.....	180
5.10.6 FU6563N.....	180
5.10.7 FU6562L.....	180
5.10.8 FU6562LA.....	180
5.10.9 FU6562Q.....	181
5.10.10 FU6562S.....	181
5.10.11 FU6562T.....	181
5.10.12 FU6532N.....	181
5.10.13 FU6532T.....	181
5.10.14 FU6522L.....	182
5.10.15 FU6522N.....	182
5.10.16 FU6522T.....	182
5.11 OSC Electrical Characteristics.....	182
5.11.1 FU6572L.....	182
5.11.2 FU6572N.....	182
5.11.3 FU6572T.....	183
5.11.4 FU6565N.....	183
5.11.5 FU6565T.....	183
5.11.6 FU6563N.....	183

5.11.7 FU6562L.....	183
5.11.8 FU6562LA.....	184
5.11.9 FU6562Q.....	184
5.11.10 FU6562S.....	184
5.11.11 FU6562T.....	184
5.11.12 FU6532N.....	184
5.11.13 FU6532T.....	185
5.11.14 FU6522L.....	185
5.11.15 FU6522N.....	185
5.11.16 FU6522T.....	185
5.12 Reset Electrical Characteristics.....	186
5.12.1 FU6572L.....	186
5.12.2 FU6572N.....	186
5.12.3 FU6572T.....	186
5.12.4 FU6565N.....	186
5.12.5 FU6565T.....	186
5.12.6 FU6563N.....	187
5.12.7 FU6562L.....	187
5.12.8 FU6562LA.....	187
5.12.9 FU6562Q.....	187
5.12.10 FU6562S.....	187
5.12.11 FU6562T.....	188
5.12.12 FU6532N.....	188
5.12.13 FU6532T.....	188
5.12.14 FU6522L.....	188
5.12.15 FU6522N.....	188
5.12.16 FU6522T.....	189
5.13 LDO Electrical Characteristics (for FU6572L / FU6572N / FU6572T / FU6565N / FU6565T / FU6563N / FU6532N / FU6532T).....	189
5.13.1 FU6572L.....	189
5.13.2 FU6572N.....	189
5.13.3 FU6572T.....	189

5.13.4 FU6565N	190
5.13.5 FU6565T	190
5.13.6 FU6563N	190
5.13.7 FU6532N	190
5.13.8 FU6532T	190
5.14 Package Thermal Resistance	191
5.14.1 LQFP48 Package Thermal Resistance (for FU6572L / FU6562L / FU6562LA / FU6522L)	191
5.14.2 QFN48-38 Package Thermal Resistance (FU6562Q)	191
5.14.3 QFN40 Package Thermal Resistance (for FU6565N / FU6572N)	191
5.14.4 QFN32 Package Thermal Resistance (for FU6563N / FU6532N / FU6522N)	191
5.14.5 TSSOP28 Package Thermal Resistance (for FU6572T / FU6565T / FU6562S / FU6562T / FU6532T / FU6522T)	192
6 Reset Control	193
6.1 Reset Source(RST_SR)	193
6.2 Reset Enable	193
6.3 RSTEXT, RSTPOW	193
6.4 Low-voltage Reset	193
6.5 Watchdog Timeout Reset	194
6.6 RSTFED Reset	194
6.7 RSTDBG Reset	194
6.8 Soft Reset	194
6.9 Reset Register	195
6.9.1 RST_SR (0xC9)	195
7 Interrupt	196
7.1 Interrupt Introduction	196
7.2 Interrupt Source Enable	196
7.3 External Interrupts	197
7.4 Interrupt Introduction	197
7.5 Interrupt Register	199
7.5.1 IE (0xA8)	199
7.5.2 IP0 (0x8A)	199

7.5.3 IP1 (0x8B)	200
7.5.4 IP2 (0x8C)	200
7.5.5 IP3 (0x8D)	200
7.5.6 TCON (0x88)	201
7.5.7 P1_IE (0xD1)	202
7.5.8 P1_IF (0xD2)	202
7.5.9 P4_IE (0xD3)	204
7.5.10 P4_IF (0xD4)	205
8 I²C	207
8.1 I ² C Introduction	207
8.2 I ² C Operation	208
8.2.1 Master Mode	208
8.2.2 Slave Device Mode	209
8.2.3 I ² C Interrupt Source	210
8.3 I ² C Register	211
8.3.1 I2C_CR (0x4028)	211
8.3.2 I2C_ID (0x4029)	211
8.3.3 I2C_DR (0x402A)	212
8.3.4 I2C_SR (0x402B)	212
9 SPI	215
9.1 SPI Introduction	215
9.2 SPI Operation	215
9.2.1 Signal Introduction	215
9.2.1.1 Master Output and Slave Input(MOSI)	215
9.2.1.2 Master Input and Slave Output(MISO)	216
9.2.1.3 Serial Clock(SCLK)	216
9.2.1.4 Negated Slave Select (NSS)	216
9.2.2 SPI Master Device Mode	218
9.2.2.1 Master Mode Configuration	218
9.2.3 SPI Slave Mode	219
9.2.3.1 Slave Mode Configuration	219
9.2.4 SPI Interrupt Source	220

9.2.5 Serial Clock Timing	220
9.3 SPI Register	221
9.3.1 SPI_CR0 (0x4030).....	221
9.3.2 SPI_CR1 (0x4031).....	222
9.3.3 SPI_CLK (0x4032).....	224
9.3.4 SPI_DR (0x4033)	224
10 UART	225
10.1 UART Introduction	225
10.2 UART Operations.....	225
10.2.1 UART1 Operating Instructions.....	225
10.2.1.1 UART1 Mode0	225
10.2.1.2 UART1 Mode1	226
10.2.1.3 UART1 Mode2	226
10.2.1.4 UART1 Mode3	226
10.2.1.5 UART1 Interrupt Sources.....	227
10.2.2 UART2 Operating Instructions.....	227
10.2.2.1 UART2 Mode0	227
10.2.2.2 UART2 Mode1	227
10.2.2.3 UART2 Mode2	228
10.2.2.4 UART2 Mode3	228
10.2.2.5 UART2 Interrupt Sources.....	228
10.3 UART1 Registers.....	229
10.3.1 UT_CR (0x98).....	229
10.3.2 UT_DR (0x99)	230
10.3.3 UT_BAUD (0x9A, 0x9B)	230
10.4 UART2 Registers.....	231
10.4.1 UT2_CR (0xD8)	231
10.4.2 UT2_DR (0x89).....	232
10.4.3 UT2_BAUD (0x4042, 0x4043).....	232
11 MDU	234
11.1 MDU Introduction	234
11.2 MDU Features.....	234

11.3 MDU Instructions.....	234
11.3.1 MDU Operations.....	234
11.3.2 16-bit Signed Multiplication with the Result Shifted Left by One-bit.....	235
11.3.3 16-bit Signed Multiplication.....	235
11.3.4 16-bit Unsigned Multiplication.....	235
11.3.5 32-bit/16-bit Unsigned Division.....	236
11.3.6 Low-pass Filter (LPF)	236
11.3.7 Coordinate Transformation (sin/cos Calculation)	237
11.3.8 Arctangent	238
11.3.9 PI/PID	239
11.3.9.1 PI/PID Introduction	239
11.3.9.2 PI/PID Features	239
11.3.9.3 PI/PID Operations	239
11.4 MDU Registers.....	241
11.4.1 MDU_CR (0xC1)	241
11.4.2 MUL0_MA (0x0FA0, 0x0FA1)	242
11.4.3 MUL0_MB (0x0FA2, 0x0FA3).....	242
11.4.4 MUL0_MC (0x0FA4, 0x0FA5, 0x0FA6, 0x0FA7).....	242
11.4.5 MUL1_MA (0x0F98, 0x0F99)	243
11.4.6 MUL1_MB (0x0F9A, 0x0F9B).....	243
11.4.7 MUL1_MC (0x0F9C, 0x0F9D, 0x0F9E, 0x0F9F).....	244
11.4.8 MUL2_MA (0x0F40, 0x0F41)	244
11.4.9 MUL2_MB (0x0F42, 0x0F43)	245
11.4.10 MUL2_MC (0x0F44, 0x0F45, 0x0F46, 0x0F47).....	245
11.4.11 MUL3_MA (0x0F38, 0x0F39).....	246
11.4.12 MUL3_MB (0x0F3A, 0x0F3B).....	246
11.4.13 MUL3_MC (0x0F3C, 0x0F3D, 0x0F3E, 0x0F3F).....	247
11.4.14 DIV0_DA (0x0F8C, 0x0F8D, 0x0F8E, 0x0F8F)	247
11.4.15 DIV0_DB (0x0F90, 0x0F91)	248
11.4.16 DIV0_DQ (0x0F92, 0x0F93, 0x0F94, 0x0F95).....	248
11.4.17 DIV0_DR (0x0F96, 0x0F97)	249
11.4.18 DIV1_DA (0x0F80, 0x0F81, 0x0F82, 0x0F83)	249

11.4.19 DIV1_DB (0x0F84, 0x0F85)	250
11.4.20 DIV1_DQ (0x0F86, 0x0F87, 0x0F88, 0x0F89)	250
11.4.21 DIV1_DR (0x0F8A, 0x0F8B)	251
11.4.22 DIV2_DA (0x0F2C, 0x0F2D, 0x0F2E, 0x0F2F)	251
11.4.23 DIV2_DB (0x0F30, 0x0F31)	252
11.4.24 DIV2_DQ (0x0F32, 0x0F33, 0x0F34, 0x0F35)	252
11.4.25 DIV2_DR (0x0F36, 0x0F37)	253
11.4.26 DIV3_DA (0x0F20, 0x0F21, 0x0F22, 0x0F23)	253
11.4.27 DIV3_DB (0x0F24, 0x0F25)	254
11.4.28 DIV3_DQ (0x0F26, 0x0F27, 0x0F28, 0x0F29)	254
11.4.29 DIV3_DR (0x0F2A, 0x0F2B)	255
11.4.30 SCAT0_COS (0x0F16, 0x0F17)	255
11.4.31 SCAT0_SIN (0x0F18, 0x0F19)	256
11.4.32 SCAT0_THE (0x0F1A, 0x0F1B)	256
11.4.33 SCAT0_RES1 (0x0F1C, 0x0F1D)	257
11.4.34 SCAT0_RES2 (0x0F1E, 0x0F1F)	257
11.4.35 SCAT1_COS (0x0F0C, 0x0F0D)	257
11.4.36 SCAT1_SIN (0x0F0E, 0x0F0F)	258
11.4.37 SCAT1_THE (0x0F10, 0x0F11)	258
11.4.38 SCAT1_RES1 (0x0F12, 0x0F13)	259
11.4.39 SCAT1_RES2 (0x0F14, 0x0F15)	259
11.4.40 SCAT2_COS (0x0F02, 0x0F03)	259
11.4.41 SCAT2_SIN (0x0F04, 0x0F05)	260
11.4.42 SCAT2_THE (0x0F06, 0x0F07)	260
11.4.43 SCAT2_RES1 (0x0F08, 0x0F09)	261
11.4.44 SCAT2_RES2 (0x0F0A, 0x0F0B)	261
11.4.45 SCAT3_COS (0x0EF8, 0x0EF9)	261
11.4.46 SCAT3_SIN (0x0EFA, 0x0EFB)	262
11.4.47 SCAT3_THE (0x0EFC, 0x0EFD)	262
11.4.48 SCAT3_RES1 (0x0EFE, 0x0EFF)	263
11.4.49 SCAT3_RES2 (0x0F00, 0x0F01)	263
11.4.50 LPF0_K (0x0FD0, 0x0FD1)	263

11.4.51 LPF0_X (0x0FD2, 0x0FD3).....	264
11.4.52 LPF0_Y (0x0FD4, 0x0FD5, 0x0FD6, 0x0FD7).....	264
11.4.53 LPF1_K (0x0FC8, 0x0FC9)	265
11.4.54 LPF1_X (0x0FCA, 0x0FCB)	265
11.4.55 LPF1_Y (0x0FCC, 0x0FCD, 0x0FCE, 0x0FCF).....	266
11.4.56 LPF2_K (0x0F78, 0x0F79).....	266
11.4.57 LPF2_X (0x0F7A, 0x0F7B)	267
11.4.58 LPF2_Y (0x0F7C, 0x0F7D, 0x0F7E, 0x0F7F)	267
11.4.59 LPF3_K (0x0F70, 0x0F71).....	268
11.4.60 LPF3_X (0x0F72, 0x0F73).....	268
11.4.61 LPF3_Y (0x0F74, 0x0F75, 0x0F76, 0x0F77).....	268
11.4.62 PIO_KP (0x0FB8, 0x0FB9).....	269
11.4.63 PIO_EK1 (0x0FBA, 0x0FBB).....	270
11.4.64 PIO_EK (0x0FBC, 0x0FBD)	270
11.4.65 PIO_KI (0x0FBE, 0x0FBF)	270
11.4.66 PIO_UKH (0x0FC0, 0x0FC1)	271
11.4.67 PIO_UKL (0x0FC2, 0x0FC3)	271
11.4.68 PIO_UKMAX (0x0FC4, 0x0FC5)	272
11.4.69 PIO_UKMIN (0x0FC6, 0x0FC7)	272
11.4.70 PI1_KP (0x0FA8, 0x0FA9)	272
11.4.71 PI1_EK1 (0x0FAA, 0x0FAB).....	273
11.4.72 PI1_EK (0x0FAC, 0x0FAD)	273
11.4.73 PI1_KI (0x0FAE, 0x0FAF).....	274
11.4.74 PI1_UKH (0x0FB0, 0x0FB1)	274
11.4.75 PI1_UKL (0x0FB2, 0x0FB3)	274
11.4.76 PI1_UKMAX (0x0FB4, 0x0FB5)	275
11.4.77 PI1_UKMIN (0x0FB6, 0x0FB7).....	275
11.4.78 PI2_KP (0x0F5C, 0x0F5D).....	276
11.4.79 PI2_EK1 (0x0F5E, 0x0F5F).....	276
11.4.80 PI2_EK (0x0F60, 0x0F61)	276
11.4.81 PI2_KI (0x0F62, 0x0F63).....	277
11.4.82 PI2_UKH (0x0F64, 0x0F65).....	277

11.4.83 PI2_UKL (0x0F66, 0x0F67)	278
11.4.84 PI2_UKMAX (0x0F68, 0x0F69)	278
11.4.85 PI2_UKMIN (0x0F6A, 0x0F6B)	278
11.4.86 PI2_KD (0x0F6C, 0x0F6D)	279
11.4.87 PI2_EK2 (0x0F6E, 0x0F6F)	279
11.4.88 PI3_KP (0x0F48, 0x0F49)	280
11.4.89 PI3_EK1 (0x0F4A, 0x0F4B)	280
11.4.90 PI3_EK (0x0F4C, 0x0F4D)	280
11.4.91 PI3_KI (0x0F4E, 0x0F4F)	281
11.4.92 PI3_UKH (0x0F50, 0x0F51)	281
11.4.93 PI3_UKL (0x0F52, 0x0F53)	282
11.4.94 PI3_UKMAX (0x0F54, 0x0F55)	282
11.4.95 PI3_UKMIN (0x0F56, 0x0F57)	282
11.4.96 PI3_KD (0x0F58, 0x0F59)	283
11.4.97 PI3_EK2 (0x0F5A, 0x0F5B)	283
12 FOC	284
12.1 FOC Overview	284
12.1.1 FOC Introduction	284
12.1.2 Reference Voltage (VREF) Input	285
12.1.3 PI Controller	285
12.1.4 Coordinate Transformation	285
12.1.4.1 Inverse Park Transformation	285
12.1.4.2 Clarke Transformation	286
12.1.4.3 Park Transformation	286
12.1.5 SVPWM	286
12.1.5.1 Continuous SVPWM	288
12.1.5.2 Discontinuous SVPWM	288
12.1.6 Overmodulation	289
12.1.7 Deadtime Compensation	289
12.1.8 Current and Voltage Sampling	289
12.1.8.1 Single-shunt Current Sampling Mode	289
12.1.8.2 Dual/Triple-shunt Current Sampling Mode	292

12.1.8.3 Current Sampling Offset.....	293
12.1.9 Angle Mode	293
12.1.9.1 Forced Ramping Angle.....	294
12.1.9.2 Forced Pulling Angle.....	294
12.1.9.3 Estimator Output Angle.....	295
12.1.9.3.1 Estimated Angle of Estimator.....	295
12.1.9.3.2 Forced Angle of Estimator	296
12.1.9.3.3 Angle Smooth Switching.....	296
12.1.9.3.4 Angle Compensation.....	297
12.1.10 Motor Real-time Parameters.....	297
12.1.10.1 Tailwind/headwind Detection.....	298
12.1.10.2 BEMF Detection.....	298
12.1.10.3 Motor Power	298
12.1.11 FG Output Generation	298
12.2 FOC Registers.....	299
12.2.1 FOC_CR0 (0x409F)	299
12.2.2 FOC_CR1 (0x40A0).....	300
12.2.3 FOC_CR2 (0x40A1).....	301
12.2.4 FOC_CR3 (0x409E).....	302
12.2.5 FOC_TSMIN (0x40A2)	303
12.2.6 FOC_TGLI (0x40A3).....	303
12.2.7 FOC_TBLO (0x40A4).....	303
12.2.8 FOC_TRGDLY (0x40A5).....	304
12.2.9 FOC_CSO (0x40A6, 0x40A7).....	304
12.2.10 FOC_RTHERSTEP (0x40A8, 0x40A9).....	305
12.2.11 FOC_RTHERACC (0x40AA, 0x40AB)	305
12.2.12 FOC_EOMELPF (0x40AA, 0x40AB)	306
12.2.13 FOC_RTHERCNT (0x40AC).....	306
12.2.14 FOC_THERCOR (0x40AD)	307
12.2.15 FOC_EMF (0x40AE, 0x40AF).....	307
12.2.16 FOC_THERCOMP (0x40AE, 0x40AF).....	307
12.2.17 FOC_DMAX (0x40B0, 0x40B1).....	308

12.2.18 FOC_OMEEST (0x40B0, 0x40B1).....	308
12.2.19 FOC_DMIN (0x40B2, 0x40B3).....	309
12.2.20 FOC_ATAN_THETA (0x40B2, 0x40B3).....	309
12.2.21 FOC_QMAX (0x40B4, 0x40B5).....	309
12.2.22 FOC_QMIN (0x40B6, 0x40B7)	310
12.2.23 FOC_UD (0x40B8, 0x40B9).....	310
12.2.24 FOC_UQ (0x40BA, 0x40BB).....	311
12.2.25 FOC_ID (0x40BC, 0x40BD)	311
12.2.26 FOC_IQ (0x40BE, 0x40BF).....	311
12.2.27 FOC_IBET (0x40C0, 0x40C1)	312
12.2.28 FOC_IQ_LPFK (0x40C0)	312
12.2.29 FOC_ID_LPFK (0x40C1)	312
12.2.30 FOC_VBET (0x40C2, 0x40C3)	313
12.2.31 FOC_UDCPS (0x40C2, 0x40C3)	313
12.2.32 FOC_UQCPS (0x40C4, 0x40C5).....	313
12.2.33 FOC_VALP (0x40C4, 0x40C5).....	314
12.2.34 FOC_FLUX (0x40C6, 0x40C7).....	314
12.2.35 FOC_IC (0x40C6, 0x40C7).....	315
12.2.36 FOC_LQ (0x40C8, 0x40C9)	315
12.2.37 FOC_IB (0x40C8, 0x40C9).....	315
12.2.38 FOC_LD (0x40CA, 0x40CB).....	316
12.2.39 FOC_IA (0x40CA, 0x40CB).....	316
12.2.40 FOC_THETA (0x40CC, 0x40CD).....	317
12.2.41 FOC_ETHETA (0x40CE, 0x40CF)	317
12.2.42 FOC_EALP (0x40D0, 0x40D1).....	318
12.2.43 FOC_EBET (0x40D2, 0x40D3).....	318
12.2.44 FOC_EOME (0x40D4, 0x40D5).....	318
12.2.45 FOC_UQEX (0x40D6, 0x40D7)	319
12.2.46 FOC_KFG (0x40D6, 0x40D7)	319
12.2.47 FOC_POW (0x40D8, 0x40D9)	320
12.2.48 FOC_EOMEKLPF (0x40D8)	320
12.2.49 FOC_IAMAX (0x40DA, 0x40DB).....	321

12.2.50 FOC_IBMAX (0x40DC, 0x40DD)	321
12.2.51 FOC_ICMAX (0x40DE, 0x40DF)	322
12.2.52 FOC_EFREQMAX (0x406F)	322
12.2.53 FOC_DKP (0x4070, 0x4071)	323
12.2.54 FOC_EKP (0x4074, 0x4075)	323
12.2.55 FOC_EKI (0x4076, 0x4077)	323
12.2.56 FOC_KSLIDE (0x4078, 0x4079)	324
12.2.57 FOC_EKLPMIN (0x407A, 0x407B)	324
12.2.58 FOC_DKI (0x407C, 0x407D)	325
12.2.59 FOC_OMEKLPF (0x407E, 0x407F)	325
12.2.60 FOC_FBASE (0x4080, 0x4081)	325
12.2.61 FOC_EFREQACC (0x4082, 0x4083)	326
12.2.62 FOC_EFREQLMIN (0x4084, 0x4085)	326
12.2.63 FOC_EFREQLHOLD (0x4086, 0x4087)	327
12.2.64 FOC_EK3 (0x4088, 0x4089)	327
12.2.65 FOC_EK4 (0x408A, 0x408B)	328
12.2.66 FOC_EK1 (0x408C, 0x408D)	328
12.2.67 FOC_EK2 (0x408E, 0x408F)	329
12.2.68 FOC_IDREF (0x4090, 0x4091)	329
12.2.69 FOC_IQREF (0x4092, 0x4093)	329
12.2.70 FOC_QKP (0x4094, 0x4095)	330
12.2.71 FOC_QKI (0x4096, 0x4097)	330
12.2.72 FOC_UDCFLT (0x4098, 0x4099)	331
13 Timer1	332
13.1 Timer1 Operations	332
13.1.1 Timer1 Counter Module	333
13.1.1.1 Prescaler	334
13.1.1.2 Base Timer	334
13.1.1.3 Reload Timer	335
13.1.2 Position Detection	336
13.1.2.1 Position Detection Signal	336
13.1.2.2 CMP/GPIO Position Detection Event	336

13.1.2.3 ADC Position Detection Event.....	337
13.1.2.4 Sampling.....	338
13.1.2.5 Filtering.....	339
13.1.3 Write Timing Interrupt.....	339
13.1.4 Timer1 Interrupt.....	339
13.2 Square-wave Control Based BLDC Motor.....	340
13.2.1 Six-step Phase Commutation of Square Wave Control.....	341
13.2.2 Square-wave Control Working Principle	341
13.2.2.1 60° Commutation Base Time.....	342
13.2.2.2 Forced Commutation at 60°	342
13.2.2.3 Diode Freewheeling Masking	343
13.2.2.4 Angle of Position Detected to Commutation	343
13.2.2.5 Cycle-by-cycle Current Limiting.....	343
13.3 Timer1 Registers	344
13.3.1 TIM1_CR0 (0x4068).....	344
13.3.2 TIM1_CR1 (0x4069).....	345
13.3.3 TIM1_CR2 (0x406A).....	345
13.3.4 TIM1_CR3 (0x406B).....	346
13.3.5 TIM1_CR4 (0x406C).....	347
13.3.6 TIM1_IER (0x406D)	347
13.3.7 TIM1_SR (0x406E)	348
13.3.8 TIM1_BCOR (0x4070, 0x4071)	350
13.3.9 TIM1_CR5 (0x4072).....	350
13.3.10 TIM1_DBRx (x = 1 ~ 7)(0x4072 + 2*x, 0x4073 + 2*x).....	351
13.3.11 TIM1_BCNTR (0x4082, 0x4083)	353
13.3.12 TIM1_BCCR (0x4084, 0x4085)	353
13.3.13 TIM1_BARR (0x4086, 0x4087)	354
13.3.14 TIM1_RARR (0x4088, 0x4089)	354
13.3.15 TIM1_RCNTR (0x408A, 0x408B)	355
13.3.16 TIM1_UCOP (0x408C, 0x408D)	355
13.3.17 TIM1_UFLP (0x408E, 0x408F).....	356
13.3.18 TIM1_URES (0x4090, 0x4091)	356

13.3.19 TIM1_KRMAX (0x4092).....	356
13.3.20 TIM1_KFMIN (0x4093)	357
13.3.21 TIM1_KF (0x4094, 0x4095)	357
13.3.22 TIM1_KR (0x4096, 0x4097).....	357
13.3.23 TIM1_ITRIP (0x4098, 0x4099).....	358
14 Timer2	359
14.1 Timer2 Instructions	359
14.1.1 Prescaler	359
14.1.2 Reading, Writing, and Counting of TIM2_CNTR	360
14.1.3 Output Mode	360
14.1.3.1 Reading and Writing of TIM2_ARR/TIM2_DR.....	360
14.1.3.2 High/Low Level Output	361
14.1.3.3 PWM Generation.....	361
14.1.3.4 Interrupts.....	361
14.1.4 Input Signal Filtering and Edge Detection	362
14.1.5 Input Capture Mode	363
14.1.6 Input Counter Mode	364
14.1.7 QEP&RSD Mode	365
14.1.7.1 RSD Comparator Sampling	367
14.1.8 Step Mode	367
14.2 Timer2 Registers	369
14.2.1 TIM2_CR0 (0xA1).....	369
14.2.2 TIM2_CR1 (0xA9).....	370
14.2.3 TIM2_CNTR (0xAA, 0xAB).....	372
14.2.4 TIM2_DR (0xAC, 0xAD)	372
14.2.5 TIM2_ARR (0xAE, 0xAF).....	373
15 Timer3/Timer4.....	374
15.1 Timer3/Timer4 Instructions.....	374
15.1.1 Prescaler	374
15.1.2 Reading, Writing and Counting of TIMx_CNTR.....	375
15.1.3 Output Mode	375
15.1.3.1 High-/Low-level Output Mode	375

15.1.3.2 PWM Generation.....	375
15.1.3.3 Interrupt Event.....	376
15.1.4 Input Signal Filtering and Edge Detection	376
15.1.5 Input Capture Mode	377
15.1.6 Timer4 FG Output Mode	378
15.2 Timer3/Timer4 Registers	379
15.2.1 TIMx_CR0 (0x9C/0x9E) (x = 3/4)	379
15.2.2 TIMx_CR1 (0x9D/0x9F) (x = 3/4)	380
15.2.3 TIMx_CNTR (0xA2, 0xA3/0x92, 0x93) (x = 3/4).....	381
15.2.4 TIMx_DR (0xA4, 0xA5/0x94, 0x95) (x = 3/4)	381
15.2.5 TIMx_ARR (0xA6, 0xA7/0x96, 0x97) (x = 3/4).....	382
16 SysTick	383
16.1 SysTick Instructions	383
16.2 SysTick Registers	383
16.2.1 DRV_SR (0x4061)	383
16.2.2 SYST_ARR (0x4064, 0x4065)	384
17 Driver	385
17.1 Driver Instructions	385
17.1.1 Driver Introduction of FU6572 / FU6562.....	385
17.1.2 FU6565 / FU6563 Driver Introduction	385
17.1.3 Driver Introduction of FU6532.....	386
17.1.4 Driver Introduction of FU6522.....	387
17.1.5 Output Control Module.....	388
17.1.5.1 Count and Compare Module.....	388
17.1.5.2 Enable and Polarity of Output Signals	389
17.1.5.3 Deadtime Module.....	390
17.1.5.4 Main Output Enable (MOE)	391
17.1.5.5 Interrupt.....	392
17.1.5.5.1 Compare Match Interrupt	392
17.1.5.5.2 FG Interrupt.....	392
17.2 Driver Registers.....	393
17.2.1 PI_CR (0xF9).....	393

17.2.2 DRV_CR (0x4062).....	393
17.2.3 DRV_SR (0x4061)	394
17.2.4 DRV_OUT (0xF8).....	395
17.2.5 DRV_CMR (0x405C, 0x405D).....	396
17.2.6 DRV_ARR (0x405E, 0x405F).....	398
17.2.7 DRV_COMR (0x405A, 0x405B)	399
17.2.8 DRV_DR (0x4058, 0x4059).....	399
17.2.9 DRV_DTR (0x4060).....	400
17.2.10 DRV_CNTR (0x4066, 0x4067).....	400
18 System clock.....	401
18.1 Clock Introduction.....	401
18.2 Clock Calibration Introduction.....	401
18.3 Registers.....	402
18.3.1 CAL_CR (0x4044, 0x4045).....	402
19 WDT.....	403
19.1 WDT Notes	403
19.2 WDT Instructions.....	403
19.3 WDT Registers.....	404
19.3.1 WDT_CR (0x4026).....	404
19.3.2 WDT_ARR (0x4027).....	404
19.3.3 CCFG1 (0x401E)	404
20 RTC.....	405
20.1 RTC Functional Block Diagram.....	405
20.2 RTC Operations.....	405
20.3 RTC Registers.....	405
20.3.1 RTC_TM (0x402C, 0x402D).....	405
20.3.2 RTC_STA (0x402E).....	406
21 IO.....	407
21.1 IO Introduction	407
21.2 IO Operations.....	408
21.3 IO Registers.....	410

21.3.1 P0_OE (0xFC).....	410
21.3.2 P1_OE (0xFD).....	410
21.3.3 P2_OE (0xFE).....	410
21.3.4 P3_OE (0xFF).....	410
21.3.5 P4_OE (0xE9).....	411
21.3.6 P5_OE (0xFB).....	411
21.3.7 P1_AN (0x4050).....	412
21.3.8 P2_AN (0x4051).....	412
21.3.9 P3_AN (0x4052).....	413
21.3.10 P4_AN(0x4047).....	413
21.3.11 P0_PU (0x4053).....	414
21.3.12 P1_PU (0x4054).....	414
21.3.13 P2_PU (0x4055).....	414
21.3.14 P3_PU (0x4056).....	414
21.3.15 P4_PU (0x4057).....	415
21.3.16 P5_PU (0x4048).....	415
21.3.17 PH_SEL (0x404C).....	416
21.3.18 PH_SEL1 (0x404D).....	416
21.3.19 PH_SEL2 (0x4049).....	417
21.3.20 P0 (0x80).....	418
21.3.21 P1 (0x90).....	418
21.3.22 P2 (0xA0).....	418
21.3.23 P3 (0xB0).....	419
21.3.24 P4 (0xB8).....	419
21.3.25 P5 (0xC0).....	420
22 ADC.....	421
22.1 ADC Introduction.....	421
22.2 ADC Functional Block Diagram.....	421
22.3 ADC Operations.....	422
22.3.1 Sequential Sampling Mode.....	422
22.3.2 Triggered Sampling Mode.....	423
22.3.3 Output Data Format.....	423

22.4 ADC Registers.....	424
22.4.1 ADC_CR (0x4039).....	424
22.4.2 ADC_MASK (0x4036, 0x4037).....	425
22.4.3 PH_SEL2 (0x4049)	426
22.4.4 DAC_CR (0x4035).....	426
22.4.5 ADC_SCYC (0x4038)	426
22.4.6 ADC0_DR (0x0FD8, 0x0FD9)	427
22.4.7 ADC1_DR (0x0FDA, 0x0FDB).....	427
22.4.8 ADC2_DR (0x0FDC, 0x0FDD)	428
22.4.9 ADC3_DR (0x0FDE, 0x0FDF)	428
22.4.10 ADC4_DR (0x0FE0, 0x0FE1).....	429
22.4.11 ADC5_DR (0x0FE2, 0x0FE3).....	429
22.4.12 ADC6_DR (0x0FE4, 0x0FE5).....	430
22.4.13 ADC7_DR (0x0FE6, 0x0FE7).....	430
22.4.14 ADC8_DR (0x0FE8, 0x0FE9).....	431
22.4.15 ADC9_DR (0x0FEA, 0x0FEB).....	431
22.4.16 ADC10_DR (0x0FEC, 0x0FED)	432
22.4.17 ADC11_DR (0x0FEE, 0x0FEF)	432
22.4.18 ADC12_DR (0x0FF0, 0x0FF1).....	433
22.4.19 ADC13_DR (0x0FF2, 0x0FF3).....	433
22.4.20 ADC14_DR (0x0FF4, 0x0FF5).....	434
22.4.21 ADC15_DR (0x0FF6, 0x0FF7).....	434
23 DAC.....	436
23.1 DAC Introduction.....	436
23.2 DAC0 Functional Block Diagram	436
23.3 DAC1 Functional Block Diagram	437
23.4 DAC Registers.....	438
23.4.1 DAC_CR (0x4035).....	438
23.4.2 DAC0_DR (0x404B)	439
23.4.3 DAC1_DR (0x404A)	439
24 DMA.....	440
24.1 DMA Instructions.....	440

24.2 DMA Registers.....	441
24.2.1 DMA0_CR0 (0x403A).....	441
24.2.2 DMA1_CR0 (0x403B).....	442
24.2.3 DMA0_LEN (0x403C).....	443
24.2.4 DMA0_BA (0x403E, 0x403F).....	443
24.2.5 DMA1_LEN (0x403D)	444
24.2.6 DMA1_BA (0x4040, 0x4041).....	444
25 VREF	446
25.1 VREF Instructions	446
25.2 VREF Registers.....	447
25.2.1 VREF_VHALF_CR (0x404F).....	447
26 VHALF	448
26.1 VHALF Instructions.....	448
26.2 VHALF Registers.....	448
27 Operational Amplifier	449
27.1 Operational Amplifier Introduction.....	449
27.2 Operational Amplifier Instructions	449
27.2.1 Bus Current Sampling Operational Amplifier (AMP0).....	449
27.2.1.1 AMP0 Normal Mode.....	449
27.2.1.2 AMP0 PGA Differential Input Mode.....	450
27.2.2 Phase Current Operational Amplifier (AMP1/AMP2)	450
27.2.2.1 AMP1 Normal Mode.....	450
27.2.2.2 AMP2 Normal Mode.....	451
27.2.2.3 AMP1 PGA Differential Input Mode.....	451
27.2.2.4 AMP2 PGA Differential Input Mode.....	451
27.2.3 Operational Amplifier AMP3	452
27.2.3.1 AMP3 Normal Mode.....	452
27.2.3.2 AMP3 PGA Differential Input Mode.....	452
27.3 Operational Amplifier Registers.....	453
27.3.1 AMP_CR0 (0x404E)	453
27.3.2 AMP_CR1 (0x4034).....	454
27.3.3 AMP_CR2 (0x4046).....	454

28 Comparator.....	455
28.1 Comparator Operations.....	455
28.1.1 Comparator CMP3.....	455
28.1.1.1 Overcurrent Protection.....	457
28.1.1.2 Cycle-by-cycle Current Limiting.....	458
28.1.2 Comparator CMP4.....	459
28.1.3 Comparator Group CMPG	460
28.1.3.1 CMPG Mode with Three Comparators (Without Built-in Resistor).....	460
28.1.3.2 CMPG Mode with Three Comparators and Built-in Resistors.....	461
28.1.3.3 CMPG Mode with Three Differential Comparators.....	462
28.1.3.4 CMPG Mode with Dual-comparators	463
28.1.4 Comparator Sampling.....	463
28.2 Comparator Registers.....	465
28.2.1 CMP_CR0 (0xD5)	465
28.2.2 CMP_CR1 (0xD6)	466
28.2.3 CMP_CR2 (0xDA).....	466
28.2.4 CMP_CR3 (0xDC).....	469
28.2.5 CMP_CR4 (0xE1).....	470
28.2.6 CMP_SAMR (0x40AD)	470
28.2.7 CMP_SR (0xD7)	471
28.2.8 HALL_CR (0xE2).....	472
28.2.9 EVT_FILT (0xD9)	473
28.2.10 TSD_CR (0x402F).....	473
29 Power Supply	475
29.1 LDO.....	475
29.1.1 LDO Operations (for FU6572 / FU6532).....	475
29.1.2 LDO Operations (for FU6565 / FU6563).....	475
29.2 Low Voltage Detection (LVD).....	476
29.2.1 LVD Introduction.....	476
29.2.2 LVD Operations	476
29.2.3 LVD Registers	477
29.2.3.1 LVSR (0xDB).....	477

30 Flash.....	479
30.1 Flash Introduction	479
30.2 Flash Operations.....	479
30.3 Flash Registers.....	480
30.3.1 FLA_CR (0x85)	480
30.3.2 FLA_KEY (0x84)	481
31 CRC	482
31.1 CRC Functional Block Diagram	482
31.2 CRC16 Polynomial.....	482
31.3 CRC16 Logic Diagram	482
31.4 CRC Operations.....	483
31.4.1 CRC Calculation of Single Byte	483
31.4.2 CRC Calculation of ROM Sector	483
31.5 CRC Registers	485
31.5.1 CRC_CR (0x4022)	485
31.5.2 CRC_DIN (0x4021)	485
31.5.3 CRC_DR (0x4023)	486
31.5.4 CRC_BEG (0x4024)	486
31.5.5 CRC_CNT (0x4025)	486
32 Sleep Mode	487
32.1 Introduction	487
32.2 Sleep Mode Registers	488
32.2.1 PCON(0x87).....	488
33 Code Protection.....	489
33.1 Instructions	489
33.2 Operating Instructions.....	489
34 Revision History.....	491

Explanation of Symbols

- > The symbol “[]” following a register indicates a bit in the register. For example, ABCD[XY] indicates the XY bit in ABCD register.
- > The symbol “x” in a register name indicates similar registers. For example, TIMx_CR0 indicates TIM3_CR0 and TIM4_CR0.
- > [m:n] indicates a range of bits. For example, [3:0] means the bits from bit3 to bit0.
- > Pm.n indicates the nth port of the Portm. P0.0 indicates the 0th port of Port0.
- > Register read and write symbols:
 - >> R: Read only
 - >> W: Write only
 - >> R/W: Read/write
 - >> W0: Only 0 can be written
 - >> W1: Only 1 can be written
- > The symbol “-” indicates an uncertainty value or invalid value.
- > The RMW instruction cannot be used for registers with different read and written representations.
- > Q (number) format is to store floating-point numbers using fixed-point numbers. MSB is the sign bit, followed by integer bits and fraction bits, where lower Q bits are assigned to the fractional part and the remaining bits are assigned to the integer part. For example, for Q12, bit15 is the sign bit, bit14 ~ bit12 represent the integer part and bit11 ~ bit0 represent the fraction part. The Q12 format has a decimal range -8 ~ 7.9998 (corresponding to 0x8000 ~ 0x7FFF).

Abbreviations

ADC	Analog to Digital Convertor
BEMF	Back Electromotive Force
BLDC	Brushless Direct Current
CRC	Cyclic Redundancy Check
DAC	Digital to Analog Convertor
DMA	Direct Memory Access
FG	Frequency Generator
FICE	Fortior Interactive Connectivity Establishment
FOC	Field Oriented Control
FOSC	Fast Oscillator
GPIO	General Purpose Input Output
IC	Integrated Circuit
I ² C	Inter Integrated Circuit
IDE	Integrated Development Environment
IRAM	Internal RAM
LDO	Low Dropout Regulator
LPF	Low Pass Filter
LSB	Least Significant Bit
LVD	Low Voltage Detection
MDU	Multiplication Division Unit
ME	Motor Engine
MSB	Most Significant Bit
MOSFET	Metal Oxide Semiconductor Field Effect Transistor
NC	Not Connected
PGA	Programmable Gain Amplifier
PI/PID	Proportional Integral/Proportional Integral Derivative
PLL	Phase Locked Loop
PWM	Pulse Width Modulation
QEP	Quadrature Encoder Pulse

RAM	Random Access Memory
RMW	Read Modified Write
ROM	Read Only Memory
RSD	Rotating State Detection
RTC	Real Time Clock
SAR	Successive Approximation Register
SCL	Serial Clock Line
SDA	Serial Data Line
SFR	Special Function Register
SMO	Sliding Mode Observer
SOSC	Slow Oscillator
SPI	Serial Peripheral Interface
SVPWM	Space Vector PWM
TSD	Temperature Sensor Detect
UART	Universal Asynchronous Receiver/Transmitter
WDT	Watchdog Timer
XRAM	External RAM
XSFR	External SFR

1 System Introduction

1.1 Features

- > Power supply of FU6572L, FU6572N, and FU6572T:
 - >> VCC: 7V ~ 20V
 - >> VDD5: Internal LDO supplies VDD5
- > Power supply of FU6565N and FU6565T:
 - >> VCC: 5V ~ 20V
 - >> VDD5: Internal LDO5 supplies
 - >> VBB: Internal LDO12 supplies
- > Power supply of FU6563N:
 - >> VCC: 6V ~ 28V
 - >> VDD5: Internal LDO5 supplies
 - >> VBB: Internal LDO12 supplies
- > Power supply of FU6562L and FU6562S:
 - >> Dual-power supply mode: External power supply 1 (12V~20V) is connected to VCC pin, and external power supply 2 (3V ~ 5.5V) is connected to VDD5 pin.
- > Power supply of FU6562LA, FU6562Q, and FU6562T:
 - >> Dual-power supply mode: External power supply 1 (10V~20V) is connected to VCC pin, and external power supply 2 (3V ~ 5.5V) is connected to VDD5 pin.
- > Power supply of FU6532N and FU6532T:
 - >> VCC: 5V ~ 28V
 - >> VDD5: Internal LDO supplies VDD5
- > Power supply of FU6522L, FU6522N, and FU6522T:
 - >> VDD5 input 3V ~ 5.5V
- > Dual core: 8051 core and ME core
- > An instruction cycle mostly takes 1 or 2 system clock cycle(s)

- > Supply 24MHz clock frequency
- > 32kB Flash with CRC, self-program and code protection
- > 256 bytes IRAM and 3.75k bytes XRAM
- > ME: Core integrating PID module, FOC module, MDU auxiliary computing module and LPF module
- > 16 interrupt sources with 4 configurable priority levels
- > Number of GPIOs:
 - >> FU6572L: 31
 - >> FU6572N: 24
 - >> FU6572T: 13
 - >> FU6565N: 23
 - >> FU6565T: 12
 - >> FU6563N: 15
 - >> FU6562L: 22
 - >> FU6562LA: 22
 - >> FU6562Q: 22
 - >> FU6562S: 9
 - >> FU6562T: 9
 - >> FU6532N: 23
 - >> FU6532T: 19
 - >> FU6522L: 40
 - >> FU6522N: 24
 - >> FU6522T: 20
- > Timers:
 - >> Timer1: Timer supporting square-wave drive timing control, automatic commutation, cycle-by-cycle current limiting and Hall/BEMF-based position sensing
 - >> Timer2 (FU6572L / FU6562L / FU6562LA / FU6562Q / FU6532N / FU6532T / FU6522L / FU6522N): Timer supporting PWM output, measurement of duty cycle and period of input PWM wave, measurement of the time of set PWM wave numbers, QEP decoding, tailwind/headwind detection, and rotation direction and speed detection of step motor.

- » Timer2 (for FU6572N / FU6572T / FU6565N / FU6565T / FU6563N / FU6562S / FU6562T / FU6522T): Basic timer counting
- » Timer3/Timer4: Timers supporting PWM output, and measurement of duty cycle and period of input PWM wave. Timer4 supports FG generation and Timer3 supports up to 48MHz input
- » SysTick Timer
- » RTC
- > Communication interfaces:
 - » 1*SPI
 - »» 4-wire mode (for FU6572L / FU6522L)
 - »» 3-wire mode (for FU6562L / FU6562LA / FU6562Q / FU6532N / FU6522N)
 - »» Single-wire debug output (for FU6572N / FU6565N / FU6532T / FU6522T)
 - » 1*I²C (for FU6572L / FU6572N / FU6565N / FU6563N / FU6532N / FU6532T / FU6522L / FU6522N / FU6522T)
 - » 2*UART (UART1 and UART2), supporting single-wire mode (for FU6572L / FU6572N / FU6565N / FU6562L / FU6562LA / FU6562Q / FU6532N / FU6532T / FU6522L / FU6522N / FU6522T)
 - » 1*UART(UART2), supporting single--wire mode (for FU6572T / FU6565T / FU6563N / FU6562S / FU6562T)
 - » Dual-channel DMA: supporting data transmission via I²C/SPI/UART (Different models support different communication interfaces. For details, please refer to the above description)
- > Analog peripherals:
 - » 12-bit ADC, operating with 1μs conversion time and internal VREF or external VREF selectable as reference voltage (external VREF is available for FU6572L / FU6572N / FU6572T / FU6565N / FU6565T / FU6563N / FU6562L / FU6562LA / FU6562Q / FU6532N / FU6532T / FU6522L only)
 - » 12-bit ADC, operating with 1μs conversion time and VDD5 selectable as reference voltage (for FU6562S, FU6522N, FU6522T, and FU6562T)
 - » Number of ADC channels:
 - »» FU6572L: 15 (AD0/AD1/AD4 are the internal channels)
 - »» FU6572N: 14 (AD0/AD1/AD4 are internal channels)
 - »» FU6572T: 10 (AD0/AD1/AD4 are internal channels)
 - »» FU6565N: 14 (AD0/AD1/AD4 are internal channels)
 - »» FU6565T: 9 (AD0/AD1/AD4 are internal channels)
 - »» FU6563N: 10 (AD0/AD1/AD4 are internal channels)
 - »» FU6562L: 13 (AD0/AD1 are internal channels)

- »» FU6562LA: 13 (AD0/AD1 are internal channels)
 - »» FU6562Q: 13 (AD0/AD1 are internal channels)
 - »» FU6562S: 7 (AD0/AD1/AD4 are internal channels)
 - »» FU6562T: 7 (AD0/AD1/AD4 are internal channels)
 - »» FU6532N: 13 (AD0/AD1/AD4 are internal channels)
 - »» FU6532T: 10 (AD0/AD1/AD4 are internal channels)
 - »» FU6522L: 16
 - »» FU6522N: 11
 - »» FU6522T: 13 (AD0/AD1/AD4/AD12 are internal channels)
- » Internal VREF. For FU6572L / FU6572N / FU6572T / FU6565N / FU6565T / FU6563N / FU6562L / FU6562LA / FU6562Q / FU6532N / FU6532T / FU6522L, 3V, 4V, 4.5V, and VDD5 can be selected as internal reference. For FU6562S, FU6562T, FU6522N, and FU6522T, only VDD5 can be selected as internal reference.
- » Internal VHALF, with VREF/2, 1/4 VREF, 1/8 VREF, and 25/64 VREF as the internal reference
- » Standalone operational amplifier(s), where PGA is configurable
 - »» FU6572L / FU6572N / FU6565N / FU6562L / FU6562LA / FU6562Q / FU6532N / FU6532T / FU6522L / FU6522N / FU6522T: 4 ↑
 - »» FU6572T / FU6565T / FU6563N / FU6562S / FU6562T: 3 ↑
- » 3-channel analog comparator
- » DAC: Single-channel 9-bit, single-channel 6-bit
- > Drive Type
 - »» 6N Pre-driver output (for FU6572L / FU6572N / FU6572T / FU6565N / FU6565T / FU6563N / FU6562L / FU6562LA / FU6562Q / FU6562S / FU6562T)
 - »» 3P3N output (for FU6532N / FU6532T)
 - »» PWM output (for FU6522L / FU6522N / FU6522T)
- > FOC module supports single/dual/triple-shunt current sampling;
- > System clock
 - »» Built-in 24MHz high-speed RC oscillator
 - »» Built-in 32.8kHz low-speed RC oscillator
- > WDT
- > LVD

- > TSD
- > Two-wire FICE protocol based in-circuit emulation

1.2 Applications

The chip can be used for the drive of sensorless or sensed BLDC/PMSM motors.

- > Applications:
 - » FU6572L / FU6572N / FU6572T / FU6565N / FU6563N: Cooling fans, vacuum cleaners, sweepers, electrical tools, etc.
 - » FU6565T: Cooling fans, vacuum cleaners, sweepers, etc.
 - » FU6562L / FU6562LA / FU6562T: Hair dryers.
 - » FU6562Q: Refrigerators, air-conditioner outdoor units, range hoods, hair dryers, etc.
 - » FU6562S: Hair dryer, ceiling fans, high-voltage fans, etc.
 - » FU6532N: Ceiling fans, standing fans, sweepers, vacuum cleaners, low-voltage hair dryers, etc.
 - » FU6532T: Standing fans, low-voltage ceiling fans, sweepers, vacuum cleaners, water pumps, etc.
 - » FU6522L / FU6522T: Electrical vehicles, balance cars, etc.
 - » FU6522N: Cooling fans.

1.3 Overview

The high-performance motor drive chip incorporates ME core and 8051 core. ME core integrates FOC, MDU, LPF, PID and SVPWM modules that allow for automatic calculation of FOC or square-wave control by the hardware for sensed/sensorless BLDC/PMSM motors. 8051 core is used for parameter configuration and routine processing. Most of 8051 core instruction cycle takes 1T or 2T clock cycle(s). The dual cores work in parallel to achieve high-performance motor control. The chip integrates high-speed operational amplifiers, comparators, high-speed ADC, CRC, SPI, I²C, UART, Timers, built-in LDO, which are suitable for FOC or square-wave based BLDC/PMSM motors.

The above are the general descriptions on the product family. The features vary by models. For details, see section 2 Pin Definitions and 4 Ordering Information.

For concise description and easy differentiation, if it is specified that a feature is applied to a specific model, the feature is exclusive to this model. For example, FU6572 refers to all models of FU6572, FU6522 refers all models of FU6522,

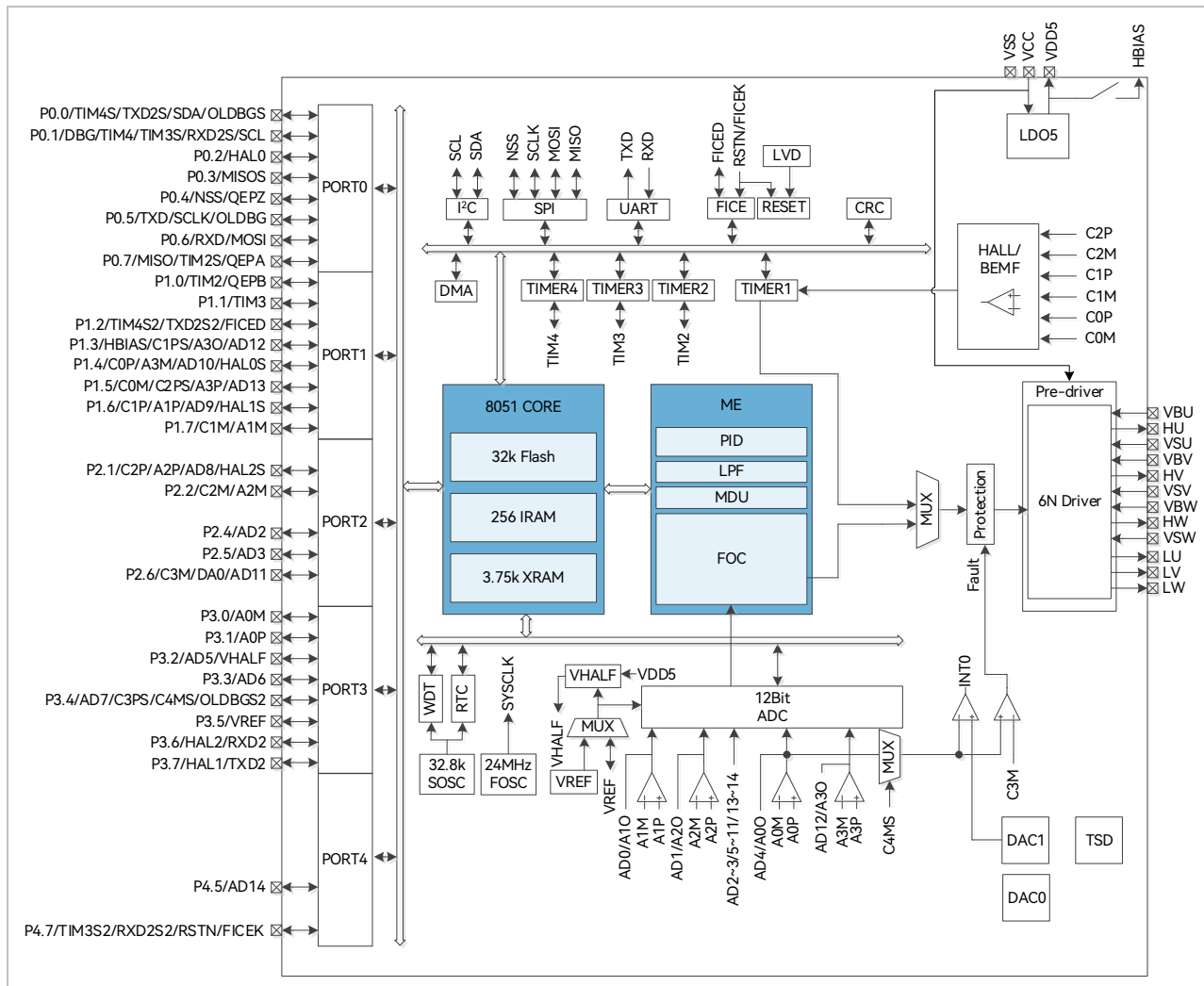
and so on. Otherwise, the feature is a common feature of the product family.

- FU6572 includes: FU6572L(LQFP48), FU6572N(QFN40), and FU6572T(TSSOP28)
- FU6565 includes: FU6565N(QFN40) and FU6565T(TSSOP28)
- FU6563 includes: FU6563N(QFN32)
- FU6562 includes: FU6562L(LQFP48), FU6562LA(LQFP48), FU6562Q(QFN48-38), FU6562S(TSSOP28), and FU6562T(TSSOP28)
- FU6532 includes: FU6532N(QFN32) and FU6532T(TSSOP28)
- FU6522 includes: FU6522L(LQFP48), FU6522N(QFN32), and FU6522T(TSSOP28)

1.4 Functional Block Diagram

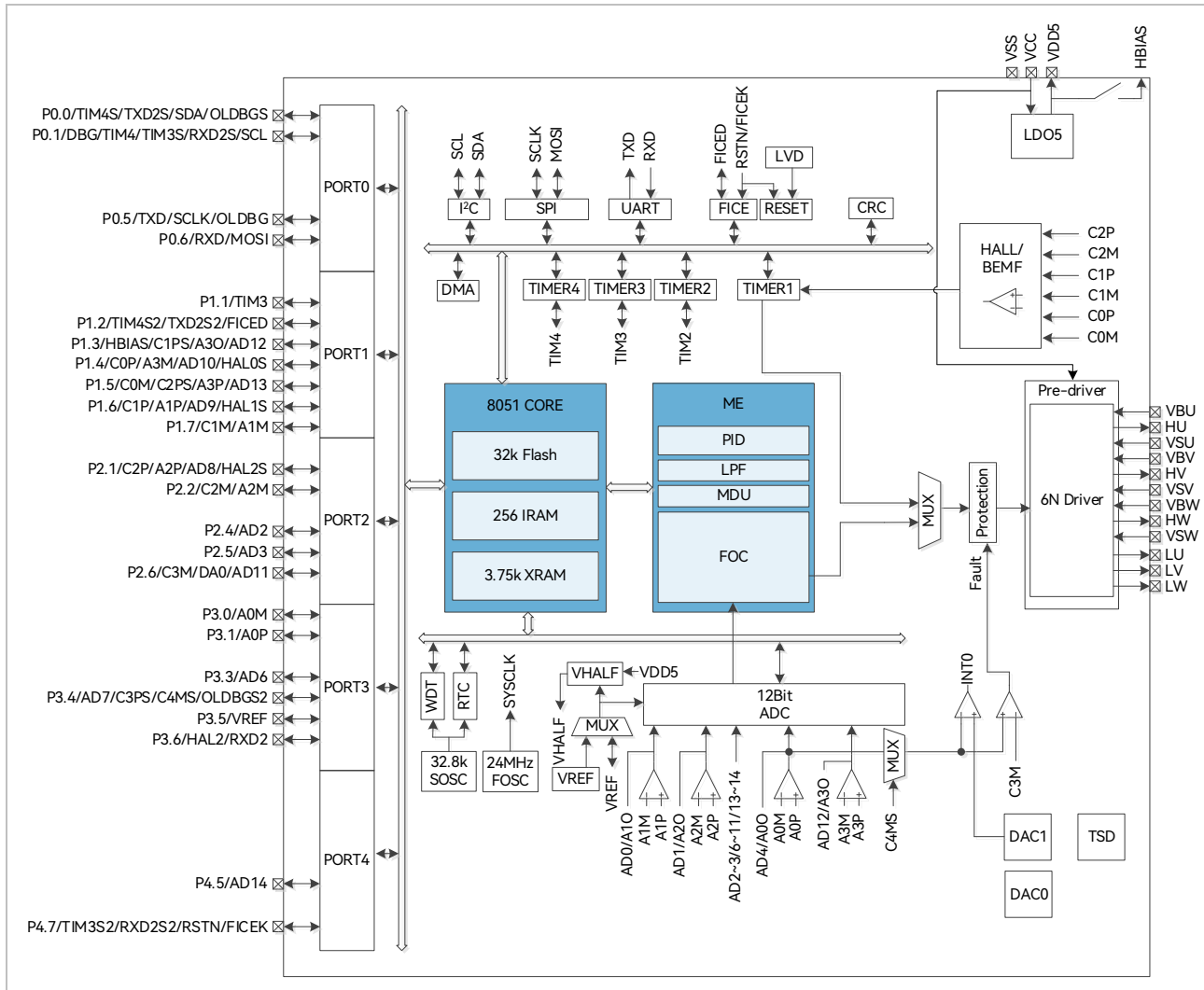
1.4.1 FU6572L

Figure 1-1 Functional Block Diagram of FU6572L



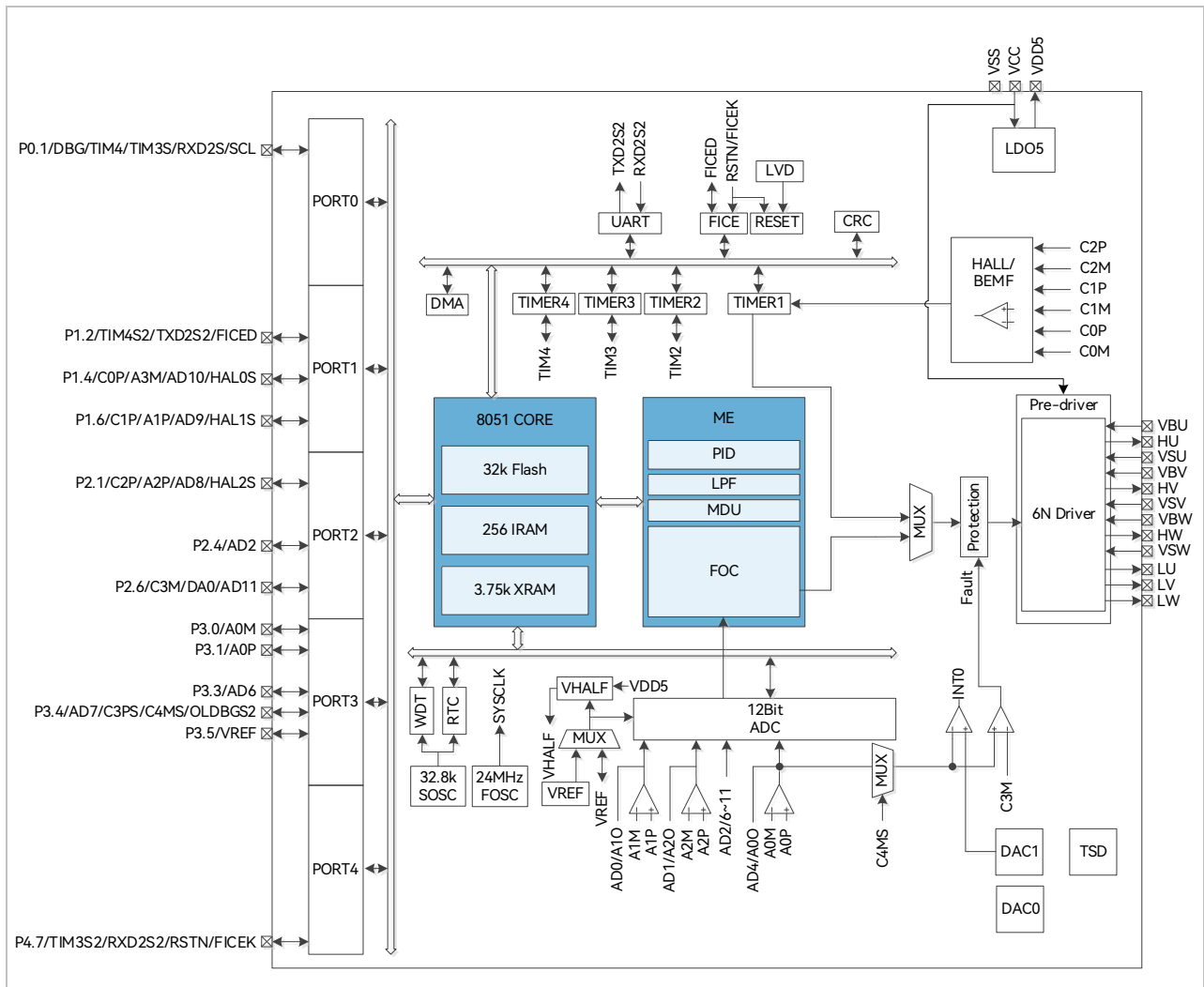
1.4.2 FU6572N

Figure 1-2 Functional Block Diagram of FU6572N



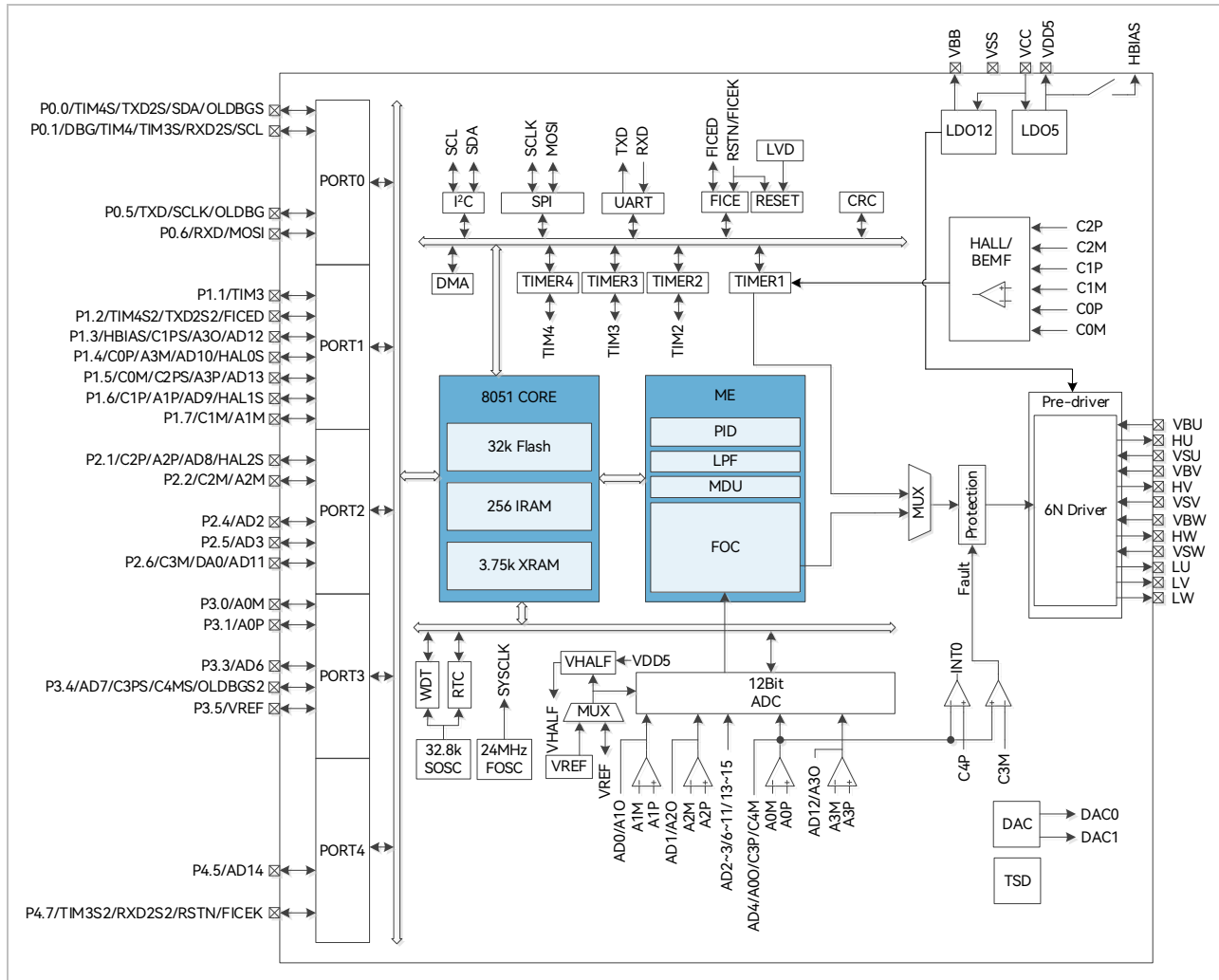
1.4.3 FU6572T

Figure 1-3 Functional Block Diagram of FU6572T



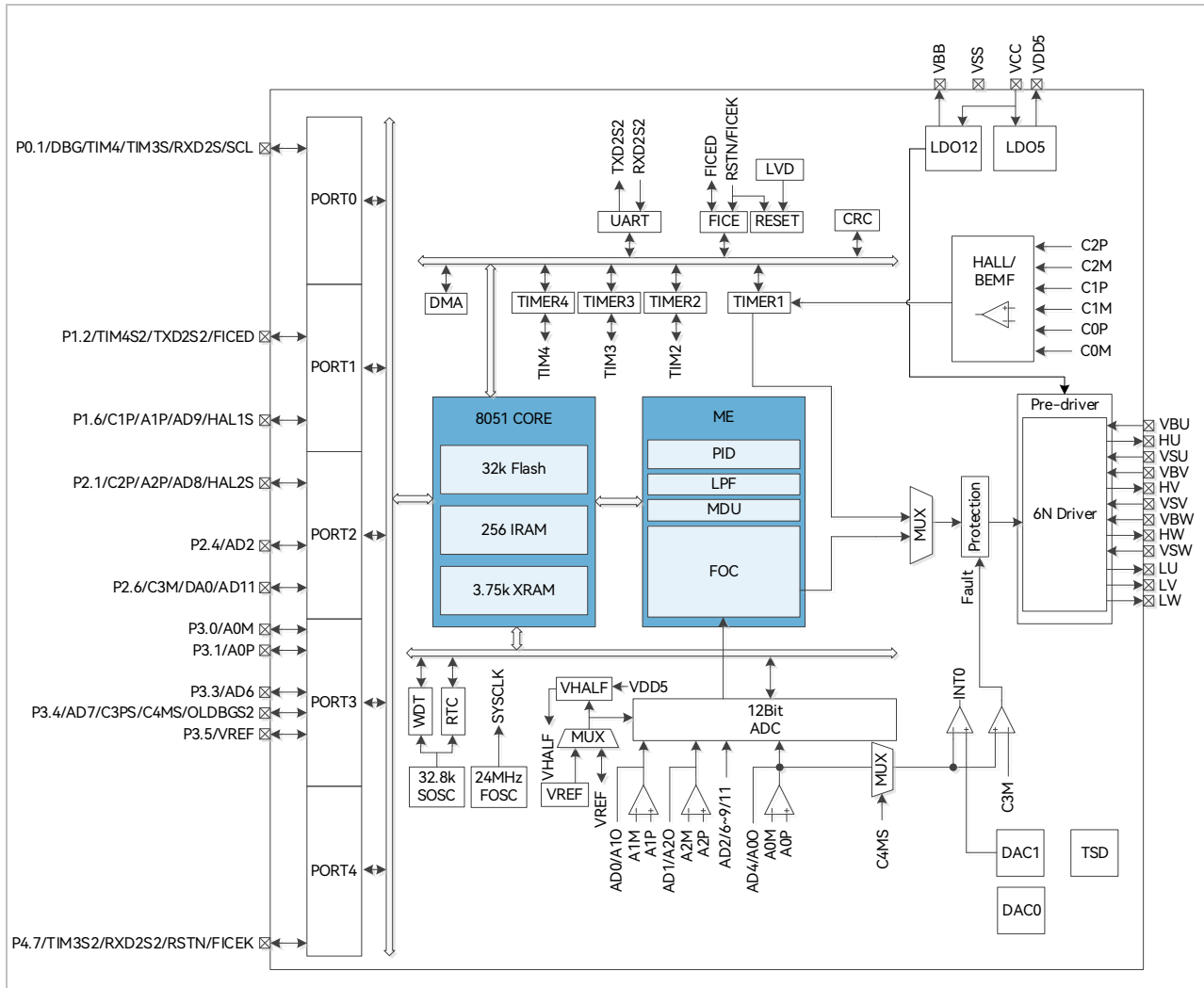
1.4.4 FU6565N

Figure 1-4 Functional Block Diagram of FU6565N



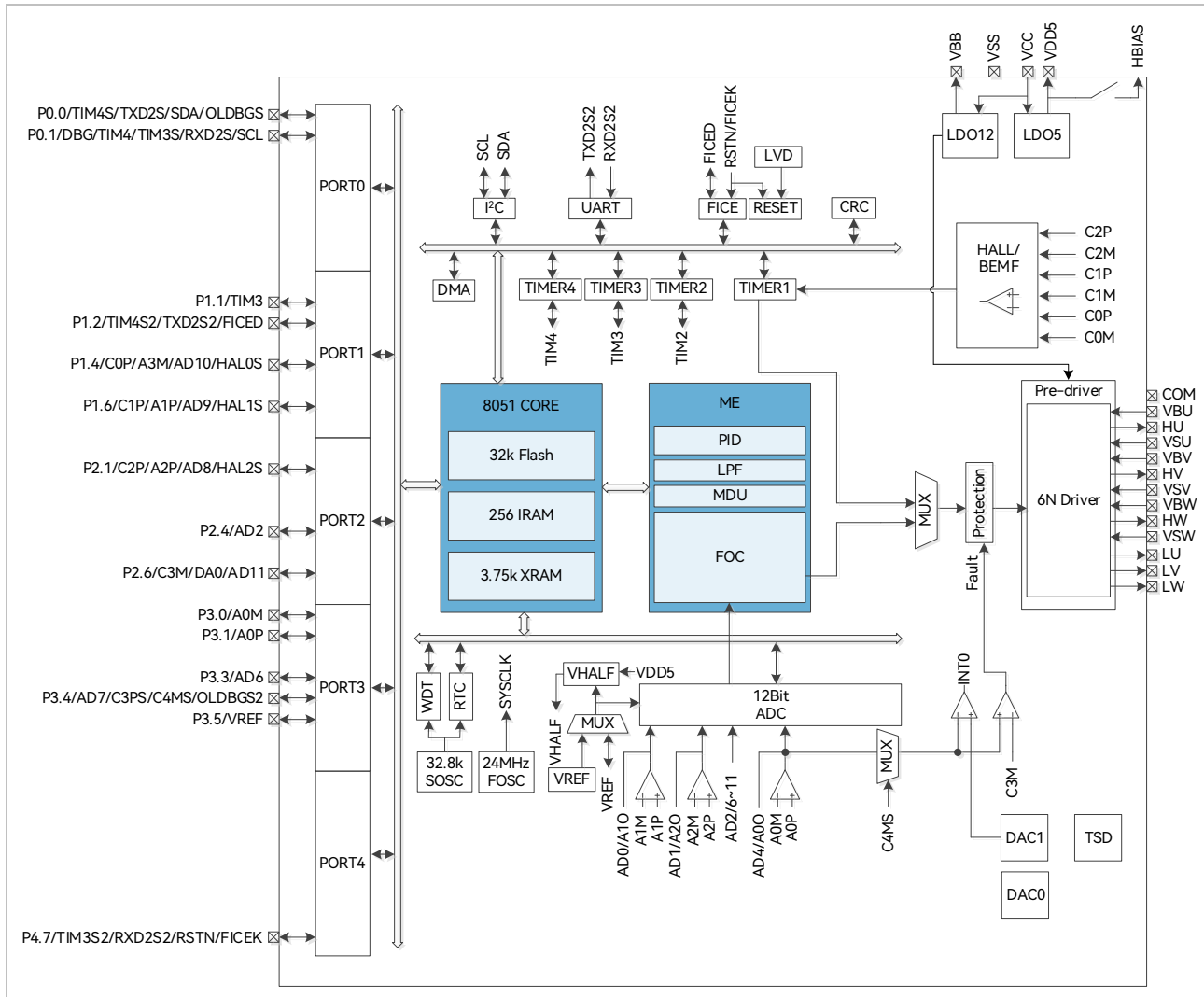
1.4.5 FU6565T

Figure 1-5 Functional Block Diagram of FU6565T



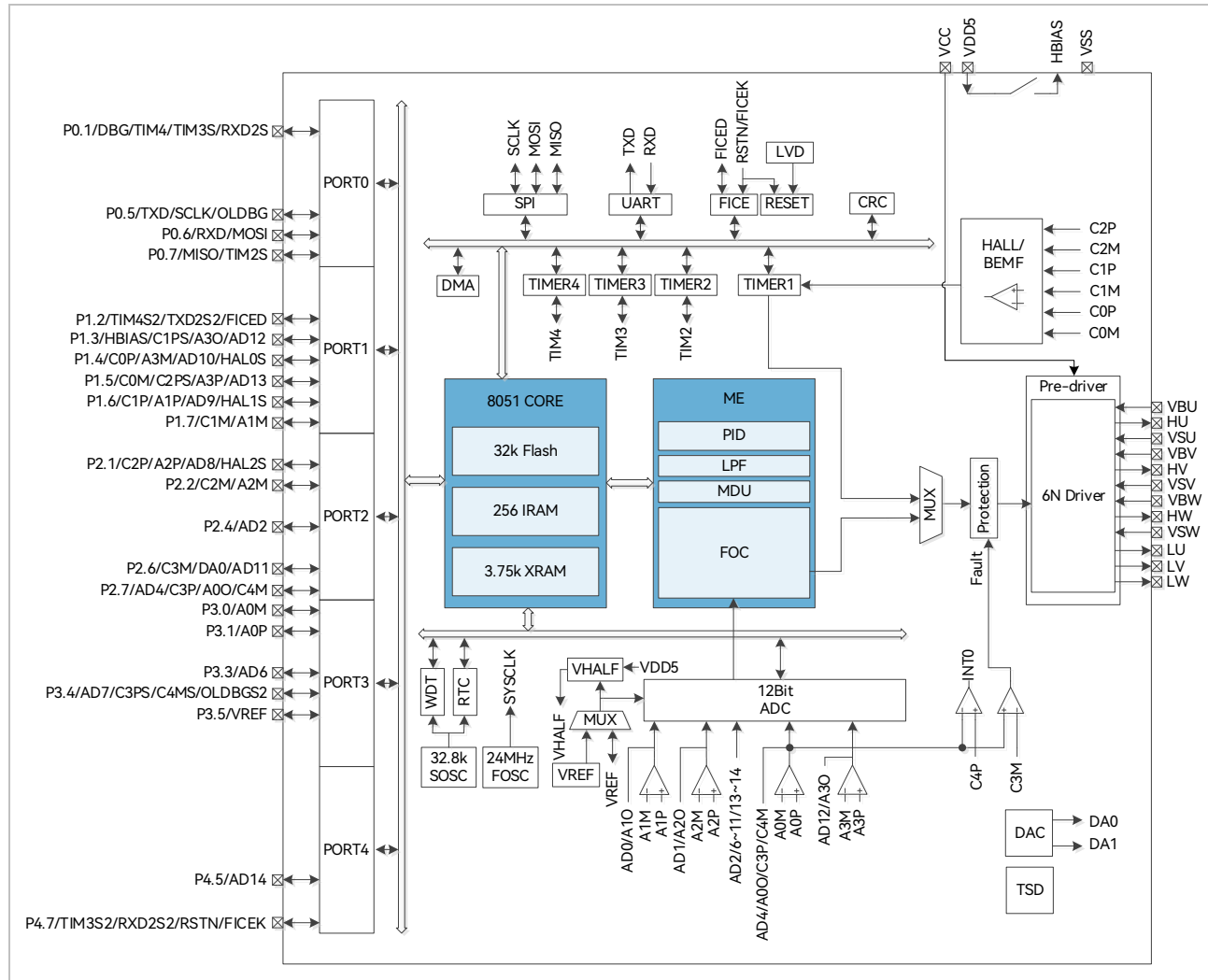
1.4.6 FU6563N

Figure 1-6 Functional Block Diagram of FU6863N



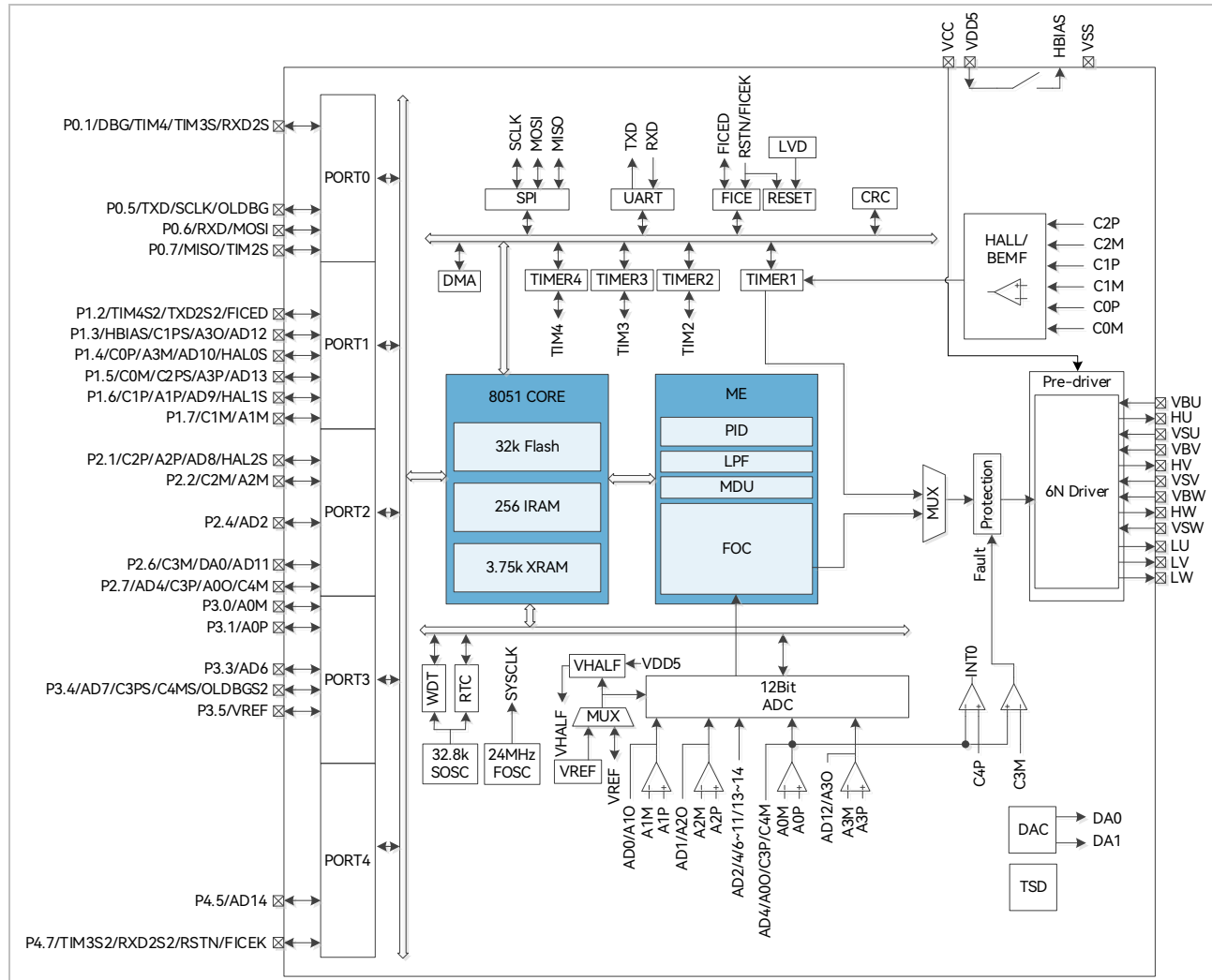
1.4.7 FU6562L

Figure 1-7 Functional Block Diagram of FU6562L



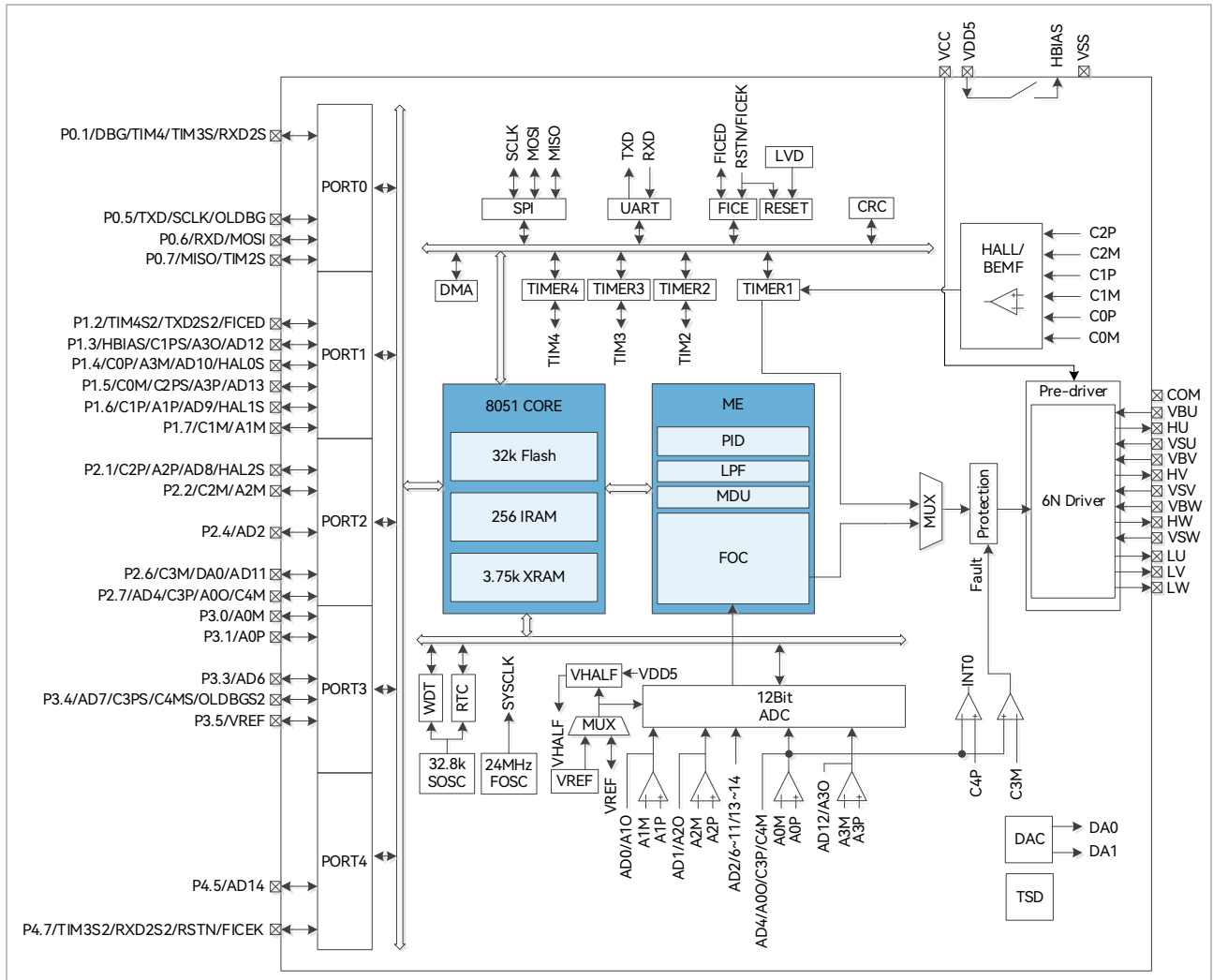
1.4.8 FU6562LA

Figure 1-8 Functional Block Diagram of FU6562LA



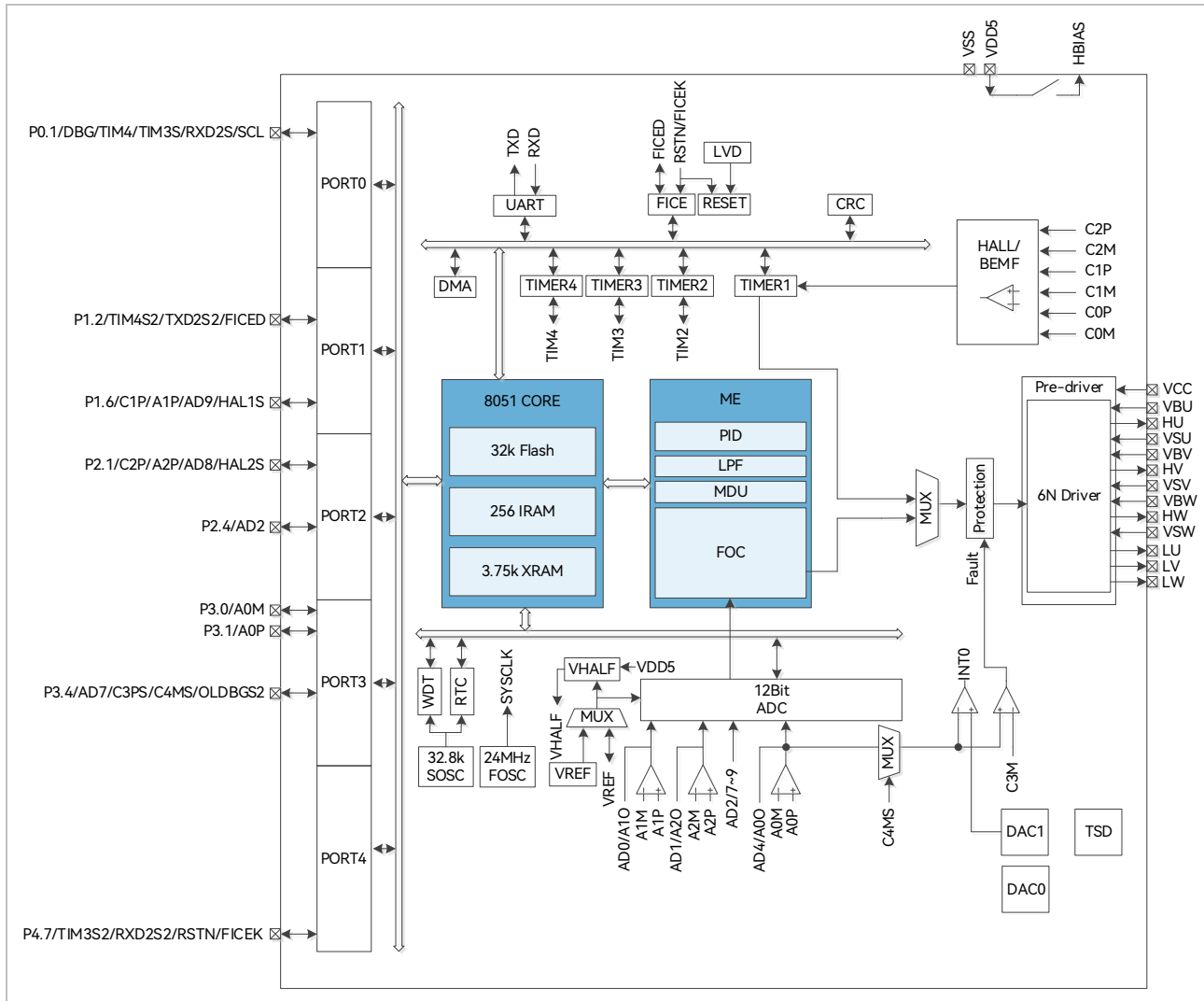
1.4.9 FU6562Q

Figure 1-9 Functional Block Diagram of FU6562Q



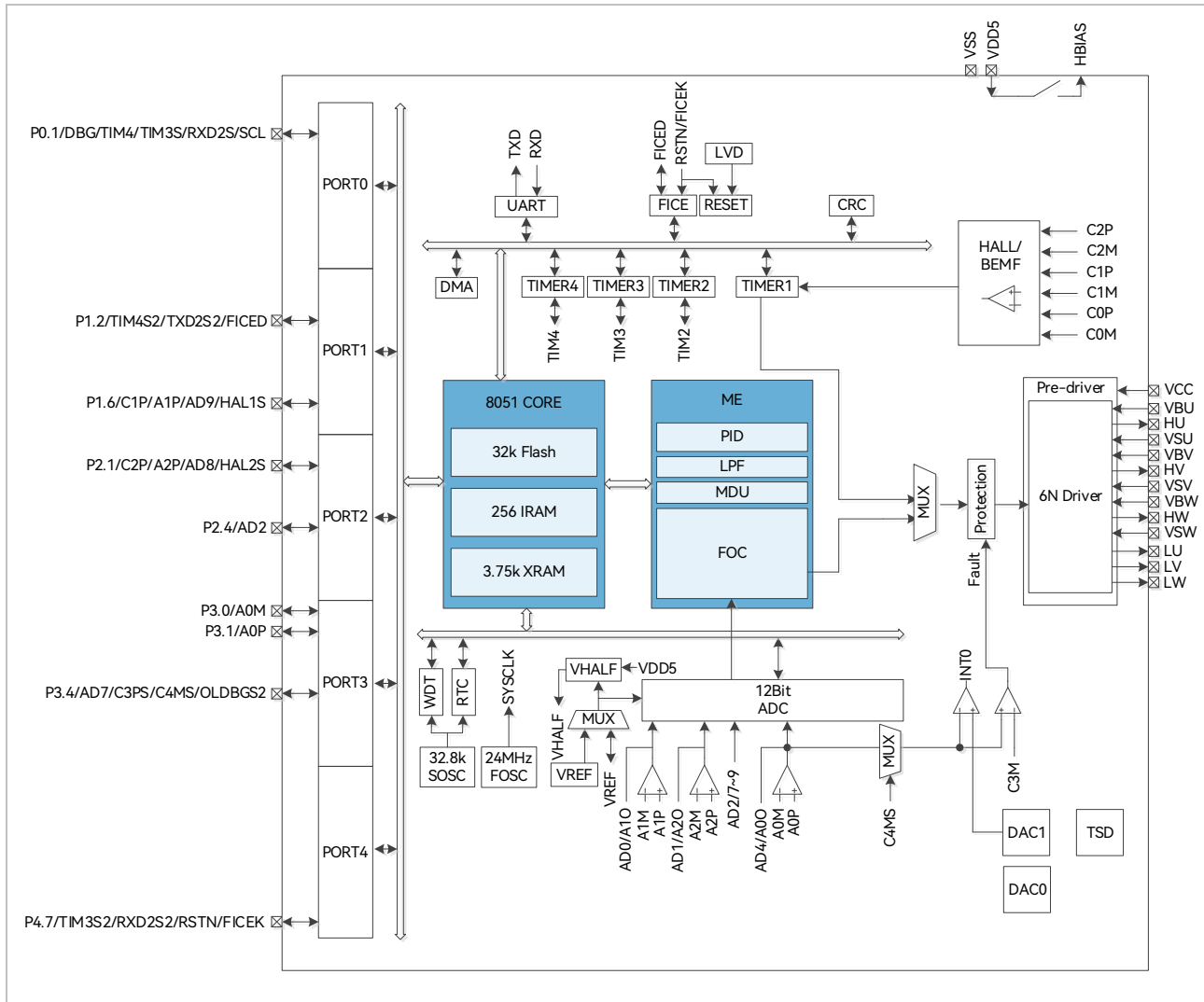
1.4.10 FU6562S

Figure 1-10 Functional Block Diagram of FU6562S



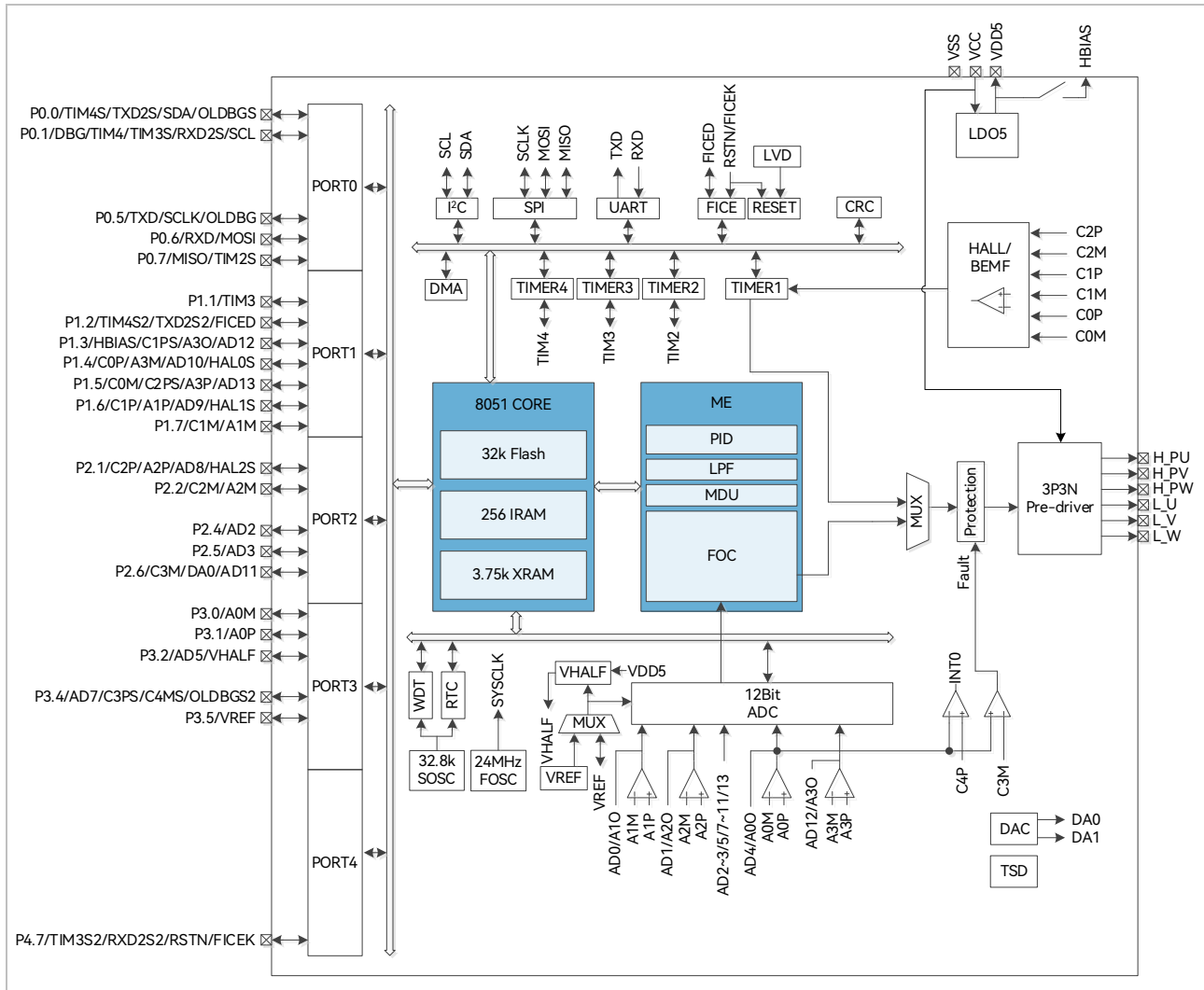
1.4.11 FU6562T

Figure 1-11 Functional Block Diagram of FU6562T



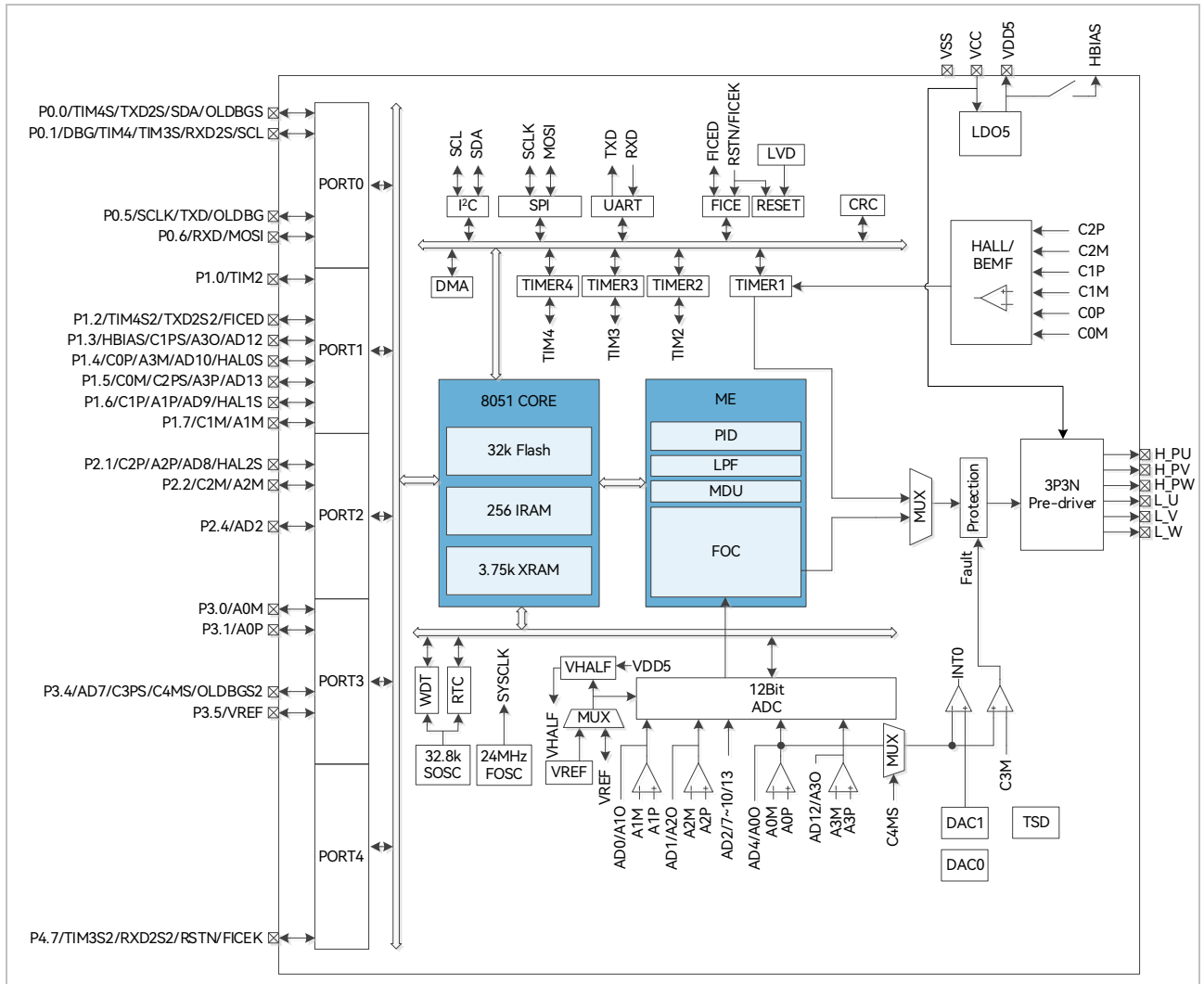
1.4.12 FU6532N

Figure 1-12 Functional Block Diagram of FU6532N



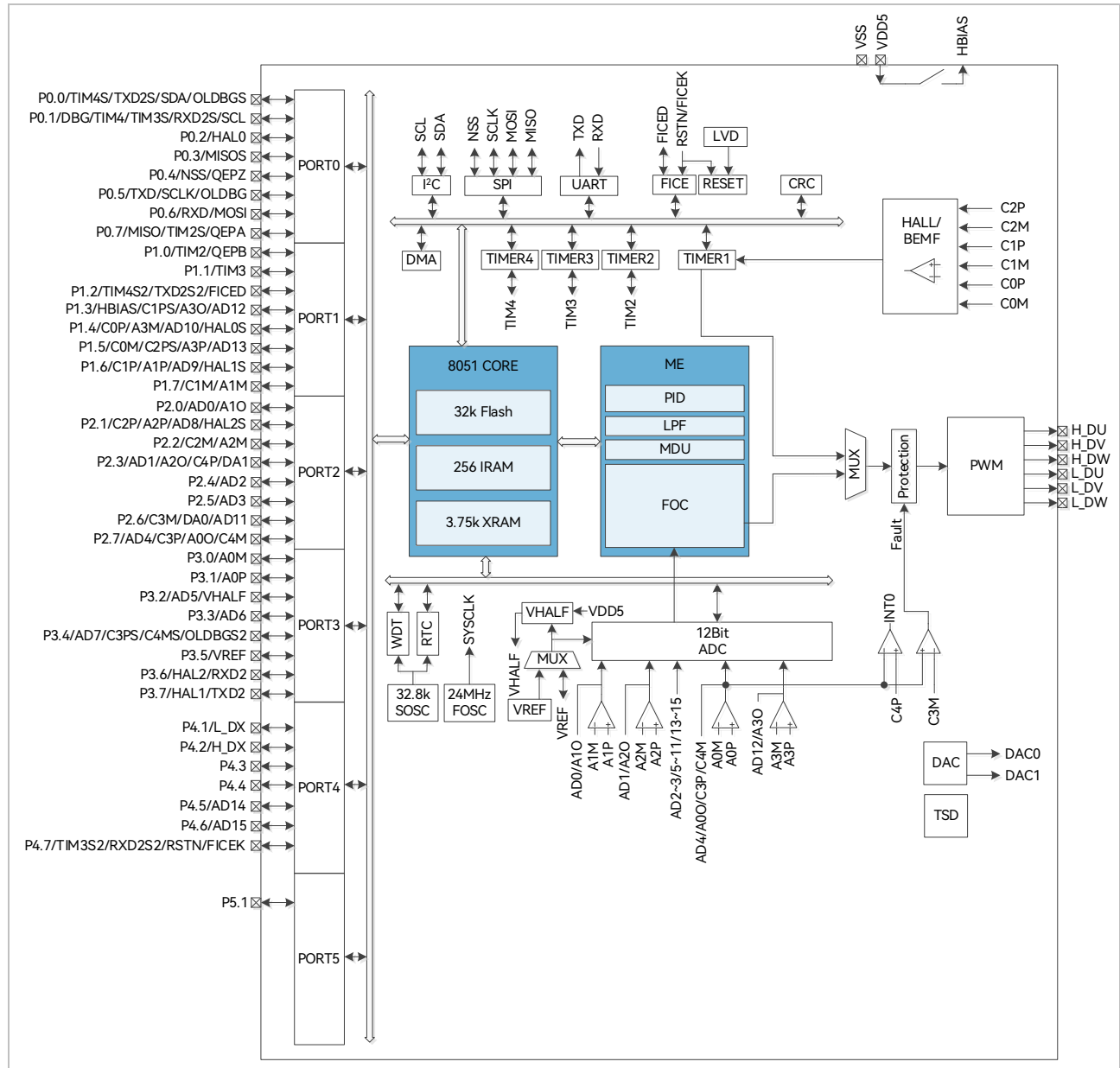
1.4.13 FU6532T

Figure 1-13 Functional Block Diagram of FU6532T



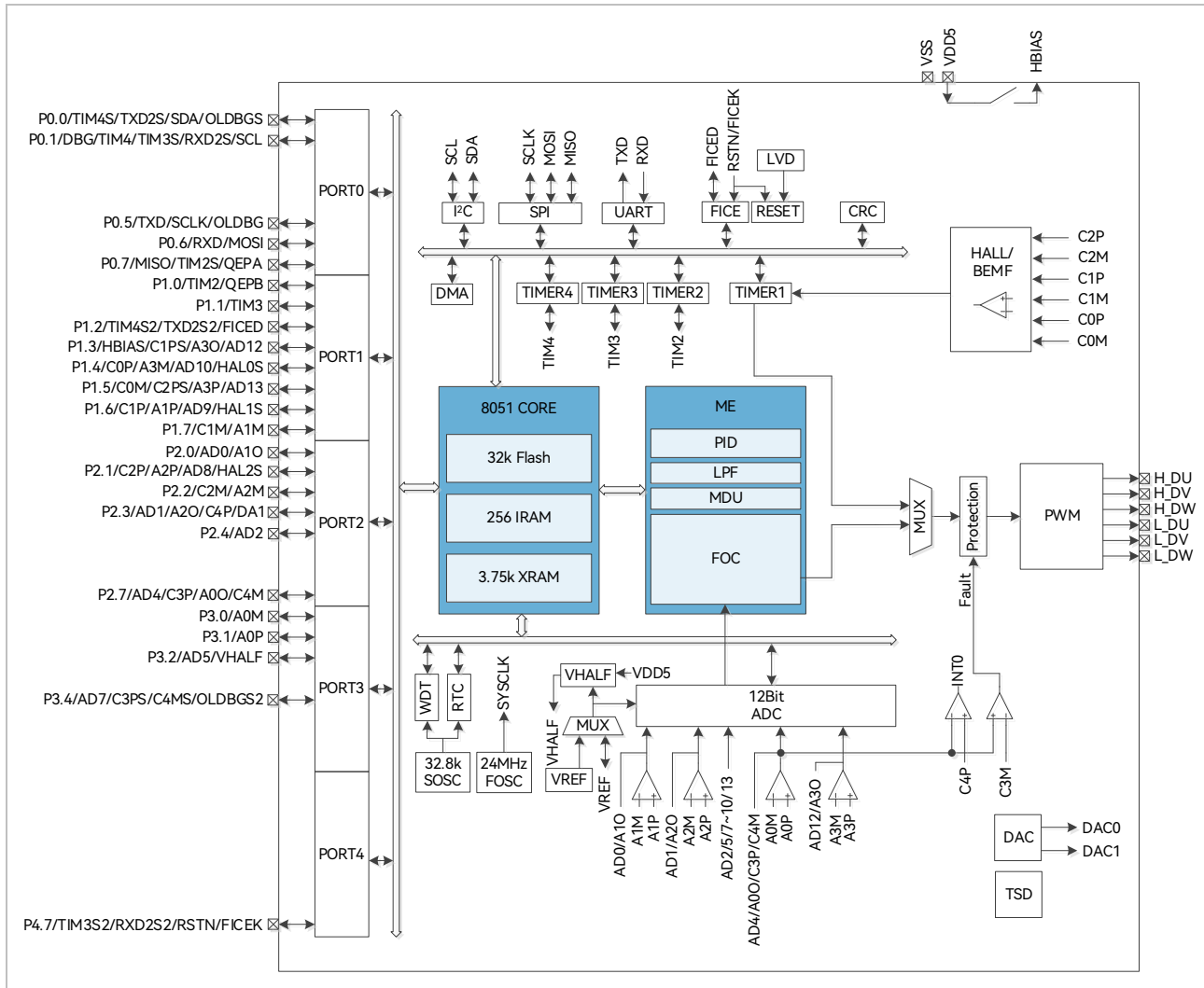
1.4.14 FU6522L

Figure 1-14 Functional Block Diagram of FU6522L



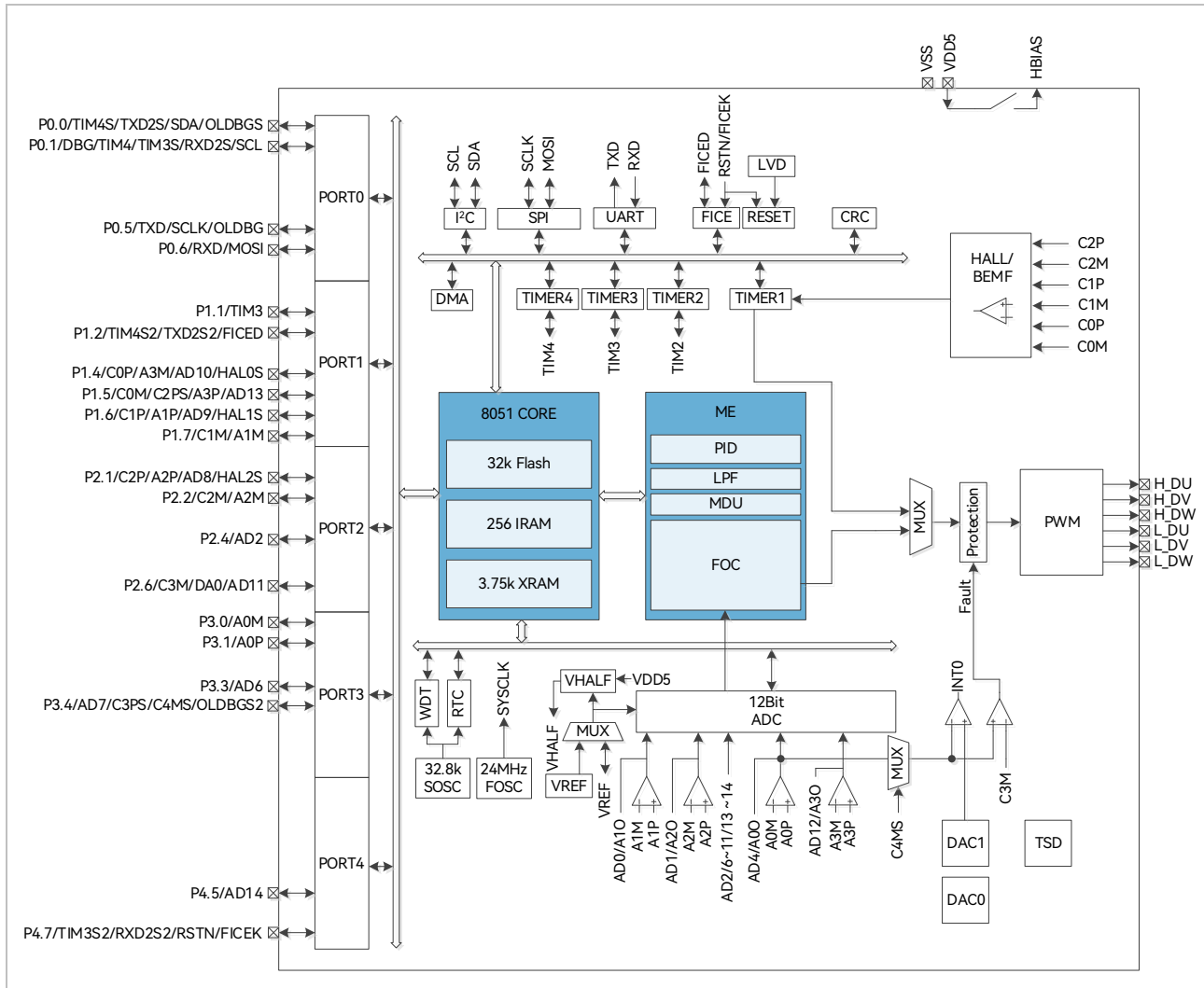
1.4.15 FU6522N

Figure 1-15 Functional Block Diagram of FU6522N



1.4.16 FU6522T

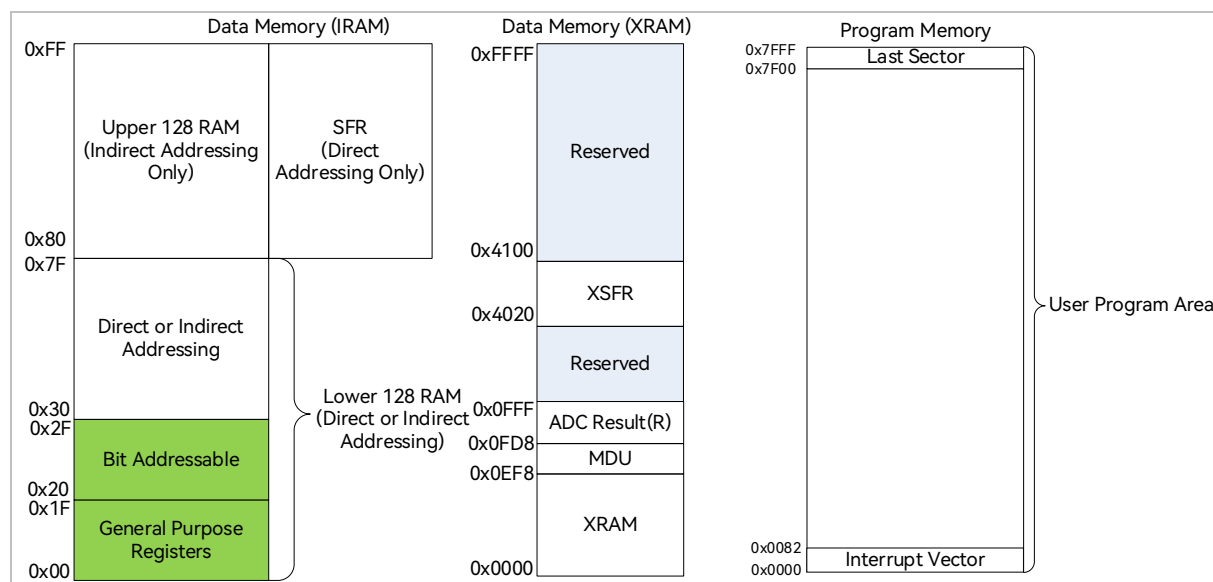
Figure 1-16 Functional Block Diagram of FU6522T



1.5 Memory Organization

The internal storage space is divided into Program Memory and Data Memory, which are independently addressed.

Figure 1-17 Memory Organization



1.5.1 Program Memory

The chip implements this program memory as Flash memory with a block from addresses 0x0000 to 0x7FFF to store control programs to store control programs.

The sector (0x0000 ~ 0x0082) is the interrupt vector address area, which is used to store the start address of each interrupt subroutine. The last sector (0x7F00~0x7FFF) contains internal control bits of the chip.

1.5.2 Data Memory

The data memory is divided into External Data Memory and Internal Data Memory, as shown in Figure 1-17.

The External Data Memory is addressed from 0x0000 to 0xFFFF, which can be accessed only with MOVX instructions. It comprises XRAM (0x0000~0x0EF7), extended control register space (0x4020~0x40FF), MDU register space (0x0EF8~0x0FD7) and ADC result memory area (0x0FD8~0x0FFF).

The Internal Data Memory is addressed from 0x00 to 0xFF. Locations 0x00 ~ 0x1F are addressable as 4 banks of general purpose registers, each bank consisting of 8 registers, adding up to 32 registers. Locations 0x20 ~ 0x7F are used for general purpose RAM memory, supporting direct and indirect addressing. Locations (0x20 ~ 0x2F) are 16-bit addressable. When locations 0x80 ~ 0xFF are accessed by indirect addressing, it points to RAM. When locations

0x80 ~ 0xFF are accessed by direct addressing, it points to SFR.

1.5.3 SFR

Table 1-1 SFR Address Mapping

Addr	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)
0xF8	DRV_OUT	PI_CR		P5_OE	P0_OE	P1_OE	P2_OE	P3_OE
0xF0	B							
0xE8		P4_OE						
0xE0	ACC	CMP_CR4	HALL_CR					
0xD8	UT2_CR	EVT_FILT	CMP_CR2	LVSR	CMP_CR3			
0xD0	PSW	P1_IE	P1_IF	P4_IE	P4_IF	CMP_CR0	CMP_CR1	CMP_SR
0xC8		RST_SR						
0xC0	P5	MDU_CR						
0xB8	P4							
0xB0	P3							
0xA8	IE	TIM2_CR1	TIM2_CNTRL	TIM2_CNTRH	TIM2_DRL	TIM2_DRH	TIM2_ARRL	TIM2_ARRH
0xA0	P2	TIM2_CR0	TIM3_CNTRL	TIM3_CNTRH	TIM3_DRL	TIM3_DRH	TIM3_ARRL	TIM3_ARRH
0x98	UT_CR	UT_DR	UT_BAUDL	UT_BAUDH	TIM3_CR0	TIM3_CR1	TIM4_CR0	TIM4_CR1
0x90	P1		TIM4_CNTRL	TIM4_CNTRH	TIM4_DRL	TIM4_DRH	TIM4_ARRL	TIM4_ARRH
0x88	TCON	UT2_DR	IP0	IP1	IP2	IP3		
0x80	P0	SP	DPL	DPH	FLA_KEY	FLA_CR		PCON



Note

- > Registers containing the symbol “_” are 16-bit snapshot registers. Snapshot registers are the dynamic registers which shall be read using variables. The value will be incorrect when the register is read directly.
- > 8-bit MCU shall read a 16-bit register twice to get the value, the 8 high-order bits and the 8 low-order bits respectively. The result will be incorrect when 8 low-order bits of the register change after MCU has read the 8 high-order bits. Therefore, when 8 high-order bits of the snapshot register are read by MCU, the corresponding 8 low-order bits are stored and read.
- > Snapshot register must be read as a whole, the 8 high-order bits first and then the 8 low-order bits.

1.5.4 XSFR

Table 1-2 XSFR Address Mapping

Addr	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)
0x40D8	FOC_POWH	FOC_POWL	FOC_IAMAXH	FOC_IAMAXL	FOC_IBMAXH	FOC_IBMAXL	FOC_ICMAXH	FOC_ICMAXL
	FOC_EOMEKLPF							
0x40D0	FOC_EALPH	FOC_EALPL	FOC_EBETH	FOC_EBETL	FOC_EOMEH	FOC_EOMEL	FOC_UQEXH	FOC_UQEXL
							FOC_KFGH	FOC_KFGL
0x40C8	FOC_IBH	FOC_IBL	FOC_IAH	FOC_IAL	FOC_THETAH	FOC_THETAL	FOC_ETHERAH	FOC_ETHERAL
	FOC_LQH	FOC_LQL	FOC_LDH	FOC_LDL				
0x40C0	FOC_IBETH	FOC_IBETL	FOC_VBETH	FOC_VBETL	FOC_VALPH	FOC_VALPL	FOC_ICH	FOC_ICL
	FOC_IQ_LPFK	FOC_ID_LPFK	FOC_UDCPSH	FOC_UDCPSL	FOC_UQCPSH	FOC_UQCPSL	FOC_FLUXH	FOC_FLUXL
0x40B8	FOC_UDH	FOC_UDL	FOC_UQH	FOC_UQL	FOC_IDH	FOC_IDL	FOC_IQH	FOC_IQL
0x40B0	FOC_DMAXH	FOC_DMAXL	FOC_DMINH	FOC_DMINL	FOC_QMAXH	FOC_QMAXL	FOC_QMINH	FOC_QMINL
	FOC_OMEESTH	FOC_OMEESTL	FOC_ATAN_THETAH	FOC_ATAN_THETAL				
0x40A8	FOC_RTHERSTEPH	FOC_RTHERSTEPL	FOC_RTHERACCH	FOC_RTHERACCL	FOC_RTHERCNT	FOC_THERCOR CMP_SAMR	FOC_THERCOMPH	FOC_THERCOMPL
			FOC_EOMELPFH	FOC_EOMELPFL			FOC_EMFH	FOC_EMFL
0x40A0	FOC_CR1	FOC_CR2	FOC_TSMIN	FOC_TGLI	FOC_TBLO	FOC_TRGDLY	FOC_CSOH	FOC_CSOL
0x4098	FOC_UDCFLTH	FOC_UDCFLTL					FOC_CR3	FOC_CR0
	TIM1_ITRIPH	TIM1_ITRIPL						
0x4090	FOC_IDREFH	FOC_IDREFL	FOC_IQREFH	FOC_IQREFL	FOC_QKPH	FOC_QKPL	FOC_QKIH	FOC_QKIL
	TIM1_URESH	TIM1_URES	TIM1_KRMAX	TIM1_KFMIN	TIM1_KFH	TIM1_KFL	TIM1_KRH	TIM1_KRL
0x4088	FOC_EK3H	FOC_EK3L	FOC_EK4H	FOC_EK4L	FOC_EK1H	FOC_EK1L	FOC_EK2H	FOC_EK2L
	TIM1_RARRH	TIM1_RARRL	TIM1_RCNTRH	TIM1_RCNTRL	TIM1_UCOPH	TIM1_UCOPL	TIM1_UFLPH	TIM1_UFLPL
0x4080	FOC_FBASEH	FOC_FBASEL	FOC_EFREQCCH	FOC_EFREQCCL	FOC_EFREQMINH	FOC_EFREQMINL	FOC_EFREQHOLDH	FOC_EFREQHOLDL
	TIM1_DBR7H	TIM1_DBR7L	TIM1_BCNTRH	TIM1_BCNTRL	TIM1_BCCRH	TIM1_BCCRL	TIM1_BARRH	TIM1_BARRL
0x4078	FOC_KSLIDEH	FOC_KSLIDEL	FOC_EKLPMFMINH	FOC_EKLPMFMINL	FOC_DKIH	FOC_DKIL	FOC_OMEKLPFH	FOC_OMEKLPFL
	TIM1_DBR3H	TIM1_DBR3L	TIM1_DBR4H	TIM1_DBR4L	TIM1_DBR5H	TIM1_DBR5L	TIM1_DBR6H	TIM1_DBR6L
0x4070	TIM1_BCORH	TIM1_BCORL	TIM1_CR5		FOC_EKPH	FOC_EKPL	FOC_EKIH	FOC_EKIL

Addr	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)
	FOC_DKPH	FOC_DKPL			TIM1_DBR1H	TIM1_DBR1L	TIM1_DBR2H	TIM1_DBR2L
0x4068	TIM1_CR0	TIM1_CR1	TIM1_CR2	TIM1_CR3	TIM1_CR4	TIM1_IER	TIM1_SR	FOC_EFREQMAX
0x4060	DRV_DTR	DRV_SR	DRV_CR		SYST_ARRH	SYST_ARRL	DRV_CNTRH	DRV_CNTRL
0x4058	DRV_DRH	DRV_DRL	DRV_COMRH	DRV_COMRL	DRV_CMRH	DRV_CMRL	DRV_ARRH	DRV_ARRL
0x4050	P1_AN	P2_AN	P3_AN	P0_PU	P1_PU	P2_PU	P3_PU	P4_PU
0x4048	P5_PU	PH_SEL2	DAC1_DR	DAC_DR	PH_SEL	PH_SEL1	AMP_CR0	VREFVHALF_CR
0x4040	DMA1_BAH	DMA1_BAL	UT2_BAUDH	UT2_BAUDL	CAL_CR0	CAL_CR1	AMP_CR2	P4_AN
0x4038	ADC_SCYC	ADC_CR	DMA0_CR0	DMA1_CR0	DMA0_LEN	DMA1_LEN	DMA0_BAH	DMA_BAL
0x4030	SPI_CR0	SPI_CR1	SPI_CLK	SPI_DR	AMP_CR1	DAC_CR	ADC_MASKH	ADC_MASKL
0x4028	I2C_CR	I2C_ID	I2C_DR	I2C_SR	RTC_TMH	RTC_TML	RTC_STA	TSD_CR
0x4020		CRC_DIN	CRC_CR	CRC_DR	CRC_BEG	CRC_CNT	WDT_CR	WDT_ARR
0x0FF0	AD12_DRH	AD12_DRL	AD13_DRH	AD13_DRL	AD14_DRH	AD14_DRL	AD15_DRH	AD15_DRL
0x0FE8	AD8_DRH	AD8_DRL	AD9_DRH	AD9_DRL	AD10_DRH	AD10_DRL	AD11_DRH	AD11_DRL
0x0FE0	AD4_DRH	AD4_DRL	AD5_DRH	AD5_DRL	AD6_DRH	AD6_DRL	AD7_DRH	AD7_DRL
0x0FD8	AD0_DRH	AD0_DRL	AD1_DRH	AD1_DRL	AD2_DRH	AD2_DRL	AD3_DRH	AD3_DRL
0x0FD0		LPF0_K		LPF0_X		LPF0_YH		LPF0_YL
0x0FC8		LPF1_K		LPF1_X		LPF1_YH		LPF1_YL
0x0FC0		PI0_UKH		PI0_UKL		PI0_UKMAX		PI0_UKMIN
0x0FB8		PI0_KP		PI0_EK1		PI0_EK		PI0_KI
0x0FB0		PI1_UKH		PI1_UKL		PI1_UKMAX		PI1_UKMIN
0x0FA8		PI1_KP		PI1_EK1		PI1_EK		PI1_KI
0x0FA0		MUL0_MA		MUL0_MB		MUL0_MCH		MUL0_MCL
0x0F98		MUL1_MA		MUL1_MB		MUL1_MCH		MUL1_MCL
0x0F90		DIV0_DB		DIV0_DQH		DIV0_DQL		DIV0_DR
0x0F88		DIV1_DQL		DIV1_DR		DIV0_DAH		DIV0_DAL
0x0F80		DIV1_DAH		DIV1_DAL		DIV1_DB		DIV1_DQH
0x0F78		LPF2_K		LPF2_X		LPF2_YH		LPF2_YL
0x0F70		LPF3_K		LPF3_X		LPF3_YH		LPF3_YL
0x0F68		PI2_UKMAX		PI2_UKMIN		PI2_KD		PI2_EK2
0x0F60		PI2_EK		PI2_KI		PI2_UKH		PI2_UKL

Addr	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)
0x0F58	PI3_KD		PI3_EK2		PI2_KP		PI2_EK1	
0x0F50	PI3_UKH		PI3_UKL		PI3_UKMAX		PI3_UKMIN	
0x0F48	PI3_KP		PI3_EK1		PI3_EK		PI3_KI	
0x0F40	MUL2_MA		MUL2_MB		MUL2_MCH		MUL2_MCL	
0x0F38	MUL3_MA		MUL3_MB		MUL3_MCH		MUL3_MCL	
0x0F30	DIV2_DB		DIV2_DQH		DIV2_DQL		DIV2_DR	
0x0F28	DIV3_DQL		DIV3_DR		DIV2_DAH		DIV2_DAL	
0x0F20	DIV3_DAH		DIV3_DAL		DIV3_DB		DIV3_DQH	
0x0F18	SCAT0_SIN		SCAT0_THE		SCAT0_RES1		SCAT0_RES2	
0x0F10	SCAT1_THE		SCAT1_RES1		SCAT1_RES2		SCAT0_COS	
0x0F08	SCAT2_RES1		SCAT2_RES2		SCAT1_COS		SCAT1_SIN	
0x0F00	SCAT3_RES2		SCAT2_COS		SCAT2_SIN		SCAT2_THE	
0x0EF8	SCAT3_COS		SCAT3_SIN		SCAT3_THE		SCAT3_RES1	

**Note**

- > Registers containing the symbol “__” are 16-bit snapshot registers. Snapshot registers are the dynamic registers which shall be read using variables. The value will be incorrect when the register is read directly.
- > 8-bit MCU shall read a 16-bit register twice to get the value, the 8 high-order bits and the 8 low-order bits respectively. The result will be incorrect when 8 low-order bits of the register change after MCU has read the 8 high-order bits. Therefore, when 8 high-order bits of the snapshot register are read by MCU, the corresponding 8 low-order bits are stored and read.
- > Snapshot register must be read as a whole, the 8 high-order bits first and then the 8 low-order bits.

2 Pin Definitions

The IO types are defined as follows:

- > DI = Digital Input
- > DO = Digital Output
- > DB = Digital Bidirectional
- > AI = Analog Input
- > AO = Analog Output
- > AB = Analog Bidirectional
- > P = Power Input/Output or Ground

2.1 FU6572L LQFP48 Pins

Table 2-1 FU6572L LQFP48 Pin Descriptions

Pin	FU6572L LQFP48	IO Type	Function Descriptions
P2.6/ C3M/ DA0/ AD11	1	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P3.0/ A0M	2	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	3	DB/ AI	GPIO AMP0 positive input
P3.2/ AD5/ VHALF	4	DB/ AI/ AO	GPIO Input of ADC channel 5 1/2 VREF voltage output, with a 1μF external capacitor
P3.3/ AD6	5	DB/ AI	GPIO Input of ADC channel 6

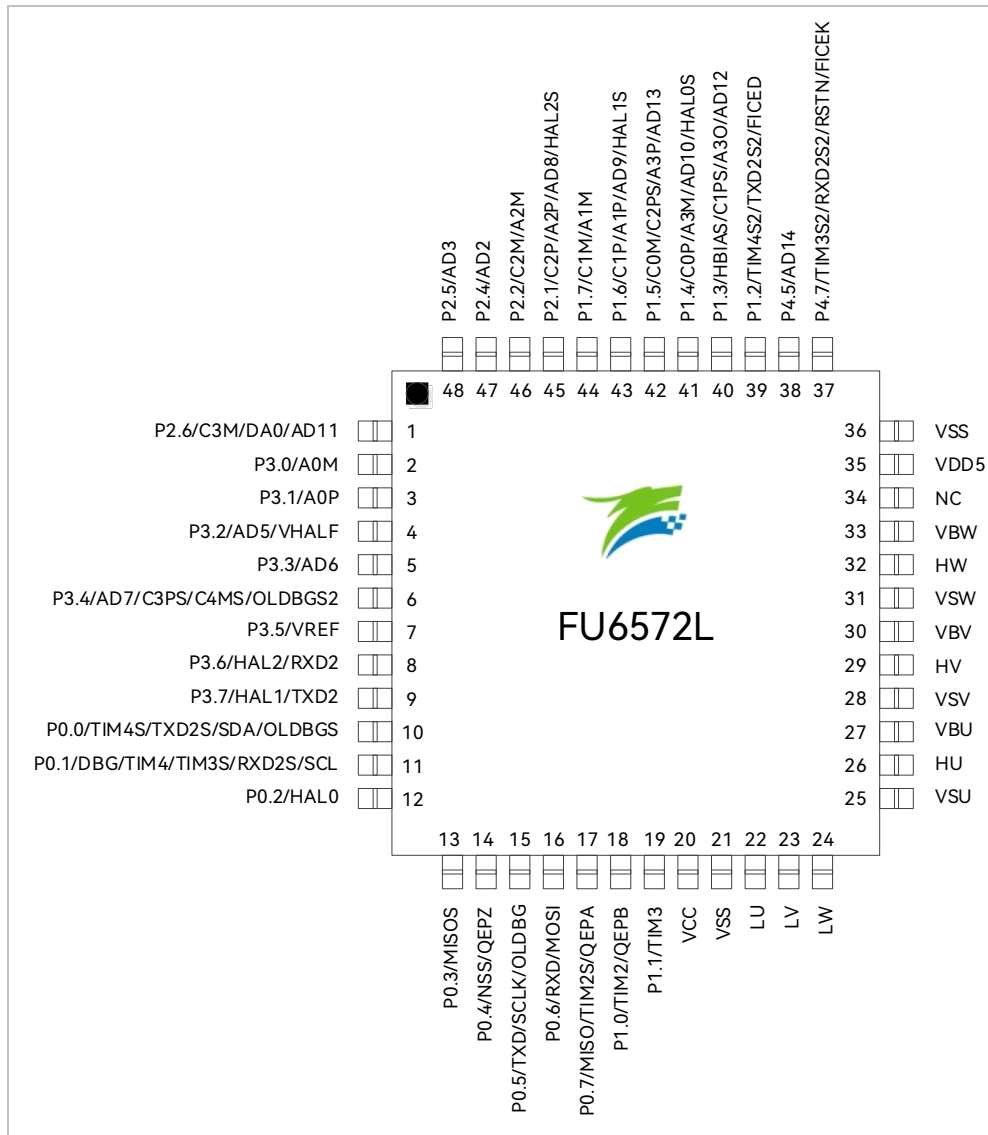
Pin	FU6572L LQFP48	IO Type	Function Descriptions
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	6	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1 μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	7	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P3.6/ HAL2/ RXD2	8	DB/ DI/ DB	GPIO Hall-IC2 logic level input UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode
P3.7/ HAL1/ TXD2	9	DB/ DI/ DO	GPIO Hall-IC1 logic level input UART2 TXD output
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBGS	10	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I ² C SDA, configured as collector open-drain output SPI debug output after function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	11	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I ² C SCL, configured as collector open-drain output
P0.2/ HAL0	12	DB/ DI	GPIO, configurable as INT0 input Hall-IC0 logic level input
P0.3/ MISOS	13	DB/ DB	GPIO, configurable as INT0 input SPI MISO after function switching, master input or slave output
P0.4/ NSS/ QEPZ	14	DB/ DB/ DB	GPIO, configurable as INT1 input SPI NSS QEP Z input/output at zero point
P0.5/ TXD/ SCLK/ OLDBG	15	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output

Pin	FU6572L LQFP48	IO Type	Function Descriptions
P0.6/ RXD/	16	DB/ DB/	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode
MOSI		DB	SPI MOSI, master output or slave input
P0.7/ MISO/ TIM2S/ QEPA	17	DB/ DB/ DB/	GPIO SPI MISO, master input or slave output Timer2 input/output after function switching
		DI	QEP encode A input
P1.0/ TIM2/ QEPB	18	DB/ DB/	GPIO, configurable as INT1 input Timer2 input/output
		DI	QEP encode B input
P1.1/ TIM3	19	DB/ DB	GPIO, configurable as INT0/INT1 input Timer3 input/output
VCC		P	Power input, with a 1μF ~ 4.7μF external capacitor
VSS	21	P	Power ground
LU	22	DO	6N Pre-driver low-side U-phase output
LV	23	DO	6N Pre-driver low-side V-phase output
LW	24	DO	6N Pre-driver low-side W-phase output
VSU	25	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
HU	26	DO	6N pre-driver high-side U-phase output
VBU	27	P	6N pre-driver U-phase bootstrap power supply
VSV	28	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	29	DO	6N Pre-driver high-side V-phase PWM output
VBV	30	P	6N pre-driver V-phase bootstrap power supply
VSW	31	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	32	DO	6N Pre-driver high-side W-phase output
VBW	33	P	6N pre-driver W-phase bootstrap power supply
NC	34	-	NC
VDD5	35	P	5V LDO output with a 1μF ~ 4.7μF external capacitor
VSS	36	P	Power ground
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	37	DI/ DI/ DI/ DI/	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor
		DI	FICE clock line
P4.5/ AD14	38	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 14

Pin	FU6572L LQFP48	IO Type	Function Descriptions
P1.2/ TIM4S2/ TXD2S2/ FICED	39	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	40	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	41	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	42	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	43	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	44	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input
P2.1/ C2P/ A2P/ AD8/ HAL2S	45	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	46	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	47	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.5/ AD3	48	DB/ AI	GPIO Input of ADC channel 3

2.2 FU6572L LQFP48 Pinout Diagram

Figure 2-1 Pinout Diagram of FU6572L LQFP48



2.3 FU6572N QFN40 Pins

Table 2-2 Pin Descriptions of FU6572N QFN40

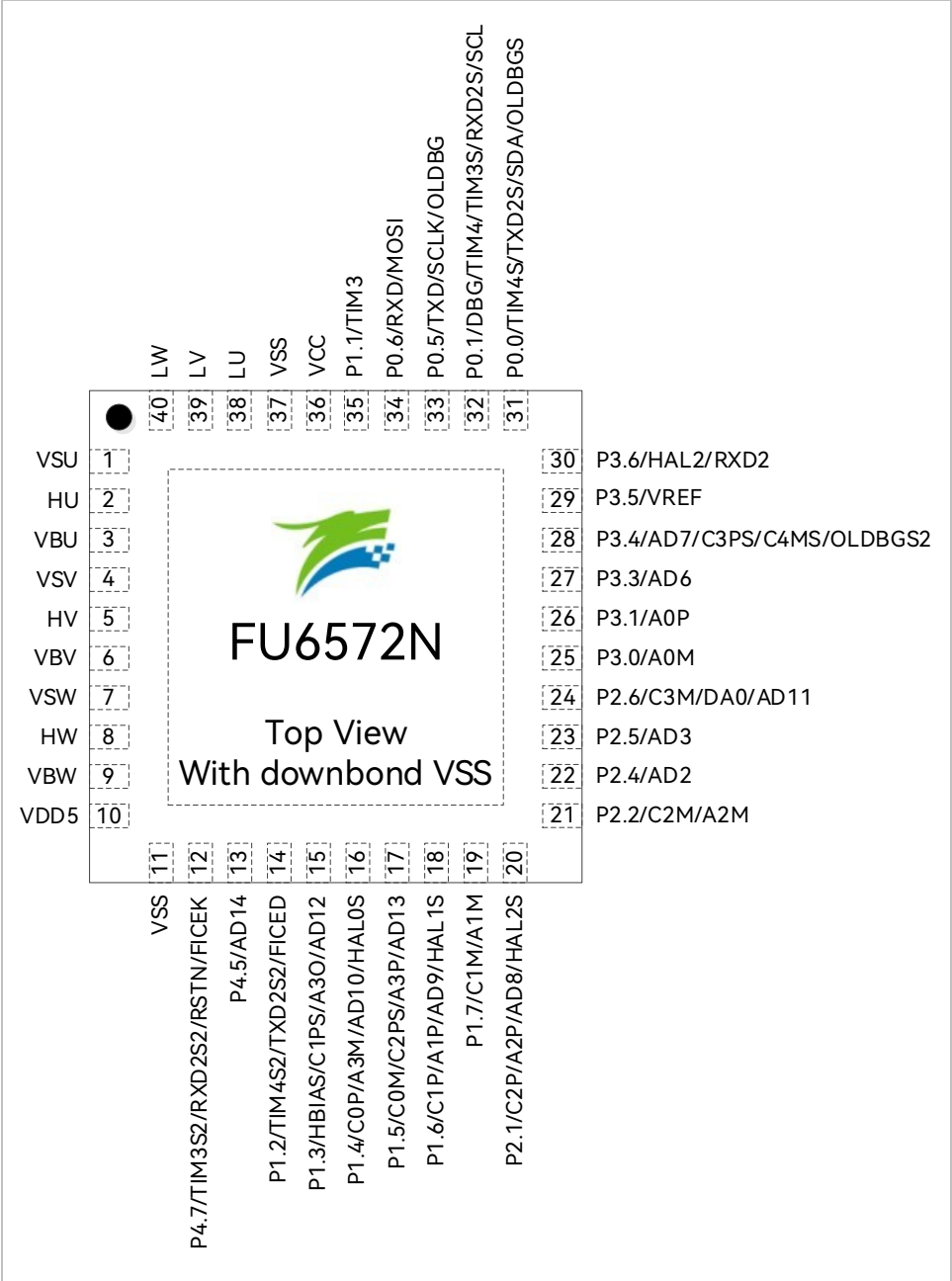
Pin	FU6572N QFN40	IO Type	Function Descriptions
VSU	1	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
HU	2	DO	6N pre-driver high-side U-phase output
VBU	3	P	6N pre-driver high-side U-phase bootstrap power supply
VSV	4	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	5	DO	6N Pre-driver high-side V-phase PWM output
VBV	6	P	6N pre-driver high-side V-phase bootstrap power supply
VSW	7	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	8	DO	6N Pre-driver high-side W-phase output
VBW	9	P	6N pre-driver high-side W-phase bootstrap power supply
VDD5	10	P	5V LDO output with a 1 μ F ~ 4.7 μ F external capacitor
VSS	11	P	Power ground
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	12	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P4.5/ AD14	13	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 14
P1.2/ TIM4S2/ TXD2S2/ FICED	14	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	15	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	16	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching

Pin	FU6572N QFN40	IO Type	Function Descriptions
P1.5/ C0M/ C2PS/ A3P/ AD13	17	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	18	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	19	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input
P2.1/ C2P/ A2P/ AD8/ HAL2S	20	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	21	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	22	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.5/ AD3	23	DB/ AI	GPIO Input of ADC channel 3
P2.6/ C3M/ DA0/ AD11	24	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P3.0/ A0M	25	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	26	DB/ AI	GPIO AMP0 positive input
P3.3/ AD6	27	DB/ AI	GPIO Input of ADC channel 6

Pin	FU6572N QFN40	IO Type	Function Descriptions
P3.4/ AD77/ C3PS/ C4MS/ OLDBGS2	28	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	29	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P3.6/ HAL2/ RXD2	30	DB/ DI/ DB	GPIO Hall-IC2 logic level input UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBGS	31	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I ² C SDA, configured as collector open-drain output SPI debug output after function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	32	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I ² C SCL, configured as collector open-drain output
P0.5/ TXD/ SCLK/ OLDBG	33	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	34	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P1.1/ TIM3	35	DB/ DB	GPIO, configurable as INT0/INT1 input Timer3 input/output
VCC	36	P	Power input, with a 1μF ~ 4.7μF external capacitor
VSS	37	P	Power ground
LU	38	DO	6N Pre-driver low-side U-phase output
LV	39	DO	6N Pre-driver low-side V-phase output
LW	40	DO	6N Pre-driver low-side W-phase output

2.4 FU6572N QFN40 Pinout Diagram

Figure 2–2 Pinout Diagram of FU6572N QFN40



2.5 FU6572T TSSOP28 Pins

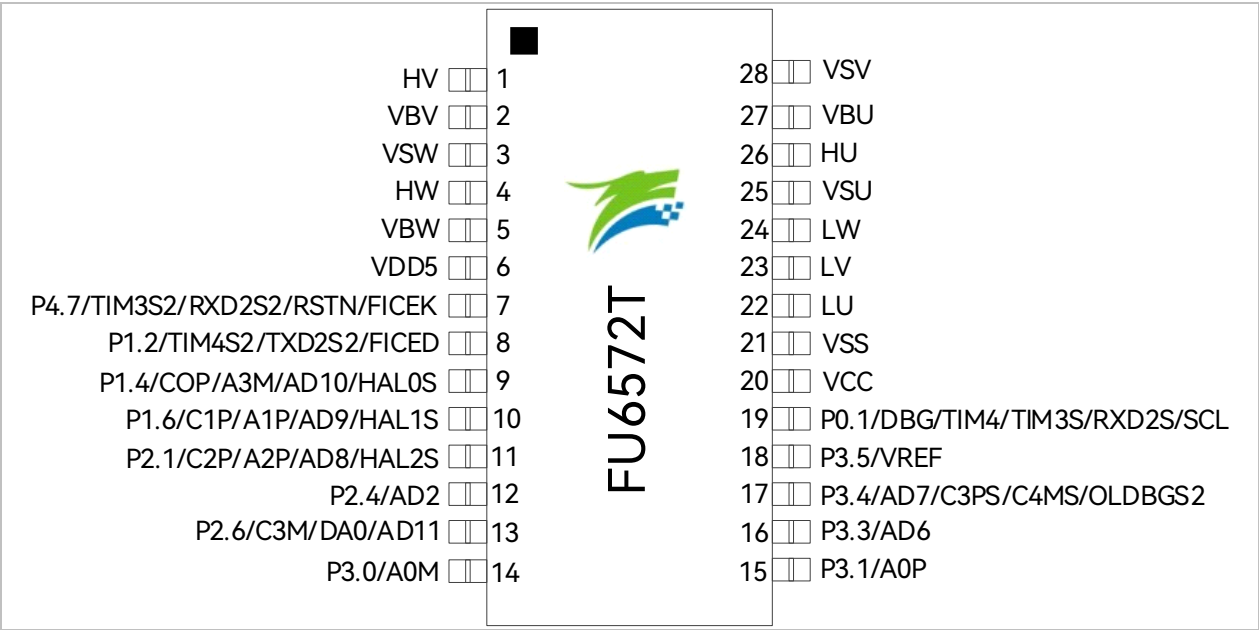
Table 2-3 FU6572T TSSOP28L Pin Descriptions

Pin	FU6572T TSSOP28	IO Type	Function Descriptions
HV	1	DO	6N Pre-driver high-side V-phase PWM output
VBV	2	P	6N pre-driver high-side V-phase bootstrap power supply
VSW	3	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	4	DO	6N Pre-driver high-side W-phase output
VBW	5	P	6N pre-driver high-side W-phase bootstrap power supply
VDD5	6	P	5V LDO output with a 1μF ~ 4.7μF external capacitor
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	7	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P1.2/ TIM4S2/ TXD2S2/ FICED	8	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.4/ C0P/ A3M/ AD10/ HAL0S	9	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.6/ C1P/ A1P/ AD9/ HAL1S	10	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P2.1/ C2P/ A2P/ AD8/ HAL2S	11	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.4/ AD2	12	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.6/ C3M/ DA0/ AD11	13	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11

Pin	FU6572T TSSOP28	IO Type	Function Descriptions
P3.0/ A0M	14	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	15	DB/ AI	GPIO AMP0 positive input
P3.3/ AD6	16	DB/ AI	GPIO Input of ADC channel 6
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	17	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	18	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	19	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I ² C SCL, configured as open-drain output
VCC	20	P	Power input, with a 1μF ~ 4.7μF external capacitor
VSS	21	P	Power ground
LU	22	DO	6N Pre-driver low-side U-phase output
LV	23	DO	6N Pre-driver low-side V-phase output
LW	24	DO	6N Pre-driver low-side W-phase output
VSU	25	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
HU	26	DO	6N pre-driver high-side U-phase output
VBU	27	P	6N pre-driver high-side U-phase bootstrap power supply
VSV	28	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap

2.6 FU6572T TSSOP28 Pinout Diagram

Figure 2-3 FU6572T TSSOP28 Pinout Diagram



2.7 FU6565N QFN40 Pins

Table 2-4 Pin Descriptions of FU6565N QFN40

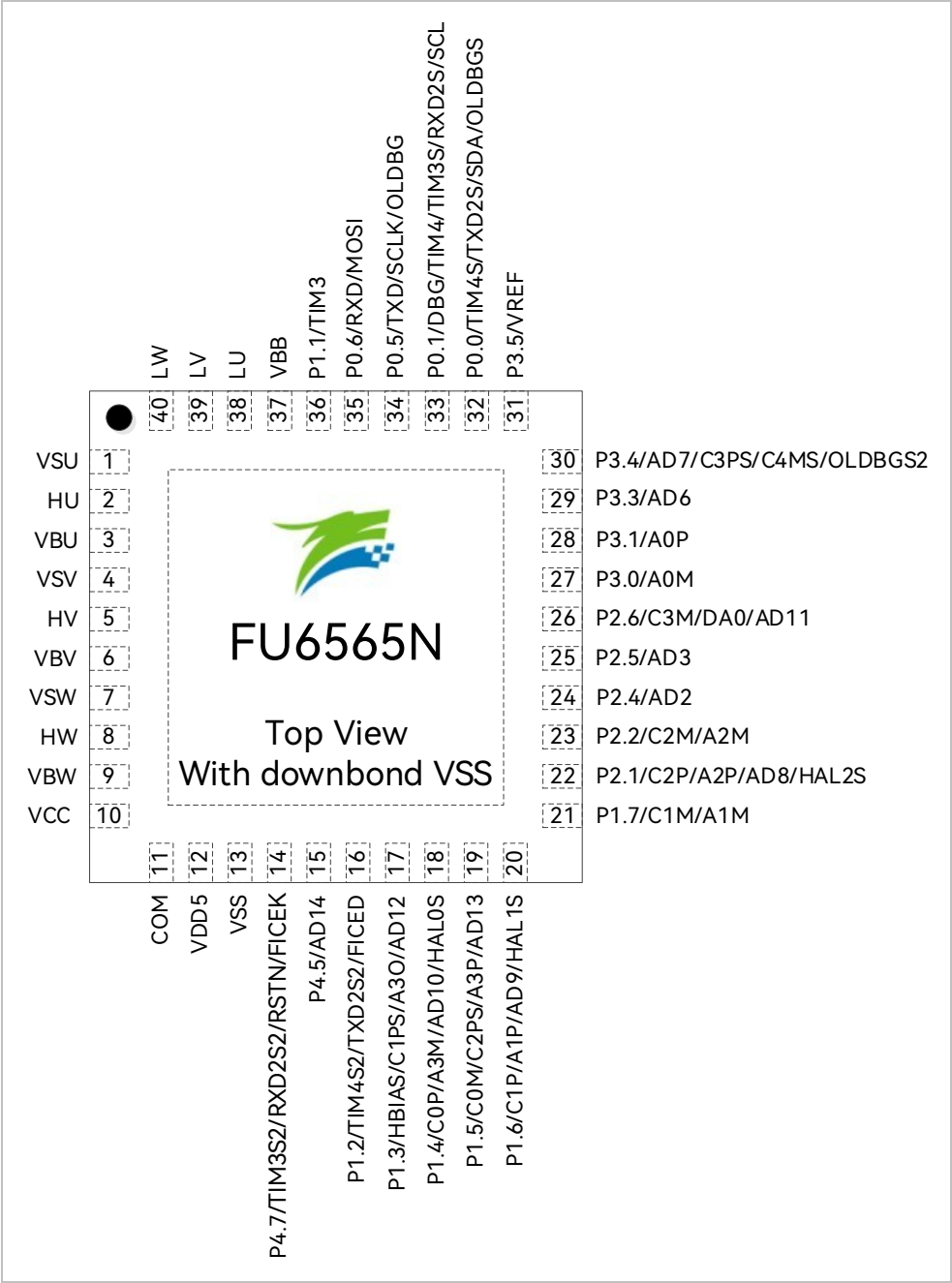
Pin	FU6565N QFN40	IO Type	Function Descriptions
VSU	1	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
HU	2	DO	6N pre-driver high-side U-phase output
VBU	3	P	6N pre-driver high-side U-phase bootstrap power supply
VSV	4	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	5	DO	6N Pre-driver high-side V-phase PWM output
VBV	6	P	6N pre-driver high-side V-phase bootstrap power supply
VSW	7	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	8	DO	6N Pre-driver high-side W-phase output
VBW	9	P	6N pre-driver high-side W-phase bootstrap power supply
VCC	10	P	Power input, with a 1 μ F ~ 4.7 μ F external capacitor
COM	11	P	6N Pre-driver ground
VDD5	12	P	5V LDO output with a 1 μ F ~ 4.7 μ F external capacitor
VSS	13	P	Ground
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	14	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P4.5/ AD14	15	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 14
P1.2/ TIM4S2/ TXD2S2/ FICED	16	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	17	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	18	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching

Pin	FU6565N QFN40	IO Type	Function Descriptions
P1.5/ C0M/ C2PS/ A3P/ AD13	19	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	20	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	21	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input
P2.1/ C2P/ A2P/ AD8/ HAL2S	22	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	23	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	24	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.5/ AD3	25	DB/ AI	GPIO Input of ADC channel 3
P2.6/ C3M/ DA0/ AD11	26	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P3.0/ A0M	27	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	28	DB/ AI	GPIO AMP0 positive input
P3.3/ AD6	29	DB/ AI	GPIO Input of ADC channel 6

Pin	FU6565N QFN40	IO Type	Function Descriptions
P3.4/ AD77/ C3PS/ C4MS/ OLDBGS2	30	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1 μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	31	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBGS	32	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I ² C SDA, configured as collector open-drain output SPI debug output after function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	33	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I ² C SCL, configured as collector open-drain output
P0.5/ TXD/ SCLK/ OLDBG	34	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	35	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P1.1/ TIM3	36	DB/ DB	GPIO, configurable as INT0/INT1 input Timer3 input/output
VBB	37	P	12V LDO output with a 1μF ~ 4.7μF external capacitor
LU	38	DO	6N Pre-driver low-side U-phase output
LV	39	DO	6N Pre-driver low-side V-phase output
LW	40	DO	6N Pre-driver low-side W-phase output

2.8 FU6565N QFN40 Pinout Diagram

Figure 2–4 Pinout Diagram of FU6565N QFN40



2.9 FU6565T TSSOP28 Pins

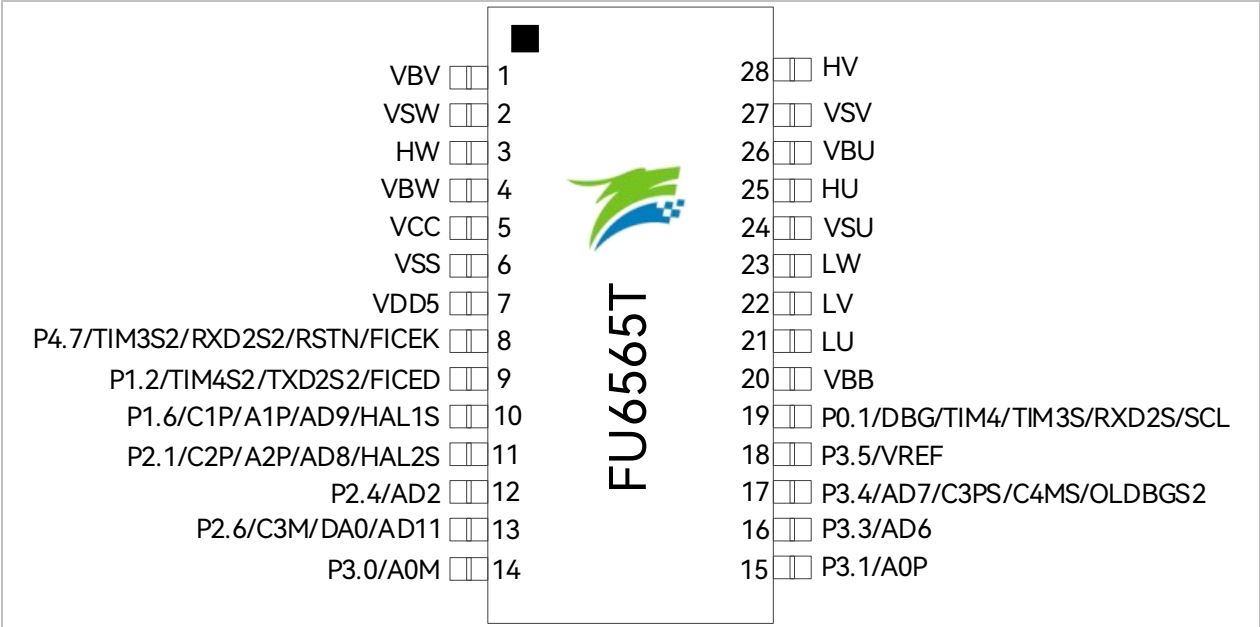
Table 2-5 FU6565T TSSOP28 Pin Descriptions

Pin	FU6565T TSSOP28	IO Type	Function Descriptions
VBV	1	P	6N pre-driver high-side V-phase bootstrap power supply
VSW	2	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	3	DO	6N Pre-driver high-side W-phase output
VBW	4	P	6N pre-driver high-side W-phase bootstrap power supply
VCC	5	P	Power input, with a 1μF ~ 4.7μF external capacitor
VSS	6	P	Ground
VDD5	7	P	5V LDO output with a 1μF ~ 4.7μF external capacitor
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	8	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P1.2/ TIM4S2/ TXD2S2/ FICED	9	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.6/ C1P/ A1P/ AD9/ HAL1S	10	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P2.1/ C2P/ A2P/ AD8/ HAL2S	11	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.4/ AD2	12	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.6/ C3M/ DA0/ AD11	13	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P3.0/ A0M	14	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	15	DB/ AI	GPIO AMP0 positive input

Pin	FU6565T TSSOP28	IO Type	Function Descriptions
P3.3/ AD6	16	DB/ AI	GPIO Input of ADC channel 6
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	17	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1 μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	18	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	19	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I ² C SCL, configured as collector open-drain output
VBB	20	P	12V LDO output with a 1μF ~ 4.7μF external capacitor
LU	21	DO	6N Pre-driver low-side U-phase output
LV	22	DO	6N Pre-driver low-side V-phase output
LW	23	DO	6N Pre-driver low-side W-phase output
VSU	24	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
HU	25	DO	6N pre-driver high-side U-phase output
VBU	26	P	6N pre-driver high-side U-phase bootstrap power supply
VSV	27	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	28	DO	6N Pre-driver high-side V-phase PWM output

2.10 FU6565T TSSOP28 Pinout Diagram

Figure 2–5 FU6565T TSSOP28 Pinout Diagram



2.11 FU6563N QFN32 Pins

Table 2-6 Pin Descriptions of FU6563N QFN32

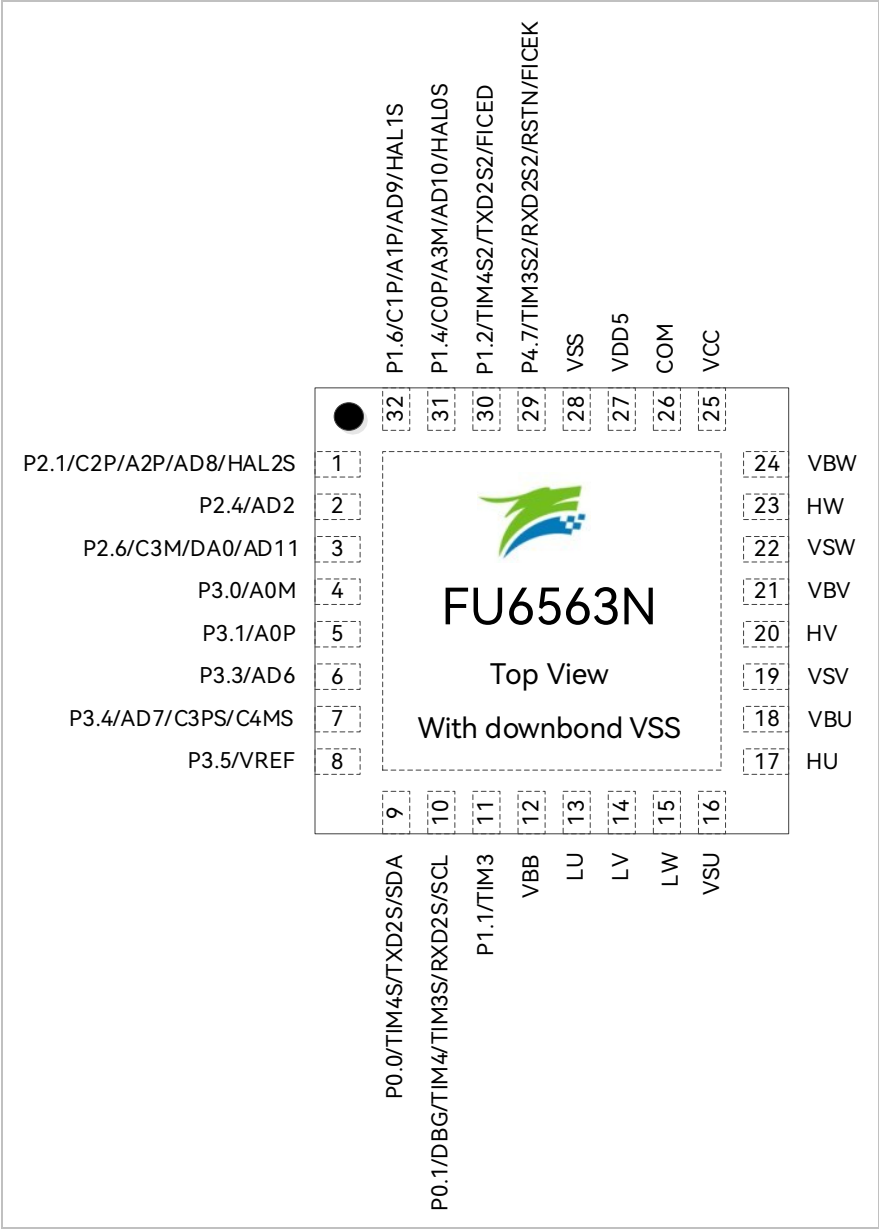
Pin	FU6563N QFN32	IO Type	Function Descriptions
P2.1/ C2P/ A2P/ AD8/ HAL2S	1	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.4/ AD2	2	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.6/ C3M/ DA0/ AD11	3	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P3.0/ A0M	4	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	5	DB/ AI	GPIO AMP0 positive input
P3.3/ AD6	6	DB/ AI	GPIO Input of ADC channel 6
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	7	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1 μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	8	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBGS	9	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I ² C SDA, configured as collector open-drain output SPI debug output after function switching

Pin	FU6563N QFN32	IO Type	Function Descriptions
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	10	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I ² C SCL, configured as collector open-drain output
P1.1/ TIM3	11	DB/ DB	GPIO, configurable as INT0/INT1 input Timer3 input/output
VBB	12	P	6N Pre-driver internal 12V LDO output with an external 1μF ~ 4.7μF capacitor
LU	13	DO	6N Pre-driver low-side U-phase output
LV	14	DO	6N Pre-driver low-side V-phase output
LW	15	DO	6N Pre-driver low-side W-phase output
VSU	16	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
HU	17	DO	6N pre-driver high-side U-phase output
VBU	18	P	6N pre-driver high-side U-phase bootstrap power supply
VSV	19	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	20	DO	6N Pre-driver high-side V-phase PWM output
VBV	21	P	6N pre-driver high-side V-phase bootstrap power supply
VSW	22	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	23	DO	6N Pre-driver high-side W-phase output
VBW	24	P	6N pre-driver high-side W-phase bootstrap power supply
VCC	25	P	Power input, with a 1μF ~ 4.7μF external capacitor
COM	26	P	6N Pre-driver ground
VDD5	27	P	5V LDO output with a 1μF ~ 4.7μF external capacitor
VSS	28	P	Power ground
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	29	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P1.2/ TIM4S2/ TXD2S2/ FICED	30	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line

Pin	FU6563N QFN32	IO Type	Function Descriptions
P1.4/ C0P/ A3M/ AD10/ HAL0S	31	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.6/ C1P/ A1P/ AD9/ HAL1S	32	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching

2.12 FU6563N QFN32 Pinout Diagram

Figure 2-6 FU6563N QFN32 Pinout Diagram



2.13 FU6562L LQFP48 Pins

Table 2-7 Pin Descriptions of FU6562L LQFP48

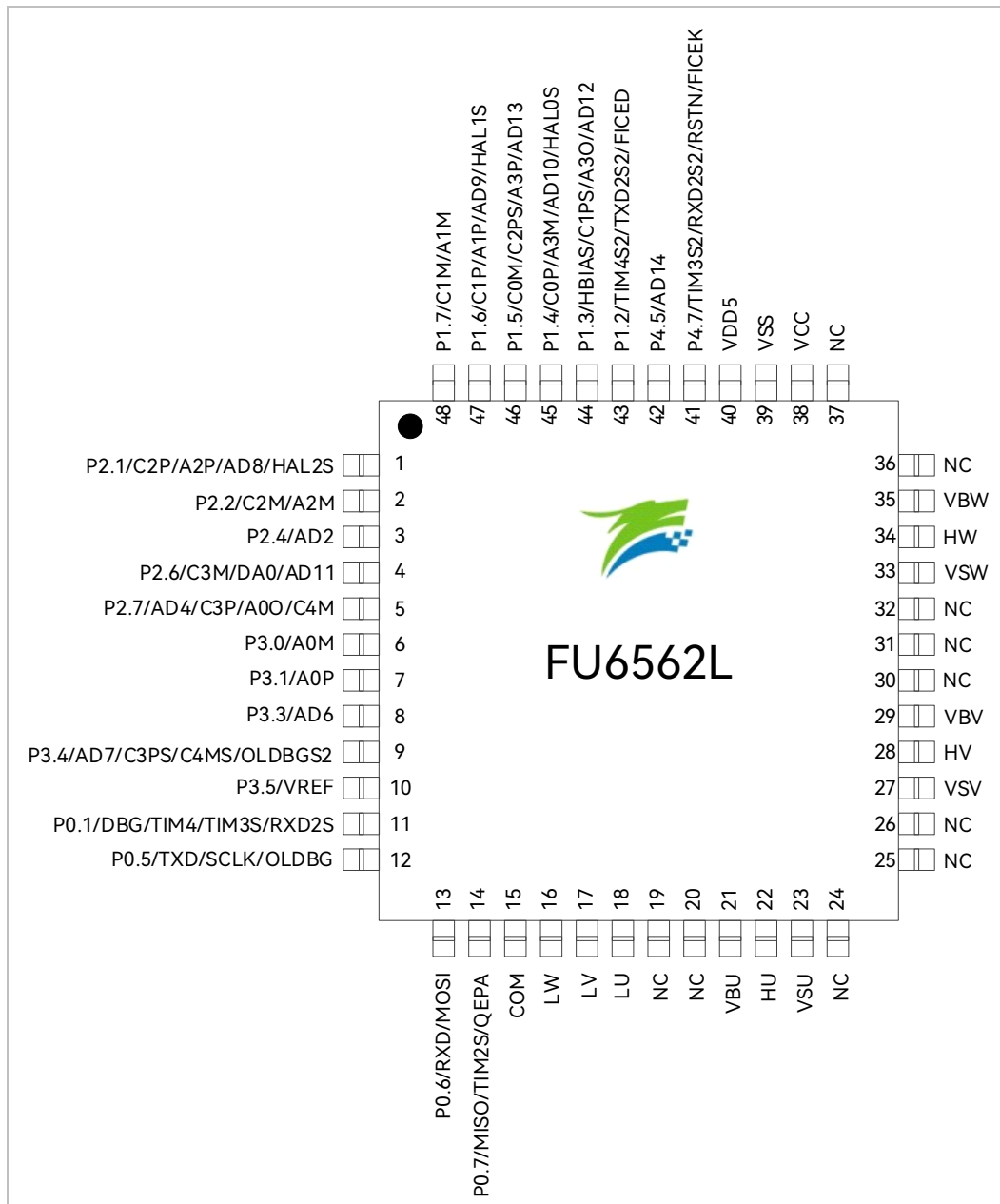
Pin	FU6562L LQFP48	IO Type	Function Descriptions
P2.1/ C2P/ A2P/ AD8/ HAL2S	1	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	2	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	3	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.6/ C3M/ DA0/ AD11	4	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P2.7/ AD4/ C3P/ A0O/ C4M	5	DB/ AI/ AI/ AO/ AI	GPIO Input of ADC channel 4 for bus current sampling CMP3 positive input AMP0 output CMP4 negative input
P3.0/ A0M	6	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	7	DB/ AI	GPIO AMP0 positive input
P3.3/ AD6	8	DB/ AI	GPIO Input of ADC channel 6
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	9	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output (P2.7) is delivered to P3.4 via a 50k Ohm internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	10	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.

Pin	FU6562L LQFP48	IO Type	Function Descriptions
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S	11	DB/ DO/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching
P0.5/ TXD/ SCLK/ OLDBG	12	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	13	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P0.7/ MISO/ TIM2S/ QEPA	14	DB/ DB/ DB/ DI	GPIO SPI MISO, master input or slave output Timer2 input/output after function switching QEP encode A input
COM	15	P	6N Pre-driver ground
LW	16	DO	6N Pre-driver low-side W-phase output
LV	17	DO	6N Pre-driver low-side V-phase output
LU	18	DO	6N Pre-driver low-side U-phase output
NC	19	-	Not connected
NC	20	-	Not connected
VBU	21	P	6N pre-driver high-side U-phase bootstrap power supply
HU	22	DO	6N pre-driver high-side U-phase output
VSU	23	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
NC	24	-	Not connected
NC	25	-	Not connected
NC	26	-	Not connected
VSV	27	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	28	DO	6N Pre-driver high-side V-phase PWM output
VBV	29	P	6N pre-driver high-side V-phase bootstrap power supply
NC	30	-	Not connected
NC	31	-	Not connected
NC	32	-	Not connected
VSW	33	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	34	DO	6N Pre-driver high-side W-phase output

Pin	FU6562L LQFP48	IO Type	Function Descriptions
VBW	35	P	6N pre-driver high-side W-phase bootstrap power supply
NC	36	-	Not connected
NC	37	-	Not connected
VCC	38	P	Power input, with a 1μF ~ 4.7μF external capacitor
VSS	39	P	Power ground
VDD5	40	P	Power input VDD 5V, with a 1μF ~ 4.7μF external capacitor. Output is not supported.
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	41	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P4.5/ AD14	42	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 14
P1.2/ TIM4S2/ TXD2S2/ FICED	43	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	44	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	45	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	46	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	47	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	48	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input

2.14 FU6562L LQFP48 Pinout Diagram

Figure 2-7 Pinout Diagram of FU6562L LQFP48



2.15 FU6562LA LQFP48 Pins

Table 2-8 Pin Descriptions of FU6562LA LQFP48

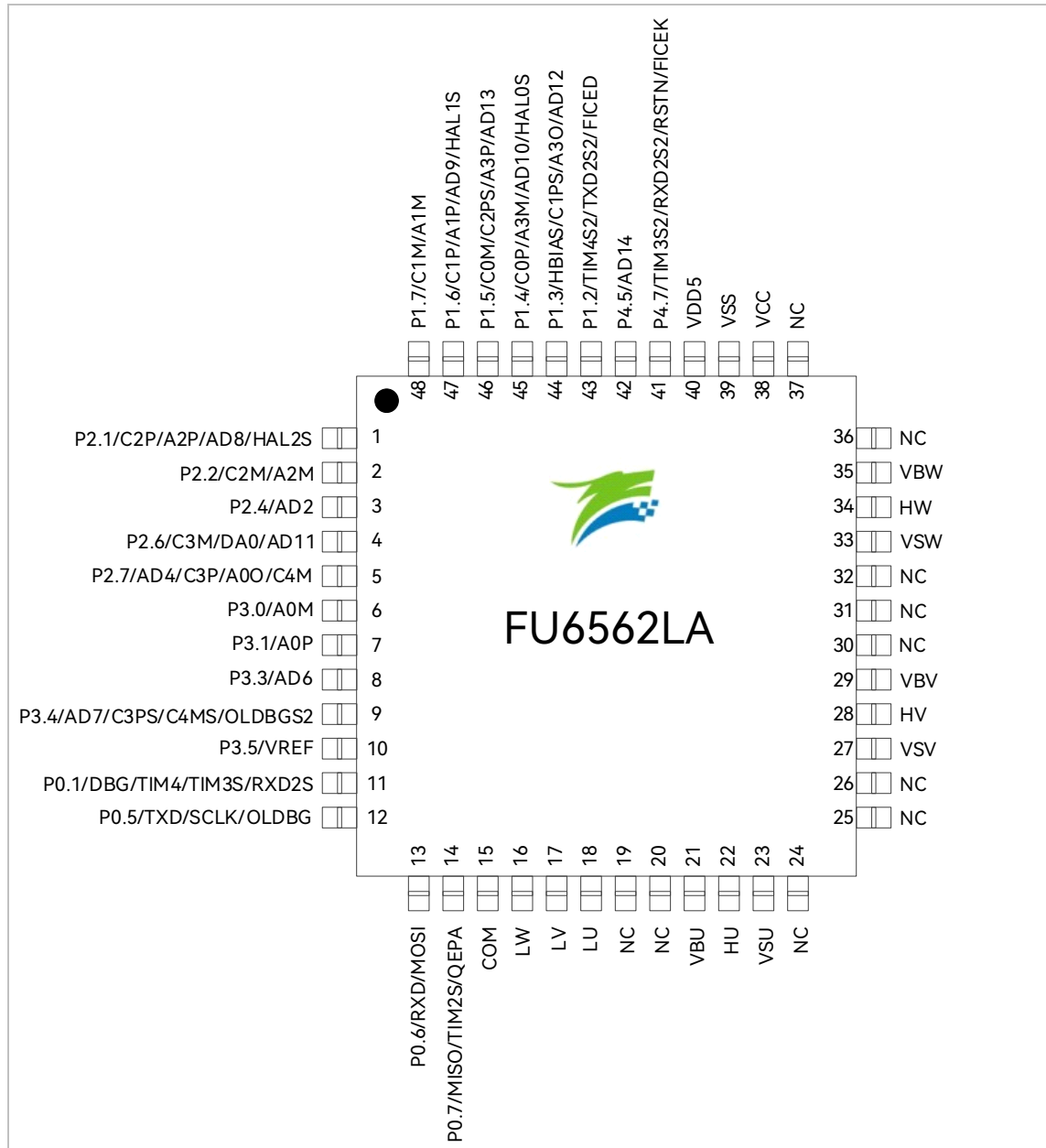
Pin	FU6562LA LQFP48	IO Type	Function Descriptions
P2.1/ C2P/ A2P/ AD8/ HAL2S	1	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	2	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	3	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.6/ C3M/ DA0/ AD11	4	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P2.7/ AD4/ C3P/ A0O/ C4M	5	DB/ AI/ AI/ AO/ AI	GPIO Input of ADC channel 4 for bus current sampling CMP3 positive input AMP0 output CMP4 negative input
P3.0/ A0M	6	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	7	DB/ AI	GPIO AMP0 positive input
P3.3/ AD6	8	DB/ AI	GPIO Input of ADC channel 6
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	9	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output (P2.7) is delivered to P3.4 via a 50k Ohm internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	10	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.

Pin	FU6562LA LQFP48	IO Type	Function Descriptions
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S	11	DB/ DO/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching
P0.5/ TXD/ SCLK/ OLDBG	12	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	13	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P0.7/ MISO/ TIM2S/ QEPA	14	DB/ DB/ DB/ DI	GPIO SPI MISO, master input or slave output Timer2 input/output after function switching QEP encode A input
COM	15	P	6N Pre-driver ground
LW	16	DO	6N Pre-driver low-side W-phase output
LV	17	DO	6N Pre-driver low-side V-phase output
LU	18	DO	6N Pre-driver low-side U-phase output
NC	19	-	Not connected
NC	20	-	Not connected
VBU	21	P	6N pre-driver high-side U-phase bootstrap power supply
HU	22	DO	6N pre-driver high-side U-phase output
VSU	23	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
NC	24	-	Not connected
NC	25	-	Not connected
NC	26	-	Not connected
VSV	27	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	28	DO	6N Pre-driver high-side V-phase PWM output
VBV	29	P	6N pre-driver high-side V-phase bootstrap power supply
NC	30	-	Not connected
NC	31	-	Not connected
NC	32	-	Not connected
VSW	33	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	34	DO	6N Pre-driver high-side W-phase output

Pin	FU6562LA LQFP48	IO Type	Function Descriptions
VBW	35	P	6N pre-driver high-side W-phase bootstrap power supply
NC	36	–	Not connected
NC	37	–	Not connected
VCC	38	P	Power input, with a 1μF ~ 4.7μF external capacitor
VSS	39	P	Power ground
VDD5	40	P	Power input VDD 5V, with a 1μF ~ 4.7μF external capacitor. Output is not supported.
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	41	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P4.5/ AD14	42	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 14
P1.2/ TIM4S2/ TXD2S2/ FICED	43	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	44	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	45	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	46	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	47	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	48	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input

2.16 FU6562LA LQFP48 Pinout Diagram

Figure 2–8 Pinout Diagram of FU6562LA LQFP48



2.17 FU6562Q QFN48–38 Pins

Table 2–9 Pin Descriptions of FU6562Q QFN48–38

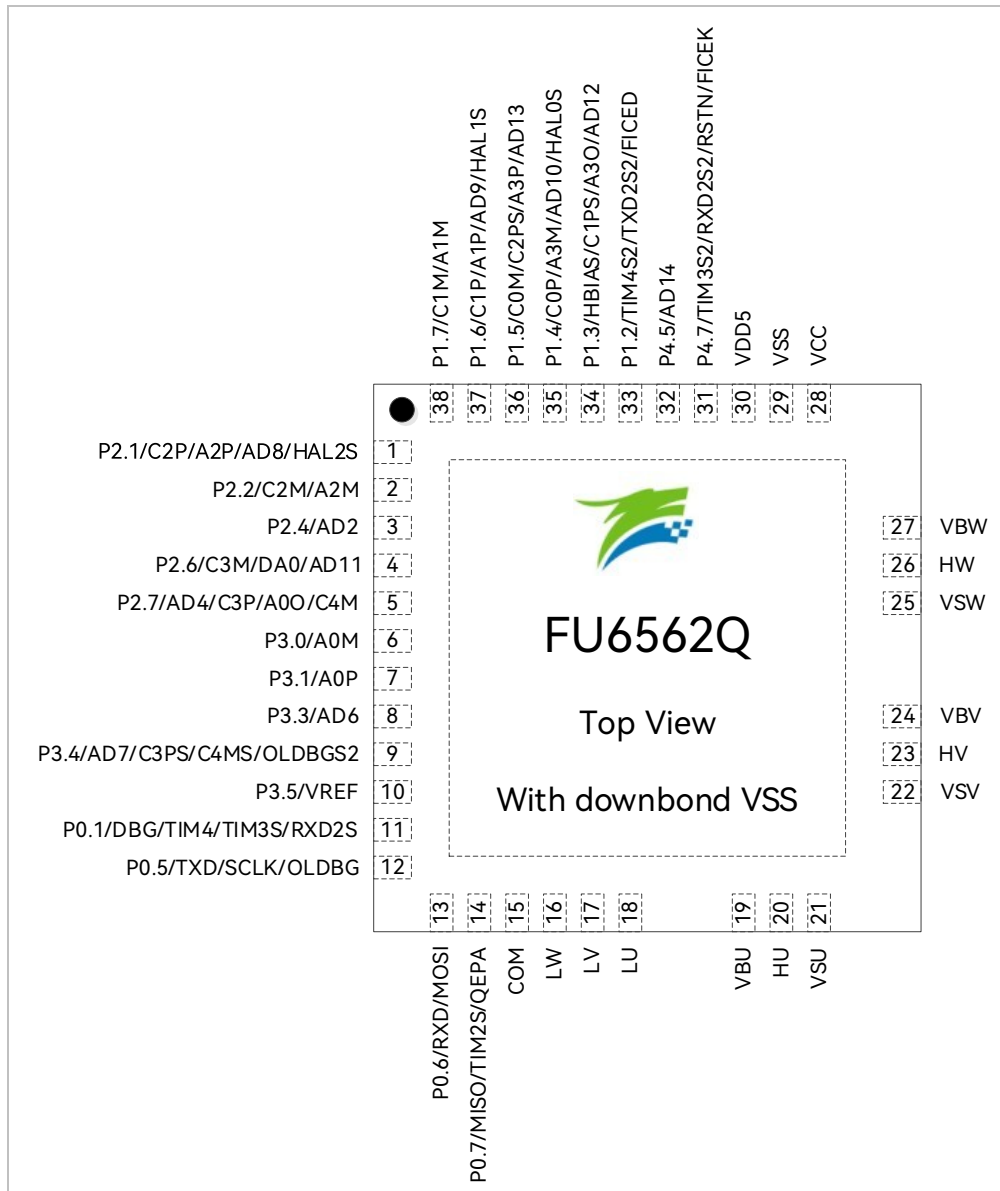
Pin	FU6562Q QFN48–38	IO Type	Function Descriptions
P2.1/ C2P/ A2P/ AD8/ HAL2S	1	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	2	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	3	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.6/ C3M/ DA0/ AD11	4	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P2.7/ AD4/ C3P/ A0O/ C4M	5	DB/ AI/ AI/ AO/ AI	GPIO Input of ADC channel 4 for bus current sampling CMP3 positive input AMP0 output CMP4 negative input
P3.0/ A0M	6	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	7	DB/ AI	GPIO AMP0 positive input
P3.3/ AD6	8	DB/ AI/	GPIO Input of ADC channel 6
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	9	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output (P2.7) is delivered to P3.4 via a 50k Ohm internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	10	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.

Pin	FU6562Q QFN48-38	IO Type	Function Descriptions
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S	11	DB/ DO/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching
P0.5/ TXD/ SCLK/ OLDBG	12	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	13	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P0.7/ MISO/ TIM2S/ QEPA	14	DB/ DB/ DB/ DI	GPIO SPI MISO, master input or slave output Timer2 input/output after function switching QEP encode A input
COM	15	P	6N Pre-driver ground
LW	16	DO	6N pre-driver low-side W-phase output
LV	17	DO	6N pre-driver low-side V-phase output
LU	18	DO	6N pre-driver low-side U-phase output
VBU	19	P	6N pre-driver high-side U-phase bootstrap power supply
HU	20	DO	6N pre-driver high-side U-phase output
VSU	21	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
VSV	22	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	23	DO	6N Pre-driver high-side V-phase PWM output
VBV	24	P	6N pre-driver high-side V-phase bootstrap power supply
VSW	25	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	26	DO	6N Pre-driver high-side W-phase output
VBW	27	P	6N pre-driver high-side W-phase bootstrap power supply
VCC	28	P	Power input, with a 1μF ~ 4.7μF external capacitor
VSS	29	P	Power ground
VDD5	30	P	Power input VDD 5V, with a 1μF ~ 4.7μF external capacitor. Output is not supported.

Pin	FU6562Q QFN48-38	IO Type	Function Descriptions
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	31	DI/ DI/ DB/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P4.5/ AD14	32	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 14
P1.2/ TIM4S2/ TXD2S2/ FICED	33	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	34	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	35	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	36	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	37	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	38	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input

2.18 FU6562Q QFN48–38 Pinout Diagram

Figure 2–9 Pinout Diagram of FU6562Q QFN48–38



2.19 FU6562S TSSOP28 Pins

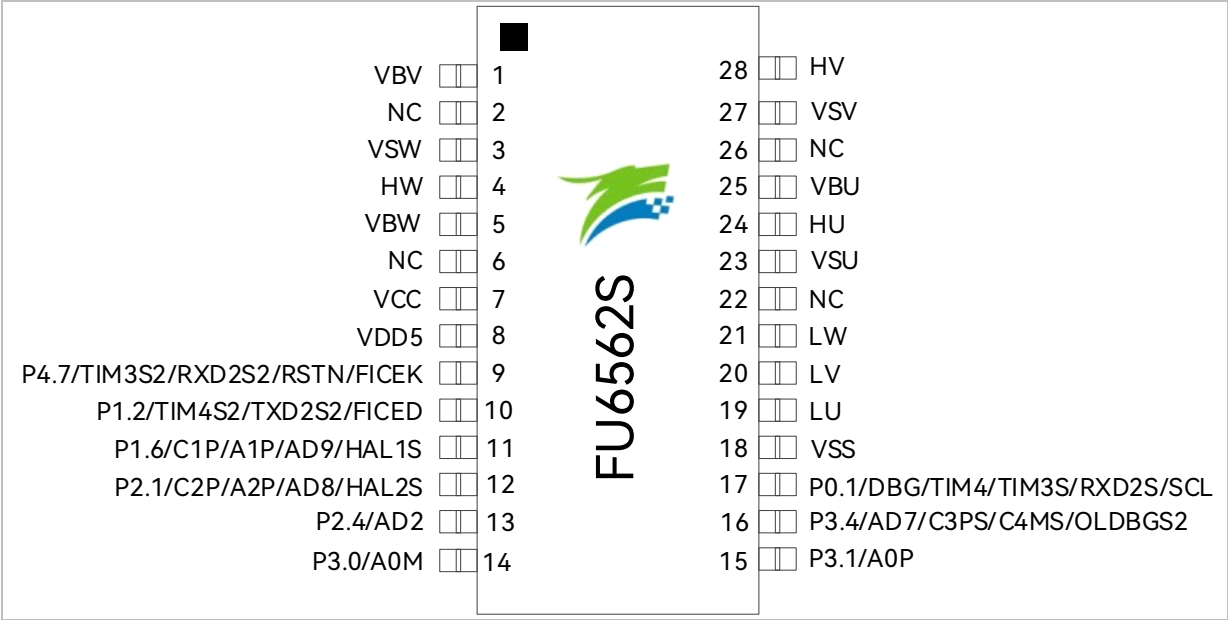
Table 2-10 Pin Descriptions of FU6562S TSSOP28

Pin	FU6562S TSSOP28	IO Type	Function Descriptions
VBV	1	P	6N pre-driver high-side V-phase bootstrap power supply
NC	2	-	Not connected
VSW	3	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	4	DO	6N Pre-driver high-side W-phase output
VBW	5	P	6N pre-driver high-side W-phase bootstrap power supply
NC	6	-	Not connected
VCC	7	P	Power input, with an external filter capacitor of 1 μ F ~ 4.7 μ F or above.
VDD5	8	P	Power input VDD 5V, with a 1 μ F ~ 4.7 μ F external capacitor. Output is not supported.
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	9	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P1.2/ TIM4S2/ TXD2S2/ FICED	10	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.6/ C1P/ A1P/ AD9/ HAL1S	11	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P2.1/ C2P/ A2P/ AD8/ HAL2S	12	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.4/ AD2	13	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P3.0/ A0M	14	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	15	DB/ AI	GPIO AMP0 positive input

Pin	FU6562S TSSOP28	IO Type	Function Descriptions
P3.4/ AD7/	16	DB/ AI/	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling.
C3PS/		AI/	CMP3 positive input after function switching
C4MS/		AI/	CMP4 negative input after function switching
OLDBGS2		DO	SPI debug output after the second function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/	17	DB/	GPIO, configurable as INT0 input
		DO/	Debug port
		DB/	Timer4 input/output before function switching
		DB/	Timer3 input/output after function switching
	17	DB/	UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching
SCL		DB	I ² C SCL, configured as collector open-drain output
VSS	18	P	Power ground
LU	19	DO	6N Pre-driver low-side U-phase output
LV	20	DO	6N Pre-driver low-side V-phase output
LW	21	DO	6N Pre-driver low-side W-phase output
NC	22	-	Not connected
VSU	23	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
HU	24	DO	6N pre-driver high-side U-phase output
VBU	25	P	6N pre-driver high-side U-phase bootstrap power supply
NC	26	-	Not connected
VSV	27	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	28	DO	6N Pre-driver high-side V-phase PWM output

2.20 FU6562S TSSOP28 Pinout Diagram

Figure 2-10 Pinout Diagram of FU6562S TSSOP28



2.21 FU6562T TSSOP28 Pins

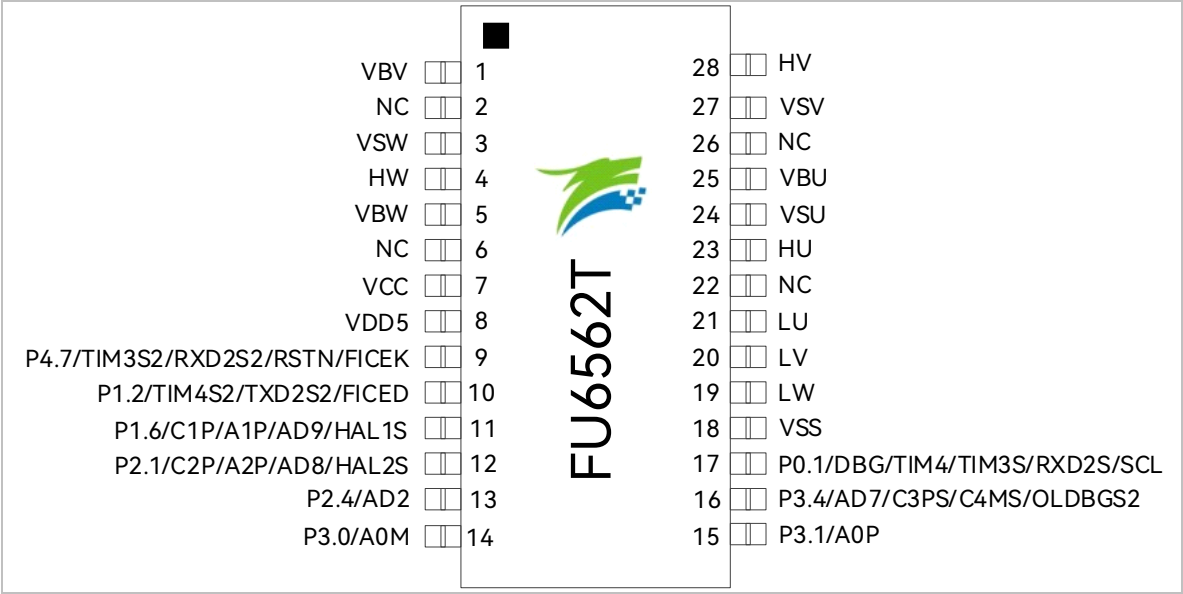
Table 2-11 Pin Descriptions of FU6562T TSSOP28

Pin	FU6562T TSSOP28	IO Type	Function Descriptions
VBV	1	P	6N pre-driver high-side V-phase bootstrap power supply
NC	2	-	Not connected
VSW	3	P	6N pre-driver W-phase input, as GND reference for W-phase high-side bootstrap
HW	4	DO	6N Pre-driver high-side W-phase output
VBW	5	P	6N pre-driver high-side W-phase bootstrap power supply
NC	6	-	Not connected
VCC	7	P	Power input, with a 1μF ~ 4.7μF external capacitor
VDD5	8	P	Power input VDD 5V, with a 1μF ~ 4.7μF external capacitor. Output is not supported.
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	9	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P1.2/ TIM4S2/ TXD2S2/ FICED	10	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.6/ C1P/ A1P/ AD9/ HAL1S	11	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P2.1/ C2P/ A2P/ AD8/ HAL2S	12	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.4/ AD2	13	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P3.0/ A0M	14	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	15	DB/ AI	GPIO AMP0 positive input

Pin	FU6562T TSSOP28	IO Type	Function Descriptions
P3.4/ AD7/	16	DB/ AI/	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1 μF external capacitor for bus average current sampling.
C3PS/		AI/	CMP3 positive input after function switching
C4MS/		AI/	CMP4 negative input after function switching
OLDBGS2		DO	SPI debug output after the second function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/	17	DB/	GPIO, configurable as INT0 input
		DO/	Debug port
		DB/	Timer4 input/output before function switching
		DB/	Timer3 input/output after function switching
	17	DB/	UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching
SCL		DB	I2C SCL, configured as collector open-drain output
VSS	18	P	Power ground
LW	19	DO	6N Pre-driver low-side W-phase output
LV	20	DO	6N Pre-driver low-side V-phase output
LU	21	DO	6N Pre-driver low-side U-phase output
NC	22	-	Not connected
HU	23	DO	6N pre-driver high-side U-phase output
VSU	24	P	6N pre-driver U-phase input, as GND reference for U-phase high-side bootstrap
VBU	25	P	6N pre-driver high-side U-phase bootstrap power supply
NC	26	-	Not connected
VSV	27	P	6N pre-driver V-phase input, as GND reference for V-phase high-side bootstrap
HV	28	DO	6N Pre-driver high-side V-phase PWM output

2.22 FU6562T TSSOP28 Pinout Diagram

Figure 2-11 Pinout Diagram of FU6562T TSSOP28



2.23 FU6532N QFN32 Pins

Table 2-12 Pin Descriptions of FU6532N QFN32

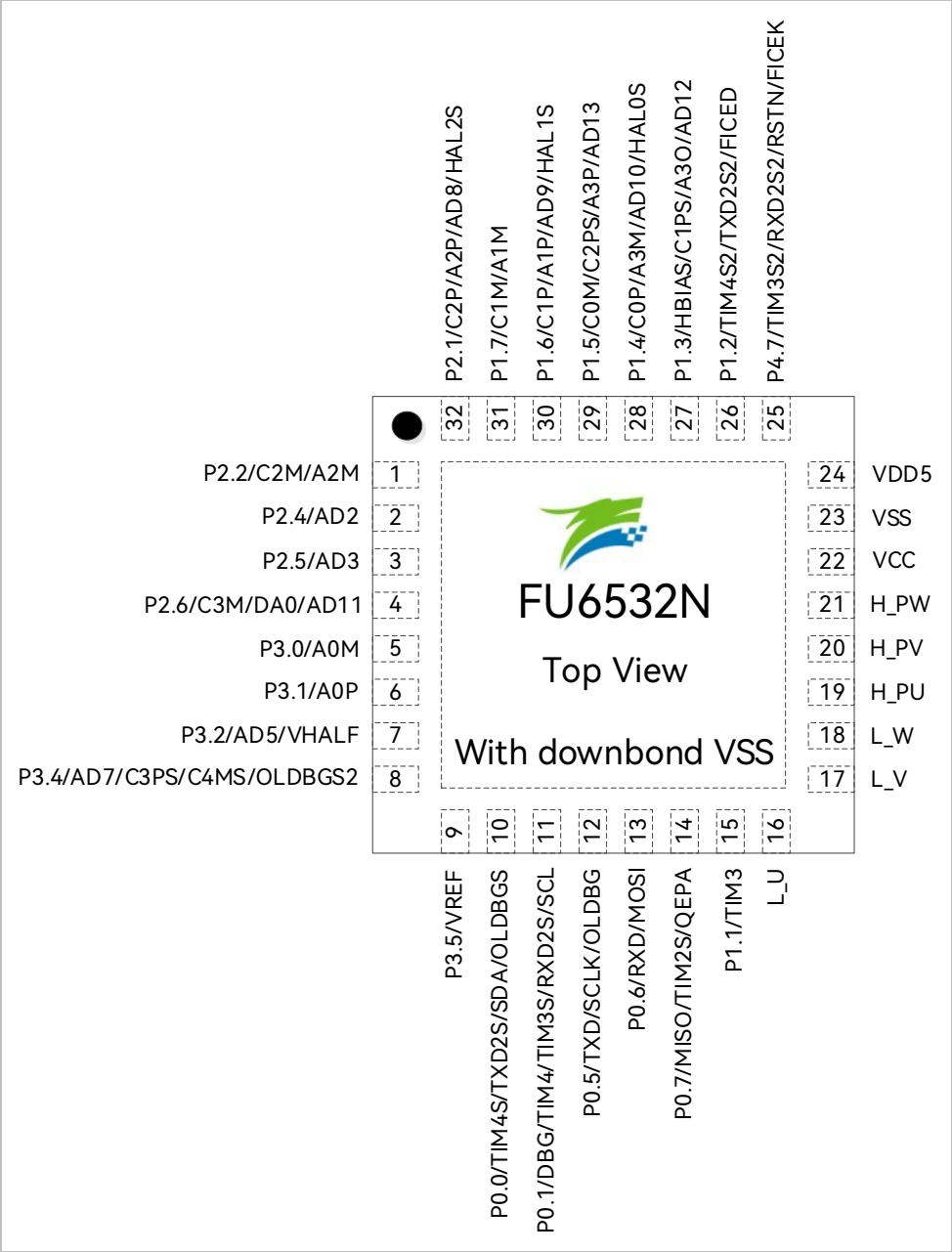
Pin	FU6532N QFN32	IO Type	Function Descriptions
P2.2/ C2M/ A2M	1	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	2	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.5/ AD3	3	DB/ AI	GPIO Input of ADC channel 3
P2.6/ C3M/ DA0/ AD11	4	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P3.0/ A0M	5	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	6	DB/ AI	GPIO AMP0 positive input
P3.2/ AD5/ VHALF	7	DB/ AI/ AO	GPIO Input of ADC channel 5 1/2 VREF voltage output, with a 1μF external capacitor
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	8	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1 μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	9	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBGS	10	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I2C SDA, configured as collector open-drain output SPI debug output after function switching

Pin	FU6532N QFN32	IO Type	Function Descriptions
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	11	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I2C SCL, configured as collector open-drain output
P0.5/ TXD/ SCLK/ OLDBG	12	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	13	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P0.7/ MISO/ TIM2S/ QEPA	14	DB/ DB/ DB/ DI	GPIO SPI MISO, master input or slave output Timer2 input/output after function switching QEP encode A input
P1.1/ TIM3	15	DB/ DB	GPIO, configurable as INT0/INT1 input Timer3 input/output
L_U	16	DO	3P3N pre-driver low-side U-phase output
L_V	17	DO	3P3N pre-driver low-side V-phase output
L_W	18	DO	3P3N pre-driver low-side W-phase output
H_PU	19	DO	3P3N pre-driver high-side U-phase output
H_PV	20	DO	3P3N pre-driver high-side V-phase output
H_PW	21	DO	3P3N pre-driver high-side W-phase output
VCC	22	P	Power input, with a 1μF ~ 4.7μF external capacitor
VSS	23	P	Power ground
VDD5	24	P	5V LDO output with a 1μF ~ 4.7μF external capacitor
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	25	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P1.2/ TIM4S2/ TXD2S2/ FICED	26	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line

Pin	FU6532N QFN32	IO Type	Function Descriptions
P1.3/ HBIAS/ C1PS/ A3O/ AD12	27	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	28	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	29	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	30	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	31	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input
P2.1/ C2P/ A2P/ AD8/ HAL2S	32	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching

2.24 FU6532N QFN32 Pinout Diagram

Figure 2-12 Pinout Diagram of FU6532N QFN32



2.25 FU6532T TSSOP28 Pins

Table 2-13 Pin Descriptions of FU6532T TSSOP28

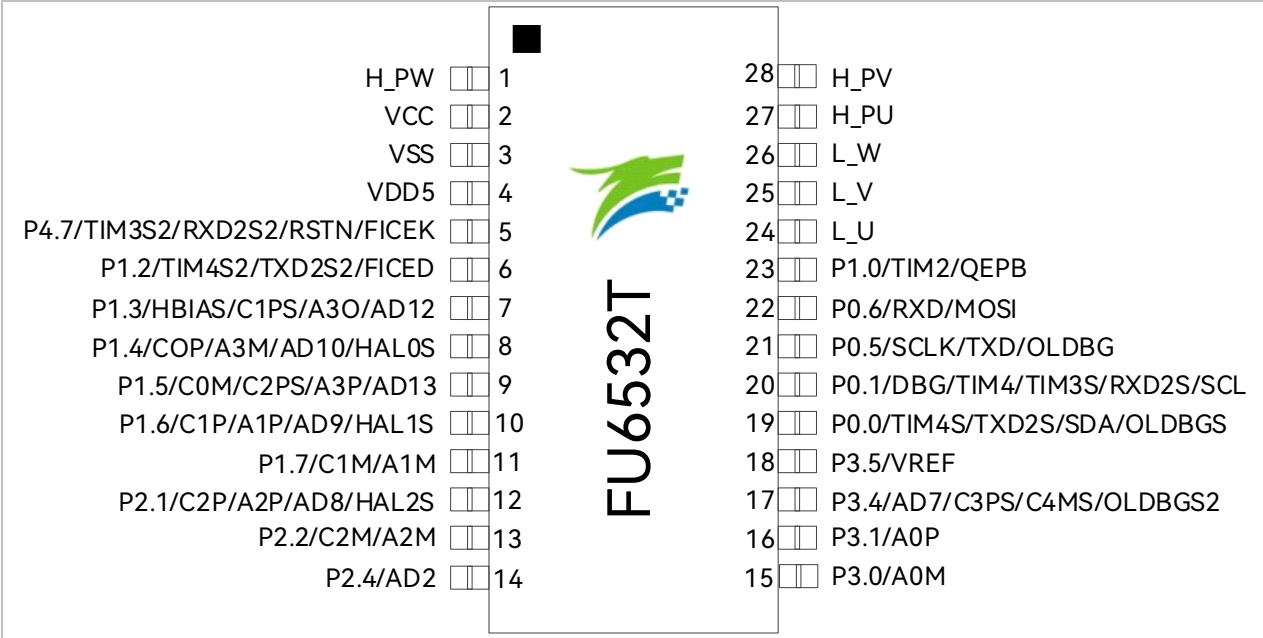
Pin	FU6532T TSSOP28	IO Type	Function Descriptions
H_PW	1	DO	3P3N pre-driver high-side W-phase output
VCC	2	P	Power input, with a 1 μ F ~ 4.7 μ F external capacitor
VSS	3	P	Power ground
VDD5	4	DO	5V LDO output with a 1 μ F ~ 4.7 μ F external capacitor
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	5	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P1.2/ TIM4S2/ TXD2S2/ FICED	6	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	7	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	8	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	9	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	10	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	11	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input

Pin	FU6532T TSSOP28	IO Type	Function Descriptions
P2.1/ C2P/ A2P/ AD8/ HAL2S	12	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	13	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	14	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P3.0/ A0M	15	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	16	DB/ AI	GPIO AMP0 positive input
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	17	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P3.5/ VREF	18	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBGS	19	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I2C SDA, configured as collector open-drain output SPI debug output after function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	20	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I2C SCL, configured as collector open-drain output
P0.5/ TXD/ SCLK/ OLDBG	21	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output

Pin	FU6532T TSSOP28	IO Type	Function Descriptions
P0.6/ RXD/ MOSI	22	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P1.0/ TIM2/ QEPB	23	DB/ DB/ DI	GPIO, configurable as INT1 input Timer2 input/output QEP encode B input
L_U	24	DO	3P3N pre-driver low-side U-phase output
L_V	25	DO	3P3N pre-driver low-side V-phase output
L_W	26	DO	3P3N pre-driver low-side W-phase output
H_PU	27	DO	3P3N pre-driver high-side U-phase output
H_PV	28	DO	3P3N pre-driver high-side V-phase output

2.26 FU6532T TSSOP28 Pinout Diagram

Figure 2-13 Pinout Diagram of FU6532T TSSOP28



2.27 FU6522L LQFP48 Pins

Table 2-14 Pin Descriptions of FU6522L LQFP48

Pin	FU6522L LQFP48	IO Type	Function Descriptions
P2.2/ C2M/ A2M	1	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.3/ AD1/ A2O/ C4P/ DA1	2	DB/ AI/ AO/ AI/ DO	GPIO Input of ADC channel 1 AMP2 output CMP4 positive input DAC1 output, without Buffer output
P2.4/ AD2	3	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.5/ AD3	4	DB/ AI	GPIO Input of ADC channel 3
P2.6/ C3M/ DA0/ AD11	5	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P2.7/ AD4/ C3P/ A0O/ C4M	6	DB/ AI/ AI/ AO/ AI	GPIO Input of ADC channel 4 for bus current sampling CMP3 positive input AMP0 output CMP4 negative input
P3.0/ A0M	7	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	8	DB/ AI	GPIO AMP0 positive input
P3.2/ AD5/ VHALF	9	DB/ AI/ AO	GPIO Input of ADC channel 5 1/2 VREF voltage output, with a 1μF external capacitor
P3.3/ AD6	10	DB/ AI	GPIO Input of ADC channel 6
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	11	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output (P2.7) is delivered to P3.4 via a 50k Ohm internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching

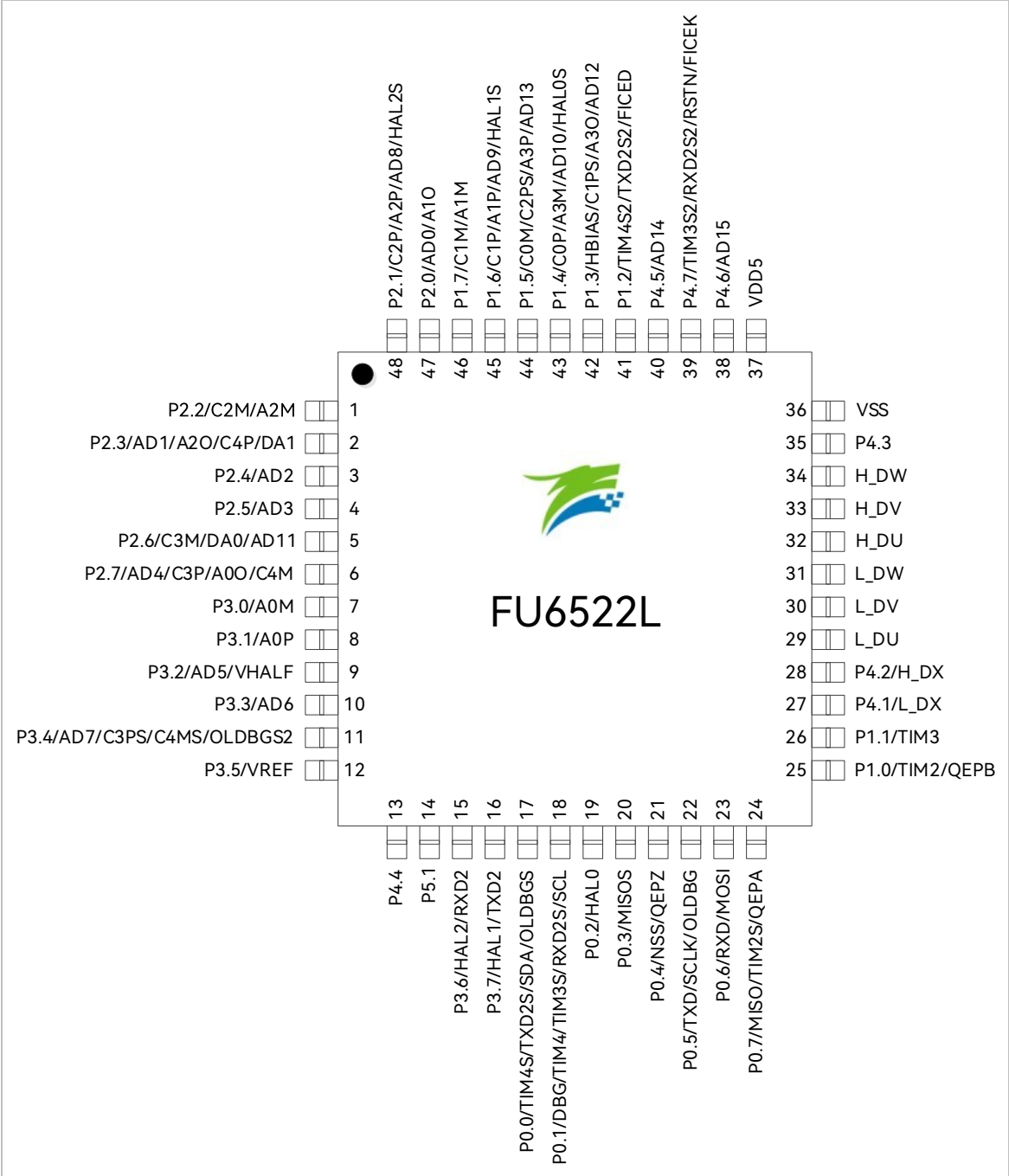
Pin	FU6522L LQFP48	IO Type	Function Descriptions
P3.5/ VREF	12	DB/ AB	GPIO ADC external VREF input or internal VREF output, with external R + C connected in series to VSS pin. R = 33Ω, C = 1μF ~ 4.7μF.
P4.4	13	DB	GPIO, configurable as INT1 input
P5.1	14	DB	GPIO
P3.6/ HAL2/ RXD2	15	DB/ DI/ DB	GPIO Hall-IC2 logic level input UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode
P3.7/ HAL1/ TXD2	16	DB/ DI/ DO	GPIO Hall-IC1 logic level input UART2 TXD output
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBG	17	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I2C SDA, configured as collector open-drain output SPI debug output after function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	18	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I2C SCL, configured as collector open-drain output
P0.2/ HAL0	19	DB/ DI	GPIO, configurable as INT0 input Hall-IC0 logic level input
P0.3/ MISOS	20	DB/ DB	GPIO, configurable as INT0 input SPI MISO after function switching, master input or slave output
P0.4/ NSS/ QEPZ	21	DB/ DB/ DB	GPIO, configurable as INT1 input SPI NSS QEP Z input/output at zero point
P0.5/ TXD/ SCLK/ OLDBG	22	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	23	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input

Pin	FU6522L LQFP48	IO Type	Function Descriptions
P0.7/ MISO/ TIM2S/ QEPA	24	DB/ DB/ DB/ DI	GPIO SPI MISO, master input or slave output Timer2 input/output after function switching QEP encode A input
P1.0/ TIM2/ QEPB	25	DB/ DB/ DI	GPIO, configurable as INT1 input Timer2 input/output QEP encode B input
P1.1/ TIM3	26	DB/ DB	GPIO, configurable as INT0/INT1 input Timer3 input/output
P4.1/ L_DX	27	DB/ DO	GPIO, configurable as INT1 input Low-side X-phase PWM output
P4.2/ H_DX	28	DB/ DO	GPIO, configurable as INT1 input High-side X-phase PWM output
L_DU	29	DO	Low-side U-phase PWM output
L_DV	30	DO	Low-side V-phase PWM output
L_DW	31	DO	Low-side W-phase PWM output
H_DU	32	DO	High-side U-phase PWM output
H_DV	33	DO	High-side V-phase PWM output
H_DW	34	DO	High-side W-phase PWM output
P4.3	35	DB	GPIO, configurable as INT1 input
VSS	36	P	Power ground
VDD5	37	P	Power input VDD 5V, with a 1μF ~ 4.7μF external capacitor. Output is not supported.
P4.6/ AD15	38	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 15
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	39	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P4.5/ AD14	40	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 14
P1.2/ TIM4S2/ TXD2S2/ FICED	41	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	42	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12

Pin	FU6522L LQFP48	IO Type	Function Descriptions
P1.4/ C0P/ A3M/ AD10/ HAL0S	43	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	44	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	45	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	46	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input
P2.0/ AD0/ A1O	47	DB/ AI/ AO	GPIO Input of ADC channel 0 AMP1 output
P2.1/ C2P/ A2P/ AD8/ HAL2S	48	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching

2.28 FU6522L LQFP48 Pinout Diagram

Figure 2-14 Pinout Diagram of FU6522L LQFP48



2.29 FU6522N QFN32 Pins

Table 2-15 Pin Descriptions of FU6522N QFN32

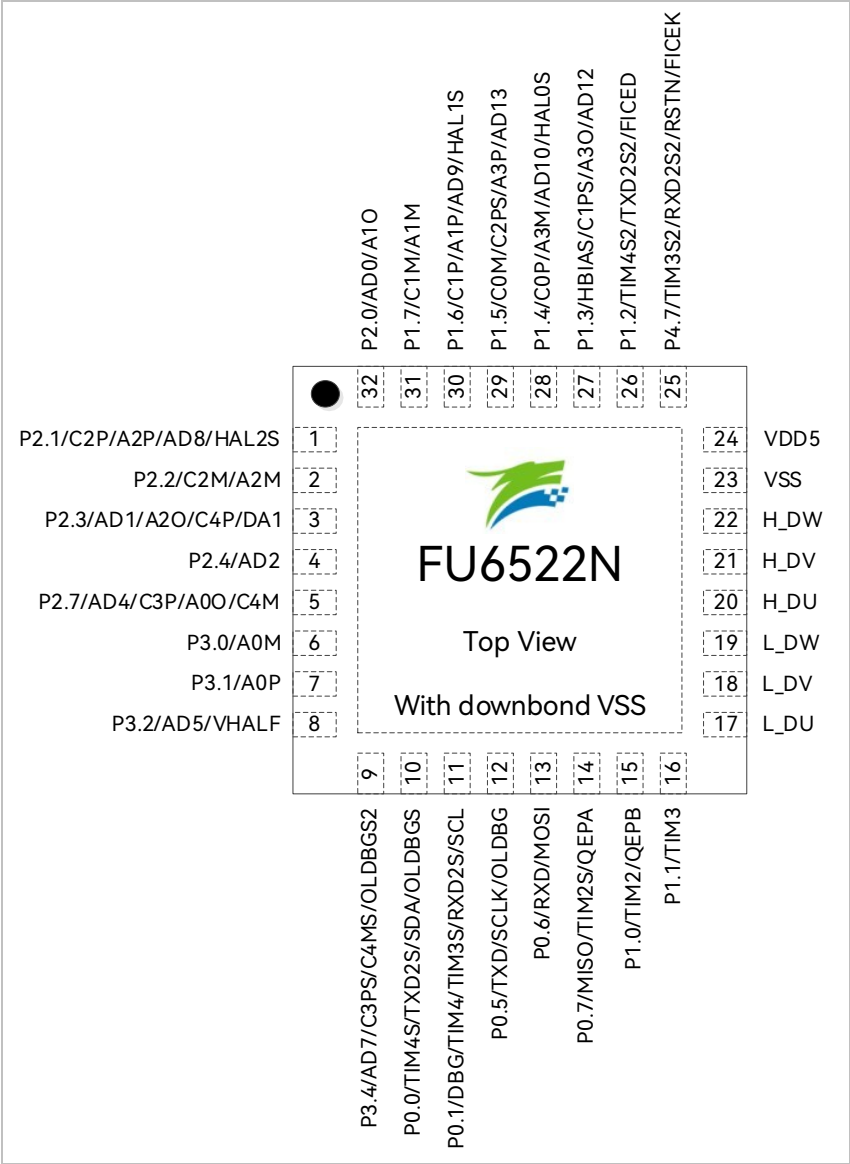
Pin	FU6522N QFN32	IO Type	Function Descriptions
P2.1/ C2P/ A2P/ AD8/ HAL2S	1	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	2	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.3/ AD1/ A2O/ C4P/ DA1	3	DB/ AI/ AO/ AI/ AO	GPIO Input of ADC channel 1 AMP2 output CMP4 positive input DAC1 output, without Buffer output
P2.4/ AD2	4	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.7/ AD4/ C3P/ A0O/ C4M	5	DB/ AI/ AI/ AO/ AI	GPIO Input of ADC channel 4 for bus current sampling CMP3 positive input AMP0 output CMP4 negative input
P3.0/ A0M	6	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	7	DB/ AI	GPIO AMP0 positive input
P3.2/ AD5/ VHALF	8	DB/ AI/ AO	GPIO Input of ADC channel 5 1/2 VREF voltage output, with a 1μF external capacitor
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	9	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output (P2.7) is delivered to P3.4 via a 50k Ohm internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching

Pin	FU6522N QFN32	IO Type	Function Descriptions
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBGS	10	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I ² C SDA, configured as collector open-drain output SPI debug output after function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	11	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I ² C SCL, configured as collector open-drain output
P0.5/ TXD/ SCLK/ OLDBG	12	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	13	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P0.7/ MISO/ TIM2S/ QEPA	14	DB/ DB/ DB/ DI	GPIO SPI MISO, master input or slave output Timer2 input/output after function switching QEP encode A input
P1.0/ TIM2/ QEPB	15	DB/ DB/ DI	GPIO, configurable as INT1 input Timer2 input/output QEP encode B input
P1.1/ TIM3	16	DB/ DB	GPIO, configurable as INT0/INT1 input Timer3 input/output
L_DU	17	DO	Low-side U-phase PWM output
L_DV	18	DO	Low-side V-phase PWM output
L_DW	19	DO	Low-side W-phase PWM output
H_DU	20	DO	High-side U-phase PWM output
H_DV	21	DO	High-side V-phase PWM output
H_DW	22	DO	High-side W-phase PWM output
VSS	23	P	Power ground
VDD5	24	P	Power input VDD 5V, with a 1μF ~ 4.7μF external capacitor. Output is not supported.

Pin	FU6522N QFN32	IO Type	Function Descriptions
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	25	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P1.2/ TIM4S2/ TXD2S2/ FICED	26	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line
P1.3/ HBIAS/ C1PS/ A3O/ AD12	27	DB/ DO/ AI/ DO/ AI	GPIO, configurable as INT1 input Hall bias power supply, internally connected to VDD5 via a switch CMP1 positive input after function switching AMP3 output Input of ADC channel 12
P1.4/ C0P/ A3M/ AD10/ HAL0S	28	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	29	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	30	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	31	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input
P2.0/ AD0/ A1O	32	DB/ AI/ AO	GPIO Input of ADC channel 0 AMP1 output

2.30 FU6522N QFN32 Pinout Diagram

Figure 2-15 Pinout Diagram of FU6522N QFN32



2.31 FU6522T TSSOP28 Pins

Table 2-16 Pin Descriptions of FU6522T TSSOP28

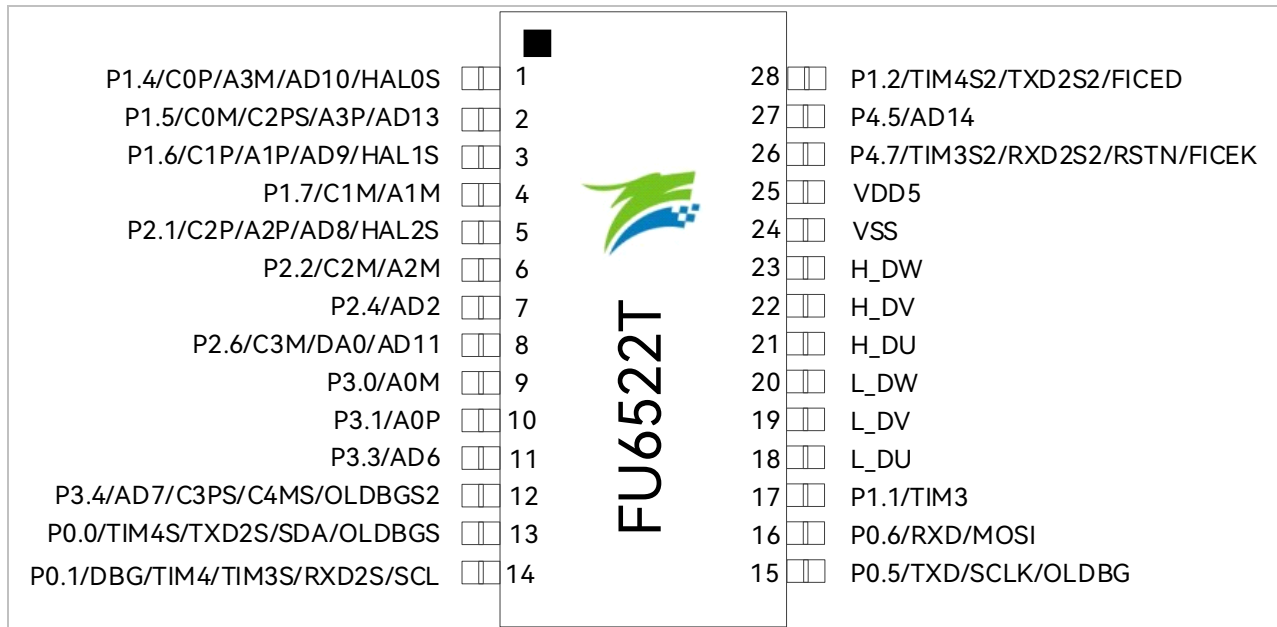
Pin	FU6522T TSSOP28	IO Type	Function Descriptions
P1.4/ C0P/ A3M/ AD10/ HAL0S	1	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP0 positive input AMP3 negative input Input of ADC channel 10 Hall0 logic level input after function switching
P1.5/ C0M/ C2PS/ A3P/ AD13	2	DB/ AI/ AI/ AI/ AI	GPIO, configurable as INT1 input CMP0 negative input CMP2 positive input after function switching AMP3 positive input Input of ADC channel 13
P1.6/ C1P/ A1P/ AD9/ HAL1S	3	DB/ AI/ AI/ AI/ DI	GPIO, configurable as INT1 input CMP1 positive input AMP1 positive input Input of ADC channel 9 Hall-IC1 logic level input after function switching
P1.7/ C1M/ A1M	4	DB/ AI/ AI	GPIO, configurable as INT1 input CMP1 negative input AMP1 negative input
P2.1/ C2P/ A2P/ AD8/ HAL2S	5	DB/ AI/ AI/ AI/ DI	GPIO CMP2 positive input AMP2 positive input Input of ADC channel 8 Hall-IC2 logic level input after function switching
P2.2/ C2M/ A2M	6	DB/ AI/ AI	GPIO CMP2 negative input AMP2 negative input
P2.4/ AD2	7	DB/ AI	GPIO Input of ADC channel 2 for bus voltage sampling
P2.6/ C3M/ DA0/ AD11	8	DB/ AI/ AO/ AI	GPIO CMP3 negative input DAC0 output, without Buffer output Input of ADC channel 11
P3.0/ A0M	9	DB/ AI	GPIO AMP0 negative input
P3.1/ A0P	10	DB/ AI	GPIO AMP0 positive input
P3.3/ AD6	11	DB/ AI	GPIO Input of ADC channel 6

Pin	FU6522T TSSOP28	IO Type	Function Descriptions
P3.4/ AD7/ C3PS/ C4MS/ OLDBGS2	12	DB/ AI/ AI/ AI/ DO	GPIO Input of ADC channel 7. When AMP_CR0[CP_EN] = 1, AMP0 output is delivered to P3.4 via a 50kΩ internal resistor. P3.4 is connected with a 1μF external capacitor for bus average current sampling. CMP3 positive input after function switching CMP4 negative input after function switching SPI debug output after the second function switching
P0.0/ TIM4S/ TXD2S/ SDA/ OLDBGS	13	DO/ DB/ DB/ DO/ DO	GPIO, configurable as INT0 input Timer4 input/output after function switching UART2 TXD output after function switching I2C SDA, configured as collector open-drain output SPI debug output after function switching
P0.1/ DBG/ TIM4/ TIM3S/ RXD2S/ SCL	14	DB/ DO/ DB/ DB/ DB/ DB	GPIO, configurable as INT0 input Debug port Timer4 input/output before function switching Timer3 input/output after function switching UART2 RXD input in two-wire mode or TXD output/RXD input in single-wire mode after function switching I ² C SCL, configured as collector open-drain output
P0.5/ TXD/ SCLK/ OLDBG	15	DB/ DO/ DB/ DO	GPIO, configurable as INT0 input UART1 TXD output SPI SCLK SPI single-wire debug output
P0.6/ RXD/ MOSI	16	DB/ DB/ DB	GPIO, configurable as INT0 input UART1 RXD input in two-wire mode or TXD output/RXD input in single-wire mode SPI MOSI, master output or slave input
P1.1/ TIM3	17	DB/ DB	GPIO, configurable as INT0/INT1 input Timer3 input/output
L_DU	18	DO	Low-side U-phase PWM output
L_DV	19	DO	Low-side V-phase PWM output
L_DW	20	DO	Low-side W-phase PWM output
H_DU	21	DO	High-side U-phase PWM output
H_DV	22	DO	High-side V-phase PWM output
H_DW	23	DO	High-side W-phase PWM output
VSS	24	P	Power ground
VDD5	25	P	Power input VDD 5V, with a 1μF ~ 4.7μF external capacitor. Output is not supported.

Pin	FU6522T TSSOP28	IO Type	Function Descriptions
P4.7/ TIM3S2/ RXD2S2/ RSTN/ FICEK	26	DI/ DI/ DI/ DI/ DI	GPIO, input only, with configurable pull-up or pull-down resistors Timer3 input after function switching UART2 RXD input after function switching Input of external reset, with built-in pull-up resistor FICE clock line
P4.5/ AD14	27	DB/ AI	GPIO, configurable as INT1 input Input of ADC channel 14
P1.2/ TIM4S2/ TXD2S2/ FICED	28	DB/ DB/ DO/ DB	GPIO, configurable as INT1 input Timer4 input/output after function switching UART2 TXD output after function switching FICE data line

2.32 FU6522T TSSOP28 Pinout Diagram

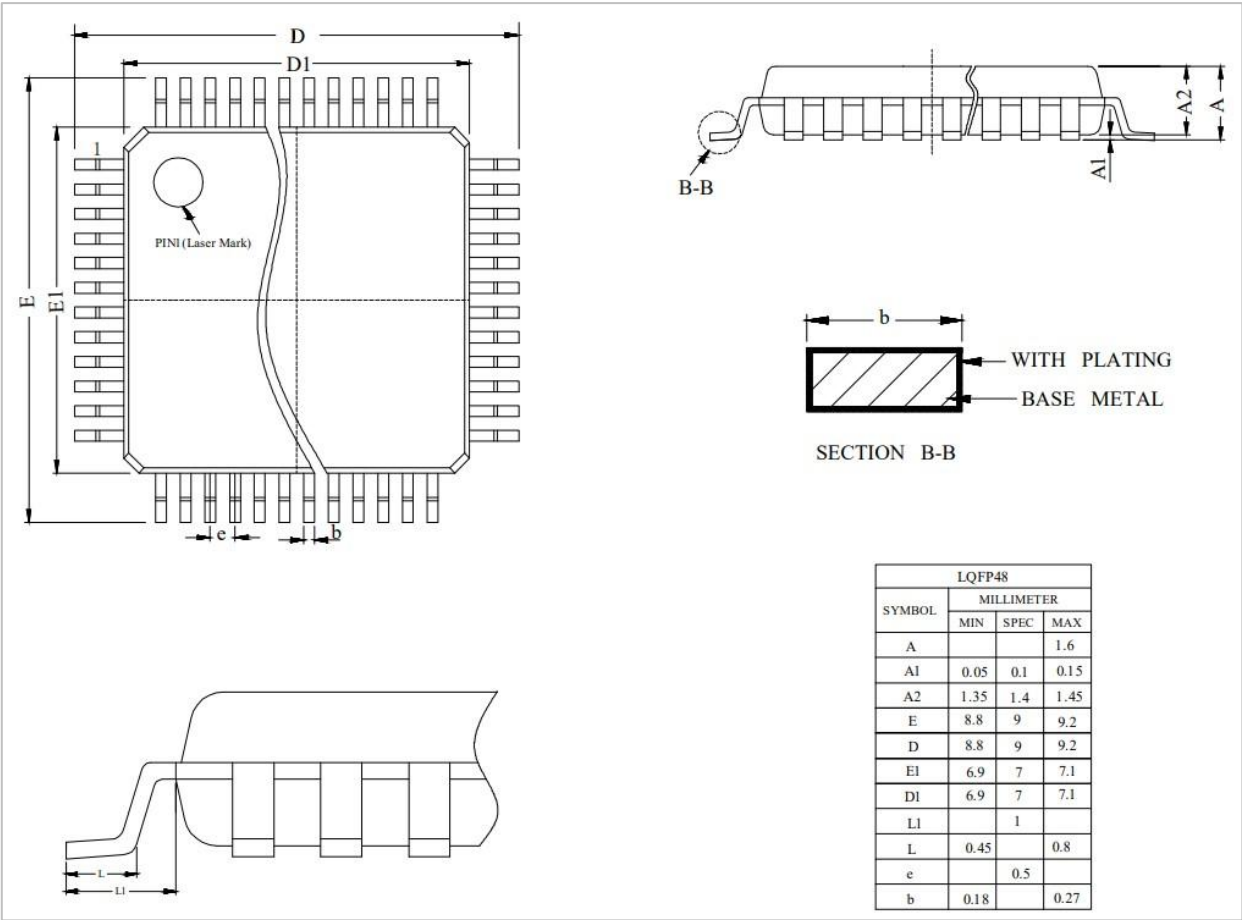
Figure 2-16 Pinout Diagram of FU6522T TSSOP28



3 Package Information

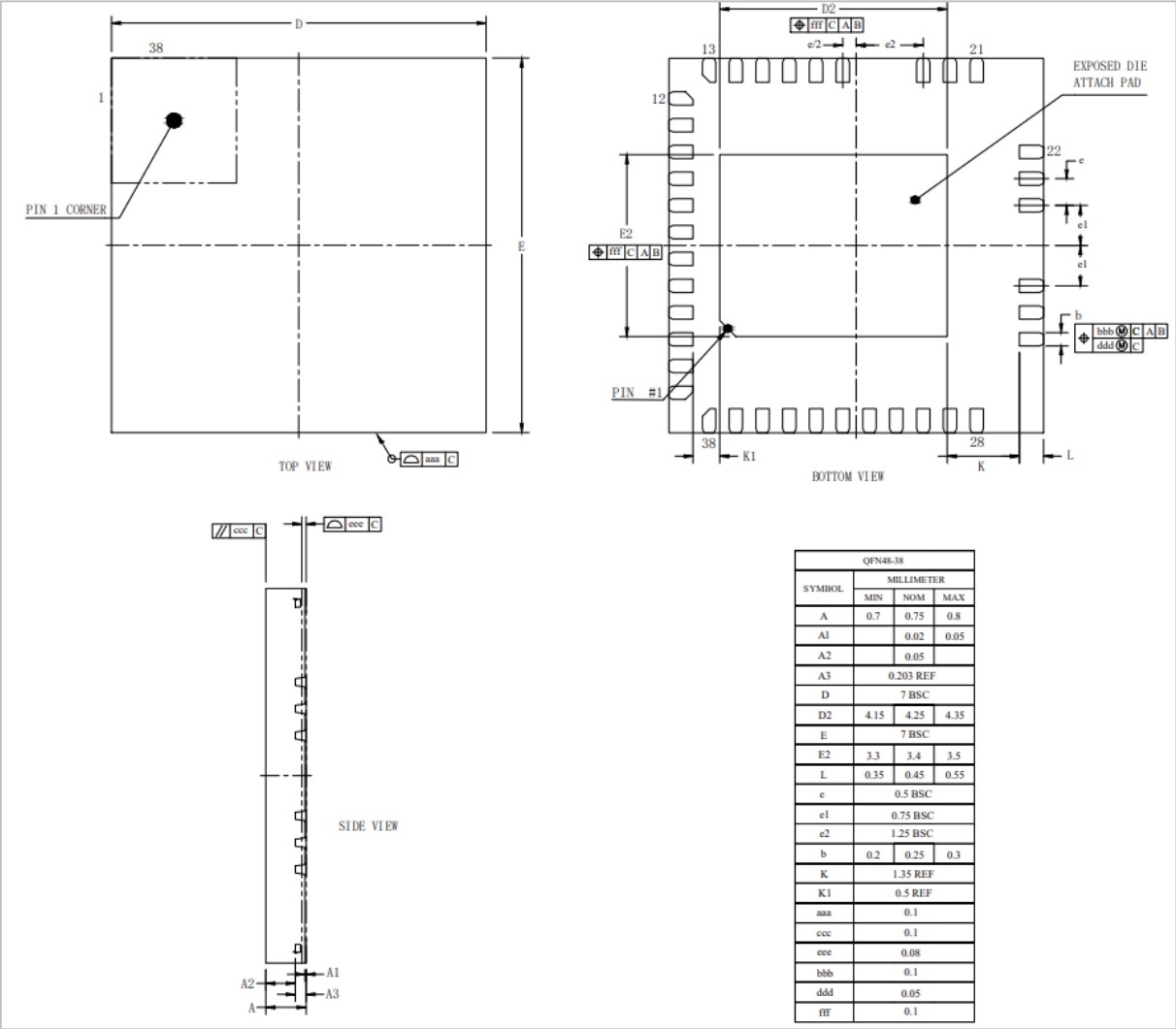
3.1 LQFP48_7X7 (for FU6572L / FU6562L / FU6562LA / FU6522L)

Figure 3-1 Package Drawings and Dimensions of LQFP48_7X7



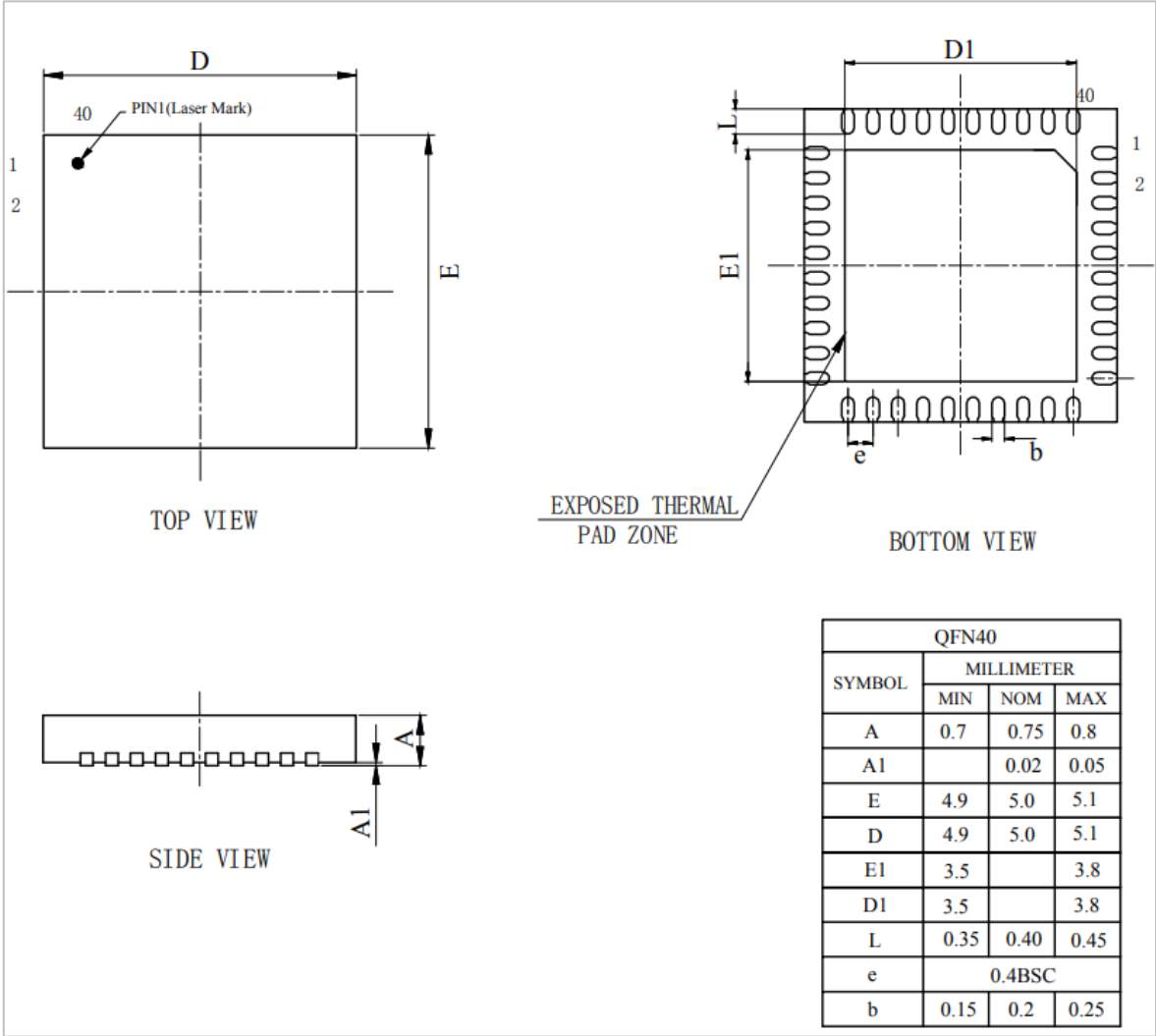
3.2 QFN48-38_7X7 (for FU6562Q)

Figure 3-2 Package Drawings of QFN48-38_7X7



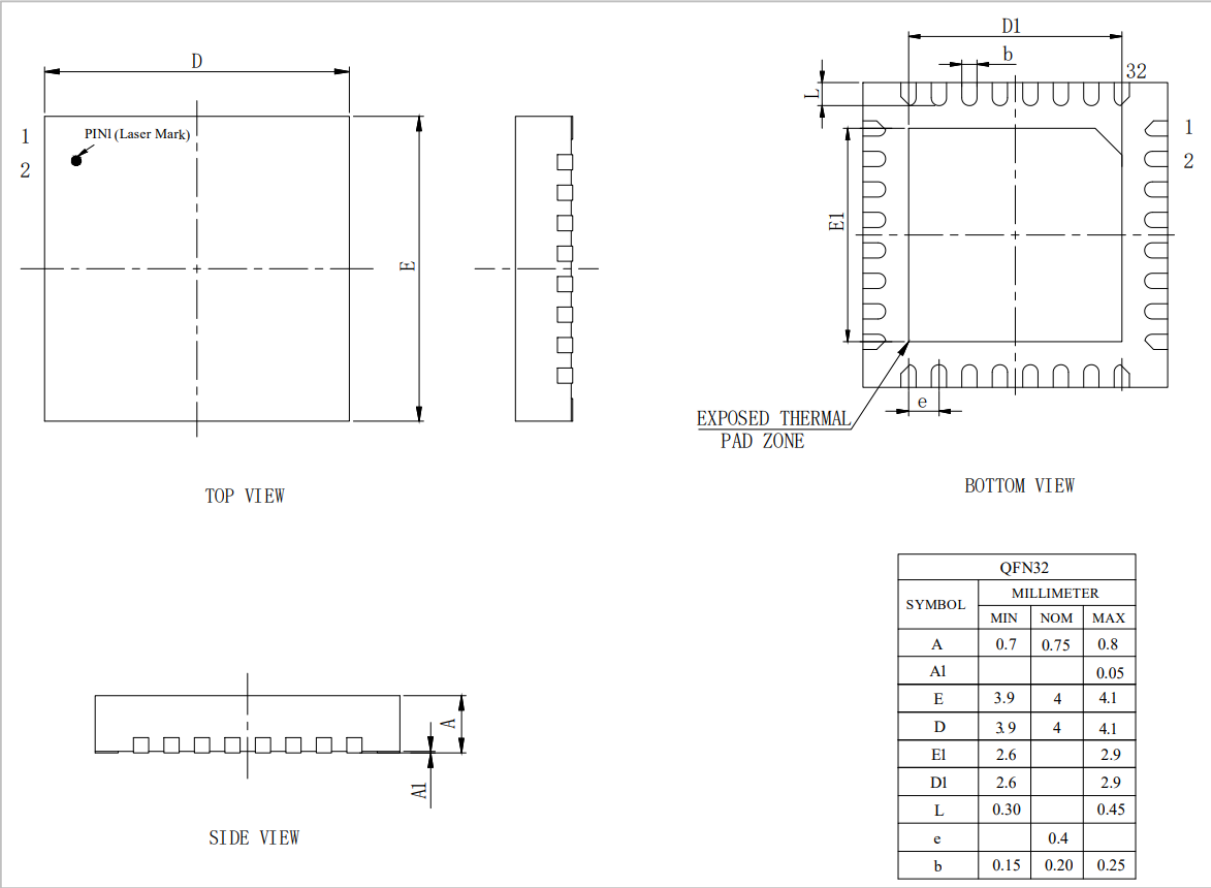
3.3 QFN40_5X5 (for FU6565N / FU6572N)

Figure 3-3 Package Drawing and Dimensions of QFN40_5X5



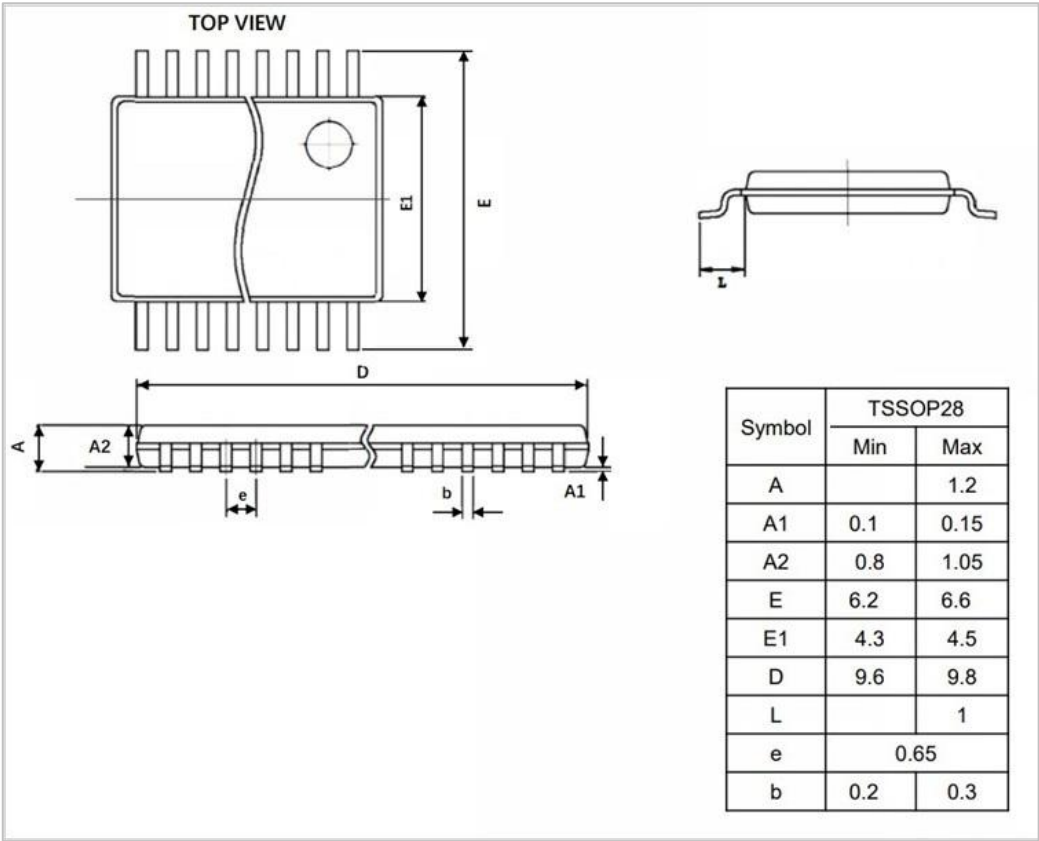
3.4 QFN32_4X4 (for FU6563N / FU6532N / FU6522N)

Figure 3-4 Package Drawings and Dimensions of QFN32_4X4



3.5 TSSOP28_9.7x4.4 (for FU6572T / FU6565T / FU6562S / FU6562T / FU6532T / FU6522T)

Figure 3-5 Package Drawings and Dimensions of TSSOP28_9.7x4.4



4 Ordering Information

Table 4-1 Model Selections

Model	Clock Rate (MHz)	Flash (kByte)	XRAM (kByte)	Clock Circuit		Driver Interface			Drive Type		I ² C	UART	SPI	DMA	GPIO	Timer	Analog Peripherals								Lead-free	Package
				Internal Fast Clock	Internal Slow Clock	6N Pre-driver	3P3N Pre-driver	PWM	Square-wave	FOC							ADC			DAC		VREF	Operational Amplifier	Comparator		
																	Number	Channel	Bits	Number	Number of Bits					
FU6572L	24	32	3.75	✓	✓	✓	-	-	✓	✓	✓	2	✓	✓	31	6	1	15	12	2	9\6	✓	4	3	✓	LQFP48 (7x7mm)
FU6572N	24	32	3.75	✓	✓	✓	-	-	✓	✓	✓	2	✓	✓	24	6	1	14	12	2	9\6	✓	4	3	✓	QFN40 (5x5mm)
FU6572T	24	32	3.75	✓	✓	✓	-	-	✓	✓	-	1	-	✓	13	6	1	10	12	2	9\6	✓	3	3	✓	TSSOP28 (9.7x4.4mm)
FU6565N	24	32	3.75	✓	✓	✓	-	-	✓	✓	✓	2	-	✓	23	6	1	14	12	2	9\6	✓	4	3	✓	QFN40 (5x5mm)
FU6565T	24	32	3.75	✓	✓	✓	-	-	✓	✓	-	1	-	✓	12	6	1	9	12	2	9\6	✓	3	3	✓	TSSOP28 (9.7x4.4mm)

Model	Clock Rate (MHz)	Flash (kByte)	XRAM (kByte)	Clock Circuit		Driver Interface			Drive Type		I ² C	UART	SPI	DMA	GPIO	Timer	Analog Peripherals								Lead-free	Package
				Internal Fast Clock	Internal Slow Clock	6N Pre-driver	3P3N Pre-driver	PWM	Square-wave	FOC							ADC			DAC		VREF	Operational Amplifier	Comparator		
																	Number	Channel	Bits	Number	Number of Bits					
FU6563N	24	32	3.75	✓	✓	✓	-	-	✓	✓	✓	1	-	✓	15	6	1	10	12	2	9\6	✓	3	3	✓	QFN32 (4x4mm)
FU6562L	24	32	3.75	✓	✓	✓	-	-	-	✓	-	2	✓	✓	22	6	1	13	12	2	9\6	✓	4	3	✓	LQFP48 (7x7mm)
FU6562LA	24	32	3.75	✓	✓	✓	-	-	-	✓	-	2	✓	✓	22	6	1	13	12	2	9\6	✓	4	3	✓	LQFP48 (7x7mm)
FU6562Q	24	32	3.75	✓	✓	✓	-	-	-	✓	-	2	✓	✓	22	6	1	13	12	2	9\6	✓	4	3	✓	QFN48-38 (7x7mm)
FU6562S	24	32	3.75	✓	✓	✓	-	-	-	✓	-	1	-	✓	9	6	1	7	12	2	9\6	✓	3	3	✓	TSSOP28 (9.7x4.4mm)
FU6562T	24	32	3.75	✓	✓	✓	-	-	-	✓	-	1	-	✓	9	6	1	7	12	2	9\6	✓	3	3	✓	TSSOP28 (9.7x4.4mm)
FU6532N	24	32	3.75	✓	✓	-	✓	-	✓	✓	✓	2	✓	✓	23	6	1	13	12	2	9\6	✓	4	3	✓	QFN32 (4x4mm)

Model	Clock Rate (MHz)	Flash (kByte)	XRAM (kByte)	Clock Circuit		Driver Interface			Drive Type		I ² C	UART	SPI	DMA	GPIO	Timer	Analog Peripherals								Lead-free	Package
				Internal Fast Clock	Internal Slow Clock	6N Pre-driver	3P3N Pre-driver	PWM	Square-wave	FOC							ADC			DAC		VREF	Operational Amplifier	Comparator		
																	Number	Channel	Bits	Number	Number of Bits					
FU6532T	24	32	3.75	✓	✓	-	✓	-	✓	✓	✓	2	-	✓	19	6	1	10	12	2	9\6	✓	4	3	✓	TSSOP28 (9.7x4.4mm)
FU6522L	24	32	3.75	✓	✓	-	-	✓	✓	✓	✓	2	✓	✓	40	6	1	16	12	2	9\6	✓	4	3	✓	LQFP48 (7x7mm)
FU6522N	24	32	3.75	✓	✓	-	-	✓	✓	✓	✓	2	✓	✓	24	6	1	11	12	2	9\6	✓	4	3	✓	QFN32 (4x4mm)
FU6522T	24	32	3.75	✓	✓	-	-	✓	✓	✓	✓	2	-	✓	20	6	1	13	12	2	9\6	✓	4	3	✓	TSSOP28 (9.7x4.4mm)

5 Electrical Characteristics

5.1 Absolute Maximum Ratings

Stress values greater than "Absolute Maximum Ratings" listed in Table 5-1 Absolute Maximum Ratings of FU6572L^[1] ~ Table 5-6 Absolute Maximum Ratings of FU6563N^[1] may cause irremediable damages to the device. These are stress ratings only, and it is NOT recommended to use your device in conditions that go beyond these stress ratings. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

5.1.1 FU6572L

Table 5-1 Absolute Maximum Ratings of FU6572L^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	22	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	110	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.2 FU6572N

Table 5-2 Absolute Maximum Ratings of FU6572N

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	22	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	110	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.3 FU6572T

Table 5-3 Absolute Maximum Ratings of FU6572T^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	22	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	110	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.4 FU6565N

Table 5-4 Absolute Maximum Ratings of FU6565N

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	26	V
VBB to VSS Voltage		-0.3	-	20	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	120	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.5 FU6565T

Table 5-5 Absolute Maximum Ratings of FU6565T^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	26	V
VBB to VSS Voltage		-0.3	-	20	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	120	V

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.6 FU6563N

Table 5-6 Absolute Maximum Ratings of FU6563N^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage	Peak Duration $t < 60s$	-0.3	-	42	V
VCC to VSS Voltage	Chip standby, shunt down pre-driver output	-0.3	-	40	V
VBB to VSS Voltage		-0.3	-	16	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	55	V
Low-side supply voltage		-0.3	-	VBB	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VBB + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.7 FU6562L

Table 5-7 Absolute Maximum Ratings of FU6562L^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	22	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	625	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.8 FU6562LA

Table 5-8 Absolute Maximum Ratings of FU6562LA^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	22	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	625	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.9 FU6562Q

Table 5-9 Absolute Maximum Ratings of FU6562Q^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	22	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	625	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.10 FU6562S

Table 5-10 Absolute Maximum Ratings of FU6562S^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	22	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	625	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LUW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.11 FU6562T

Table 5-11 Absolute Maximum Ratings of FU6562T^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage		-0.3	-	22	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
High-side Floating Voltage $V_{BU,BV,BW}$		-0.3	-	625	V
Low-side supply voltage		-0.3	-	VCC	V
Low-side Output Voltage $V_{LU,LV,LW}$		-0.3	-	VCC + 0.3	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.12 FU6532N

Table 5-12 Absolute Maximum Ratings of FU6532N^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage	Peak Duration $t < 60s$	-0.3	-	36	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.13 FU6532T

Table 5-13 Absolute Maximum Ratings of FU6532T^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VCC to VSS Voltage	Peak Duration $t < 60s$	-0.3	-	36	V
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.14 FU6522L

Table 5-14 Absolute Maximum Ratings of FU6522L^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.15 FU6522N

Table 5-15 Absolute Maximum Ratings of FU6522N

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V

5.1.16 FU6522T

Table 5-16 Absolute Maximum Ratings of FU6522T^[1]

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Junction Temperature T_J		-40	-	125	°C
Storage Temperature T_{STG}		-55	-	125	°C
VDD5 to VSS Voltage ^[2]		-0.3	-	6.5	V
RSTN/GPIO to VSS Voltage		-0.3	-	VDD5 + 0.3	V



Note

[1] All pins are referenced to VSS unless otherwise specified

[2] VDD5 must be in the range of 5V~5.5V during Flash write or erase.

5.2 Global Electrical Characteristics

5.2.1 FU6572L

Table 5-17 Global Electrical Characteristics of FU6572L

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		7	-	20	V
$V_{BU,BV,BW}$ Floating Voltage		-	-	90	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		-	-	20	V
I_{VCC} Operating Current	$V_{CC} = 15\text{V}$	-	12	-	mA
I_{VCC} Standby Current ^[3]	$V_{CC} = 15\text{V}$	-	5	-	mA
I_{VCC} Sleep-mode Current	$V_{CC} = 15\text{V}$	-	180	-	μA

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating Ambient Temperature T_A		-40	-	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	-40	-	105 ^[4]	°C

5.2.2 FU6572N

Table 5-18 Global Electrical Characteristics of FU6572N

($T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$, $V_{CC} = 7V \sim 20V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		7	-	20	V
$V_{BU,BV,BW}$ Floating Voltage		-	-	90	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		-	-	20	V
I_{VCC} Operating Current	$V_{CC} = 15V$	-	12	-	mA
I_{VCC} Standby Current ^[3]	$V_{CC} = 15V$	-	5	-	mA
I_{VCC} Sleep-mode Current	$V_{CC} = 15V$	-	180	-	μA
Operating Ambient Temperature T_A		-40	-	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	-40	-	105 ^[4]	°C

5.2.3 FU6572T

Table 5-19 Global Electrical Characteristics of FU6572T

($T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$, $V_{CC} = 7V \sim 20V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		7	-	20	V
$V_{BU,BV,BW}$ Floating Voltage		-	-	90	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		-	-	20	V
I_{VCC} Operating Current	$V_{CC} = 15V$	-	12	-	mA
I_{VCC} Standby Current ^[3]	$V_{CC} = 15V$	-	5	-	mA
I_{VCC} Sleep-mode Current	$V_{CC} = 15V$	-	180	-	μA
Operating Ambient Temperature T_A		-40	-	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	-40	-	105 ^[4]	°C

5.2.4 FU6565N

Table 5-20 Global Electrical Characteristics of FU6565N

($T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$, $V_{CC} = 5V \sim 20V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		5	-	20	V

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{BU,BV,BW}$ Floating Voltage		–	–	100	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage	$V_{CC} = 15V$	–	12	–	V
I_{VCC} Operating Current	$V_{CC} = 15V$	–	12	–	mA
I_{VCC} Standby Current ^[3]	$V_{CC} = 15V$	–	5	–	mA
I_{VCC} Sleep-mode Current	$V_{CC} = 15V$	–	240	–	μA
Operating Ambient Temperature T_A		–40	–	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	–40	–	105 ^[4]	°C

5.2.5 FU6565T

Table 5-21 Global Electrical Characteristics of FU6565T

($T_A = -40^{\circ}C \sim 85^{\circ}C$, $V_{CC} = 5V \sim 20V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{CC} Operating Voltage ^[1]		5	–	20	V
$V_{BU,BV,BW}$ Floating Voltage		–	–	100	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage	$V_{CC} = 15V$	–	12	–	V
I_{VCC} Operating Current	$V_{CC} = 15V$	–	12	–	mA
I_{VCC} Standby Current ^[3]	$V_{CC} = 15V$	–	5	–	mA
I_{VCC} Sleep-mode Current	$V_{CC} = 15V$	–	240	–	μA
Operating Ambient Temperature T_A		–40	–	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	–40	–	105 ^[4]	°C

5.2.6 FU6563N

Table 5-22 Global Electrical Characteristics of FU6563N

($T_A = -40^{\circ}C \sim 85^{\circ}C$ and $V_{CC} = 6V \sim 28V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{CC} Operating Voltage ^[1]		6	–	28	V
V_{BU}, V_{BV}, V_{BW} Floating Voltage		–	–	50	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		–	–	15	V
I_{VCC} Operating Current ^[3]		–	15	–	mA
I_{VCC} Standby Current ^[3]		–	5	–	mA
I_{VCC} Sleep-mode Current ^[3]		–	300	–	μA
Operating Ambient Temperature T_A		–40	–	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	–40	–	105 ^[4]	°C

5.2.7 FU6562L

Table 5-23 Global Electrical Characteristics of FU6562L

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 12\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		12	–	20	V
VDD5 Operating Voltage ^[2]		3	–	5.5	V
V_{BU} , V_{BV} , V_{BW} Floating Voltage		–	–	600	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		10	–	18	V
I_{VDD5} Operating Current ^[3]		–	15	–	mA
I_{VDD5} Standby Current ^[3]		–	5	–	mA
I_{VDD5} Sleep-mode Current ^[3]		–	25	100	μA
Operating Ambient Temperature T_A		–40	–	85	$^{\circ}\text{C}$
Operating Ambient Temperature T_A	$V_{CC} \leq 15\text{V} \ \& \ I_{VCC} \leq 30\text{mA}$	–40	–	105 ^[4]	$^{\circ}\text{C}$

5.2.8 FU6562LA

Table 5-24 Global Electrical Characteristics of FU6562LA

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		10	–	20	V
VDD5 Operating Voltage ^[2]		3	–	5.5	V
V_{BU} , V_{BV} , V_{BW} Floating Voltage		–	–	600	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		10	–	20	V
I_{VDD5} Operating Current ^[3]		–	15	–	mA
I_{VDD5} Standby Current ^[3]		–	5	–	mA
I_{VDD5} Sleep-mode Current ^[3]		–	25	100	μA
Operating Ambient Temperature T_A		–40	–	85	$^{\circ}\text{C}$
Operating Ambient Temperature T_A	$V_{CC} \leq 15\text{V} \ \& \ I_{VCC} \leq 30\text{mA}$	–40	–	105 ^[4]	$^{\circ}\text{C}$

5.2.9 FU6562Q

Table 5-25 Global Electrical Characteristics of FU6562Q

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		10	–	20	V
VDD5 Operating Voltage ^[2]		3	–	5.5	V
V_{BU} , V_{BV} , V_{BW} Floating Voltage		–	–	600	V

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		10	–	20	V
I_{VDD5} Operating Current ^[3]		–	15	–	mA
I_{VDD5} Standby Current ^[3]		–	5	–	mA
I_{VDD5} Sleep-mode Current ^[3]		–	25	100	μA
Operating Ambient Temperature T_A		–40	–	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	–40	–	105 ^[4]	°C

5.2.10 FU6562S

Table 5-26 Global Electrical Characteristics of FU6562S

($T_A = -40^{\circ}C \sim 85^{\circ}C$, $V_{CC} = 12V \sim 20V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		12	–	20	V
VDD5 Operating Voltage ^[2]		3	–	5.5	V
V_{BU}, V_{BV}, V_{BW} Floating Voltage		–	–	600	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		12	–	20	V
I_{VDD5} Operating Current ^[3]		–	15	–	mA
I_{VDD5} Standby Current ^[3]		–	5	–	mA
I_{VDD5} Sleep-mode Current ^[3]		–	25	100	μA
Operating Ambient Temperature T_A		–40	–	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	–40	–	105 ^[4]	°C

5.2.11 FU6562T

Table 5-27 Global Electrical Characteristics of FU6562T

($T_A = -40^{\circ}C \sim 85^{\circ}C$, $V_{CC} = 10V \sim 20V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		10	–	20	V
VDD5 Operating Voltage ^[2]		3	–	5.5	V
V_{BU}, V_{BV}, V_{BW} Floating Voltage		–	–	600	V
$V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage		10	–	20	V
I_{VDD5} Operating Current ^[3]		–	15	–	mA
I_{VDD5} Standby Current ^[3]		–	5	–	mA
I_{VDD5} Sleep-mode Current ^[3]		–	25	100	μA
Operating Ambient Temperature T_A		–40	–	85	°C
Operating Ambient Temperature T_A	$V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$	–40	–	105 ^[4]	°C

5.2.12 FU6532N

Table 5-28 Global Electrical Characteristics of FU6532N

(T_A = -40°C ~ 85°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		5	-	28	V
I _{VCC} Operating Current	VCC = 15V	-	12	-	mA
I _{VCC} Standby Current ^[3]	VCC = 15V	-	5	-	mA
I _{VCC} Sleep-mode Current	VCC = 15V	-	180	-	μA
Operating Ambient Temperature T _A		-40	-	85	°C
Operating Ambient Temperature T _A	VCC ≤ 15V & I _{VCC} ≤ 30mA	-40	-	105 ^[4]	°C

5.2.13 FU6532T

Table 5-29 Global Electrical Characteristics of FU6532T

(T_A = -40°C ~ 85°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC Operating Voltage ^[1]		5	-	28	V
I _{VCC} Operating Current	VCC = 15V	-	12	-	mA
I _{VCC} Standby Current ^[3]	VCC = 15V	-	5	-	mA
I _{VCC} Sleep-mode Current	VCC = 15V	-	180	-	μA
Operating Ambient Temperature T _A		-40	-	85	°C
Operating Ambient Temperature T _A	VCC ≤ 15V & I _{VCC} ≤ 30mA	-40	-	105 ^[4]	°C

5.2.14 FU6522L

Table 5-30 Global Electrical Characteristics of FU6522L

(T_A = -40°C ~ 85°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Operating Voltage ^[2]		3	-	5.5	V
I _{VDD5} Operating Current ^[3]		-	15	-	mA
I _{VDD5} Standby Current ^[3]		-	5	-	mA
I _{VDD5} Sleep-mode Current ^[3]		-	25	100	μA
Operating Ambient Temperature T _A		-40	-	105 ^[4]	°C

5.2.15 FU6522N

Table 5-31 Global Electrical Characteristics of FU6522N

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$ and $V_{DD5} = 5\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Operating Voltage ^[2]		3	–	5.5	V
I _{VDD5} Operating Current ^[3]		–	15	–	mA
I _{VDD5} Standby Current ^[3]		–	5	–	mA
I _{VDD5} Sleep-mode Current ^[3]		–	25	100	μA
Operating Ambient Temperature T_A		–40	–	105 ^[4]	°C

5.2.16 FU6522T

Table 5-32 Global Electrical Characteristics of FU6522T

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$ and $V_{DD5} = 5\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Operating Voltage ^[2]		3	–	5.5	V
I _{VDD5} Operating Current ^[3]		–	15	–	mA
I _{VDD5} Standby Current ^[3]		–	5	–	mA
I _{VDD5} Sleep-mode Current ^[3]		–	25	100	μA
Operating Ambient Temperature T_A		–40	–	105 ^[4]	°C



Note

[1] VCC voltage rise rate ranges from 0.5V/μs to 0.1V/s depending on samples batches.

[2] VDD5 must be in the range of 5V~5.5V during Flash write or erase.

[3] Characteristics may vary with different configurations.

[4] The chip can work at the maximum T_A only if T_J does not exceed the maximum T_J at any time

5.3 GPIO Electrical Characteristics

5.3.1 FU6572L

Table 5-33 GPIO Electrical Characteristics of FU6572L

($T_A = 25^{\circ}\text{C}$ and $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^{\circ}\text{C}$	–	15	–	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^{\circ}\text{C}$	–	13	–	ns

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ

**Note**

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5.

[2] GPIOs except P0[2:0], P1[6:3], P2[1] and P3[7:6].

[3] P0[2:0], P1[6:3], P2[1] and P3[7:6]

[4] P0[1], P1[1] and P4[7]

5.3.2 FU6572N

Table 5-34 GPIO Electrical Characteristics of FU6572N

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	-	13	-	ns
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ

**Note**

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5.

[2] GPIOs except P0[1:0], P1[6:3], P2[1] and P3[6].

[3] P0[1:0], P1[6:3], P2[1] and P3[6]

[4] P0[1], P1[1] and P4[7]

5.3.3 FU6572T

Table 5-35 GPIO Electrical Characteristics of FU6572T

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	–	15	–	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	–	13	–	ns
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 – 0.7	–	–	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	–	–	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	–	–	V
V _{IL} Low-level Input Voltage		–	–	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	–	33	–	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	–	5.6	–	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	–	30	–	kΩ



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5.

[2] GPIOs except P0[1], P1[4], P1[6] and P2[1].

[3] P0[1], P1[6], P1[4], and P2[1]

[4] P0[1], P1[1] and P4[7]

5.3.4 FU6565N

Table 5-36 GPIO Electrical Characteristics of FU6565N

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	–	15	–	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	–	13	–	ns
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 – 0.7	–	–	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	–	–	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	–	–	V
V _{IL} Low-level Input Voltage		–	–	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	–	33	–	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	–	5.6	–	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	–	30	–	kΩ



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is $0.6 \cdot VDD5$.

[2] GPIOs except P0[1:0], P1[6:3] and P2[1].

[3] P0[1:0], P1[6:3], and P2[1]

[4] P0[1], P1[1] and P4[7]

5.3.5 FU6565T

Table 5-37 GPIO Electrical Characteristics of FU6565T

($T_A = 25^\circ\text{C}$, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	-	13	-	ns
V_{OH} High-level Output Voltage	$I_{OH} = 4\text{mA}$	$VDD5 - 0.7$	-	-	V
V_{OL} Low-level Output Voltage	$I_{OL} = 4\text{mA}$	-	-	$VSS + 0.7$	V
V_{IH} High-level Input Voltage ^[1]		$0.7 \cdot VDD5$	-	-	V
V_{IL} Low-level Input Voltage		-	-	$0.2 \cdot VDD5$	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	k Ω
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	k Ω
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	k Ω



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is $0.6 \cdot VDD5$.

[2] GPIOs except P0[1], P1[6] and P2[1].

[3] P0[1], P1[6] and P2[1]

[4] P0[1] and P4[7]

5.3.6 FU6563N

Table 5-38 GPIO Electrical Characteristics of FU6563N

($T_A = 25^\circ\text{C}$ and VCC = 6V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	-	13	-	ns

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ

**Note**

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5.

[2] GPIOs except P0[1:0], P1[4], P1[6] and P2[1].

[3] P0[1:0], P1[6], P1[4], and P2[1]

[4] P0[1], P1[1] and P4[7]

5.3.7 FU6562L

Table 5-39 GPIO Electrical Characteristics f FU6562L

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	-	13	-	ns
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ

**Note**

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5

[2] GPIOs except P0[1], P1[6:3] and P2[1]

[3] P0[1], P1[6:3], and P2[1]

[4] P0[1] and P4[7]

5.3.8 FU6562LA

Table 5-40 GPIO Electrical Characteristics of FU6562LA
($T_A = 25^\circ\text{C}$ and $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	-	13	-	ns
V_{OH} High-level Output Voltage	$I_{OH} = 4\text{mA}$	$V_{DD5} - 0.7$	-	-	V
V_{OL} Low-level Output Voltage	$I_{OL} = 4\text{mA}$	-	-	$V_{SS} + 0.7$	V
V_{IH} High-level Input Voltage ^[1]		$0.7 \cdot V_{DD5}$	-	-	V
V_{IL} Low-level Input Voltage		-	-	$0.2 \cdot V_{DD5}$	V
Pull-up Resistor ^[2]	$V_{DD5} = 5\text{V}$	-	33	-	k Ω
Pull-up Resistor ^[3]	$V_{DD5} = 5\text{V}$	-	5.6	-	k Ω
Pull-down Resistor ^[4]	$V_{DD5} = 5\text{V}$	-	30	-	k Ω



Note

[1] When $V_{DD5} = 5\text{V}$, minimum value of V_{IH} is $0.6 \cdot V_{DD5}$

[2] GPIOs except P0[1], P1[6:3] and P2[1]

[3] P0[1], P1[6:3], and P2[1]

[4] P0[1] and P4[7]

5.3.9 FU6562Q

Table 5-41 GPIO Electrical Characteristics of FU6562Q
($T_A = 25^\circ\text{C}$ and $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	-	13	-	ns
V_{OH} High-level Output Voltage	$I_{OH} = 4\text{mA}$	$V_{DD5} - 0.7$	-	-	V
V_{OL} Low-level Output Voltage	$I_{OL} = 4\text{mA}$	-	-	$V_{SS} + 0.7$	V
V_{IH} High-level Input Voltage ^[1]		$0.7 \cdot V_{DD5}$	-	-	V
V_{IL} Low-level Input Voltage		-	-	$0.2 \cdot V_{DD5}$	V
Pull-up Resistor ^[2]	$V_{DD5} = 5\text{V}$	-	33	-	k Ω
Pull-up Resistor ^[3]	$V_{DD5} = 5\text{V}$	-	5.6	-	k Ω
Pull-down Resistor ^[4]	$V_{DD5} = 5\text{V}$	-	30	-	k Ω



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is $0.6 \cdot VDD5$

[2] GPIOs except P0[1], P1[6:3] and P2[1]

[3] P0[1], P1[6:3], and P2[1]

[4] P0[1] and P4[7]

5.3.10 FU6562S

Table 5-42 GPIO Electrical Characteristics of FU6562S

($T_A = 25^\circ\text{C}$ and $VCC = 12\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	–	15	–	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	–	13	–	ns
V_{OH} High-level Output Voltage	$I_{OH} = 4\text{mA}$	$VDD5 - 0.7$	–	–	V
V_{OL} Low-level Output Voltage	$I_{OL} = 4\text{mA}$	–	–	$VSS + 0.7$	V
V_{IH} High-level Input Voltage ^[1]		$0.7 \cdot VDD5$	–	–	V
V_{IL} Low-level Input Voltage		–	–	$0.2 \cdot VDD5$	V
Pull-up Resistor ^[2]	$VDD5 = 5\text{V}$	–	33	–	k Ω
Pull-up Resistor ^[3]	$VDD5 = 5\text{V}$	–	5.6	–	k Ω
Pull-down Resistor ^[4]	$VDD5 = 5\text{V}$	–	30	–	k Ω



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is $0.6 \cdot VDD5$.

[2] GPIOs except P0[1], P1[6] and P2[1].

[3] P0[1], P1[6] and P2[1]

[4] P0[1] and P4[7]

5.3.11 FU6562T

Table 5-43 GPIO Electrical Characteristics of FU6562T

($T_A = 25^\circ\text{C}$ and $VCC = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	–	15	–	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	–	13	–	ns

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5

[2] GPIOs except P0[1], P1[6] and P2[1]

[3] P0[1], P1[6] and P2[1]

[4] P0[1] and P4[7]

5.3.12 FU6532N

Table 5-44 GPIO Electrical Characteristics of FU6532N

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	-	13	-	ns
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5

[2] GPIOs except P0[1:0], P1[6:3] and P2[1]

[3] P0[1:0], P1[6:3], and P2[1]

[4] P0[1], P1[1] and P4[7]

5.3.13 FU6532T

Table 5-45 GPIO Electrical Characteristics of FU6532T

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	-	13	-	ns
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5

[2] GPIOs except P0[1], P1[4], P1[6] and P2[1]

[3] P0[1], P1[6], P1[4], and P2[1]

[4] P0[1], P1[1] and P4[7]

5.3.14 FU6522L

Table 5-46 GPIO Electrical Characteristics of FU6522L

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	-	15	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	-	13	-	ns
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is $0.6 \cdot VDD5$

[2] GPIOs except P0[2:0], P1[6:3], P2[1] and P3[7:6]

[3] P0[2:0], P1[6:3], P2[1] and P3[7:6]

[4] P0[1], P1[1] and P4[7]

5.3.15 FU6522N

Table 5-47 GPIO Electrical Characteristics of FU6522N

($T_A = 25^\circ\text{C}$ and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	–	15	–	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	–	13	–	ns
V_{OH} High-level Output Voltage	$I_{OH} = 4\text{mA}$	$VDD5 - 0.7$	–	–	V
V_{OL} Low-level Output Voltage	$I_{OL} = 4\text{mA}$	–	–	$VSS + 0.7$	V
V_{IH} High-level Input Voltage ^[1]		$0.7 \cdot VDD5$	–	–	V
V_{IL} Low-level Input Voltage		–	–	$0.2 \cdot VDD5$	V
Pull-up Resistor ^[2]	VDD5 = 5V	–	33	–	k Ω
Pull-up Resistor ^[3]	VDD5 = 5V	–	5.6	–	k Ω
Pull-down Resistor ^[4]	VDD5 = 5V	–	30	–	k Ω



Note

[1] When VDD5 = 5V, minimum value of V_{IH} is $0.6 \cdot VDD5$

[2] GPIOs except P0[1:0], P1[6:3] and P2[1]

[3] P0[1:0], P1[6:3], and P2[1]

[4] P0[1], P1[1] and P4[7]

5.3.16 FU6522T

Table 5-48 GPIO Electrical Characteristics of FU6522T

($T_A = 25^\circ\text{C}$ and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	–	15	–	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	–	13	–	ns

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V _{OH} High-level Output Voltage	I _{OH} = 4mA	VDD5 - 0.7	-	-	V
V _{OL} Low-level Output Voltage	I _{OL} = 4mA	-	-	VSS + 0.7	V
V _{IH} High-level Input Voltage ^[1]		0.7*VDD5	-	-	V
V _{IL} Low-level Input Voltage		-	-	0.2*VDD5	V
Pull-up Resistor ^[2]	VDD5 = 5V	-	33	-	kΩ
Pull-up Resistor ^[3]	VDD5 = 5V	-	5.6	-	kΩ
Pull-down Resistor ^[4]	VDD5 = 5V	-	30	-	kΩ

**Note**

[1] When VDD5 = 5V, minimum value of V_{IH} is 0.6*VDD5

[2] GPIOs except P0[1:0], P1[6:4] and P2[1]

[3] P0[1:0], P1[6:4] and P2[1]

[4] P0[1], P1[1] and P4[7]

5.4 6N Pre-driver Output IO Electrical Characteristics (for FU6572L / FU6572N / FU6572T / FU6565N / FU6565T / FU6563N / FU6562L / FU6562LA / FU6562Q / FU6562S / FU6562T)

5.4.1 FU6572L

Table 5-49 6N Pre-driver IO Electrical Characteristics of FU6572L

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	VCC = 15V	-	0.8	-	A
Low-level Peak Output Current	VCC = 15V	-	0.8	-	A
VDD5 Output Voltage	VCC = 15V and internal LDO supplies voltage	-	5	-	V
VCC UVLO Lockout Voltage		4.3	4.8	5.3	V
VCC UVLO Release Voltage		4.0	4.5	5.0	V
VCC UVLO Hysteresis Voltage		0.2	0.3	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	30	70	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	30	70	ns
Deadtime		-	100	-	ns

5.4.2 FU6572N

Table 5-50 6N Pre-driver IO Electrical Characteristics of FU6572N

($T_A = 25^\circ\text{C}$ and $V_{CC} = 15\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	$V_{CC} = 15\text{V}$	–	0.8	–	A
Low-level Peak Output Current	$V_{CC} = 15\text{V}$	–	0.8	–	A
VDD5 Output Voltage	$V_{CC} = 15\text{V}$ and internal LDO supplies voltage	–	5	–	V
VCC UVLO Lockout Voltage		4.3	4.8	5.3	V
VCC UVLO Release Voltage		4.0	4.5	5.0	V
VCC UVLO Hysteresis Voltage		0.2	0.3	–	V
Turn-on Rise Time	1nF load, from 10% to 90%	–	30	70	ns
Turn-off Fall Time	1nF load, from 90% to 10%	–	30	70	ns
Deadtime		–	100	–	ns

5.4.3 FU6572T

Table 5-51 6N Pre-driver IO Electrical Characteristics of FU6572T

($T_A = 25^\circ\text{C}$ and $V_{CC} = 15\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	$V_{CC} = 15\text{V}$	–	0.8	–	A
Low-level Peak Output Current	$V_{CC} = 15\text{V}$	–	0.8	–	A
VDD5 Output Voltage	$V_{CC} = 15\text{V}$ and internal LDO supplies voltage	–	5	–	V
VCC UVLO Lockout Voltage		4.3	4.8	5.3	V
VCC UVLO Release Voltage		4.0	4.5	5.0	V
VCC UVLO Hysteresis Voltage		0.2	0.3	–	V
Turn-on Rise Time	1nF load, from 10% to 90%	–	30	70	ns
Turn-off Fall Time	1nF load, from 90% to 10%	–	30	70	ns
Deadtime		–	100	–	ns

5.4.4 FU6565N

Table 5-52 6N Pre-driver IO Electrical Characteristics of FU6565N

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	VCC = 15V	-	0.6	-	A
Low-level Peak Output Current	VCC = 15V	-	0.6	-	A
VDD5 Output Voltage	VCC = 15V and internal LDO supplies voltage	-	5	-	V
VCC UVLO Lockout Voltage		-	4.7	-	V
VCC UVLO Release Voltage		-	4.4	-	V
VCC UVLO Hysteresis Voltage		-	0.3	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	50	-	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	30	-	ns
Deadtime		-	100	-	ns

5.4.5 FU6565T

Table 5-53 6N Pre-driver IO Electrical Characteristics of FU6565T

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	VCC = 15V	-	0.6	-	A
Low-level Peak Output Current	VCC = 15V	-	0.6	-	A
VDD5 Output Voltage	VCC = 15V and internal LDO supplies voltage	-	5	-	V
VCC UVLO Lockout Voltage		-	4.7	-	V
VCC UVLO Release Voltage		-	4.4	-	V
VCC UVLO Hysteresis Voltage		-	0.3	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	50	-	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	30	-	ns
Deadtime		-	100	-	ns

5.4.6 FU6563N

Table 5-54 6N Pre-driver IO Electrical Characteristics of FU6563N

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	VCC = 15V	-	0.2	-	A
Low-level Peak Output Current	VCC = 15V	-	0.2	-	A
VBB Output Voltage	I _{VBB} = 20mA	-	12	-	V
VDD5 Output Voltage	VCC = 15V and internal LDO supplies voltage	-	5	-	V
VCC UVLO Lockout Voltage		-	4.8	-	V
VCC UVLO Release Voltage		-	4.5	-	V
VCC UVLO Hysteresis Voltage		0.2	0.3	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	70	100	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	55	80	ns
Deadtime		-	120	-	ns

5.4.7 FU6562L

Table 5-55 6N Pre-driver IO Electrical Characteristics of FU6562L

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current		-	0.21	-	A
Low-level Peak Output Current		-	0.36	-	A
VCC UVLO Lockout Voltage		8.1	9	9.9	V
VCC UVLO Release Voltage		7.5	8.4	9.3	V
VCC UVLO Hysteresis Voltage		0.4	0.6	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	90	-	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	50	-	ns
Deadtime		-	500	-	ns

5.4.8 FU6562LA

Table 5-56 6N Pre-driver IO Electrical Characteristics of FU6562LA

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	VCC = 10V ~ 20V	0.07	0.11	-	A
Low-level Peak Output Current	VCC = 10V ~ 20V	0.11	0.18	-	A
VCC UVLO Lockout Voltage		8.3	9.0	9.8	V
VCC UVLO Release Voltage		7.5	8.1	8.8	V
VCC UVLO Hysteresis Voltage		0.8	0.9	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	200	350	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	100	180	ns
Deadtime		-	220	400	ns

5.4.9 FU6562Q

Table 5-57 6N Pre-driver IO Electrical Characteristics of FU6562Q

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	VCC = 10V ~ 20V	0.07	0.11	-	A
Low-level Peak Output Current	VCC = 10V ~ 20V	0.11	0.18	-	A
VCC UVLO Lockout Voltage		8.3	9.0	9.8	V
VCC UVLO Release Voltage		7.5	8.1	8.8	V
VCC UVLO Hysteresis Voltage		0.8	0.9	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	200	350	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	100	180	ns
Deadtime		-	220	400	ns

5.4.10 FU6562S

Table 5-58 6N Pre-driver IO Electrical Characteristics of FU6562S

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current		-	0.21	-	A
Low-level Peak Output Current		-	0.36	-	A

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VCC UVLO Lockout Voltage		8.1	9	9.9	V
VCC UVLO Release Voltage		7.5	8.4	9.3	V
VCC UVLO Hysteresis Voltage		0.4	0.6	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	110	-	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	45	-	ns
Deadtime		-	300	-	ns

5.4.11 FU6562T

Table 5-59 6N Pre-driver IO Electrical Characteristics of FU6562T

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-level Peak Output Current	VCC = 10V ~ 20V	0.07	0.11	-	A
Low-level Peak Output Current	VCC = 10V ~ 20V	0.11	0.18	-	A
VCC UVLO Lockout Voltage		8.3	9.0	9.8	V
VCC UVLO Release Voltage		7.5	8.1	8.8	V
VCC UVLO Hysteresis Voltage		0.8	0.9	-	V
Turn-on Rise Time	1nF load, from 10% to 90%	-	200	350	ns
Turn-off Fall Time	1nF load, from 90% to 10%	-	100	180	ns
Deadtime		-	220	400	ns

5.5 3P3N Pre-driver IO Electrical Characteristics (for FU6532N / FU6532T)

5.5.1 FU6532N

Table 5-60 3P3N Pre-driver IO Electrical Characteristics of FU6532N

(T_A = 25°C and VCC = 15V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-side Output Source Current		-	150	-	mA
High-side Output Sink Current		-	90	-	mA
Low-side Output Source Current		-	150	-	mA
Low-side Output Sink Current		-	180	-	mA
Rise Time of High-side Output	1nF load, from 10% to 90%	-	25	-	ns
Fall Time of High-side Output	1nF load, from 90% to 10%	-	90	-	ns

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Rise Time of Low-side Output	1nF load, from 10% to 90%	-	115	-	ns
Fall Time of Low-side Output	1nF load, from 90% to 10%	-	60	-	ns

5.5.2 FU6532T

Table 5-61 3P3N Pre-driver IO Electrical Characteristics of FU6532T

($T_A = 25^\circ\text{C}$ and $V_{CC} = 15\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
High-side Output Source Current		-	150	-	mA
High-side Output Sink Current		-	90	-	mA
Low-side Output Source Current		-	150	-	mA
Low-side Output Sink Current		-	180	-	mA
Rise Time of High-side Output	1nF load, from 10% to 90%	-	25	-	ns
Fall Time of High-side Output	1nF load, from 90% to 10%	-	90	-	ns
Rise Time of Low-side Output	1nF load, from 10% to 90%	-	115	-	ns
Fall Time of Low-side Output	1nF load, from 90% to 10%	-	60	-	ns

5.6 PWM IO Electrical Characteristics (for FU6522L / FU6522N / FU6522T)

5.6.1 FU6522L

Table 5-62 PWM IO Electrical Characteristics of FU6522L

($T_A = 25^\circ\text{C}$ and $V_{DD5} = 5\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Output Source Current	$P1\_AN[HDIO] = 1$, $T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$	30	50	-	mA
Output Sink Current	$P1\_AN[HDIO] = 1$, $T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$	60	100	-	mA
Turn-on Rise Time	50pF load, from 10% to 90%, $T_A = 25^\circ\text{C}$	-	18	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, $T_A = 25^\circ\text{C}$	-	12	-	ns

5.6.2 FU6522N

Table 5-63 PWM IO Electrical Characteristics of FU6522N

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Output Source Current	P1_AN[HDIO] = 1, T _A = -40°C ~ 85°C	30	50	-	mA
Output Sink Current	P1_AN[HDIO] = 1, T _A = -40°C ~ 85°C	60	100	-	mA
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	-	18	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	-	12	-	ns

5.6.3 FU6522T

Table 5-64 PWM IO Electrical Characteristics of FU6522T

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Output Source Current	P1_AN[HDIO] = 1, T _A = -40°C ~ 85°C	30	50	-	mA
Output Sink Current	P1_AN[HDIO] = 1, T _A = -40°C ~ 85°C	60	100	-	mA
Turn-on Rise Time	50pF load, from 10% to 90%, T _A = 25°C	-	18	-	ns
Turn-off Fall Time	50pF load, from 90% to 10%, T _A = 25°C	-	12	-	ns

5.7 ADC Electrical Characteristics

5.7.1 FU6572L

Table 5-65 ADC Electrical Characteristics of FU6572L

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	-	2	-	LSB
DNL (Differential Nonlinearity)	12-bit	-	1.5	-	LSB
OFFSET (Offset Error)	12-bit	-	6	-	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	-	70.8	-	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	-	10.5	-	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	-	68.2	-	dB

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
THD (Total Harmonic Distortion)	$f_{IN} = 350\text{kHz}$	–	67	–	dB
R_{IN} Input Resistance		–	800	–	Ω
C_{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.2 FU6572N

Table 5-66 ADC Electrical Characteristics of FU6572N

($T_A = 25^\circ\text{C}$ and $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	$f_{IN} = 350\text{kHz}$	–	70.8	–	dB
ENOB (Effective Number of Bits)	$f_{IN} = 350\text{kHz}$	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	$f_{IN} = 350\text{kHz}$	–	68.2	–	dB
THD (Total Harmonic Distortion)	$f_{IN} = 350\text{kHz}$	–	67	–	dB
R_{IN} Input Resistance		–	800	–	Ω
C_{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.3 FU6572T

Table 5-67 ADC Electrical Characteristics of FU6572T

($T_A = 25^\circ\text{C}$ and $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	$f_{IN} = 350\text{kHz}$	–	70.8	–	dB
ENOB (Effective Number of Bits)	$f_{IN} = 350\text{kHz}$	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	$f_{IN} = 350\text{kHz}$	–	68.2	–	dB
THD (Total Harmonic Distortion)	$f_{IN} = 350\text{kHz}$	–	67	–	dB
R_{IN} Input Resistance		–	800	–	Ω
C_{IN} Input Capacitance		–	30	–	pF

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.4 FU6565N

Table 5-68 ADC Electrical Characteristics of FU6565N

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.5 FU6565T

Table 5-69 ADC Electrical Characteristics of FU6565T

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.6 FU6563N

Table 5-70 ADC Electrical Characteristics of FU6563N

(T_A = 25°C and VCC = 6V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.7 FU6562L

Table 5-71 ADC Electrical Characteristics of FU6562L

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.8 FU6562LA

Table 5-72 ADC Electrical Characteristics of FU6562LA

($T_A = 25^\circ\text{C}$ and $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	$f_{IN} = 350\text{kHz}$	–	70.8	–	dB
ENOB (Effective Number of Bits)	$f_{IN} = 350\text{kHz}$	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	$f_{IN} = 350\text{kHz}$	–	68.2	–	dB
THD (Total Harmonic Distortion)	$f_{IN} = 350\text{kHz}$	–	67	–	dB
R_{IN} Input Resistance		–	800	–	Ω
C_{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.9 FU6562Q

Table 5-73 ADC Electrical Characteristics of FU6562Q

($T_A = 25^\circ\text{C}$ and $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	$f_{IN} = 350\text{kHz}$	–	70.8	–	dB
ENOB (Effective Number of Bits)	$f_{IN} = 350\text{kHz}$	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	$f_{IN} = 350\text{kHz}$	–	68.2	–	dB
THD (Total Harmonic Distortion)	$f_{IN} = 350\text{kHz}$	–	67	–	dB
R_{IN} Input Resistance		–	800	–	Ω
C_{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.10 FU6562S

Table 5-74 ADC Electrical Characteristics of FU6562S

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.11 FU6562T

Table 5-75 ADC Electrical Characteristics of FU6562T

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.12 FU6532N

Table 5-76 ADC Electrical Characteristics of FU6532N

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.13 FU6532T

Table 5-77 ADC Electrical Characteristics of FU6532T

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.14 FU6522L

Table 5-78 ADC Electrical Characteristics of FU6522L

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.15 FU6522N

Table 5-79 ADC Electrical Characteristics of FU6522N

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]

5.7.16 FU6522T

Table 5-80 ADC Electrical Characteristics of FU6522T

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
INL (Integral Nonlinearity)	12-bit	–	2	–	LSB
DNL (Differential Nonlinearity)	12-bit	–	1.5	–	LSB
OFFSET (Offset Error)	12-bit	–	6	–	LSB
SNR (Signal-to-noise Ratio)	f _{IN} = 350kHz	–	70.8	–	dB
ENOB (Effective Number of Bits)	f _{IN} = 350kHz	–	10.5	–	Bit
SFDR (Spurious-free Dynamic Range)	f _{IN} = 350kHz	–	68.2	–	dB
THD (Total Harmonic Distortion)	f _{IN} = 350kHz	–	67	–	dB
R _{IN} Input Resistance		–	800	–	Ω
C _{IN} Input Capacitance		–	30	–	pF
Conversion Time		–	13	–	ADCLK ^[1]
Sampling Time		3	–	63	ADCLK2 ^[2]



Note

[1] ADCLK = 24MHz

[2] ADCLK2 = 12MHz

5.8 VREF and VHALF Electrical Characteristics

5.8.1 FU6572L

Table 5-81 VREF and VHALF Electrical Characteristics of FU6572L

(T_A = -40°C ~ 85°C, VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	25*VREF/64 – 0.2	25*VREF/64	25*VREF/64 + 0.2	V
	VREF_VHALF_CR[VHALFSEL] = 11	VREF/2 – 0.2	VREF/2	VREF/2 + 0.2	V

5.8.2 FU6572N

Table 5-82 VREF and VHALF Electrical Characteristics of FU6572N

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot V_{REF}/64 - 0.2$	$25 \cdot V_{REF}/64$	$25 \cdot V_{REF}/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$V_{REF}/2 - 0.2$	$V_{REF}/2$	$V_{REF}/2 + 0.2$	V

5.8.3 FU6572T

Table 5-83 VREF and VHALF Electrical Characteristics of FU6572T

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot V_{REF}/64 - 0.2$	$25 \cdot V_{REF}/64$	$25 \cdot V_{REF}/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$V_{REF}/2 - 0.2$	$V_{REF}/2$	$V_{REF}/2 + 0.2$	V

5.8.4 FU6565N

Table 5-84 VREF and VHALF Electrical Characteristics of FU6565N

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 5\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.5 FU6565T

Table 5-85 VREF and VHALF Electrical Characteristics of FU6565T

($T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$, $VCC = 5V \sim 20V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	$VREF/8$	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	$VREF/4$	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.6 FU6563N

Table 5-86 VREF and VHALF Electrical Characteristics of FU6563N

($T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$ and $VCC = 6V \sim 28V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	$VREF/8$	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	$VREF/4$	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.7 FU6562L

Table 5-87 VREF and VHALF Electrical Characteristics of FU6562L

($T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$, $VCC = 12V \sim 20V$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.8 FU6562LA

Table 5-88 VREF and VHALF Electrical Characteristics of FU6562LA

(T_A = -40°C ~ 85°C, VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.9 FU6562Q

Table 5-89 VREF and VHALF Electrical Characteristics of FU6562Q

(T_A = -40°C ~ 85°C, VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.10 FU6562S

Table 5-90 VREF and VHALF Electrical Characteristics of FU6562S

(T_A = -40°C ~ 85°C, VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	25*VREF/64 - 0.2	25*VREF/64	25*VREF/64 + 0.2	V
	VREF_VHALF_CR[VHALFSEL] = 11	VREF/2 - 0.2	VREF/2	VREF/2 + 0.2	V

5.8.11 FU6562T

Table 5-91 VREF and VHALF Electrical Characteristics of FU6562T

(T_A = -40°C ~ 85°C, VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	25*VREF/64 - 0.2	25*VREF/64	25*VREF/64 + 0.2	V
	VREF_VHALF_CR[VHALFSEL] = 11	VREF/2 - 0.2	VREF/2	VREF/2 + 0.2	V

5.8.12 FU6532N

Table 5-92 VREF and VHALF Electrical Characteristics of FU6532N

(T_A = -40°C ~ 85°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.13 FU6532T

Table 5-93 VREF and VHALF Electrical Characteristics of FU6532T

(T_A = -40°C ~ 85°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.14 FU6522L

Table 5-94 VREF and VHALF Electrical Characteristics of FU6522L

(T_A = -40°C ~ 85°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 00	4.3	4.5	4.7	V
	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
	VREF_VHALF_CR[VRVSEL] = 10	2.8	3	3.2	V
	VREF_VHALF_CR[VRVSEL] = 11	3.8	4	4.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 00	0.46	VREF/8	0.66	V
	VREF_VHALF_CR[VHALFSEL] = 01	1	VREF/4	1.25	V
	VREF_VHALF_CR[VHALFSEL] = 10	$25 \cdot VREF/64 - 0.2$	$25 \cdot VREF/64$	$25 \cdot VREF/64 + 0.2$	V
	VREF_VHALF_CR[VHALFSEL] = 11	$VREF/2 - 0.2$	$VREF/2$	$VREF/2 + 0.2$	V

5.8.15 FU6522N

Table 5-95 VREF and VHALF Electrical Characteristics of FU6522N

(T_A = -40°C ~ 85°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 11	VREF/2 - 0.2	VREF/2	VREF/2 + 0.2	V

5.8.16 FU6522T

Table 5-96 VREF and VHALF Electrical Characteristics of FU6522T

(T_A = -40°C ~ 85°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VREF	VREF_VHALF_CR[VRVSEL] = 01	4.8	5	5.2	V
VHALF	VREF_VHALF_CR[VHALFSEL] = 11	VREF/2 - 0.2	VREF/2	VREF/2 + 0.2	V

5.9 Operational Amplifier Electrical Characteristics

5.9.1 FU6572L

Table 5-97 Operational Amplifier Electrical Characteristics of FU6572L

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB
Unity-gain Bandwidth (UGBW)	C _L = 40pF	6	10	-	MHz
Slew Rate (SR)	C _L = 40pF	10	15	-	V/μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	-
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	-
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	-
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	-

5.9.2 FU6572N

Table 5-98 Operational Amplifier Electrical Characteristics of FU6572N

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB
Unity-gain Bandwidth (UGBW)	C _L = 40pF	6	10	-	MHz
Slew Rate (SR)	C _L = 40pF	10	15	-	V/μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	-
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	-
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	-
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	-

5.9.3 FU6572T

Table 5-99 Operational Amplifier Electrical Characteristics of FU6572T

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB
Unity-gain Bandwidth (UGBW)	C _L = 40pF	6	10	-	MHz
Slew Rate (SR)	C _L = 40pF	10	15	-	V/μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	-
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	-
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	-
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	-

5.9.4 FU6565N

Table 5-100 Operational Amplifier Electrical Characteristics of FU6565N

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–

5.9.5 FU6565T

Table 5-101 Operational Amplifier Electrical Characteristics of FU6565T

($T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	–	$V_{DD5} - 1.5$	V
VOS Operational Amplifier Offset Voltage	$T_A = 25^\circ\text{C}$	–	5	10	mV
AOL Open-loop Gain	$R_L = 100\text{k}\Omega$	–	80	–	dB
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–

5.9.6 FU6563N

Table 5-102 Operational Amplifier Electrical Characteristics of FU6563N

($T_A = 25^\circ\text{C}$ and $V_{CC} = 6\text{V} \sim 28\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	–	$V_{DD5} - 1.5$	V
VOS Operational Amplifier Offset Voltage	$T_A = 25^\circ\text{C}$	–	5	10	mV
AOL Open-loop Gain	$R_L = 100\text{k}\Omega$	–	80	–	dB
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–

5.9.7 FU6562L

Table 5-103 Operational Amplifier Electrical Characteristics of FU6562L

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB
Unity-gain Bandwidth (UGBW)	C _L = 40pF	6	10	-	MHz
Slew Rate (SR)	C _L = 40pF	10	15	-	V/μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	-
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	-
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	-
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	-

5.9.8 FU6562LA

Table 5-104 Operational Amplifier Electrical Characteristics of FU6562LA

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB
Unity-gain Bandwidth (UGBW)	C _L = 40pF	6	10	-	MHz
Slew Rate (SR)	C _L = 40pF	10	15	-	V/μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	-
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	-
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	-
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	-

5.9.9 FU6562Q

Table 5-105 Operational Amplifier Electrical Characteristics of FU6562Q

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–

5.9.10 FU6562S

Table 5–106 Operational Amplifier Electrical Characteristics of FU6562S

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	–	VDD5 – 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	–	5	10	mV
AOL Open-loop Gain	R _L = 100k Ω	–	80	–	dB
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–

5.9.11 FU6562T

Table 5–107 Operational Amplifier Electrical Characteristics of FU6562T

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	–	VDD5 – 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	–	5	10	mV
AOL Open-loop Gain	R _L = 100k Ω	–	80	–	dB
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–

5.9.12 FU6532N

Table 5-108 Operational Amplifier Electrical Characteristics of FU6532N

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB
Unity-gain Bandwidth (UGBW)	C _L = 40pF	6	10	-	MHz
Slew Rate (SR)	C _L = 40pF	10	15	-	V/μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	-
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	-
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	-
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	-

5.9.13 FU6532T

Table 5-109 Operational Amplifier Electrical Characteristics of FU6532T

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB
Unity-gain Bandwidth (UGBW)	C _L = 40pF	6	10	-	MHz
Slew Rate (SR)	C _L = 40pF	10	15	-	V/μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	-
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	-
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	-
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	-

5.9.14 FU6522L

Table 5-110 Operational Amplifier Electrical Characteristics of FU6522L

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	-	VDD5 - 1.5	V
VOS Operational Amplifier Offset Voltage	T _A = 25°C	-	5	10	mV
AOL Open-loop Gain	R _L = 100kΩ	-	80	-	dB

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–

5.9.15 FU6522N

Table 5-111 Operational Amplifier Electrical Characteristics of FU6522N

($T_A = 25^\circ\text{C}$ and $V_{DD5} = 5\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	–	$V_{DD5} - 1.5$	V
VOS Operational Amplifier Offset Voltage	$T_A = 25^\circ\text{C}$	–	5	10	mV
AOL Open-loop Gain	$R_L = 100\text{k}\Omega$	–	80	–	dB
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–

5.9.16 FU6522T

Table 5-112 Operational Amplifier Electrical Characteristics of FU6522T

($T_A = 25^\circ\text{C}$ and $V_{DD5} = 5\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VICMR Common-mode Input Voltage Range		0	–	$V_{DD5} - 1.5$	V
VOS Operational Amplifier Offset Voltage	$T_A = 25^\circ\text{C}$	–	5	10	mV
AOL Open-loop Gain	$R_L = 100\text{k}\Omega$	–	80	–	dB
Unity-gain Bandwidth (UGBW)	$C_L = 40\text{pF}$	6	10	–	MHz
Slew Rate (SR)	$C_L = 40\text{pF}$	10	15	–	V/ μs
Operational Amplifier Gain ^{[1][2]}	AMP_CR1[AMP0_GAIN] = 001	1.88	2	2.12	–
	AMP_CR1[AMP0_GAIN] = 010	3.76	4	4.24	–
	AMP_CR1[AMP0_GAIN] = 011	7.5	8	8.5	–
	AMP_CR1[AMP0_GAIN] = 100	15	16	17	–



Note

[1] The operational amplifier gain is measured when both positive and negative inputs of the operational amplifier are connected in series with 1kΩ resistors. The operational amplifier gain varies with external resistors

[2] AMP0 is used as an example. For other operational amplifiers, see AMP_CR1 (0x4034) for the configurations. AMP_CR1 (0x4034)

5.10 BEMF Electrical Characteristics

5.10.1 FU6572L

Table 5-113 BEMF Electrical Characteristics of FU6572L

($T_A = 25^\circ\text{C}$ and $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	$T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.2 FU6572N

Table 5-114 BEMF Electrical Characteristics of FU6572N

($T_A = 25^\circ\text{C}$ and $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	$T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.3 FU6572T

Table 5-115 BEMF Electrical Characteristics of FU6572T

($T_A = 25^\circ\text{C}$ and $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	$T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.4 FU6565N

Table 5-116 BEMF Electrical Characteristics of FU6565N

($T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	$T_A = -40^\circ\text{C} \sim 85^\circ\text{C}$	5.4	6.8	8.2	kΩ

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Relative Accuracy between BEMF Built-in Resistors		–	1	–	%

5.10.5 FU6565T

Table 5-117 BEMF Electrical Characteristics of FU6565T

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		–	1	–	%

5.10.6 FU6563N

Table 5-118 BEMF Electrical Characteristics of FU6563N

(T_A = 25°C and VCC = 6V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		–	1	–	%

5.10.7 FU6562L

Table 5-119 BEMF Electrical Characteristics of FU6562L

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		–	1	–	%

5.10.8 FU6562LA

Table 5-120 BEMF Electrical Characteristics of FU6562LA

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		–	1	–	%

5.10.9 FU6562Q

Table 5-121 BEMF Electrical Characteristics of FU6562Q

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.10 FU6562S

Table 5-122 BEMF Electrical Characteristics of FU6562S

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.11 FU6562T

Table 5-123 BEMF Electrical Characteristics of FU6562T

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.12 FU6532N

Table 5-124 BEMF Electrical Characteristics of FU6532N

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.13 FU6532T

Table 5-125 BEMF Electrical Characteristics of FU6532T

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.14 FU6522L

Table 5-126 BEMF Electrical Characteristics of FU6522L

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.15 FU6522N

Table 5-127 BEMF Electrical Characteristics of FU6522N

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.10.16 FU6522T

Table 5-128 BEMF Electrical Characteristics of FU6522T

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BEMF Built-in Resistor	T _A = -40°C ~ 85°C	5.4	6.8	8.2	kΩ
Relative Accuracy between BEMF Built-in Resistors		-	1	-	%

5.11 OSC Electrical Characteristics

5.11.1 FU6572L

Table 5-129 OSC Electrical Characteristics of FU6572L

(T_A = -40°C ~ 85°C, VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.2 FU6572N

Table 5-130 OSC Electrical Characteristics of FU6572N

(T_A = -40°C ~ 85°C, VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Low-speed Clock Rate		29	32.8	37	kHz

5.11.3 FU6572T

Table 5-131 OSC Electrical Characteristics of FU6572T

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 7\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.4 FU6565N

Table 5-132 OSC Electrical Characteristics of FU6565N

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 5\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.5 FU6565T

Table 5-133 OSC Electrical Characteristics of FU6565T

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 5\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.6 FU6563N

Table 5-134 OSC Electrical Characteristics of FU6563N

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 6\text{V} \sim 28\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.7 FU6562L

Table 5-135 OSC Electrical Characteristics of FU6562L

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 12\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Low-speed Clock Rate		29	32.8	37	kHz

5.11.8 FU6562LA

Table 5-136 OSC Electrical Characteristics of FU6562LA

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.9 FU6562Q

Table 5-137 OSC Electrical Characteristics of FU6562Q

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.10 FU6562S

Table 5-138 OSC Electrical Characteristics of FU6562S

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 12\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.11 FU6562T

Table 5-139 OSC Electrical Characteristics of FU6562T

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 10\text{V} \sim 20\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.12 FU6532N

Table 5-140 OSC Electrical Characteristics of FU6532N

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 5\text{V} \sim 28\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Low-speed Clock Rate		29	32.8	37	kHz

5.11.13 FU6532T

Table 5-141 OSC Electrical Characteristics of FU6532T

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$, $V_{CC} = 5\text{V} \sim 28\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.14 FU6522L

Table 5-142 OSC Electrical Characteristics of FU6522L

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$ and $V_{DD5} = 5\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.15 FU6522N

Table 5-143 OSC Electrical Characteristics of FU6522N

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$ and $V_{DD5} = 5\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz

5.11.16 FU6522T

Table 5-144 OSC Electrical Characteristics of FU6522T

($T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$ and $V_{DD5} = 5\text{V}$ unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
System Clock Rate		23.5	24	24.5	MHz
Low-speed Clock Rate		29	32.8	37	kHz



Note

Note: SYSCLK refers to system clock rate, and T to system clock cycle. Unless otherwise specified, the system clock rate of chip is 24MHz and $T = 1/\text{SYSCLK}$.

5.12 Reset Electrical Characteristics

5.12.1 FU6572L

Table 5-145 Reset Electrical Characteristics of FU6572L

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.2 FU6572N

Table 5-146 Reset Electrical Characteristics of FU6572N

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.3 FU6572T

Table 5-147 Reset Electrical Characteristics of FU6572T

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.4 FU6565N

Table 5-148 Reset Electrical Characteristics of FU6565N

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.5 FU6565T

Table 5-149 Reset Electrical Characteristics of FU6565T

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.6 FU6563N

Table 5-150 Reset Electrical Characteristics of FU6563N

(T_A = 25°C and VCC = 6V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	–	–	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.7 FU6562L

Table 5-151 Reset Electrical Characteristics of FU6562L

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	–	–	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.8 FU6562LA

Table 5-152 Reset Electrical Characteristics of FU6562LA

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	–	–	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.9 FU6562Q

Table 5-153 Reset Electrical Characteristics of FU6562Q

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	–	–	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.10 FU6562S

Table 5-154 Reset Electrical Characteristics of FU6562S

(T_A = 25°C and VCC = 12V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	–	–	μs

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.11 FU6562T

Table 5-155 Reset Electrical Characteristics of FU6562T

(T_A = 25°C and VCC = 10V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.12 FU6532N

Table 5-156 Reset Electrical Characteristics of FU6532N

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.13 FU6532T

Table 5-157 Reset Electrical Characteristics of FU6532T

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.14 FU6522L

Table 5-158 Reset Electrical Characteristics of FU6522L

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.15 FU6522N

Table 5-159 Reset Electrical Characteristics of FU6522N

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.12.16 FU6522T

Table 5-160 Reset Electrical Characteristics of FU6522T

(T_A = 25°C and VDD5 = 5V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Minimum Time for RSTN Released to Low		50	-	-	μs
VDD5 Reset Threshold	Reset Voltage LVR = 3.0V	2.8	3.0	3.2	V

5.13 LDO Electrical Characteristics (for FU6572L / FU6572N / FU6572T / FU6565N / FU6565T / FU6563N / FU6532N / FU6532T)

5.13.1 FU6572L

Table 5-161 LDO Electrical Characteristics of FU6572L

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Voltage		4.8	5	5.2	V

5.13.2 FU6572N

Table 5-162 LDO Electrical Characteristics of FU6572N

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Voltage		4.8	5	5.2	V

5.13.3 FU6572T

Table 5-163 LDO Electrical Characteristics of FU6572T

(T_A = 25°C and VCC = 7V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Voltage		4.8	5	5.2	V

5.13.4 FU6565N

Table 5-164 LDO Electrical Characteristics of FU6565N

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VBB Voltage		11	12	13	V
VDD5 Voltage		4.8	5	5.2	V

5.13.5 FU6565T

Table 5-165 LDO Electrical Characteristics of FU6565T

(T_A = 25°C, VCC = 5V ~ 20V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VBB Voltage		11	12	13	V
VDD5 Voltage		4.8	5	5.2	V

5.13.6 FU6563N

Table 5-166 LDO Electrical Characteristics of FU6563N

(T_A = 25°C and VCC = 6V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VBB Voltage		11.5	12	12.5	V
VDD5 Voltage		4.8	5	5.2	V

5.13.7 FU6532N

Table 5-167 LDO Electrical Characteristics of FU6532N

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Voltage		4.8	5	5.2	V

5.13.8 FU6532T

Table 5-168 LDO Electrical Characteristics of FU6532T

(T_A = 25°C and VCC = 5V ~ 28V unless otherwise specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDD5 Voltage		4.8	5	5.2	V

5.14 Package Thermal Resistance

5.14.1 LQFP48 Package Thermal Resistance (for FU6572L / FU6562L / FU6562LA / FU6522L)

Table 5-169 LQFP48 Package Thermal Resistance

Parameter	Test Conditions	Value	Unit
Junction-to-ambient Thermal Resistance $\theta_{JA}^{[1]}$	JEDEC standard, 2S2P PCB	36	°C/W
	JEDEC standard, 1S0P PCB	60	°C/W
Junction-to-case Thermal Resistance $\theta_{JC}^{[1]}$	JEDEC standard, 2S2P PCB	10.5	°C/W

5.14.2 QFN48-38 Package Thermal Resistance (FU6562Q)

Table 5-170 QFN48-38 Package Thermal Resistance

Parameter	Test Conditions	Value	Unit
Junction-to-ambient Thermal Resistance $\theta_{JA}^{[1]}$	JEDEC standard, 2S2P PCB	33	°C/W
	JEDEC standard, 1S0P PCB	55	°C/W
Junction-to-case Thermal Resistance $\theta_{JC}^{[1]}$	JEDEC standard, 2S2P PCB	9.2	°C/W

5.14.3 QFN40 Package Thermal Resistance (for FU6565N / FU6572N)

Table 5-171 QFN40 Package Thermal Resistance

Parameter	Test Conditions	Value	Unit
Junction-to-ambient Thermal Resistance $\theta_{JA}^{[1]}$	JEDEC standard, 2S2P PCB	52.4	°C/W
	JEDEC standard, 1S0P PCB	72.2	°C/W
Junction-to-case Thermal Resistance $\theta_{JC}^{[1]}$	JEDEC standard, 2S2P PCB	17	°C/W

5.14.4 QFN32 Package Thermal Resistance (for FU6563N / FU6532N / FU6522N)

Table 5-172 QFN32 Package Thermal Resistance

Parameter	Test Conditions	Value	Unit
Junction-to-ambient Thermal Resistance $\theta_{JA}^{[1]}$	JEDEC standard, 2S2P PCB	47	°C/W
	JEDEC standard, 1S0P PCB	74	°C/W
Junction-to-case Thermal Resistance $\theta_{JC}^{[1]}$	JEDEC standard, 2S2P PCB	20	°C/W

5.14.5 TSSOP28 Package Thermal Resistance (for FU6572T / FU6565T / FU6562S / FU6562T / FU6532T / FU6522T)

Table 5-173 TSSOP28 Package Thermal Resistance

Parameter	Test Conditions	Value	Unit
Junction-to-ambient Thermal Resistance $\theta_{JA}^{[1]}$	JEDEC standard, 2S2P PCB	65	°C/W
	JEDEC standard, 1S0P PCB	85	°C/W
Junction-to-case Thermal Resistance $\theta_{JC}^{[1]}$	JEDEC standard, 2S2P PCB	20	°C/W



Note

[1] The actual measurements may vary depending on the conditions

6 Reset Control

6.1 Reset Source(RST_SR)

The chip includes a reset circuitry with 7 reset sources:

- > Power on reset (RSTPOW)
- > External pin reset (RSTEXT)
- > Low voltage detector reset (RSTLVD)
- > Watchdog timer reset (RSTWDT)
- > Flash error detector reset (RSTFED)
- > Debug reset (RSTDBG)
- > Soft reset (SOFTTR)

The reset flag can be queried and is recorded in the RST_SR register. The most recent reset shall set the relevant status flag(s) to 1 while clearing all other flag bits to 0. To clear the status flags, set RST_CR[RSTCLR] = 1, which shall clear RST_SR[7:3] & RST_SR[0]. After reset, the MCU initiates program execution from address 0x0000.

6.2 Reset Enable

See the relevant control register for reset enable configuration.

6.3 RSTEXT, RSTPOW

The chip resets when the RSTN pin remains low for more than 50μs.

The chip resets when the power supply voltage exceeds the reset threshold voltage.

6.4 Low-voltage Reset

The chip's internal circuitry monitors VDD5 voltage. When the VDD5 voltage drops below the reset voltage threshold, the internal monitor circuitry sends a LVD reset signal to reset the chip.

Configuring corresponding register enables the low-voltage detection circuit and sets the low-voltage

threshold.

6.5 Watchdog Timeout Reset

After enabling the watchdog timer, the software must repeatedly feed the dog in the program to clean the timer. If the program fails or fails to feed the watchdog, the watchdog timer will overflow or trigger a chip reset.

6.6 RSTFED Reset

The Flash operation module provides the MOVX instruction, enabling software to perform self-writing, self-erasing, and reading operations on Flash. A Flash illegal operation reset occurs when either performing a self-erase on the last sector (0x7F00 ~ 0x7FFF), or executing a self-write operation on the last byte (0x7FFF). RSTFED is always enabled and cannot be disabled.

6.7 RSTDBG Reset

Click the Reset button of the IDE to send a debug reset signal when the chip enters the debug state.

6.8 Soft Reset

When $RST\_SR[SOFTR] = 1$, the chip resets immediately, and then the flag bit is set to 1.

6.9 Reset Register

6.9.1 RST_SR (0xC9)

Bit	7	6	5	4	3	2	1	0
Name	RSTPOW/ RSTCLR	RSTEXT	RSTLVD	RSV	RSTWDT	RSTFED	RSTDBG	SOFTR
Type	R/W1	R	R	-	R	R	R	R/W1
Reset	-	-	-	-	-	-	-	-

Bit	Name	Description
[7]	RSTPOW/ RSTCLR	Power-on Reset Flag Read: 0: The last reset is not a power-on reset 1: The last reset is a power-on reset Write: 0: Meaningless 1: Clear the reset bit of RST_SR[7:3] & RST_SR[0]
[6]	RSTEXT	External Pin Reset Flag 0: The last reset is not an external pin reset 1: The last reset is an external pin reset
[5]	RSTLVD	Low-voltage Detection (LVD) Reset Flag 0: The last reset is not an LVD reset 1: The last reset is an LVD reset
[4]	RSV	Reserved
[3]	RSTWDT	Watchdog Timer Reset Flag 0: The last reset is not a watchdog reset 1: The last reset is a watchdog reset
[2]	RSTFED	Flash Error Detector Reset Flag 0: The last reset is not Flash error detector reset 1: The last reset is a Flash error detector reset
[1]	RSTDBG	Debug Reset Flag 0: The last reset is not a Debug reset 1: The last reset is a Debug reset
[0]	SOFTR	Soft Reset Read: 0: The last reset is not soft reset 1: The last reset is soft reset Write: 0: No effect 1: Soft reset is triggered

7 Interrupt

7.1 Interrupt Introduction

The chip includes an interrupt system with a total of 16 interrupt sources. Each interrupt source can be individually programmed in IP0 ~ IP3 registers with one of four priority levels. Interrupt flags (IF) are located in an SFRs or XSFRs. The associated IF is set by the hardware to “1” when the internal circuitry or an external source meets the interrupt conditions. If $IE[EA] = 1$ and both the associated interrupt EA and IF bits are set to “1”, an interrupt request is generated and sent to CPU. If no other interrupt service routine (ISR) of greater priority is currently being serviced, the system enters interrupt state to service the requesting ISR.

Each interrupt source except the Reset Interrupt can be assigned a priority level. A low priority interrupt can be interrupted by a high priority interrupt. The low priority interrupt will not be serviced until the ISR for the high priority interrupt completes. An interrupt will not be preempted by another of the same priority level. Each interrupt source can be individually configured to one of four priority levels in the Interrupt Priority (IP) register. Priority level assigned ascends from 0 to 3 and is defaulted to 0. If two interrupt requests are generated at the same time, the interrupt with the higher priority is serviced first. If two interrupt sources have the same priority level, a fixed priority order is used to arbitrate. See Table 7-1 Interrupt Introduction for the interrupt sources and default priority orders, where the lower the mark the higher the priority level.

7.2 Interrupt Source Enable

$IE[EA]$ is the global interrupt enable bit. The MCU does not respond to any interrupt request when $IE[EA] = 0$.

Each interrupt source can be individually enabled or disabled by configuring the corresponding interrupt enable bit in an SFR or XSFR. When the enable bit of the global interrupt or an interrupt is cleared, the interrupt flag that is set to “1” is held in a pending state. Once the enable bit is set to “1”, the MCU immediately enters the interrupt subroutine. Therefore, make sure to clear corresponding interrupt flag bit before enabling the interrupt.

7.3 External Interrupts

The external interrupt has 2 interrupt sources: INT0 and INT1. They both can be configured as interrupt on rising edge, interrupt on falling edge or interrupt on edge changes (rise or fall).

The number of digit input ports for external interrupts varies by packages. See section Pin Definitions for details. The digital input signals from P0.0~P0.3, P0.5~P0.6 and P1.1 and output signals from CMP4 can be used to trigger an INT0. The interrupt source is selected through LVSR[EXT0CFG] bit. These trigger sources share one interrupt entry point, one interrupt flag bit TCON[IF0] and one interrupt enable bit IE[EX0]. TCON[IT0] bit selects the interrupt edge. IP0[PX0] bit configures the priority level.

The digital input signals from P1.0~P1.7, P4.0~P4.6 and P0.4 can be used to trigger an INT1. P1_IF and P4_IF are interrupt flag bits, and P1_IE and P4_IE are interrupt enable bits. Each trigger source has a corresponding interrupt flag bit and an interrupt enable bit. INT1 can select multiple trigger sources that are recognized by P1_IF and P4_IF in the interrupt subroutine. These 16 interrupt sources share one interrupt entry and one interrupt enable bit IE[EX1]. To enable INT1, first set IE[EX1] to “1” and then configure the corresponding enable bit. The interrupt edge is configured by TCON[IT1] bit, and the priority level by IP0[PX1] bit. See 7.5.7 P1_IE (0xD1) ~ 7.5.10 P4_IF (0xD4) for INT1 interrupt flag registers and enable registers.

7.4 Interrupt Introduction

Table 7-1 Interrupt Introduction

Interrupt Source	Priority Order	Interrupt Vector	Flag Bit	Software Erase	Interrupt Enable Bit	Priority Set
Reset	The Highest	0x0000	None	No	Continuously Enable	The Highest
LVW Interrupt TSD Interrupt	0	0x0003	LVSR[0] TCON[5]	Yes	CCFG1[6] IE[1]	IP0[1:0]
INT0	1	0x000B	TCON[2]	Yes	IE[0]	IP0[3:2]
INT1	2	0x0013	P1_IF[7:0] P4_IF[7:0]	Yes	IE[2]	IP0[5:4]
FG Interrupt DRV CM Interrupt	3	0x001B	DRV_SR[5:4]	Yes	DRV_SR[3] DRV_SR[2:0]	IP0[7:6]
Timer2 Interrupt	4	0x0023	TIM2_CR1[7:5]	Yes	TIM2_CR1[4:3] TIM2_CR0[3]	IP1[1:0]

Interrupt Source	Priority Order	Interrupt Vector	Flag Bit	Software Erase	Interrupt Enable Bit	Priority Set
Timer1 Interrupt	5	0x002B	TIM1_SR[5:0]	Yes	TIM1_IER[5:0]	IP1[3:2]
ADC Interrupt	6	0x0033	ADC_CR[0]	Yes	ADC_CR[1]	IP1[5:4]
CMP0/1/2 Interrupt Hall Interrupt	7	0x003B	CMP_SR[6:4] HALL_CR[7]	Yes	CMP_CR0[5:0] HALL_CR[6]	IP1[7:6]
RTC Interrupt	8	0x0043	RTC_STA[6]	Yes	IE[6]	IP2[1:0]
Timer3 Interrupt	9	0x004B	TIM3_CR1[7:5]	Yes	TIM3_CR1[4:3] TIM3_CR0[3]	IP2[3:2]
Systick Interrupt	10	0x0053	DRV_SR[7]	Yes	DRV_SR[6]	IP2[5:4]
Timer4 Interrupt	11	0x005B	TIM4_CR1[7:5]	Yes	TIM4_CR1[4:3] TIM4_CR0[3]	IP2[7:6]
CMP3 Interrupt	12	0x0063	CMP_SR[7]	Yes	CMP_CR0[7:6]	IP3[1:0]
I2C Interrupt UART1 Interrupt	13	0x006B	I2C_SR[0] UT_CR[1:0]	Yes	I2C_CR[0] IE[4]	IP3[3:2]
SPI Interrupt UART2 Interrupt	14	0x0073	SPI_CR1[7:4] UT2_CR[1:0]	Yes	IE[3] UT2_BAUDH[5]	IP3[5:4]
DMA Interrupt	15	0x007B	DMA0_CR0[0] DMA1_CR0[0]	Yes	DMA0_CR0[2] DMA1_CR0[2:1] = 10	IP3[7:6]

**Note**

- > For the control bits UT_CR[RI], UT_CR[TI], UT2_CR[UT2RI], UT2_CR[UT2TI], DMA0_CR0[DMAIF], and DMA1_CR0[DMAIF], the software can clear or set these bits. Setting them to 1 generates an interrupt request. For interrupt event flags not mentioned above, software can only clear them (write 0), while writing 1 has no effect
- > For a register containing multiple interrupt flags, you can write a “1” to the active interrupt flags in order to prevent clearing a interrupt flag to 0. Take DRV_SR as an example. When DRV_SR[SYSTIF] is cleared to 0 by software, you can use the statement `DRV_SR = (DRV_SR&0x7F) | 0x30` to prevent the software from clearing DRV_SR[FGIF] and DRV_SR[DCIF] to 0

7.5 Interrupt Register

7.5.1 IE (0xA8)

Bit	7	6	5	4	3	2	1	0
Name	EA	RTCIE	RSV	ES0	SPIIE	EX1	TSDIE	EX0
Type	R/W	R/W	-	R/W	R/W	R/W	R/W	R/W
Reset	0	0	-	0	0	0	0	0

Bit	Name	Description
[7]	EA	Global Interrupt Enable 0: Disable 1: Enable
[6]	RTCIE	RTC Interrupt Enable 0: Disable 1: Enable
[5]	RSV	Reserved
[4]	ES0	UART1 Interrupt Enable 0: Disable 1: Enable
[3]	SPIIE	SPI Interrupt Enable 0: Disable 1: Enable
[2]	EX1	INT1 Enable 0: Disable 1: Enable
[1]	TSDIE	TSD Interrupt Enable 0: Disable 1: Enable
[0]	EX0	INT0 Enable 0: Disable 1: Enable

7.5.2 IP0 (0x8A)

Bit	7	6	5	4	3	2	1	0
Name	PDRV		PX1		PX0		PLVW_TSD	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:6]	PDRV	FG/DRV CM Interrupt Priority Settings
[5:4]	PX1	INT1 Priority Settings

[3:2]	PX0	INT0 Priority Settings
[1:0]	PLVW_TSD	LVW/TSD Interrupt Priority Settings

**Note**

The setting value of 0 to 3 indicates the interrupt priorities from low to high respectively

7.5.3 IP1 (0x8B)

Bit	7	6	5	4	3	2	1	0
Name	PCMP_HALL		PADC		PTIM1		PTIM2	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:6]	PCMP_HALL	CMP0/1/2 & Hall Interrupt Priority Settings
[5:4]	PADC	ADC Interrupt Priority Settings
[3:2]	PTIM1	Timer1 Interrupt Priority Settings
[1:0]	PTIM2	Timer2 Interrupt Priority Settings

**Note**

The setting value of 0 to 3 indicates the interrupt priorities from low to high respectively

7.5.4 IP2 (0x8C)

Bit	7	6	5	4	3	2	1	0
Name	PTIM4		PSYSTICK		PTIM3		PRTC	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:6]	PTIM4	Timer4 Interrupt Priority Settings
[5:4]	PSYSTICK	Systick Interrupt Priority Settings
[3:2]	PTIM3	Timer3 Interrupt Priority Settings
[1:0]	PRTC	RTC Interrupt Priority Settings

**Note**

The setting value of 0 to 3 indicates the interrupt priorities from low to high respectively.

7.5.5 IP3 (0x8D)

Bit	7	6	5	4	3	2	1	0
Name	PDMA		PSPI_UT2		PI2C_UT1		PCMP3	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:6]	PDMA	DMA Interrupt Priority Settings
[5:4]	PSPI_UT2	SPI/UART2 Interrupt Priority Settings
[3:2]	PI2C_UT1	I ² C/UART1 Interrupt Priority Settings
[1:0]	PCMP3	CMP3 Interrupt Priority Settings

**Note**

The setting value of 0 to 3 indicates the interrupt priorities from low to high respectively

7.5.6 TCON (0x88)

Bit	7	6	5	4	3	2	1	0
Name	RSV		TSDIF	IT1		IF0	IT0	
Type	-	-	R/W0	R/W	R/W	R/W0	R/W	R/W
Reset	-	-	0	0	0	0	0	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5]	TSDIF	TSD Interrupt Flag Bit This bit is set by hardware to “1” when an over-temperature event occurs. Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless  Note > Clear to 0 after TSDEN > This flag works with the overtemperature status bit LVSR[TSDIF]
[4:3]	IT1	External Interrupt 1 (INT1) Edge Select 00: Rising trigger interrupt 01: Falling trigger interrupt 1X: Level change (rise or fall) trigger interrupt
[2]	IF0	External Interrupt 0 (INT0) Interrupt Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless

[1:0]	IT0	External Interrupt 0 (INT0) Edge Select 00: Rising trigger interrupt 01: Falling trigger interrupt 1X: Level change (rise or fall) trigger interrupt

7.5.7 P1_IE (0xD1)

Bit	7	6	5	4	3	2	1	0
Name	P17_IE	P16_IE	P15_IE	P14_IE	P13_IE	P12_IE	P11_IE	P10_IE
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	P17_IE	P1.7 INT1 Enable 0: Disable 1: Enable
[6]	P16_IE	P1.6 INT1 Enable 0: Disable 1: Enable
[5]	P15_IE	P1.5 INT1 Enable 0: Disable 1: Enable
[4]	P14_IE	P1.4 INT1 Enable 0: Disable 1: Enable
[3]	P13_IE	P1.3 INT1 Enable 0: Disable 1: Enable
[2]	P12_IE	P1.2 INT1 Enable 0: Disable 1: Enable
[1]	P11_IE	P1.1 INT1 Enable 0: Disable 1: Enable
[0]	P10_IE	P1.0 INT1 Enable 0: Disable 1: Enable

7.5.8 P1_IF (0xD2)

Bit	7	6	5	4	3	2	1	0
Name	P17_IF	P16_IF	P15_IF	P14_IF	P13_IF	P12_IF	P11_IF	P10_IF
Type	R/W0	R/W0	R/W0	R/W0	R/W0	R/W0	R/W0	R/W0

Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	P17_IF	P1.7 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[6]	P16_IF	P1.6 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[5]	P15_IF	P1.5 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[4]	P14_IF	P1.4 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[3]	P13_IF	P1.3 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[2]	P12_IF	P1.2 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write:

		0: Cleared 1: Meaningless
[1]	P11_IF	P1.1 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[0]	P10_IF	P1.0 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless

7.5.9 P4_IE (0xD3)

Bit	7	6	5	4	3	2	1	0
Name	P04_IE	P46_IE	P45_IE	P44_IE	P43_IE	P42_IE	P41_IE	P40_IE
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	P04_IE	P0.4 INT1 Enable 0: Disable 1: Enable
[6]	P46_IE	P4.6 INT1 Enable 0: Disable 1: Enable
[5]	P45_IE	P4.5 INT1 Enable 0: Disable 1: Enable
[4]	P44_IE	P4.4 INT1 Enable 0: Disable 1: Enable
[3]	P43_IE	P4.3 INT1 Enable 0: Disable 1: Enable
[2]	P42_IE	P4.2 INT1 Enable 0: Disable 1: Enable

[1]	P41_IE	P4.1 INT1 Enable 0: Disable 1: Enable
[0]	P40_IE	P4.0 INT1 Enable 0: Disable 1: Enable

7.5.10 P4_IF (0xD4)

Bit	7	6	5	4	3	2	1	0
Name	P04_IF	P46_IF	P45_IF	P44_IF	P43_IF	P42_IF	P41_IF	P40_IF
Type	R/W0	R/W0	R/W0	R/W0	R/W0	R/W0	R/W0	R/W0
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	P04_IF	P0.4 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[6]	P46_IF	P4.6 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[5]	P45_IF	P4.5 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[4]	P44_IF	P4.4 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[3]	P43_IF	P4.3 INT1 Flag

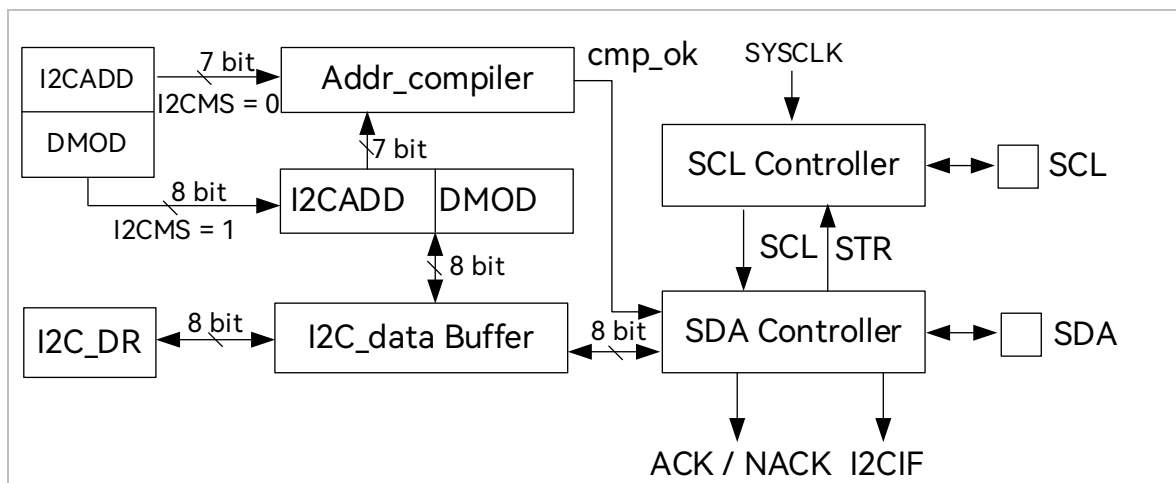
		Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[2]	P42_IF	P4.2 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[1]	P41_IF	P4.1 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[0]	P40_IF	P4.0 INT1 Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless

8 I²C

8.1 I²C Introduction

The I²C module provides an industry standard two-wire serial interface and is a simple bi-directional synchronous serial bus for communication between MCU and external I²C devices, as shown in Figure 8-1. The bus consists of two serial lines: SDA (serial data line) and SCL (serial clock line). P0.0 serves as SDA port and P0.1 as SCL port. After I²C is enabled, P0.0 and P0.1 automatically shifts into open-drain outputs.

Figure 8-1 I²C Block Diagram



Main features:

- > Supports standard mode (up to 100kHz), fast mode (up to 400kHz) and fast plus mode (up to 1MHz)
- > Supports master mode and slave mode
- > Supports 7-bit address mode and general call address mode
- > Supports DMA data transfer

Both SDA and SCL lines are high level when the bus is idle, which is the only basis for detecting whether the bus is idle or not. Only one master device and at least one slave device are active on the bus during the transmission. When the bus is occupied, other devices must wait for the bus idle to start an I²C communication. The master starts the bus to transfer data. Clock signal is sent to all devices via SCL and the slave address and read/write mode are sent via SDA. When a device on the bus matches the address, it acts as a slave. The relationships between masters and slaves or data transfer direction on the bus are

not constant. The process for the master to send data to the slave is shown in Figure 8-2. The master first addresses the slave device and waits for the slave response. And then, it sends data to the slave. Finally, the master terminates the data transmission. The process for the master to receive data from the slave is shown in Figure 8-3. The master first addresses the slave and waits for the slave response. And then, it receives the data from the slave. Finally, the master terminates the data transmission. In this case, the master generates the timing clock and stops the data transmission.

Figure 8-2 Master Transmits Data to Slave

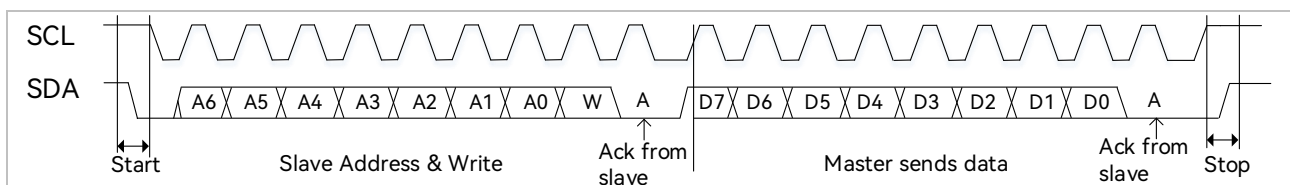
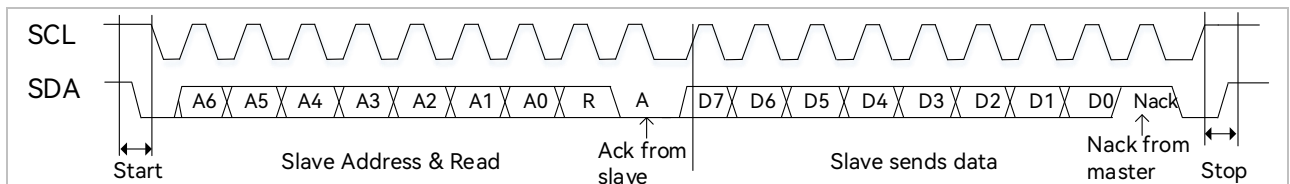


Figure 8-3 Master Receives Data from Slave



8.2 I²C Operation

8.2.1 Master Mode

1. Set I2C_CR[I2CMS] = 1 to “1” to select master mode;
2. Set I2C_CR[I2CSPD] to set the clock rate of SCL;
3. Set I2C_ID[I2CADD] to set the slave address;
4. Set I2C_SR[DMOD] to set the read/write direction;
5. Set I2C_CR[I2CEN] = 1 to enable I²C;
6. Set I2C_SR[I2CSTA] = 1 to transmit START and address. After ACK/NACK is received, I2C_SR[STR] is set to “1” by hardware and SCL is pulled LOW by the master;
7. Sending Data: Write the data to I2C_DR register. The master starts to transmit data when I2C_SR[STR] is reset and SCL is released. After the data is transmitted and ACK/NACK is received, I2C_SR[STR] is set to

“1” by hardware and SCL is pulled LOW by the master;

8. Receiving Data: The master starts to receive data when I2C_SR[STR] is reset and SCL is released. After the data is received, I2C_SR[STR] is set to “1” by hardware and SCL is pulled LOW by the master. Configure ACK/NACK via I2C_SR[NACK], and then clear I2C_SR[STR] to release SCL to transmit ACK/NACK signal. After the data is received, I2C_SR[STR] is set to “1” by hardware and SCL is pulled LOW by the master;
9. Stop communication: Set I2C_SR[I2CSTP] to “1” when I2C_SR[STR] is “1” and stop signal is sent after I2C_SR[STR] is cleared.

8.2.2 Slave Device Mode

1. Set I2C_CR[I2CMS] = 0 to set the slave mode;
2. Set I2C_ID[I2CADD] to set the slave address or set I2C_ID[GC] = 1 to enable general call mode;
3. Set I2C_CR[I2CEN] = 1 to enable I²C;
4. After START signal and the correct address are received, I2C_SR[I2CSTA] and I2C_SR[STR] are set to “1” by hardware and SCL is pulled LOW by the slave. ACK/NACK is configured via I2C_SR[NACK] and the slave determines whether to receive or send the data via I2C_SR[DMOD];
5. Sending Data: Write the data to I2C_DR register, and clear I2C_SR[STR] to release SCL. The data is sent after ACK/NACK is transmitted. After the data is sent and ACK/NACK is received from the master, I2C_SR[STR] is set to “1” by hardware and SCL is pulled LOW by the slave;
6. Receiving Data: Clear I2C_SR[STR] to release SCL to receive data. After the data is received, I2C_SR[STR] is set to “1” by hardware and SCL is pulled LOW by the slave. ACK/NACK is configured via I2C_SR[NACK] to reset I2C_SR[STR] to release SCL for ACK/NACK transmission. If new data is received, I2C_SR[STR] is set to “1” by hardware and SCL is pulled LOW by the slave;
7. RESTART: If the slave is processing a service when receiving START signal, it stops the current routine and waits for receiving address.

8.2.3 I²C Interrupt Source

I²C interrupt sources:

- > I2C_SR[STR] = 1 generates an interrupt. This interrupt source is valid in both master and slave modes.
- > I2C_SR[I2CSTP] = 1 generates an interrupt. This interrupt source is only valid in slave mode.

8.3 I²C Register

8.3.1 I2C_CR (0x4028)

Bit	7	6	5	4	3	2	1	0
Name	I2CEN	I2CMS	RSV	I2CDMANAKINT	I2CDMAAUTO	I2CSPD		I2CIE
Type	R/W	R/W	-	R/W	R/W	R/W	R/W	R/W
Reset	0	0	-	0	0	0	0	0

Bit	Name	Description
[7]	I2CEN	I ² C Enable Enable the corresponding GPIO switching to I2C mode, configuring as open-drain output. I2C pull-up activation depends on the port pull-up configuration. 0: Disable 1: Enable
[6]	I2CMS	Master/Slave Device Mode 0: Slave device mode 1: Master device mode
[5]	RSV	Reserved
[4]	I2CDMANAKINT	DMA Transmission Interrupt Enable When NAK Reply Is Ignored 0: Disable 1: Enable
[3]	I2CDMAAUTO	DMA Transmission: The first data byte enables automatically. 0: Disable 1: Enable
[2:1]	I2CSPD	I ² C Transfer Rate Setting. Valid only in Master Mode 00: 100kHz 01: 400kHz 10: 1MHz 11: Reserved
[0]	I2CIE	I ² C Interrupt Enable 0: Disable 1: Enable

8.3.2 I2C_ID (0x4029)

Bit	7	6	5	4	3	2	1	0
Name	I2CADD							GC
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	0	1	0	1	0	1	0

Bit	Name	Description

[7:1]	I2CADD	Slave Device Address
[0]	GC	Broadcast mode, only effective in the slave device mode. 0: Disable broadcast call 1: Enable broadcast call, even when the address is 0x00.

8.3.3 I2C_DR (0x402A)

Bit	7	6	5	4	3	2	1	0
Name	I2C_DR							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	I2C_DR	I ² C Data Register Read: Data prepared to send or already received Write: Data prepared to send

8.3.4 I2C_SR (0x402B)

Bit	7	6	5	4	3	2	1	0
Name	I2CBSY	DMOD	RSV	I2CSTA	I2CSTP	STR	NACK	I2CIF
Type	R	R/W	-	R/W	R/W	R/W0	R/W	R
Reset	0	0	-	0	0	0	0	0

Bit	Name	Description
[7]	I2CBSY	I ² C Busy Status Flag Bit When I2C_CR[I2CEN] = 0, I2C_SR[I2CBSY] is cleared to “0” by hardware. Master device mode: The bit is set to 1 by hardware when START is successfully send and is cleared when STOP is successfully sent. Slave device mode: The bit is set to 1 by hardware when START is received and is matched successfully and is cleared when STOP is successfully sent.
[6]	DMOD	I ² C Read and Write Flag Bit 0: Write mode (Send data by the master device and receive data by the slave device) 1: Read mode (Send data by the master device and receive data by the slave device)  Note Slave mode read only
[5]	RSV	Reserved
[4]	I2CSTA	Master device mode:

		When this bit is configured with “1”, START and address bytes are transmitted after both SCL and SDA are HIGH confirmed by the hardware. This bit is cleared to “0” by hardware automatically when the transmission is completed, and I2C_SR[I2CSTA] writing is forbidden during data transmission. After the data is sent or received, I2C_SR[I2CSTA] is set to “1” to transmit RESTART. 0: No START and address bytes 1: Send START or RESTART and address bytes Slave device mode: The bit is set to 1 by hardware when START is received and the address byte is matched successfully and then the software is cleared. Table 8-1 Mapping of I2C_SR[I2CSTA/I2CSTP] and I2C Data Type in Slave Mode <table><tr><th>I2CSTA</th><th>I2CSTP</th><th>I²C Data Type</th></tr><tr><td>0</td><td>0</td><td>Data Byte</td></tr><tr><td>0</td><td>1</td><td>STOP</td></tr><tr><td>1</td><td>0</td><td>START + Address Byte</td></tr><tr><td>1</td><td>1</td><td>Receive STOP first Then receive START + address byte</td></tr></table>  Note When I2C_CR[I2CEN] = 0, I2C_SR[I2CSTA] is automatically cleared to “0”	I2CSTA	I2CSTP	I ² C Data Type	0	0	Data Byte	0	1	STOP	1	0	START + Address Byte	1	1	Receive STOP first Then receive START + address byte
I2CSTA	I2CSTP	I ² C Data Type															
0	0	Data Byte															
0	1	STOP															
1	0	START + Address Byte															
1	1	Receive STOP first Then receive START + address byte															
[3]	I2CSTP	Master device mode: This bit cannot be written to “1” by software unless I2C_SR[I2CBSY] = 1; STOP is transmitted after I2C_SR[STR] is cleared to release SCL. After the transmission, this bit is cleared to “0” automatically by hardware. If I2C_SR[I2CSTA] and I2C_SR[I2CSTP] are written to “1” at the same time and I2C_SR[I2CBSY] is “1”, I2C first sends STOP, then START and address bytes. After START and address bytes are transmitted, I2C_SR[STR] is set to “1” by hardware. I2C_SR[I2CSTP] writing is forbidden during data transmission. 0: Do not send STOP 1: Send STOP Slave device mode: The bit is set to 1 by hardware when STOP is received and then the software is cleared. See Table 8-1 for status flag.  Note When I2C_CR[I2CEN] = 0, I2C_SR[I2CSTP] is automatically cleared to “0” by hardware															
[2]	STR	I²C Bus Hang Detection Flag Master device mode: After START and address or DATA byte are transmitted, I2C_SR[STR] are set to “1” by hardware and SCL is pulled LOW. SCL is released after I2C_SR[STR] is cleared by software.															

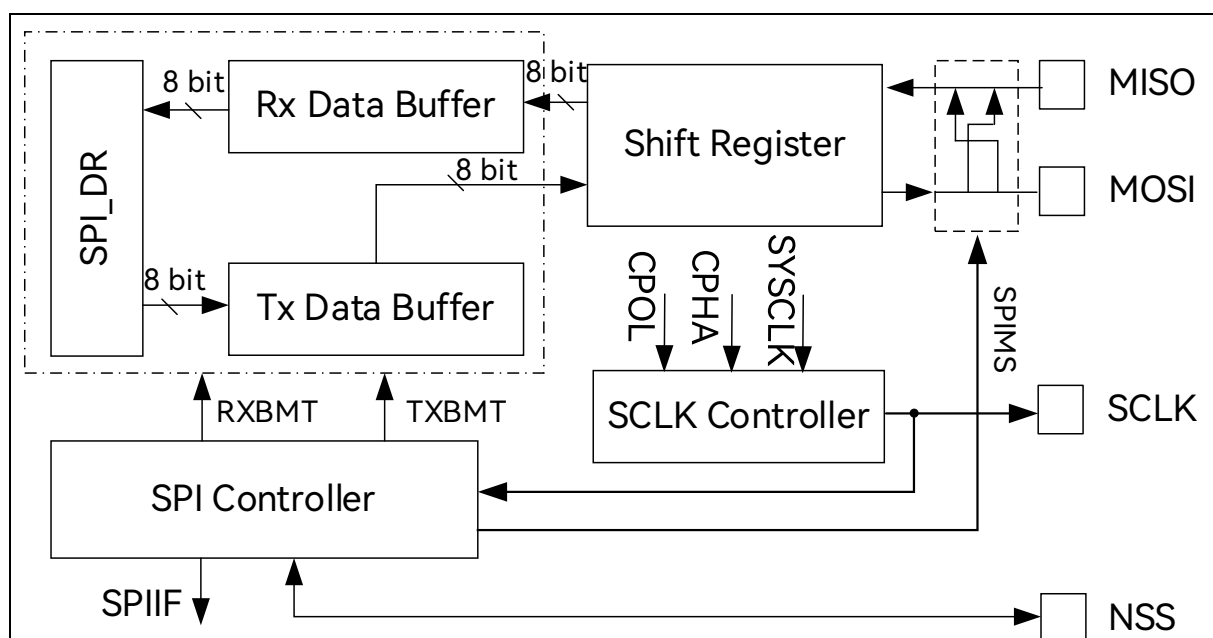
		When I2C_SR[I2CSTA] and I2C_SR[I2CSTP] are both “1”, I2C_SR[STR] is set to “1” only after hardware sends STOP and START & address bytes. Slave device mode: When DATA byte is received or START is received and address matches, I2C_SR[STR] is set to “1” by hardware and SCL is pulled LOW. SCL is released after I2C_SR[STR] is cleared by software.  Note This bit is set to 1 by hardware and the software is cleared. When I2C_CR[I2CEN] = 0, I2C_SR[STR] is automatically cleared to “0”.
[1]	NACK	This bit refers to the feedback from a receiver to a sender after a byte is transferred via I²C. It is automatically cleared to “0” when I2C_SR[I2CEN] = 0. 0: ACK, indicating that the receiver can continue to receive data. 1: NACK, indicating that the receiver attempts to stop data transmission. When the device is in READ mode, I2C_SR[NACK] is configured to transmit ACK/NACK after the 8th bit of data is received. 0: The 9th bit sends ACK 1: The 9th bit sends NACK When the device is in WRITE mode, I2C_SR[NACK] is read to receive ACK/NACK after the 8th bit of data is transmitted. 0: The 9th bit receives ACK 1: The 9th bit receives NACK
[0]	I2CIF	I²C Interrupt Flag Bit 0: No interrupt occurs 1: Interrupt occurs When I2C_SR[STR] = 1, an interrupt is generated in both Master and Slave modes. When I2C_SR[I2CSTP] = 1, an interrupt is generated only in Slave mode.

9 SPI

9.1 SPI Introduction

SPI provides access to a high-speed and full-duplex synchronous serial bus, with its block diagram shown in Figure 9-1. SPI can operate as a master or slave device in 3-wire or 4-wire mode, and supports multiple masters and slaves on a single SPI bus.

Figure 9-1 SPI Block Diagram



9.2 SPI Operation

9.2.1 Signal Introduction

4 signals of SPI is MOSI, MISO, SCLK, and NSS.

9.2.1.1 Master Output and Slave Input(MOSI)

MOSI (Master Out Slave In) is the master device's output and slave device's input, used for serial data transmission from master to slave. Data is transmitted MSB-first, meaning the shift register's most significant bit (MSB) is sequentially output to the MOSI pin. The master-out, slave-in (MOSI) signal is an output from a master

device and an input to slave devices. It is used to serially transfer data from the master to the slave. Data is transferred with most-significant bit (MSB) first, namely, the master begins its transmission by driving the MSB of the shift register on its MOSI pin.

9.2.1.2 Master Input and Slave Output(MISO)

The MISO signal is an output from a slave device and an input to the master device. The MISO pin is placed in a high-impedance state when the SPI module is disabled or when the SPI operates in 4-wire mode as a slave that is not selected. When the SPI acts as a slave in 3-wire mode or operates in 4-wire mode as a slave that is selected, MISO is used to serially transfer data from the slave to the master. Data is transferred with most-significant bit (MSB) first, namely, the master begins its transmission by driving the MSB of the shift register on its MOSI pin.

9.2.1.3 Serial Clock(SCLK)

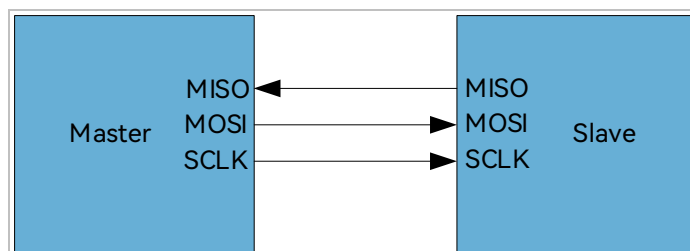
The serial clock (SCLK) signal is an output from the master device and an input to slave devices. It is used to synchronize serial data transmission between the master and slave. SCLK signal is generated by SPI operating as a master. In 4-wire slave mode, SCLK is ignored when the slave device is not selected (NSS=1).

9.2.1.4 Negated Slave Select (NSS)

The slave-select (NSS) is dependent on the setting of SPI_CR1[NSSMOD] bit. SPI may operate in 3-Wire Mode, 4-Wire Slave/Multi-Master Mode or 4-Wire Single Master Mode. When SPI operates in 4-Wire Slave/Multi-Master Mode, NSS is enabled as an input. In this mode, a particular SPI master function is disabled to prevent SPI bus collision where two or more masters simultaneously initiate data transfer. When SPI operates in 4-Wire Single Master Mode, the master NSS is configured as chip select output. When SPI operates in 3-Wire Mode, NSS is disabled. When SPI operates as a master, multiple addressed slave devices can be selected using general-purpose I/O pins.

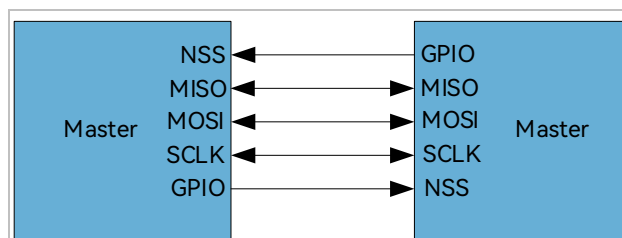
When SPI_CR1[NSSMOD] = 00, SPI operates in 3-Wire Mode. NSS port is not necessary in this mode and there is only one master and one slave on the SPI bus. The connection diagram is shown in Figure 9-2.

Figure 9-2 Connection Diagram of 3-wire SPI Mode



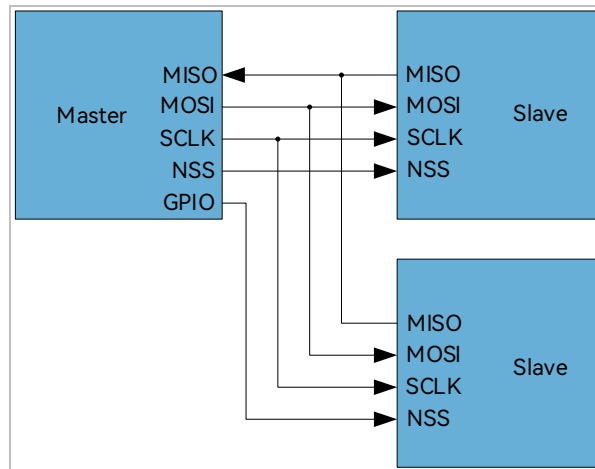
When $\text{SPI\_CR1}[\text{NSSMOD}] = 01$, SPI operates in 4-Wire Slave/Multi-Master Mode. In this mode, NSS pins on the SPI bus are configured as inputs, waiting to be addressed by the master. When $\text{SPI\_CR0}[\text{SPIMS}] = 0$, SPI operates in 4-Wire Slave Mode. If NSS is set to “0”, the slave is selected; while NSS is set to “1”, the slave is not selected. When $\text{SPI\_CR0}[\text{SPIMS}] = 1$, SPI operates in Master Mode and defaults to Multi-Master Mode. When SPI operates in Multi-Master Mode, NSS is configured as an input to disable the master SPI. When NSS pin of a master on the SPI bus is pulled low, $\text{SPI\_CR0}[\text{SPIMS}]$ and $\text{SPI\_CR1}[\text{SPIEN}]$ are cleared to “0” by hardware to disable the SPI, and the Mode Fault Flag $\text{SPI\_CR1}[\text{MODF}]$ is set to “1”. In this case, SPI communication remains halted before the SPI is re-enabled by software. In this mode, multiple masters are allowed for communication on the SPI bus. The connection diagram is shown in Figure 9-3.

Figure 9-3 Connection Diagram of 4-Wire Single Master Mode



When $\text{SPI\_CR1}[\text{NSSMOD}] = 1X$, SPI operates in 4-Wire Single Master Mode. In this mode, NSS pin of the master on the bus is configured as an output, and NSS pin of the slave devices are configured as inputs. $\text{SPI\_CR1}[\text{NSSMOD0}]$ setting decides the output level of NSS pin serving as signal to select a slave. Other slaves can be selected using GPIO pins. The connection diagram is shown in Figure 9-4.

Figure 9-4 Connection Diagram of 4-Wire Single Master Mode



9.2.2 SPI Master Device Mode

When $\text{SPI\_CR0}[\text{SPIMS}] = 1$, SPI operates in master mode, which provides SCLK signal for SPI bus. When the data is written to SPI_DR, it is firstly written to the transmit buffer and $\text{SPI\_CR1}[\text{TXBMT}]$ is cleared to “0”. If the shift register is empty, the data in the transmit buffer will be transferred to the shift register for the transmission. The master SPI begins its transmission by driving the MSB of shift register on its MOSI pin. After the transmission is completed, $\text{SPI\_CR1}[\text{SPIIF}]$ and $\text{SPI\_CR1}[\text{TXBMT}]$ are set to “1”. While the SPI master transfers data to a slave on the MOSI line, the addressed SPI slave simultaneously transfers data in the shift register to the SPI master on the MISO line in a full-duplex operation. Therefore, $\text{SPI\_CR1}[\text{SPIIF}]$ flag serves as both a transmit-complete flag and a receive-data-ready flag, and the data in the shift register is that received by MISO, which is transferred to the receive buffer. The data from SPI_DR is that of the receive buffer. If the data is written to SPI_DR when $\text{SPI\_CR1}[\text{TXBMT}]$ is “0”, the write conflict flag bit $\text{SPI\_CR1}[\text{WCOL}]$ will be set to “1” and the data in the transmit buffer keeps unchanged.

9.2.2.1 Master Mode Configuration

1. Configure $\text{SPI\_CR1}[\text{NSSMOD}]$ to set the SPI operating mode;
2. Configure $\text{SPI\_CR0}[\text{CPOL}]$ to set the clock polarity;
3. Configure $\text{SPI\_CR0}[\text{CPHA}]$ to set the clock phase;
4. Set $\text{SPI\_CR0}[\text{SPIMS}]$ to “1” to select master mode;
5. Configure SPI_CLK to set the SCLK rate;

6. Set SPI_CR1[SPIEN] to “1” to enable SPI;
7. Write the data to SPI_DR. SPI transmits data for each write;
8. After SPI_CR1[SPIIF] is set to “1”, SPI_DR is read to receive the data.

9.2.3 SPI Slave Mode

When SPI_CR0[SPIMS] = 0, SPI operates in slave mode. In this mode, SCLK signal is sent by the master SPI. The data is shifted from MOSI pin and shifted out from MISO pin. If no SCLK signal is input, shift register of the slave is in the stop state. If the signal of SCLK is input, the shift register of slave starts to receive and transmit data through MOSI and MISO pins. The slave device cannot initiate transfers. The data sent to the master device is pre-loaded into the shift register by writing to SPI_DR. If the shift register is empty, the data in the transit buffer is transferred into the shift register. After the transmission is completed, SPI_CR1[SPIIF] and SPI_CR1[TXBMT] are set to “1”. The received data that is transferred into receive buffer and receive buffer empty flag bit SPI_CR0[RXBMT] is cleared, indicating the new data has not been read. If SPI_CR0[RXBMT] is “0” and there is new data ready to be sent to the receive buffer, SPI_CR1[RXOVRN] is set to “1” and the data in the receive buffer remains unaffected. When data is written to SPI_DR, SPI_CR1[TXBMT] is cleared. If data is written in this case, the write conflict flag bit SPI_CR1[WCOL] is set to “1” and the data in the transmit buffer keeps unchanged.

9.2.3.1 Slave Mode Configuration

1. Configure SPI_CR1[NSSMOD] to set the SPI operating mode;
2. Configure SPI_CR0[CPOL] to set the clock polarity;
3. Configure SPI_CR0[CPHA] to set the clock phase;
4. Set SPI_CR0[SPIMS] to “0” to select slave mode;
5. Set SPI_CR1[SPIEN] to “1” to enable SPI;
6. Write data to SPI_DR and wait for the master to transmit the clock signal.

9.2.4 SPI Interrupt Source

SPI interrupt source includes:

- SPI interrupt flag SPI_CR1[SPIIF] is set to “1” each time after the byte is transferred.
- If SPI_DR is written when the data in transmit buffer has not been transferred to the shift register, the write conflict flag SPI_CR1[WCOL] is set to “1” and the write operation will not be implemented.
- When SPI works as a master in a multi-master system and NSS pin is pulled LOW, the mode error flag SPI_CR1[MODF] is set to “1”. When a mode error occurs, SPI_CR0[SPIMS] and SPI_CR1[SPIEN] are cleared. SPI is forbidden to allow another master to control the bus.
- The receive overflow flag SPI_CR1[RXOVRN] is set to “1” when SPI operates in slave mode and a transmission is completed while the receive buffer still holds unread data from a previous transfer. And the received data will not be transferred to the receive buffer.

9.2.5 Serial Clock Timing

Four combinations of serial clock phase and idle polarity can be selected using the CPHA and CPOL bits in the SPI_CR0 Register. SPI_CR0[CPHA] selects the clock phase (the edge of the SCLK signal used to latch the data in shift register). SPI_CR0[CPOL] selects the polarity. Both master and slave devices must be configured with the same clock phase and polarity. When the clock phase and polarity is configured, SPI shall be disabled (SPI_CR1[SPIEN] = 0). The timing relationships of SCL and SDA in clock phase and polarity combinations are shown in Figure 9-5 and Figure 9-6.

Figure 9-5 SDA/SCL Line Timing Diagram (SPI_CR0[CPHA] = 0)

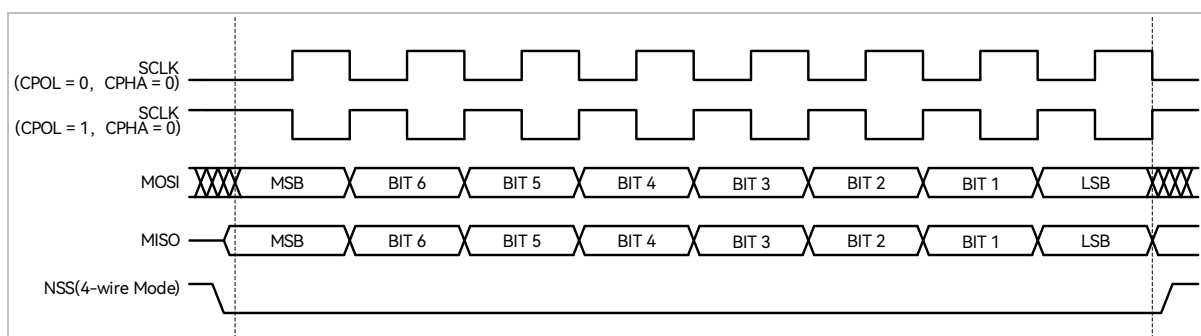
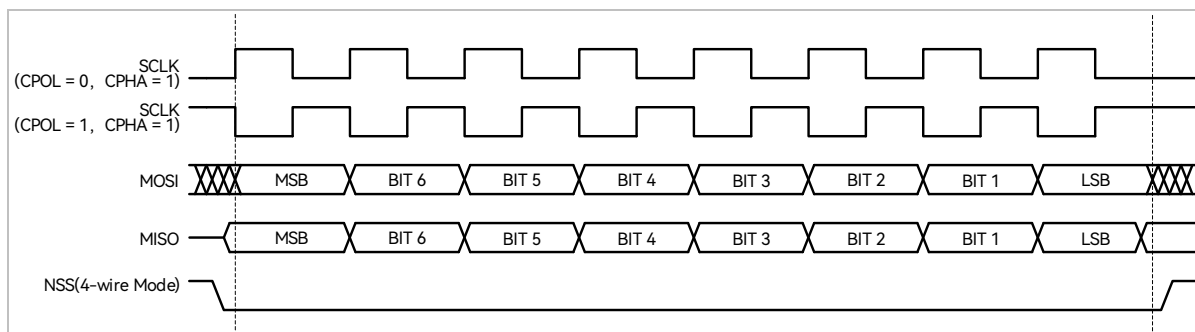


Figure 9-6 SDA/SCL Line Timing Diagram (SPI_CR0[CPHA] = 1)



9.3 SPI Register

9.3.1 SPI_CR0 (0x4030)

Bit	7	6	5	4	3	2	1	0
Name	SPIBSY	SPIMS	CPHA	CPOL	SLVSEL	NSSIN	SRMT	RXBMT
Type	R	R/W	R/W	R/W	R	R	R	R
Reset	0	0	0	0	0	1	1	1

Bit	Name	Description
[7]	SPIBSY	SPI Busy Flag 0: No SPI transmission 1: SPI transmission is operating
[6]	SPIMS	Master/Slave Mode Selection 0: Slave device mode 1: Master device mode
[5]	CPHA	Clock Phase 0: Data is received on the leading edge and transmitted on the trailing edge of SCLK's active phase. 1: Data is transmitted on the leading edge and received on the trailing edge of SCLK's active phase.
[4]	CPOL	Clock Idle Polarity 0: Low level in idle state. 1: High level in idle state.
[3]	SLVSEL	NSS Select Flag This bit is set to "1" when the filtered signal of NSS is low, indicating that the device is selected as slave. When NSS is high, this bit is cleared to "0", indicating that the device is not selected as slave. 0: The device is NOT selected as slave. 1: The device is selected as slave.
[2]	NSSIN	NSS real-time signal without filter

[1]	SRMT	Shift Register Empty Flag (valid only in Slave Mode) 0: Data has been shifted out of the Transit Buffer into the shift register or SCLK changes. 1: There is no data in the shift register or transmit and receive buffer.  Note SPI_CR0[SRMT] = 1 in Master Mode
[0]	RXBMT	Receive Register Empty Flag (Valid only in slave mode) 0: New data in the receive buffer has not been read. 1: Data has been read and there is no new data in the receive buffer.  Note SPI_CR0[RXBMT] = 1 in Master Mode

**Note**

Clock phase and idle polarity modes SPI_CR0[CPHA:CPOL]:

- > 00: Receive data on rising edge, and send on falling edge. Idle level is low
- > 01: Send data on rising edge, and receive data on falling edge. Idle level is high
- > 10: Send data on rising edge, and receive data on falling edge. Idle level is low
- > 11: Receive data on rising edge, and send data on falling edge. Idle level is high

9.3.2 SPI_CR1 (0x4031)

Bit	7	6	5	4	3	2	1	0
Name	SPIIF	WCOL	MODF	RXOVRN	NSSMOD		TXBMT	SPIEN
Type	R/W0	R/W0	R/W0	R/W0	R/W	R/W	R	R/W
Reset	0	0	0	0	0	0	1	0

Bit	Name	Description
[7]	SPIIF	SPI Interrupt Flag The flag is automatically set to 1 by hardware after each 8-bit data transmission completes. Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: Meaningless
[6]	WCOL	Write Collision Interrupt Flag When SPI_CR1[TXBMT] is "0", a write to SPI_DR sets this bit to 1. This bit can be cleared to "0" by software only. Read:

		0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: No effect.
[5]	MODF	Master Mode Error Interrupt Flag This bit is set to “1” when a master mode conflict is detected (SPI_CR0[NSSIN] = 0, SPI_CR1[SPIMS] = 1 and SPI_CR1[NSSMOD] = 01). This bit can be cleared to “0” by software only. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: No effect.
[4]	RXOVRN	Receive Overflow Interrupt Flag (Slave Mode only) This bit is set to “1” by hardware (and generates a SPI interrupt) when the Receive Buffer still holds unread data from a previous transfer and the last bit of the current transfer has been shifted into the SPI shift register. This bit cannot be cleared to “0” automatically by hardware, and can be cleared by software only. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: No effect.
[3:2]	NSSMOD	SPI Mode Selection 00: 3-Wire Slave or 3-wire Master Mode. NSS signal is not routed to a port pin. 01: 4-Wire Slave or Multi-Master Mode (Default). NSS pin is configured as an input. 1X: 4-Wire Single-Master Mode. NSS pin is configured as output and outputs SPI_CR1[2] value.
[1]	TXBMT	Transmit Buffer Empty Flag This bit is cleared to “0” when new data is written to the Transit Buffer. It is set to “1” when the data in the Transit Buffer is transferred to the SPI shift register, indicating that it is safe to write a new byte to the transmit buffer. 0: A new byte is written to the transmit buffer. 1: Data in the transmit buffer has been transferred to the shift register.
[0]	SPIEN	SPI Enable 0: Disable 1: Enable

9.3.3 SPI_CLK (0x4032)

Bit	7	6	5	4	3	2	1	0
Name	SPI_CLK							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	SPI_CLK	SPI Baud Rate Setting This bit is valid in master mode only, and can be written only when SPI_CR1[SPIEN] = 0. Baud rate = $\text{SYSCLK}/2/(\text{SPI\_CLK} + 1)$ Example: If baud rate = 2400kHz, then $\text{SPI\_CLK} = (24\text{M}/2/2400\text{k}) - 1 = 4$, i.e. 0x04. Maximum baud rate sent by the SPI master: 12 MB Maximum baud rate received by the SPI master: 4 MB Maximum baud rate sent by the SPI slave: 2.4M Maximum baud rate received by SPI slave: 2.4M  Note When MDU PI/PID and slave SPI are active at the same time (using DMA transfer), the master SPI Baud Rate shall be less than 600kHz to prevent erroneous data transmitted from the slave SPI

9.3.4 SPI_DR (0x4033)

Bit	7	6	5	4	3	2	1	0
Name	SPI_DR							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	SPI_DR	SPI Data Register SPI_DR register is for transmitting and receiving SPI data. Read: Receive the data of Receive Buffer Write: Write the data into Transit Buffer and initiate a transfer

10 UART

10.1 UART Introduction

UART is a full-duplex or half-duplex serial data exchange interface as shown in Figure 10-1. The baud rate is configurable and supports DMA transmission. Figure 10-2 depicts the UART timing.

Figure 10-1 UART Block Diagram

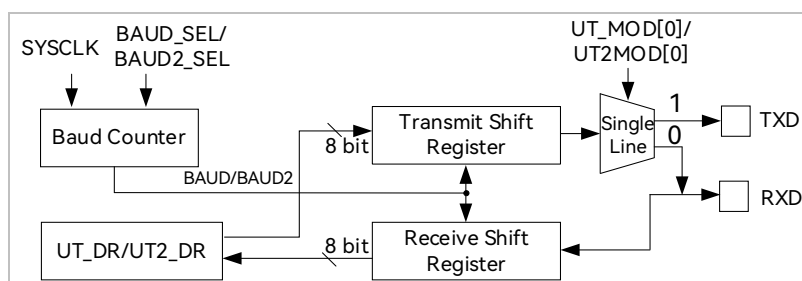
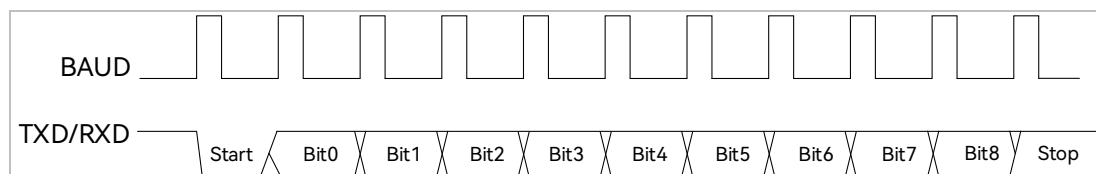


Figure 10-2 UART Timing Diagram



10.2 UART Operations

The corresponding registers shall be enabled before using UART feature. See section 21.3.17 PH_SEL (0x404C) (bit [5] and [6])~ section 21.3.18 PH_SEL1 (0x404D) for details.

10.2.1 UART1 Operating Instructions

10.2.1.1 UART1 Mode0

UART1 mode0 works in single-wire half-duplex mode. RXD pin is configured as both an output (Transmit Data Bus) and an input (Receive Data Bus). It uses a total of 10 bits (1 start bit, 8 data bits and 1 stop bit) to receive or transmit data. The baud rate is configured by UT_BAUD[BAUD].

Sending Data: Write the data to UT_DR and clear UT_CR[TI]. RXD outputs 10-bit data. UT_CR[TI] is set to "1" after the transmission is completed.

Receiving Data: Set `UT_CR[REN]` to "1" to receive the data and clear `UT_CR[RI]`. The data is received via `RXD`. After the data is received, `UT_CR[RI]` is set to "1" and `UT_DR` is read to obtain the data.

10.2.1.2 UART1 Mode1

UART1 mode1 works in full/half duplex mode. `TXD` pin is configured as an output (Transmit Data Bus), and `RXD` pin as an input (Receive Data Bus). It uses a total of 10 bits (1 start bit, 8 data bits and 1 stop bit) to receive or transmit data. The baud rate is configured by `UT_BAUD[BAUD]`.

Sending Data: Write the data to `UT_DR` and clear `UT_CR[TI]`. `TXD` outputs 10-bit data. `UT_CR[TI]` is set to "1" after the transmission is completed.

Receiving Data: Set `UT_CR[REN]` to "1" to receive the data and clear `UT_CR[RI]`. The data is received via `RXD`. After the data is received, `UT_CR[RI]` is set to "1" and `UT_DR` is read to obtain the data.

10.2.1.3 UART1 Mode2

UART1 mode2 works in single-wire half-duplex mode. `RXD` pin is configured as both an output (Transmit Data Bus) and an input (Receive Data Bus). It uses a total of 11 bits (1-bit start, 9-bit data and 1-bit stop) to receive or transmit data. The baud rate is configured by `UT_BAUD[BAUD]`.

Sending Data: Write the first 8 bits of the data to `UT_DR` and the 9th bit to `UT_CR[TB8]`, and clear `UT_CR[TI]`. `TXD` outputs 11-bit data. `UT_CR[TI]` is set to "1" after the transmission is completed.

Receiving Data: Set `UT_CR[REN]` to "1" to receive the data and clear `UT_CR[RI]`. The data is received via `RXD`. After the data is received, `UT_CR[RI]` is set to "1". `UT_CR[RB8]` stores the 9th bit of the data, and `UT_DR` stores the first 8 bits.

10.2.1.4 UART1 Mode3

UART1 mode3 works in full/half duplex mode. `TXD` pin is configured as an output (Transmit Data Bus), and `RXD` as an input (Receive Data Bus). It uses a total of 11 bits (1-bit start, 9-bit data, 1-bit stop) to receive or transmit data. The baud rate is configured by `UT_BAUD[BAUD]`.

Sending Data: Write the first 8 bits of the data to `UT_DR` and the 9th bit to `UT_CR[TB8]`, and clear `UT_CR[TI]`. `TXD` outputs 11-bit data. `UT_CR[TI]` is set to "1" after the transmission is completed.

Receiving Data: Set UT_CR[REN] to “1” to receive the data and clear UT_CR[RI]. The data is received via RXD. After the data is received, UT_CR[RI] is set to “1”. UT_CR[RB8] stores the 9th bit of the data, and UT_DR stores the first 8 bits.

10.2.1.5 UART1 Interrupt Sources

UART1 interrupt sources include:

- After UART1 transmits the data, UT_CR[TI] is set to “1” by hardware.
- After UART1 receives the data and STOP, UT_CR[RI] is set to “1” by hardware.

10.2.2 UART2 Operating Instructions

10.2.2.1 UART2 Mode0

UART2 mode0 works in single-wire half-duplex mode. RXD pin is configured as both an output (Transmit Data Bus) and an input (Receive Data Bus). It uses a total of 10 bits (1-bit start, 8-bit data, 1-bit stop) to receive or transmit data. The baud rate is configured by UT2_BAUD[BAUD2].

Sending Data: Write the data to UT2_DR and clear UT2_CR[UT2TI]. RXD outputs 10-bit data. UT2_CR[UT2TI] is set to “1” after the transmission is completed.

Receiving Data: Set UT2_CR[UT2REN] to “1” to receive the data and clear UT2_CR[UT2RI]. The data is received via RXD. After the data is received, UT2_CR[UT2RI] is set to “1” and UT2_DR is read to obtain the data.

10.2.2.2 UART2 Mode1

UART2 mode1 works in full/half duplex mode. TXD pin is configured as an output (Transmit Data Bus), and RXD as an input (Receive Data Bus). It uses a total of 10 bits (1-bit start, 8-bit data, 1-bit stop) to receive or transmit data. The baud rate is configured by UT2_BAUD[BAUD2].

Sending Data: Write the data to UT2_DR and clear UT2_CR[UT2TI]. TXD outputs 10-bit data. UT2_CR[UT2TI] is set to “1” after the transmission is completed.

Receiving Data: Set UT2_CR[UT2REN] to “1” to receive the data and clear UT2_CR[UT2RI]. The data is received via RXD. After the data is received, UT2_CR[UT2RI] is set to “1” and UT2_DR is read to obtain the data.

10.2.2.3 UART2 Mode2

UART2 mode2 works in single-wire half-duplex mode. RXD pin is configured as both an output (Transmit Data Bus) and an input (Receive Data Bus). It uses a total of 11 bits (1-bit start, 9-bit data, and 1-bit stop) to receive or transmit data. The baud rate is configured by UT2_BAUD[BAUD2].

Sending Data: Write the first 8 bits of the data to UT2_DR and the 9th bit to UT2_CR[UT2TB8], and clear UT2_CR[UT2TI]. TXD outputs 11-bit data. UT2_CR[UT2TI] is set to “1” after the transmission is completed.

Receiving Data: Set UT2_CR[UT2REN] to “1” to receive the data and clear UT2_CR[UT2RI]. The data is received via RXD. After the data is received, UT2_CR[UT2RI] is set to “1”. UT2_CR[UT2RB8] stores the 9th bit of the data, and UT2_DR stores the first 8 bits.

10.2.2.4 UART2 Mode3

UART2 mode3 works in full/half duplex mode. TXD pin is configured as an output (Transmit Data Bus), and RXD as an input (Receive Data Bus). It uses a total of 11 bits (1-bit start, 9-bit data, 1-bit stop) to receive or transmit data. The baud rate is configured by UT2_BAUD[BAUD2].

Sending Data: Write the first 8 bits of the data to UT2_DR and the 9th bit to UT2_CR[UT2TB8], and clear UT2_CR[UT2TI]. TXD outputs 11-bit data. UT2_CR[UT2TI] is set to “1” after the transmission is completed.

Receiving Data: Set UT2_CR[UT2REN] to “1” to receive the data and clear UT2_CR[UT2RI]. The data is received via RXD. After the data is received, UT2_CR[UT2RI] is set to “1”. UT2_CR[UT2RB8] stores the 9th bit of the data, and UT2_DR stores the first 8 bits.

10.2.2.5 UART2 Interrupt Sources

UART2 interrupt sources:

- After UART2 transmits data, UT2_CR[UT2TI] is set to “1” by hardware.
- After UART2 receives data and STOP, UT2_CR[UT2RI] is set to “1” by hardware.

10.3 UART1 Registers

10.3.1 UT_CR (0x98)

Bit	7	6	5	4	3	2	1	0
Name	UT_MOD		SM2	REN	TB8	RB8	TI	RI
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:6]	UT_MOD	Mode Selection 00: Mode0 01: Mode1 10: Mode2 11: Mode3
[5]	SM2	Communication Mode Selection 0: Single-device Communication 1: Multi-device Communication
[4]	REN	Receive Enable 0: Disable 1: Enable
[3]	TB8	Bit9 of the Transmitted Data in Mode2 and Mode3
[2]	RB8	Bit9 of the Received Data in Mode2 and Mode3
[1]	TI	Data Transmitting Completed Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0". 1: Interrupt Pending
[0]	RI	Data Receiving Completed Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0". 1: Interrupt Pending

10.3.2 UT_DR (0x99)

Bit	7	6	5	4	3	2	1	0
Name	UT_DR							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	UT_DR	Transmit/ Receive Data Read: Data received Write: Data to be transmitted  Note The UART1 data buffer consists of two independent buffers, i.e., a receive buffer and a transmit buffer, which can send and receive data at the same time. The transmit buffer can be written only but not read, while the receive buffer can be read only but not written. Both buffers share a same address

10.3.3 UT_BAUD (0x9A, 0x9B)

UT_BAUDH (0x9B)								
Bit	15	14	13	12	11	10	9	8
Name	BAUD_SEL	UART_RX_INV	UART_TX_INV	RSV	BAUD[11:8]			
Type	R/W	R/W	R/W	-	R/W	R/W	R/W	R/W
Reset	0	0	0	-	0	0	0	0
UT_BAUDL(0x9A)								
Bit	7	6	5	4	3	2	1	0
Name	BAUD[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	0	0	1	1	0	1	1

Bit	Name	Description
[15]	BAUD_SEL	Frequency Multiplier Enable 0: Disable 1: Enable
[14]	UART_RX_INV	Receive Inverting Enable 0: Disable 1: Enable
[13]	UART_TX_INV	Transmit Inverting Enable 0: Disable 1: Enable

[12]	RSV	Reserved
[11:0]	BAUD	Baud Rate Setting $\text{Baud rate} = \text{SYSCLK} / (16 / (1 + \text{UT\_BAUD}[\text{BAUD\_SEL}])) / (\text{UT\_BAUD}[\text{BAUD}] + 1)$ Example: If baud rate = 9600 and $\text{UT\_BAUD}[\text{BAUD\_SEL}] = 0$, then $\text{UT\_BAUD}[\text{BAUD}] = (24\text{M} / 16 / 9600 / (1 + 0)) - 1 = 155$, i.e., 0x9B

10.4 UART2 Registers

10.4.1 UT2_CR (0xD8)

Bit	7	6	5	4	3	2	1	0
Name	UT2MOD		UT2SM2	UT2REN	UT2TB8	UT2RB8	UT2TI	UT2RI
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:6]	UT2MOD	Mode Selection 00: Mode0 01: Mode1 10: Mode2 11: Mode3
[5]	UT2SM2	Communication Mode Selection 0: Single-device Communication 1: Multi-device Communication
[4]	UT2REN	Receive Enable 0: Disable 1: Enable
[3]	UT2TB8	Bit9 of the Transmitted Data in Mode2 and Mode3
[2]	UT2RB8	Bit9 of the Received Data in Mode2 and Mode3
[1]	UT2TI	Data Transmitting Completed Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0". 1: Interrupt Pending
[0]	UT2RI	Data Receiving Completed Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0".

1: Interrupt Pending

10.4.2 UT2_DR (0x89)

Bit	7	6	5	4	3	2	1	0
Name	UT2_DR							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	UT2_DR	Transmit/Receive Data Read: Data received Write: Data to be transmitted  Note The UART2 data buffer consists of two independent buffers, i.e., a receive buffer and a transmit buffer, which can send and receive data at the same time. The transmit buffer can be written only but not read, while the receive buffer can be read only but not written. Both buffers share a same address

10.4.3 UT2_BAUD (0x4042, 0x4043)

UT2_BAUDH(0x4042)								
Bit	15	14	13	12	11	10	9	8
Name	BAUD2_SEL	UART2_RX_INV	UART2_TX_INV	UART2IEN	BAUD2[11:8]			
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

UT2_BAUDL(0x4043)								
Bit	7	6	5	4	3	2	1	0
Name	BAUD2[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	0	0	1	1	0	1	1

Bit	Name	Description
[15]	BAUD2_SEL	Frequency Multiplier Enable 0: Disable 1: Enable
[14]	UART2_RX_INV	Receive Inverting Enable 0: Disable 1: Enable
[13]	UART2_TX_INV	Transmit Inverting Enable 0: Disable

		1: Enable
[12]	UART2IEN	UART2 Interrupt Enable 0: Disable 1: Enable
[11:0]	BAUD2	Baud Rate Setting Baud rate = $\text{SYSCLK}/(16/(1 + \text{UT2\_BAUD}[\text{BAUD2\_SEL}]))/(\text{UT2\_BAUD}[\text{BAUD2}] + 1)$ Example: If baud rate = 9600 and $\text{UT2\_BAUD}[\text{BAUD\_SEL}] = 0$, then $\text{UT2\_BAUD}[\text{BAUD2}] = (24\text{M}/16/9600/(1 + 0)) - 1 = 155$, i.e., 0x9B

11 MDU

11.1 MDU Introduction

MDU is a built-in computing co-processor that assists the CPU in processing complex operations efficiently. It supports multiplication, division, trigonometric operation, LPF operation and PID operation. MDU module can be invoked in different interrupt services and master programs, and the results are independent from each other.

11.2 MDU Features

The MDU module has the following features:

- Support invocation with nested interrupt
- Hardware acceleration to reduce CPU load
- Support the following modes:
 - 16-bit signed multiplication
 - 16-bit signed multiplication (result shifted left by one-bit)
 - 16-bit unsigned multiplication
 - 32-bit/16-bit unsigned division
 - Low-pass filter (LPF)
 - Coordinate transformation (SIN/COS)
 - Arctangent (ATAN)
 - PI/PID

11.3 MDU Instructions

11.3.1 MDU Operations

MDU is operated as follows:

1. Configure MDU_CR[MDUMOD] register to select computing mode of the MDU module;

2. Write the data to the associated computing units, and configure MDU_CR[MDUSTA] to select computing unit of the MDU module, and start MDU computing;
3. Wait for MDU_CR[MDUBSY] to be cleared to “0” by hardware.

**Note**

When using MDU, ensure that the computing mode and other data have been written before configuring MDU_CR[MDUSTA]

11.3.2 16-bit Signed Multiplication with the Result Shifted Left by One-bit

When MDU_CR[MDUMOD] = 000, MDU module works in the 16-bit signed multiplication mode with the result shifted left by one-bit. As shown in Table 11-1, after 16-bit signed data is written to MULx_MA and MULx_MB as multiplicand and multiplier respectively, 32-bit signed data is obtained by the product shifting left by one bit. The result is accessed by reading MULx_MC register.

Table 11-1 Register Definitions in 16-bit Signed Multiplication Mode with Result Shifted Left by One-bit

Data Register	Input	Output
MULx_MA	Multiplicand	–
MULx_MB	Multiplier	–
MULx_MC	–	Product

11.3.3 16-bit Signed Multiplication

When MDU_CR[MDUMOD] = 001, MDU module works in the 16-bit signed multiplication mode. As shown in Table 11-2, 31-bit signed data is obtained after 16-bit signed data is written to MULx_MA and MULx_MB as multiplicand and multiplier respectively. The result is accessed by reading MULx_MC register.

Table 11-2 Register Definitions in 16-bit Signed Multiplication Mode

Data Register	Input	Output
MULx_MA	Multiplicand	–
MULx_MB	Multiplier	–
MULx_MC	–	Product

11.3.4 16-bit Unsigned Multiplication

When MDU_CR[MDUMOD] = 010, MDU module works in the 16-bit unsigned multiplication mode. As shown in Table 11-3, 32-bit unsigned data is obtained after 16-bit unsigned data is written to MULx_MA and MULx_MB as multiplicand and multiplier respectively. The result is accessed by reading MULx_MC register.

Table 11-3 Register Definitions in 16-bit Unsigned Multiplication Mode

Data Register	Input	Output
MULx_MA	Multiplicand	-
MULx_MB	Multiplier	-
MULx_MC	-	Product

11.3.5 32-bit/16-bit Unsigned Division

When MDU_CR[MDUMOD] = 011, MDU module works in the 32-bit/16-bit unsigned division mode. As shown in Table 11-4, 32-bit unsigned quotient and 16-bit unsigned remainder is obtained after 32-bit unsigned dividend and a 16-bit unsigned divisor are written to DIVx_DA and DIVx_DB registers respectively. The quotient and remainder are accessed by reading DIVx_DQ and DIVx_DR registers respectively.

Table 11-4 Register Definitions in the Unsigned Division Mode

Data Register	Input	Output
DIVx_DA	Multiplicand	-
DIVx_DB	Multiplier	-
DIVx_DQ	-	Quotient
DIVx_DR	-	Remainder

11.3.6 Low-pass Filter (LPF)

When MDU_CR[MDUMOD] = 110, MDU module works in LPF mode.

The calculation formula of LPF is:

$$Y_k = Y_{k-1} + K \times (X_k - Y_{k-1})$$

Where,

Y_k : Filtered value

Y_{k-1} : Previous filtered output

K : Filter coefficient

X_k : Value to be filtered

As shown in Table 11-5, Y_k and Y_{k-1} are 32-bit signed data, X_k and K are 16-bit signed data. Y_k is obtained after Y_{k-1} is written to LPFx_Y, K to LPFx_K and X_k to LPFx_X, and is accessed by reading LPFx_Y.

Table 11-5 Register Definitions in LPF Mode

Data Register	Input	Output
LPFx_X	X_k	-
LPFx_K	K	-
LPFx_Y	Y_{k-1}	Y_k

11.3.7 Coordinate Transformation (sin/cos Calculation)

When MDU_CR[MDUMOD] = 100, MDU module works in Coordinate Transformation mode. As shown in Figure 11-1, the coordinate transformation converts the components $\cos_i$ and $\sin_i$ of vector A under the x-y axis to the components $\cos_o$ and $\sin_o$ under the x'-y' axis, with the x'-y' axis lagging the x-y axis by θ .

The formula for coordinate transformation is:

$$\cos_o = \cos_i \times \cos \theta - \sin_i \times \sin \theta$$

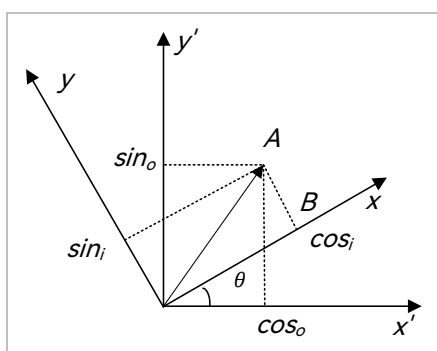
$$\sin_o = \cos_i \times \sin \theta + \sin_i \times \cos \theta$$

In particular, when $\sin_i = 0$, the coordinate transformation is a sine and cosine calculation with $\cos_i$ as the amplitude, calculated as:

$$\cos_o = \cos_i \times \cos \theta$$

$$\sin_o = \cos_i \times \sin \theta$$

Figure 11-1 Coordinate Transformation



As shown in Table 11-6, $\cos_i$, $\sin_i$, θ , $\cos_o$ and $\sin_o$ are all 16-bit signed data. $\cos_i$ is written to SCATx_COS, $\sin_i$ to SCATx_SIN and θ to SCATx_THE to calculate $\cos_o$ and $\sin_o$. The results $\cos_o$ and $\sin_o$ are accessed by reading SCATx_RES1 and SCATx_RES2 respectively.

Table 11-6 Register Definitions in the Coordinate Transformation Mode

Data Register	Input	Output
SCATx_COS	$\cos_i$	-
SCATx_SIN	$\sin_i$	-
SCATx_THE	θ	-
SCATx_RES1	-	$\cos_o$
SCATx_RES2	-	$\sin_o$

11.3.8 Arctangent

When MDU_CR[MDUMOD] = 101, MDU module works in arctangent (ATAN) mode.

ATAN calculates the amplitude and angle of a vector based on sine and cosine inputs. The calculation formula is:

$$U = \sqrt{(U \sin \theta)^2 + (U \cos \theta)^2}$$

$$\theta = \tan^{-1} \left(\frac{U \sin \theta}{U \cos \theta} \right)$$

Where,

$U \sin \theta$. Sin component of the vector

$U \cos \theta$. Cosine component of the vector

θ . Calculated vector angle

U . Calculated vector amplitude

As shown in Table 11-7, $U \cos \theta$ and $U \sin \theta$, U and θ are 16-bit signed data. $U \cos \theta$ is written to SCATx_COS and $U \sin \theta$ to SCATx_SIN to calculate U and θ . U and θ are accessed by reading SCATx_RES1 and SCATx_RES2 respectively.

Table 11-7 Register Definitions in ATAN Mode

Data Register	Input	Output
SCATx_COS	$U \cos \theta$	-
SCATx_SIN	$U \sin \theta$	-
SCATx_RES1	-	U
SCATx_RES2	-	θ

11.3.9 PI/PID

11.3.9.1 PI/PID Introduction

PI/PID regulator is a linear controller, where the output is generated by linear combination of error proportional, integral and differential actions, and then implemented by an actuator. In motor control system, it is used to for speed and position control.

PI algorithm:

$$U_k = U_{k-1} + Kp \times (E_k - E_{k-1}) + Ki \times E_k$$

PID algorithm:

$$U_k = U_{k-1} + Kp \times (E_k - E_{k-1}) + Ki \times E_k + Kd \times (E_k - 2 \times E_{k-1} + E_{k-2})$$

Where,

U_k : Output for round k of calculation

U_{k-1} : Output for round $k-1$ of calculation

E_k : Deviation for round k of input

E_{k-1} and E_{k-2} : Deviations for round $k-1$ and round $k-2$ of calculation

K_p , K_i and K_d : Proportional (P), integral (I) and differential (D) coefficients of regulator

The maximum U_k is represented as Plx_UKMAX ($x=0\sim3$) and the minimum value as Plx_UKMIN

11.3.9.2 PI/PID Features

- > Parameter range is configurable
- > Support multiple invocations but not with nested interrupt
- > Produce a 32-bit result Plx_UK
- > Results are read after Busy Flag is reset to “0”

11.3.9.3 PI/PID Operations

1. Initialize MDU before the operations, and configure K_p , K_i , K_d and the maximum and minimum values of

U_k ;

2. Set MDU_CR[MDUMOD] to 111, and then select Comp_Unit0 and Comp_Unit1 as PI Mode, and Comp_Unit2 and Comp_Unit3 as PID Mode. Later, configure MDU_CR[MDUSTA] bit to select the desired computing unit and start PI/PID computing. At this time, busy flag MDU_CR[MDUBSY] is automatically set to “1”.
3. Read MDU_CR[MDUBSY] bit by software. When this bit is 0, it indicates that the calculation is completed, and calculation result Plx_UK is updated.
4. Read Plx_UK to obtain the output.



Note

- > The data format of PI_KP is Q12 and that of other registers are Q15.
- > Plx_UK and Plx_EK1 values default to the previous calculated U_k and E_k . The related values change after Plx_EK1 and Plx_UK are written.
- > When PI controller is invoked repeatedly, relevant parameters shall be saved after each PI operation, and initialized before the next PI operation. Initialization codes are shown as below:

```

Plx_KP = KP;                // Initialize  $K_p$ 

Plx_KI = KI;                // Initialize  $K_i$ 

Plx_KD = KD;                // Initialize  $K_d$ 

Plx_UKMAX = UKMAX;          // Initialize maximum output

Plx_UKMIN = UKMIN;          // Initialize minimum output

Plx_EK1 = X;                // Initialize  $E_{k-1}$ 

Plx_UKH = Y1;               // Initialize 16 high-order bits of  $U_{k-1}$ 

Plx_UKL = Y2;               // Initialize 16 low-order bits of  $U_{k-1}$ 

```

11.4 MDU Registers

11.4.1 MDU_CR (0xC1)

Bit	7	6	5	4	3	2	1	0
Name	MDUBSY	MDUSTA				MDUMOD		
Type	R	R/W1	R/W1	R/W1	R/W1	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	MDUBSY	MDU Busy Flag A write of MDU_CR[6:3] to this bit starts MDU module. The bit is set to “1” after MDU completes operations.
[6:3]	MDUSTA	The bit is used to configure computing unit of the MDU. Four options are available. MDU module starts operation after initiating the computing. 0001: Comp_Unit0 activated 0010: Comp_Unit1 activated 0100: Comp_Unit2 activated 1000: Comp_Unit3 activated
[2:0]	MDUMOD	MDU Mode Selection 000: 16-bit Signed Multiplication (the result shifted left by one-bit) 001: 16-bit Signed Multiplication 010: 16-bit Unsigned Multiplication 011: 32-bit/16-bit Unsigned Division 100: Coordinate Transformation (SIN/COS) 101: ATAN 110: LPF 111: PI/PID; The mode of PI and PID is determined by the computing unit. The computing unit 0 and 1 select PI mode, and the computing unit 2 and 3 select PID mode.

11.4.2 MUL0_MA (0x0FA0, 0x0FA1)

MUL0_MAH(0x0FA0)								
Bit	15	14	13	12	11	10	9	8
Name	MUL0_MA[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL0_MAL(0x0FA1)								
Bit	7	6	5	4	3	2	1	0
Name	MUL0_MA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	MUL0_MA	Data register A of MUL0; Multiplicand of the multiplication

11.4.3 MUL0_MB (0x0FA2, 0x0FA3)

MUL0_MBH(0x0FA2)								
Bit	15	14	13	12	11	10	9	8
Name	MUL0_MB[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL0_MBL(0x0FA3)								
Bit	7	6	5	4	3	2	1	0
Name	MUL0_MB[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	MUL0_MB	Data register B of MUL0; Multiplicand of the multiplication

11.4.4 MUL0_MC (0x0FA4, 0x0FA5, 0x0FA6, 0x0FA7)

MUL0_MCHH(0x0FA4)								
Bit	31	30	29	28	27	26	25	24
Name	MUL0_MC[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL0_MCHL(0x0FA5)								
Bit	23	22	21	20	19	18	17	16
Name	MUL0_MC[13:16]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL0_MCLH(0x0FA6)								
Bit	15	14	13	12	11	10	9	8
Name	MUL0_MC[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL0_MCLL(0x0FA7)								
Bit	7	6	5	4	3	2	1	0
Name	MUL0_MC[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	Name		Description					
[31:0]	MUL0_MC		Product of MUL0. The 16 high-order bits of the data is held by MUL0_MCH and the 16 low-order bits by MUL0_MCL.					

11.4.5 MUL1_MA (0x0F98, 0x0F99)

MUL1_MAH(0x0F98)								
Bit	15	14	13	12	11	10	9	8
Name	MUL1_MA[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL1_MAL(0x0F99)								
Bit	7	6	5	4	3	2	1	0
Name	MUL1_MA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	Name		Description					
[15:0]	MUL1_MA		Data register A of MUL1; Multiplicand of the multiplication					

11.4.6 MUL1_MB (0x0F9A, 0x0F9B)

MUL1_MBH(0x0F9A)								
Bit	15	14	13	12	11	10	9	8
Name	MUL1_MB[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL1_MBL(0x0F9B)								
Bit	7	6	5	4	3	2	1	0
Name	MUL1_MB[7:0]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	MUL1_MB	Data register B of MUL1; Multiplier of the multiplication

11.4.7 MUL1_MC (0x0F9C, 0x0F9D, 0x0F9E, 0x0F9F)

MUL1_MCHH(0x0F9C)								
Bit	31	30	29	28	27	26	25	24
Name	MUL1_MC[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL1_MCHL(0x0F9D)								
Bit	23	22	21	20	19	18	17	16
Name	MUL1_MC[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL1_MCLH(0x0F9E)								
Bit	15	14	13	12	11	10	9	8
Name	MUL1_MC[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL1_MCLL(0x0F9F)								
Bit	7	6	5	4	3	2	1	0
Name	MUL1_MC[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	MUL1_MC	Product of MUL1. The 16 high-order bits of the data is held by MUL1_MCH and the 16 low-order bits by MUL1_MCL.

11.4.8 MUL2_MA (0x0F40, 0x0F41)

MUL2_MAH(0x0F40)								
Bit	15	14	13	12	11	10	9	8
Name	MUL2_MA[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL2_MAL(0x0F41)								
Bit	7	6	5	4	3	2	1	0
Name	MUL2_MA[7:0]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	MUL2_MA	Data register A of MUL2; Multiplicand of the multiplication

11.4.9 MUL2_MB (0x0F42, 0x0F43)

MUL2_MBH(0x0F42)								
Bit	15	14	13	12	11	10	9	8
Name	MUL2_MB[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL2_MBL(0x0F43)								
Bit	7	6	5	4	3	2	1	0
Name	MUL2_MB[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	MUL2_MB	Data register B of MUL2; Multiplier of the multiplication

11.4.10 MUL2_MC (0x0F44, 0x0F45, 0x0F46, 0x0F47)

MUL2_MCHH(0x0F44)								
Bit	31	30	29	28	27	26	25	24
Name	MUL2_MC[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL2_MCHL(0x0F45)								
Bit	23	22	21	20	19	18	17	16
Name	MUL2_MC[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL2_MCLH(0x0F46)								
Bit	15	14	13	12	11	10	9	8
Name	MUL2_MC[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL2_MCLL(0x0F47)								
Bit	7	6	5	4	3	2	1	0

Name	MUL2_MC[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	MUL2_MC	Product of MUL2. The 16 high-order bits of the data is held by MUL2_MCH and the 16 low-order bits by MUL2_MCL.

11.4.11 MUL3_MA (0x0F38, 0x0F39)

MUL3_MAH(0x0F38)								
Bit	15	14	13	12	11	10	9	8
Name	MUL3_MA[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL3_MAL(0x0F39)								
Bit	7	6	5	4	3	2	1	0
Name	MUL3_MA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	MUL3_MA	Data register A of MUL3; Multiplicand of the multiplication

11.4.12 MUL3_MB (0x0F3A, 0x0F3B)

MUL3_MBH(0x0F3A)								
Bit	15	14	13	12	11	10	9	8
Name	MUL3_MB[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL3_MBL(0x0F3B)								
Bit	7	6	5	4	3	2	1	0
Name	MUL3_MB[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	MUL3_MB	Data register B of MUL3; Multiplier of the multiplication

11.4.13 MUL3_MC (0x0F3C, 0x0F3D, 0x0F3E, 0x0F3F)

MUL3_MCHH(0x0F3C)								
Bit	31	30	29	28	27	26	25	24
Name	MUL3_MC[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL3_MCHL(0x0F3D)								
Bit	23	22	21	20	19	18	17	16
Name	MUL3_MC[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL3_MCLH(0x0F3E)								
Bit	15	14	13	12	11	10	9	8
Name	MUL3_MC[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
MUL3_MCLL(0x0F3F)								
Bit	7	6	5	4	3	2	1	0
Name	MUL3_MC[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	MUL3_MC	Product of MUL3. The 16 high-order bits of the data is held by MUL3_MCH and the 16 low-order bits by MUL3_MCL.

11.4.14 DIV0_DA (0x0F8C, 0x0F8D, 0x0F8E, 0x0F8F)

DIV0_DAHH(0x0F8C)								
Bit	31	30	29	28	27	26	25	24
Name	DIV0_DA[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV0_D AHL(0x0F8D)								
Bit	23	22	21	20	19	18	17	16
Name	DIV0_DA[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV0_D ALH(0x0F8E)								
Bit	15	14	13	12	11	10	9	8
Name	DIV0_DA[15:8]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV0_DALL(0x0F8F)								
Bit	7	6	5	4	3	2	1	0
Name	DIV0_DA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	DIV0_DA	Dividend of DIV0. The 16 high-order bits of the data is held by DIV0_DAH and the 16 low-order bits by DIV0_DAL.

11.4.15 DIV0_DB (0x0F90, 0x0F91)

DIV0_DBH(0x0F90)								
Bit	15	14	13	12	11	10	9	8
Name	DIV0_DB[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV0_DBL(0x0F91)								
Bit	7	6	5	4	3	2	1	0
Name	DIV0_DB[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	DIV0_DB	Data register B of DIV0; Divisor of the division

11.4.16 DIV0_DQ (0x0F92, 0x0F93, 0x0F94, 0x0F95)

DIV0_DQHH(0x0F92)								
Bit	31	30	29	28	27	26	25	24
Name	DIV0_DQ[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV0_DQHL(0x0F93)								
Bit	23	22	21	20	19	18	17	16
Name	DIV0_DQ[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV0_DQLH(0x0F94)								
Bit	15	14	13	12	11	10	9	8
Name	DIV0_DQ[15:8]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV0_DQLL(0x0F95)								
Bit	7	6	5	4	3	2	1	0
Name	DIV0_DQ[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	DIV0_DQ	Quotient of DIV0. The 16 high-order bits of the data is held by DIV0_DQH and the 16 low-order bits by DIV0_DQL.

11.4.17 DIV0_DR (0x0F96, 0x0F97)

DIV0_DRH(0x0F96)								
Bit	15	14	13	12	11	10	9	8
Name	DIV0_DR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV0_DRL(0x0F97)								
Bit	7	6	5	4	3	2	1	0
Name	DIV0_DR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	DIV0_DR	Remainder of DIV0

11.4.18 DIV1_DA (0x0F80, 0x0F81, 0x0F82, 0x0F83)

DIV1_DAHH(0x0F80)								
Bit	31	30	29	28	27	26	25	24
Name	DIV1_DA[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV1_D AHL(0x0F81)								
Bit	23	22	21	20	19	18	17	16
Name	DIV1_DA[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV1_D ALH(0x0F82)								
Bit	15	14	13	12	11	10	9	8

Name					DIV1_DA[15:8]			
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV1_DALL(0x0F83)								
Bit	7	6	5	4	3	2	1	0
Name								
DIV1_DA[7:0]								
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	DIV1_DA	Dividend of DIV1. The 16 high-order bits of the data is held by DIV1_DA and the 16 low-order bits by DIV1_DA.

11.4.19 DIV1_DB (0x0F84, 0x0F85)

DIV1_DBH(0x0F84)								
Bit	15	14	13	12	11	10	9	8
Name	DIV1_DB[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV1_DBL(0x0F85)								
Bit	7	6	5	4	3	2	1	0
Name	DIV1_DB[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	Name		Description					
[15:0]	DIV1_DB		Data register B of DIV1; Divisor of the division					

11.4.20 DIV1_DQ (0x0F86, 0x0F87, 0x0F88, 0x0F89)

DIV1_DQHH(0x0F86)								
Bit	31	30	29	28	27	26	25	24
Name	DIV1_DQ[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV1_DQHL(0x0F87)								
Bit	23	22	21	20	19	18	17	16
Name	DIV1_DQ[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV1_DQLH(0x0F88)								

Bit	15	14	13	12	11	10	9	8
Name	DIV1_DQ[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV1_DQLL(0x0F89)								
Bit	7	6	5	4	3	2	1	0
Name	DIV1_DQ[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	DIV1_DQ	Quotient of DIV1. The 16 high-order bits of the data is held by DIV1_DQH and the 16 low-order bits by DIV1_DQL.

11.4.21 DIV1_DR (0x0F8A, 0x0F8B)

DIV1_DRH(0x0F8A)								
Bit	15	14	13	12	11	10	9	8
Name	DIV1_DR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV1_DRL(0x0F8B)								
Bit	7	6	5	4	3	2	1	0
Name	DIV1_DR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	DIV1_DR	Remainder of DIV1

11.4.22 DIV2_DA (0x0F2C, 0x0F2D, 0x0F2E, 0x0F2F)

DIV2_DAHH(0x0F2C)								
Bit	31	30	29	28	27	26	25	24
Name	DIV2_DA[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV2_D AHL(0x0F2D)								
Bit	23	22	21	20	19	18	17	16
Name	DIV2_DA[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

DIV2_DALH(0x0F2E)								
Bit	15	14	13	12	11	10	9	8
Name	DIV2_DA[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV2_DALL(0x0F2F)								
Bit	7	6	5	4	3	2	1	0
Name	DIV2_DA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	Name		Description					
[31:0]	DIV2_DA		Dividend of DIV2. The 16 high-order bits of the data is held by DIV2_DA and the 16 low-order bits by DIV2_DA.					

11.4.23 DIV2_DB (0x0F30, 0x0F31)

DIV2_DBH(0x0F30)								
Bit	15	14	13	12	11	10	9	8
Name	DIV2_DB[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV2_DBL(0x0F31)								
Bit	7	6	5	4	3	2	1	0
Name	DIV2_DB[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	Name		Description					
[15:0]	DIV2_DB		Data register B of DIV2; Divisor of the division					

11.4.24 DIV2_DQ (0x0F32, 0x0F33, 0x0F34, 0x0F35)

DIV2_DQHH(0x0F32)								
Bit	31	30	29	28	27	26	25	24
Name	DIV2_DQ[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV2_DQHL(0x0F33)								
Bit	23	22	21	20	19	18	17	16
Name	DIV2_DQ[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0
DIV2_DQLH(0x0F34)								
Bit	15	14	13	12	11	10	9	8
Name	DIV2_DQ[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV2_DQLL(0x0F35)								
Bit	7	6	5	4	3	2	1	0
Name	DIV2_DQ[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	DIV2_DQ	Quotient of DIV2. The 16 high-order bits of the data is held by DIV2_DQH and the 16 low-order bits by DIV2_DQL.

11.4.25 DIV2_DR (0x0F36, 0x0F37)

DIV2_DRH(0x0F36)								
Bit	15	14	13	12	11	10	9	8
Name	DIV2_DR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV2_DRL(0x0F37)								
Bit	7	6	5	4	3	2	1	0
Name	DIV2_DR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	DIV2_DR	Remainder of DIV2

11.4.26 DIV3_DA (0x0F20, 0x0F21, 0x0F22, 0x0F23)

DIV3_DAHH(0x0F20)								
Bit	31	30	29	28	27	26	25	24
Name	DIV3_DA[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV3_D AHL(0x0F21)								
Bit	23	22	21	20	19	18	17	16
Name	DIV3_DA[23:16]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV3_DALH(0x0F22)								
Bit	15	14	13	12	11	10	9	8
Name	DIV3_DA[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV3_DALL(0x0F23)								
Bit	7	6	5	4	3	2	1	0
Name	DIV3_DA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	DIV3_DA	Dividend of DIV3. The 16 high-order bits of the data is held by DIV3_DAH and the 16 low-order bits by DIV3_DAL.

11.4.27 DIV3_DB (0x0F24, 0x0F25)

DIV3_DBH(0x0F24)								
Bit	15	14	13	12	11	10	9	8
Name	DIV3_DB[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV3_DBL(0x0F25)								
Bit	7	6	5	4	3	2	1	0
Name	DIV3_DB[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	DIV3_DB	Data register B of DIV3; Divisor of the division

11.4.28 DIV3_DQ (0x0F26, 0x0F27, 0x0F28, 0x0F29)

DIV3_DQHH(0x0F26)								
Bit	31	30	29	28	27	26	25	24
Name	DIV3_DQ[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV3_DQHL(0x0F27)								
Bit	23	22	21	20	19	18	17	16

Name	DIV3_DQ[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV3_DQLH(0x0F28)								
Bit	15	14	13	12	11	10	9	8
Name	DIV3_DQ[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV3_DQLL(0x0F29)								
Bit	7	6	5	4	3	2	1	0
Name	DIV3_DQ[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	DIV3_DQ	Quotient of DIV3. The 16 high-order bits of the data is held by DIV3_DQH and the 16 low-order bits by DIV3_DQL.

11.4.29 DIV3_DR (0x0F2A, 0x0F2B)

DIV3_DRH(0x0F2A)								
Bit	15	14	13	12	11	10	9	8
Name	DIV3_DR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DIV3_DRL(0x0F2B)								
Bit	7	6	5	4	3	2	1	0
Name	DIV3_DR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	DIV3_DR	Remainder of DIV3

11.4.30 SCAT0_COS (0x0F16, 0x0F17)

SCAT0_COSH(0x0F16)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT0_COS[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT0_COSL(0x0F17)								

Bit	7	6	5	4	3	2	1	0
Name	SCAT0_COS[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT0_COS	COS input in SIN/COS or ATAN mode of computing unit SCAT0

11.4.31 SCAT0_SIN (0x0F18, 0x0F19)

SCAT0_SINH(0x0F18)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT0_SIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT0_SINL(0x0F19)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT0_SIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT0_SIN	SIN input in SIN/COS or ATAN mode of computing unit SCAT0

11.4.32 SCAT0_THE (0x0F1A, 0x0F1B)

SCAT0_THEH(0x0F1A)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT0_THE[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT0_THEL(0x0F1B)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT0_THE[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT0_THE	THE input in SIN/COS mode of computing unit SCAT0

11.4.33 SCAT0_RES1 (0x0F1C, 0x0F1D)

SCAT0_RES1H(0x0F1C)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT0_RES1[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT0_RES1L(0x0F1D)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT0_RES1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT0_RES1	COS output in SIN/COS mode of computing unit SCAT0; U output in ATAN mode

11.4.34 SCAT0_RES2 (0x0F1E, 0x0F1F)

SCAT0_RES2H(0x0F1E)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT0_RES2[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT0_RES2L(0x0F1F)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT0_RES2[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT0_RES2	SIN output in SIN/COS mode of computing unit SCAT0; θ output in ATAN mode

11.4.35 SCAT1_COS (0x0F0C, 0x0F0D)

SCAT1_COSH(0x0F0C)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT1_COS[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT1_COSL(0x0F0D)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT1_COS[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT1_COS	COS input in SIN/COS or ATAN mode of computing unit SCAT1

11.4.36 SCAT1_SIN (0x0F0E, 0x0F0F)

SCAT1_SINH(0x0F0E)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT1_SIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT1_SINL(0x0F0F)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT1_SIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT1_SIN	SIN input in SIN/COS or ATAN mode of computing unit SCAT1

11.4.37 SCAT1_THE (0x0F10, 0x0F11)

SCAT1_THEH(0x0F10)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT1_THE[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT1_THEL(0x0F11)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT1_THE[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT1_THE	THE input in SIN/COS mode of computing unit SCAT1

11.4.38 SCAT1_RES1 (0x0F12, 0x0F13)

SCAT1_RES1H(0x0F12)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT1_RES1[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT1_RES1L(0x0F13)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT1_RES1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT1_RES1	COS output in SIN/COS mode of computing unit SCAT1; <i>U</i> output in ATAN mode

11.4.39 SCAT1_RES2 (0x0F14, 0x0F15)

SCAT1_RES2H(0x0F14)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT1_RES2[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT1_RES2L(0x0F15)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT1_RES2[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT1_RES2	SIN output in SIN/COS mode of computing unit SCAT1; <i>U</i> output in ATAN mode

11.4.40 SCAT2_COS (0x0F02, 0x0F03)

SCAT2_COSH(0x0F02)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT2_COS[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT2_COSL(0x0F03)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT2_COS[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT2_COS	COS input in SIN/COS or ATAN mode of computing unit SCAT2

11.4.41 SCAT2_SIN (0x0F04, 0x0F05)

SCAT2_SINH(0x0F04)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT2_SIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT2_SINL(0x0F05)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT2_SIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT2_SIN	SIN input in SIN/COS or ATAN mode of computing unit SCAT2

11.4.42 SCAT2_THE (0x0F06, 0x0F07)

SCAT2_THEH(0x0F06)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT2_THE[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT2_THEL(0x0F07)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT2_THE[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT2_THE	THE input in SIN/COS mode of computing unit SCAT2

11.4.43 SCAT2_RES1 (0x0F08, 0x0F09)

SCAT2_RES1H(0x0F08)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT2_RES1[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT2_RES1L(0x0F09)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT2_RES1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT2_RES1	COS output in SIN/COS mode of computing unit SCAT2; U output in ATAN mode

11.4.44 SCAT2_RES2 (0x0F0A, 0x0F0B)

SCAT2_RES2H(0x0F0A)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT2_RES[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT2_RES2L(0x0F0B)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT2_RES[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT2_RES2	SIN output in SIN/COS mode of computing unit SCAT2; θ output in ATAN mode

11.4.45 SCAT3_COS (0x0EF8, 0x0EF9)

SCAT3_COSH(0x0EF8)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT3_COS[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT3_COSL(0x0EF9)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT3_COS[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT3_COS	COS input in SIN/COS or ATAN mode of computing unit SCAT3

11.4.46 SCAT3_SIN (0x0EFA, 0x0EFB)

SCAT3_SINH(0x0EFA)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT3_SIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT3_SINL(0x0EFB)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT3_SIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT3_SIN	SIN input in SIN/COS or ATAN mode of computing unit SCAT3

11.4.47 SCAT3_THE (0x0EFC, 0x0EFD)

SCAT3_THEH(0x0EFC)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT3_THE[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SCAT3_THEL(0x0EFD)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT3_THE[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT3_THE	THE input in SIN/COS mode of computing unit SCAT3

11.4.48 SCAT3_RES1 (0x0EFE, 0x0EFF)

SCAT3_RES1H(0x0EFE)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT3_RES1[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT3_RES1L(0x0EFF)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT3_RES1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT3_RES1	COS output in SIN/COS mode of computing unit SCAT3; <i>U</i> output in ATAN mode

11.4.49 SCAT3_RES2 (0x0F00, 0x0F01)

SCAT3_RES2H(0x0F00)								
Bit	15	14	13	12	11	10	9	8
Name	SCAT3_RES[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
SCAT3_RES2L(0x0F01)								
Bit	7	6	5	4	3	2	1	0
Name	SCAT3_RES[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	SCAT3_RES2	SIN output in SIN/COS mode of computing unit SCAT3; θ output in ATAN mode

11.4.50 LPF0_K (0x0FD0, 0x0FD1)

LPF0_KH(0x0FD0)								
Bit	15	14	13	12	11	10	9	8
Name	LPF0_K[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

LPF0_KL(0x0FD1)								
Bit	7	6	5	4	3	2	1	0
Name	LPF0_K[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	LPF0_K	K input of LPF0

11.4.51 LPF0_X (0x0FD2, 0x0FD3)

LPF0_XH(0x0FD2)								
Bit	15	14	13	12	11	10	9	8
Name	LPF0_X[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

LPF0_XL(0x0FD3)								
Bit	7	6	5	4	3	2	1	0
Name	LPF0_X[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	LPF0_X	X input of LPF0

11.4.52 LPF0_Y (0x0FD4, 0x0FD5, 0x0FD6, 0x0FD7)

LPF0_YHH(0x0FD4)								
Bit	31	30	29	28	27	26	25	24
Name	LPF0_Y[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

LPF0_YHL(0x0FD5)								
Bit	23	22	21	20	19	18	17	16
Name	LPF0_Y[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

LPF0_YLH(0x0FD6)								
Bit	15	14	13	12	11	10	9	8
Name	LPF0_Y[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

LPF0_YLL(0x0FD7)								
Bit	7	6	5	4	3	2	1	0
Name	LPF0_Y[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	LPF0_Y	Input and output of the register in LPF0 Input: LPF0_Y _{k-1} Output: LPF0_Y _k

11.4.53 LPF1_K (0x0FC8, 0x0FC9)

LPF1_KH(0x0FC8)								
Bit	15	14	13	12	11	10	9	8
Name	LPF1_K[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

LPF1_KL(0x0FC9)								
Bit	7	6	5	4	3	2	1	0
Name	LPF1_K[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	LPF1_K	K input of LPF1

11.4.54 LPF1_X (0x0FCA, 0x0FCB)

LPF1_XH(0x0FCA)								
Bit	15	14	13	12	11	10	9	8
Name	LPF1_X[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

LPF1_XL(0x0FCB)								
Bit	7	6	5	4	3	2	1	0
Name	LPF1_X[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description

[15:0]	LPF1_X	X input of LPF1

11.4.55 LPF1_Y (0x0FCC, 0x0FCD, 0x0FCE, 0x0FCF)

LPF1_YHH(0x0FCC)								
Bit	31	30	29	28	27	26	25	24
Name	LPF1_Y[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF1_YHL(0x0FCD)								
Bit	23	22	21	20	19	18	17	16
Name	LPF1_Y[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF1_YLH(0x0FCE)								
Bit	15	14	13	12	11	10	9	8
Name	LPF1_Y[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF1_YLL(0x0FCF)								
Bit	7	6	5	4	3	2	1	0
Name	LPF1_Y[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	LPF1_Y	Input and output of the register in LPF1 Input: LPF1_Y _{k-1} Output: LPF1_Y _k

11.4.56 LPF2_K (0x0F78, 0x0F79)

LPF2_KH(0x0F78)								
Bit	15	14	13	12	11	10	9	8
Name	LPF2_K[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF2_KL(0x0F79)								
Bit	7	6	5	4	3	2	1	0
Name	LPF2_K[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	LPF2_K	K input of LPF2

11.4.57 LPF2_X (0x0F7A, 0x0F7B)

LPF2_XH(0x0F7A)								
Bit	15	14	13	12	11	10	9	8
Name	LPF2_X[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF2_XL(0x0F7B)								
Bit	7	6	5	4	3	2	1	0
Name	LPF2_X[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	LPF2_X	X input of LPF2

11.4.58 LPF2_Y (0x0F7C, 0x0F7D, 0x0F7E, 0x0F7F)

LPF2_YHH(0x0F7C)								
Bit	31	30	29	28	27	26	25	24
Name	LPF2_Y[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF2_YHL(0x0F7D)								
Bit	23	22	21	20	19	18	17	16
Name	LPF2_Y[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF2_YLH(0x0F7E)								
Bit	15	14	13	12	11	10	9	8
Name	LPF2_Y[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF2_YLL(0x0F7F)								
Bit	7	6	5	4	3	2	1	0
Name	LPF2_Y[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description

[31:0]	LPF2_Y	Input and output of the register in LPF2 Input: LPF2_Y _{k-1} Output: LPF2_Y _k

11.4.59 LPF3_K (0x0F70, 0x0F71)

LPF3_KH(0x0F70)								
Bit	15	14	13	12	11	10	9	8
Name	LPF3_K[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF3_KL(0x0F71)								
Bit	7	6	5	4	3	2	1	0
Name	LPF3_K[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	LPF3_K	K input of LPF3

11.4.60 LPF3_X (0x0F72, 0x0F73)

LPF3_XH(0x0F72)								
Bit	15	14	13	12	11	10	9	8
Name	LPF3_X[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF3_XL(0x0F73)								
Bit	7	6	5	4	3	2	1	0
Name	LPF3_X[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	LPF3_K	X input of LPF3

11.4.61 LPF3_Y (0x0F74, 0x0F75, 0x0F76, 0x0F77)

LPF3_YHH(0x0F74)								
Bit	31	30	29	28	27	26	25	24
Name	LPF3_Y[31:24]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0
LPF3_YHL(0x0F75)								
Bit	23	22	21	20	19	18	17	16
Name	LPF3_Y[23:16]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF3_YLH(0x0F76)								
Bit	15	14	13	12	11	10	9	8
Name	LPF3_Y[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
LPF3_YLL(0x0F77)								
Bit	7	6	5	4	3	2	1	0
Name	LPF3_Y[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[31:0]	LPF3_Y	Input and output of the register in LPF3 Input: LPF3_Y _{k-1} Output: LPF3_Y _k

11.4.62 PI0_KP (0x0FB8, 0x0FB9)

PI0_KPH(0x0FB8)								
Bit	15	14	13	12	11	10	9	8
Name	PI0_KP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI0_KPL(0x0FB9)								
Bit	7	6	5	4	3	2	1	0
Name	PI0_KP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI0_KP	Proportional coefficient of PI0

11.4.63 PI0_EK1 (0x0FBA, 0x0FBB)

PI0_EK1H(0x0FBA)								
Bit	15	14	13	12	11	10	9	8
Name	PI0_EK1[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI0_EK1L(0x0FBB)								
Bit	7	6	5	4	3	2	1	0
Name	PI0_EK1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI0_EK1	Previous input deviation of PI0

11.4.64 PI0_EK (0x0FBC, 0x0FBD)

PI0_EKH(0x0FBC)								
Bit	15	14	13	12	11	10	9	8
Name	PI0_EK[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI0_EKL(0x0FBD)								
Bit	7	6	5	4	3	2	1	0
Name	PI0_EK[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI0_EK	Present input deviation of PI0

11.4.65 PI0_KI (0x0FBE, 0x0FBF)

PI0_KIH(0x0FBE)								
Bit	15	14	13	12	11	10	9	8
Name	PI0_KI[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI0_KIL(0x0FBF)								
Bit	7	6	5	4	3	2	1	0

Name	PI0_KI[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI0_KI	Integral coefficient of PI0

11.4.66 PI0_UKH (0x0FC0, 0x0FC1)

PI0_UKHH(0x0FC0)								
Bit	15	14	13	12	11	10	9	8
Name	PI0_UKH[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI0_UKHL(0x0FC1)								
Bit	7	6	5	4	3	2	1	0
Name	PI0_UKH[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI0_UKH	16 high-order bits of PI0 output

11.4.67 PI0_UKL (0x0FC2, 0x0FC3)

PI0_UKLH(0x0FC2)								
Bit	15	14	13	12	11	10	9	8
Name	PI0_UKL[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI0_UKLL(0x0FC3)								
Bit	7	6	5	4	3	2	1	0
Name	PI0_UKL[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI0_UKL	16 low-order bits of PI0 output

11.4.68 PIO_UKMAX (0x0FC4, 0x0FC5)

PIO_UKMAXH(0x0FC4)								
Bit	15	14	13	12	11	10	9	8
Name	PIO_UKMAX[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PIO_UKMAXL(0x0FC5)								
Bit	7	6	5	4	3	2	1	0
Name	PIO_UKMAX[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PIO_UKMAX	Maximum output of PIO

11.4.69 PIO_UKMIN (0x0FC6, 0x0FC7)

PIO_UKMINH(0x0FC6)								
Bit	15	14	13	12	11	10	9	8
Name	PIO_UKMIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PIO_UKMINL(0x0FC7)								
Bit	7	6	5	4	3	2	1	0
Name	PIO_UKMIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PIO_UKMIN	Minimum output of PIO

11.4.70 PI1_KP (0x0FA8, 0x0FA9)

PI1_KPH(0x0FA8)								
Bit	15	14	13	12	11	10	9	8
Name	PI1_KP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI1_KPL(0x0FA9)								
Bit	7	6	5	4	3	2	1	0

Name	PI1_KP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI1_KP	Proportional coefficient of PI1

11.4.71 PI1_EK1 (0x0FAA, 0x0FAB)

PI1_EK1H(0x0FAA)								
Bit	15	14	13	12	11	10	9	8
Name	PI1_EK1[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI1_EK1L(0x0FAB)								
Bit	7	6	5	4	3	2	1	0
Name	PI1_EK1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI1_EK1	Previous input deviation of PI1

11.4.72 PI1_EK (0x0FAC, 0x0FAD)

PI1_EKH(0x0FAC)								
Bit	15	14	13	12	11	10	9	8
Name	PI1_EK[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI1_EKL(0x0FAD)								
Bit	7	6	5	4	3	2	1	0
Name	PI1_EK[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI1_EK	Present input deviation of PI1

11.4.73 PI1_KI (0x0FAE, 0x0FAF)

PI1_KIH(0x0FAE)								
Bit	15	14	13	12	11	10	9	8
Name	PI1_KI[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI1_KIL(0x0FAF)								
Bit	7	6	5	4	3	2	1	0
Name	PI1_KI[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI1_KI	Integral coefficient of PI1

11.4.74 PI1_UKH (0x0FB0, 0x0FB1)

PI1_UKHH(0x0FB0)								
Bit	15	14	13	12	11	10	9	8
Name	PI1_UKH[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI1_UKHL(0x0FB1)								
Bit	7	6	5	4	3	2	1	0
Name	PI1_UKH[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI1_UKH	16 high-order bits of PI1 output

11.4.75 PI1_UKL (0x0FB2, 0x0FB3)

PI1_UKLH(0x0FB2)								
Bit	15	14	13	12	11	10	9	8
Name	PI1_UKL[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI1_UKLL(0x0FB3)								
Bit	7	6	5	4	3	2	1	0

Name	PI1_UKL[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI1_UKL	16 low-order bits of PI1 output

11.4.76 PI1_UKMAX (0x0FB4, 0x0FB5)

PI1_UKMAXH(0x0FB4)								
Bit	15	14	13	12	11	10	9	8
Name	PI1_UKMAX[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI1_UKMAXL(0x0FB5)								
Bit	7	6	5	4	3	2	1	0
Name	PI1_UKMAX[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI1_UKMAX	Maximum output of PI1

11.4.77 PI1_UKMIN (0x0FB6, 0x0FB7)

PI1_UKMINH(0x0FB6)								
Bit	15	14	13	12	11	10	9	8
Name	PI1_UKMIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI1_UKMINL(0x0FB7)								
Bit	7	6	5	4	3	2	1	0
Name	PI1_UKMIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI1_UKMIN	Minimum output of PI1

11.4.78 PI2_KP (0x0F5C, 0x0F5D)

PI2_KPH(0x0F5C)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_KP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_KPL(0x0F5D)								
Bit	7	6	5	4	3	2	1	0
Name	PI2_KP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_KP	Proportional coefficient of PI2

11.4.79 PI2_EK1 (0x0F5E, 0x0F5F)

PI2_EK1H(0x0F5E)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_EK1[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_EK1L(0x0F5F)								
Bit	7	6	5	4	3	2	1	0
Name	PI2_EK1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_EK1	Previous input deviation of PI2

11.4.80 PI2_EK (0x0F60, 0x0F61)

PI2_EKH(0x0F60)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_EK[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_EKL(0x0F61)								
Bit	7	6	5	4	3	2	1	0

Name	PI2_EK[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_EK	Present input deviation of PI2

11.4.81 PI2_KI (0x0F62, 0x0F63)

PI2_KIH(0x0F62)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_KI[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_KIL(0x0F63)								
Bit	7	6	5	4	3	2	1	0
Name	PI2_KI[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_KI	Integral coefficient of PI2

11.4.82 PI2_UKH (0x0F64, 0x0F65)

PI2_UKHH(0x0F64)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_UKH[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_UKHL(0x0F65)								
Bit	7	6	5	4	3	2	1	0
Name	PI2_UKH[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_UKH	16 high-order bits of PI2 output

11.4.83 PI2_UKL (0x0F66, 0x0F67)

PI2_UKLH(0x0F66)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_UKL[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_UKLL(0x0F67)								
Bit	7	6	5	4	3	2	1	0
Name	PI2_UKL[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_UKL	16 low-order bits of PI2 output

11.4.84 PI2_UKMAX (0x0F68, 0x0F69)

PI2_UKMAXH(0x0F68)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_UKMAX[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_UKMAXL(0x0F69)								
Bit	7	6	5	4	3	2	1	0
Name	PI2_UKMAX[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_UKMAX	Maximum output of PI2

11.4.85 PI2_UKMIN (0x0F6A, 0x0F6B)

PI2_UKMINH(0x0F6A)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_UKMIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_UKMINL(0x0F6B)								
Bit	7	6	5	4	3	2	1	0

Name	PI2_UKMIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_UKMIN	Minimum output of PI2

11.4.86 PI2_KD (0x0F6C, 0x0F6D)

PI2_KDH(0x0F6C)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_KD[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_KDL(0x0F6D)								
Bit	7	6	5	4	3	2	1	0
Name	PI2_KD[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_KD	Differential coefficient of PI2

11.4.87 PI2_EK2 (0x0F6E, 0x0F6F)

PI2_EK2H(0x0F6E)								
Bit	15	14	13	12	11	10	9	8
Name	PI2_EK2[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI2_EK2L(0x0F6F)								
Bit	7	6	5	4	3	2	1	0
Name	PI2_EK2[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI2_EK2	Deviation before previous input deviation of PI2

11.4.88 PI3_KP (0x0F48, 0x0F49)

PI3_KPH(0x0F48)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_KP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_KPL(0x0F49)								
Bit	7	6	5	4	3	2	1	0
Name	PI3_KP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_KP	Proportional coefficient of PI3

11.4.89 PI3_EK1 (0x0F4A, 0x0F4B)

PI3_EK1H(0x0F4A)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_EK1[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_EK1L(0x0F4B)								
Bit	7	6	5	4	3	2	1	0
Name	PI3_EK1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_EK1	Previous input deviation of PI3

11.4.90 PI3_EK (0x0F4C, 0x0F4D)

PI3_EKH(0x0F4C)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_EK[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_EKL(0x0F4D)								
Bit	7	6	5	4	3	2	1	0

Name	PI3_EK[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_EK	Present input deviation of PI3

11.4.91 PI3_KI (0x0F4E, 0x0F4F)

PI3_KIH(0x0F4E)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_KI[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_KIL(0x0F4F)								
Bit	7	6	5	4	3	2	1	0
Name	PI3_KI[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_KI	Integral coefficient of PI3

11.4.92 PI3_UKH (0x0F50, 0x0F51)

PI3_UKHH(0x0F50)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_UKH[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_UKHL(0x0F51)								
Bit	7	6	5	4	3	2	1	0
Name	PI3_UKH[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_UKH	16 high-order bits of PI3 output

11.4.93 PI3_UKL (0x0F52, 0x0F53)

PI3_UKLH(0x0F52)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_UKL[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_UKLL(0x0F53)								
Bit	7	6	5	4	3	2	1	0
Name	PI3_UKL[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_UKL	16 low-order bits of PI3 output

11.4.94 PI3_UKMAX (0x0F54, 0x0F55)

PI3_UKMAXH(0x0F54)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_UKMAX[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_UKMAXL(0x0F55)								
Bit	7	6	5	4	3	2	1	0
Name	PI3_UKMAX[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_UKMAX	Maximum output of PI3

11.4.95 PI3_UKMIN (0x0F56, 0x0F57)

PI3_UKMINH(0x0F56)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_UKMIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_UKMINL(0x0F57)								
Bit	7	6	5	4	3	2	1	0

Name	PI3_UKMIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_UKMIN	Minimum output of PI3

11.4.96 PI3_KD (0x0F58, 0x0F59)

PI3_KDH(0x0F58)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_KD[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_KDL(0x0F59)								
Bit	7	6	5	4	3	2	1	0
Name	PI3_KD[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_KD	Differential coefficient of PI3

11.4.97 PI3_EK2 (0x0F5A, 0x0F5B)

PI3_EK2H(0x0F5A)								
Bit	15	14	13	12	11	10	9	8
Name	PI3_EK2[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
PI3_EK2L(0x0F5B)								
Bit	7	6	5	4	3	2	1	0
Name	PI3_EK2[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	PI3_EK2	Deviation before previous input deviation of PI3

12 FOC

12.1 FOC Overview

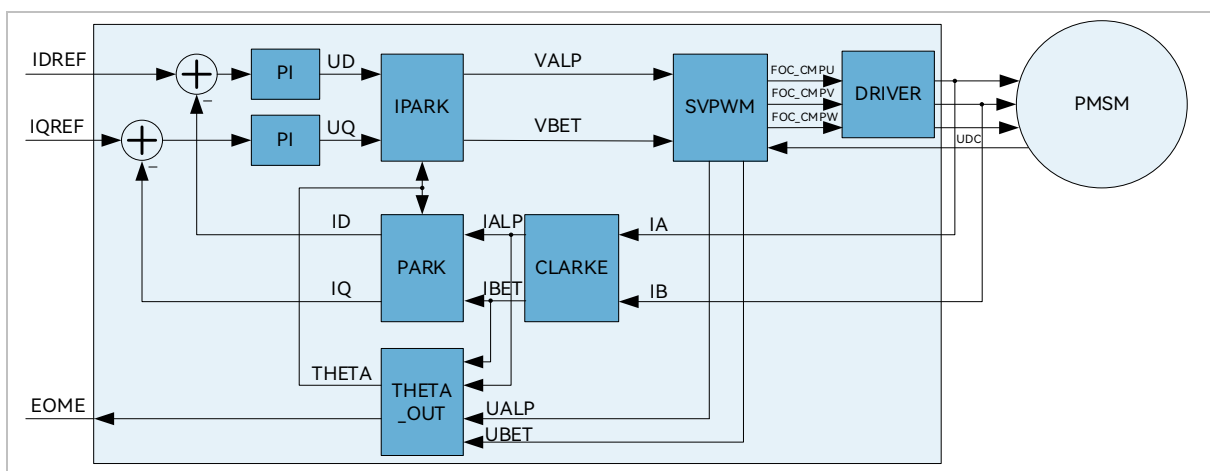
12.1.1 FOC Introduction

The FOC module is used in sensorless and sensed FOC motor drive applications and SVPWM-based motor control applications. When $DRV\_CR[FOC\_EN] = 0$, FOC module is inactivated and FOC clock stops. The relevant FOC registers are forced into the reset state and cannot be written.

The FOC module consists of angle estimator, PI controller, coordinate transform module, current sampling module and PWM output module. The angle estimator uses the sampling motor current to estimate the rotor position and implement sensorless FOC-based motor control. MCU can also process the signals from the position sensor to implement sensed FOC-based control.

- Sensorless FOC: Angle for coordinate transformation is obtained by angle estimator, and the motor speed is estimated for speed closed-loop control.
- Sensor-based FOC: FOC module provides the angle input interface. MCU samples position sensor signals and calculates electrical angle of the motor. Software sends the result to FOC module for coordinate transformation.

Figure 12-1 FOC Block Diagram



12.1.2 Reference Voltage (VREF) Input

The current loop of FOC module uses the d-axis current reference value FOC_IDREF and the q-axis current reference value FOC_IQREF as the reference, and uses the d-axis current sampling value FOC_ID and the q-axis current sampling value FOC_IQ as the feedback. FOC module outputs real-time estimated motor speed FOC_EOME. MCU can use FOC_EOME as the feedback to build speed loop and send the output of speed loop to FOC_IQREF to implement the speed-current dual closed loop control.

12.1.3 PI Controller

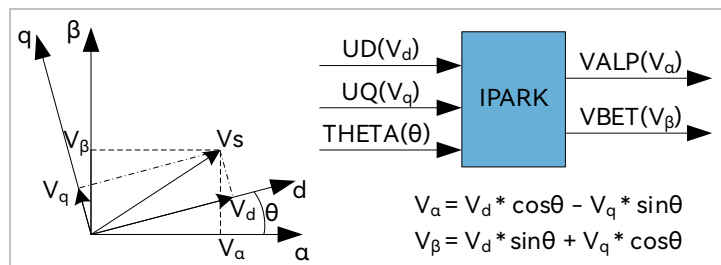
FOC module integrates two PI controllers:

1. Flux control: PI controller of d-axis current, with current reference FOC_IDREF minus feedback current FOC_ID as the error input, proportional coefficient FOC_DQKP and the integral coefficient FOC_DQKI for adjustment of PI performance, and FOC_DMAX and FOC_DMIN for limiting of the output amplitude. The output is voltage reference of d-axis FOC_UD;
2. Torque control: PI controller of q-axis current, with current reference FOC_IQREF minus feedback current FOC_IQ as the error input, proportional coefficient FOC_DQKP and the integral coefficient FOC_DQKI for adjustment of PI performance, and FOC_QMAX and FOC_QMIN for limiting of the output amplitude. The output is voltage reference of q-axis FOC_UQ.

12.1.4 Coordinate Transformation

12.1.4.1 Inverse Park Transformation

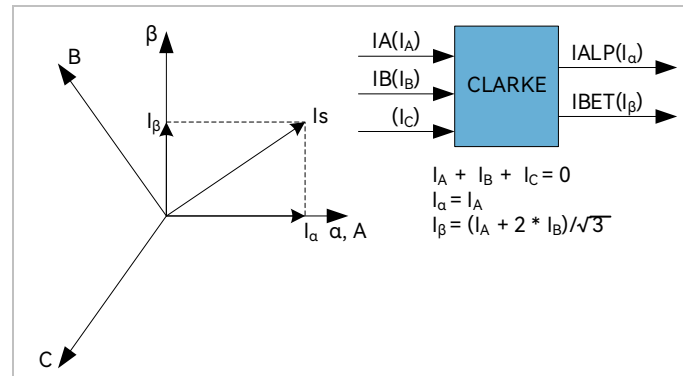
Figure 12-2 Inverse Park Transformation



Inverse Park transformation is used to transform two voltage vectors obtained by PI controller, FOC_UD and FOC_UQ, from dq-axis coordinate to αβ-axis coordinate.

12.1.4.2 Clarke Transformation

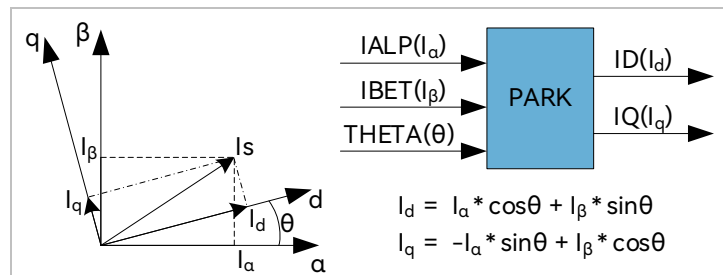
Figure 12-3 Clarke Transformation



Clarke transformation is used to transform the sampled current from 3-phase stationary coordinate to αβ-axis coordinate.

12.1.4.3 Park Transformation

Figure 12-4 Park Transformation



Park transformation is used to transform the current vectors, obtained after Clarke transformation, from αβ-axis coordinate to dq-axis coordinate to get the sampled dq-axis current FOC_ID and FOC_IQ.

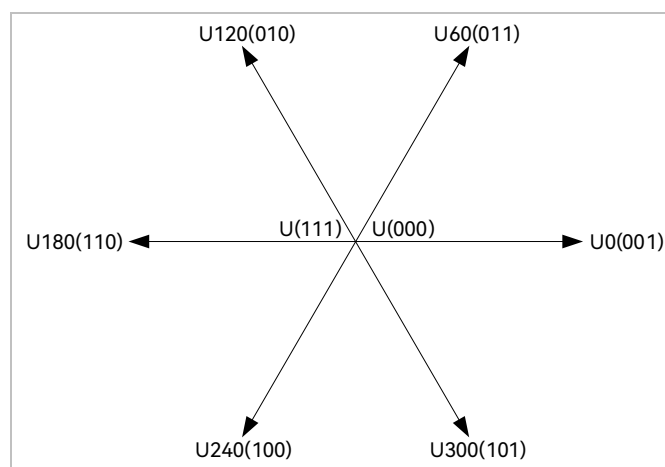
12.1.5 SVPWM

SVPWM algorithm is an important part of FOC. The main idea is to obtain quasi-circular rotating magnetic field by switching the inverter space voltage vectors. This method decreases harmonic components of the phase current, harmonic losses of the motor and torque ripple, and achieves high voltage utilization.

SVPWM generates pulse-width modulation signals for the 3-phase motor voltage control, whose process can be reduced to a few simple equations. Since high side and low side of the inverter cannot be turned on simultaneously, there are two states for a phase, i.e., phase connected to bus voltage (represented by 1) or phase connected to ground (represented by 0). Therefore, voltage vector output of THE inverter has a total of

23 = 8 possible states. XCXBXA represents the voltage vectors, where XC represents the state of C-phase, XB represents the state of B-phase and XA represents the state of A-phase. For example, “100” represents the state that C-phase voltage is connected to bus voltage and A, B-phases are connected to ground. When the states of 3-phase are all 1 or 0, there is no voltage drop between two phases and the state is called inactive state or zero voltage vector. The other 6 states which have voltage output are active voltage vectors with an adjacent state rotation offset of 60 degrees.

Figure 12-5 SVPWM Voltage Vector



SVPWM uses the sum of two adjacent vectors to generate any voltage vector located in the voltage vector space. As shown in Figure 12-6, U_{OUT} is the desired vector and it is in the sector between U_{60} and U_0 . Based on the principle of equal impulse, the effect, U_0 applied $2 \cdot T_1$ time and U_{60} applied $2 \cdot T_2$ time, is equivalent to the U_{OUT} . The rest of time (T_0) is applied by zero voltage vector.

Figure 12-6 SVPWM Voltage Vector Synthesis

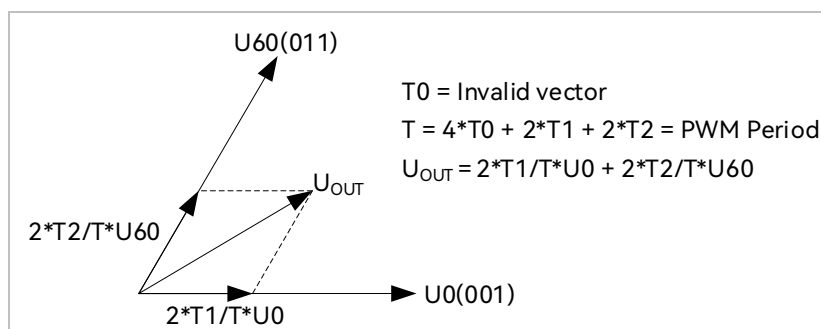


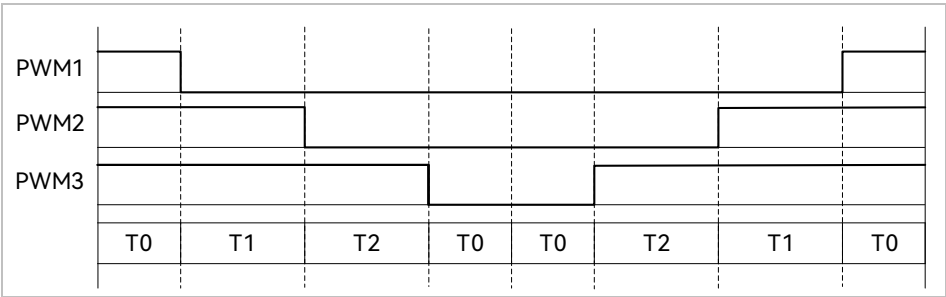
Table 12-1 States of SVPWM Inverter

Phase C	Phase B	Phase A	U_{ALP}	U_{BET}	Vector
0	0	0	0	0	000
0	0	1	$\frac{2}{3}U_{DC}$	0	001
0	1	1	$\frac{1}{3}U_{DC}$	$\frac{1}{3}U_{DC}$	011
0	1	0	$-\frac{1}{3}U_{DC}$	$\frac{1}{3}U_{DC}$	010
1	1	0	$-\frac{2}{3}U_{DC}$	0	110
1	0	0	$-\frac{1}{3}U_{DC}$	$-\frac{1}{3}U_{DC}$	100
1	0	1	$\frac{1}{3}U_{DC}$	$-\frac{1}{3}U_{DC}$	101
1	1	1	0	0	111

12.1.5.1 Continuous SVPWM

In single-shunt current sampling mode, continuous SVPWM is always used. In dual/triple-shunt current sampling mode, FOC_CR2[F5SEG] is set to “0” to select continuous SVPWM as the output mode.

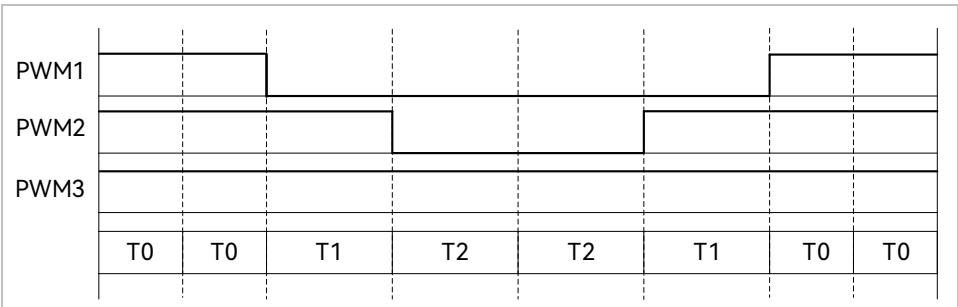
Figure 12-7 Output Level of Continuous SVPWM



12.1.5.2 Discontinuous SVPWM

Discontinuous SVPWM is available in dual/triple-shunt current sampling mode. FOC_CR2[F5SEG] is set to “1” to activate this mode.

Figure 12-8 Output Level of Discontinuous SVPWM



12.1.6 Overmodulation

Overmodulation is available in single/dual/triple-shunt current sampling mode. Configuring FOC_CR1[OVMDL] = 1 enables overmodulation feature. The FOC_UD, FOC_UQ, related limit amplitudes and voltage output are multiplied by 1.15 in this mode.

12.1.7 Deadtime Compensation

Deadtime compensation is available in dual/triple-shunt current sampling mode. The compensation value of deadtime is configured by FOC_TSMIN. This mode improves the quality of phase current at low speed.

12.1.8 Current and Voltage Sampling

In FOC mode, bus voltage and phase current are sampled by hardware automatically. Before the FOC module operates, ADC and operational amplifier shall be enabled and the corresponding control registers be configured. No configuration is required for ADC channel and mode. Single/dual/triple/advanced single-shunt current sampling mode is selected by setting FOC_CR1[CSM]. In single-shunt current sampling mode, ADC channel 4 is the default sampling channel of the bus current (itrip). In -shunt current sampling mode, ADC channel 0 and channel 1 are the default sampling channels of A-phase current (ia) and B-phase current (ib) respectively. In triple-shunt current sampling mode, ADC channel 0, channel 1 and channel 4 are the default sampling channels of ia, ib and ic respectively. Channel 14 or channel 2 can be selected for bus voltage sampling can be selected for bus voltage sampling.

12.1.8.1 Single-shunt Current Sampling Mode

FOC_CR1[CSM] is set to "00" to select the single-shunt current sampling mode. In this mode, FOC module samples itrip (channel 4) twice during DRV timer counting-up operation, and samples bus voltage during DRV timer counting-down operation and after FOC module completes the calculation.

Since deadtime affects the accuracy of current sampling, FOC module samples within T1' and T2', which is the applied time of active voltage vector with deadtime removed. FOC_TRGDLY is the register which advance or delay the current sampling time, and this register shall be configured reasonably to ensure sampling is completed within T1' and T2'. For example, if FOC_TRGDLY = 5, the sampling time is delayed by $5 \times T = 208\text{ns}$; and if FOC_TRGDLY = 0xFB(-5), the sampling time is advanced by $5 \times T = 208\text{ns}$.

Figure 12-9 Single-shunt Current Sampling Timing

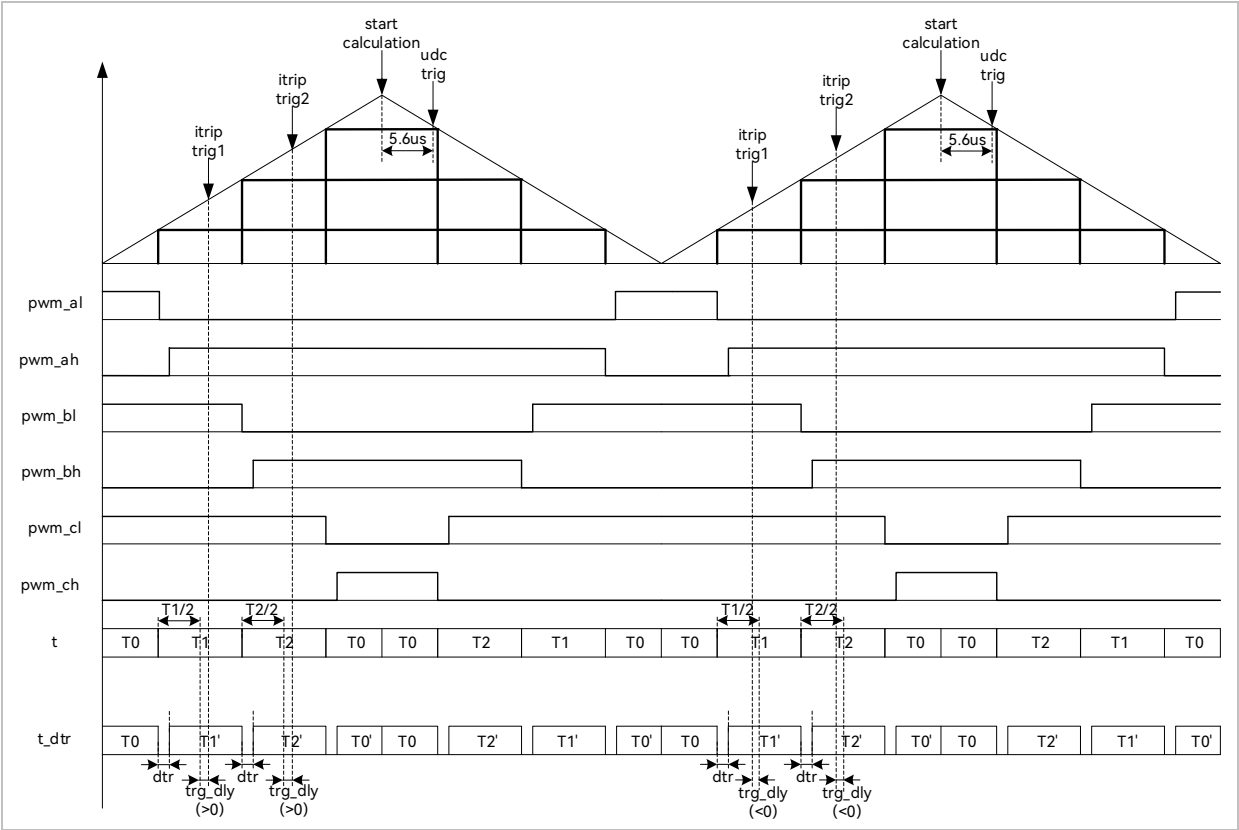
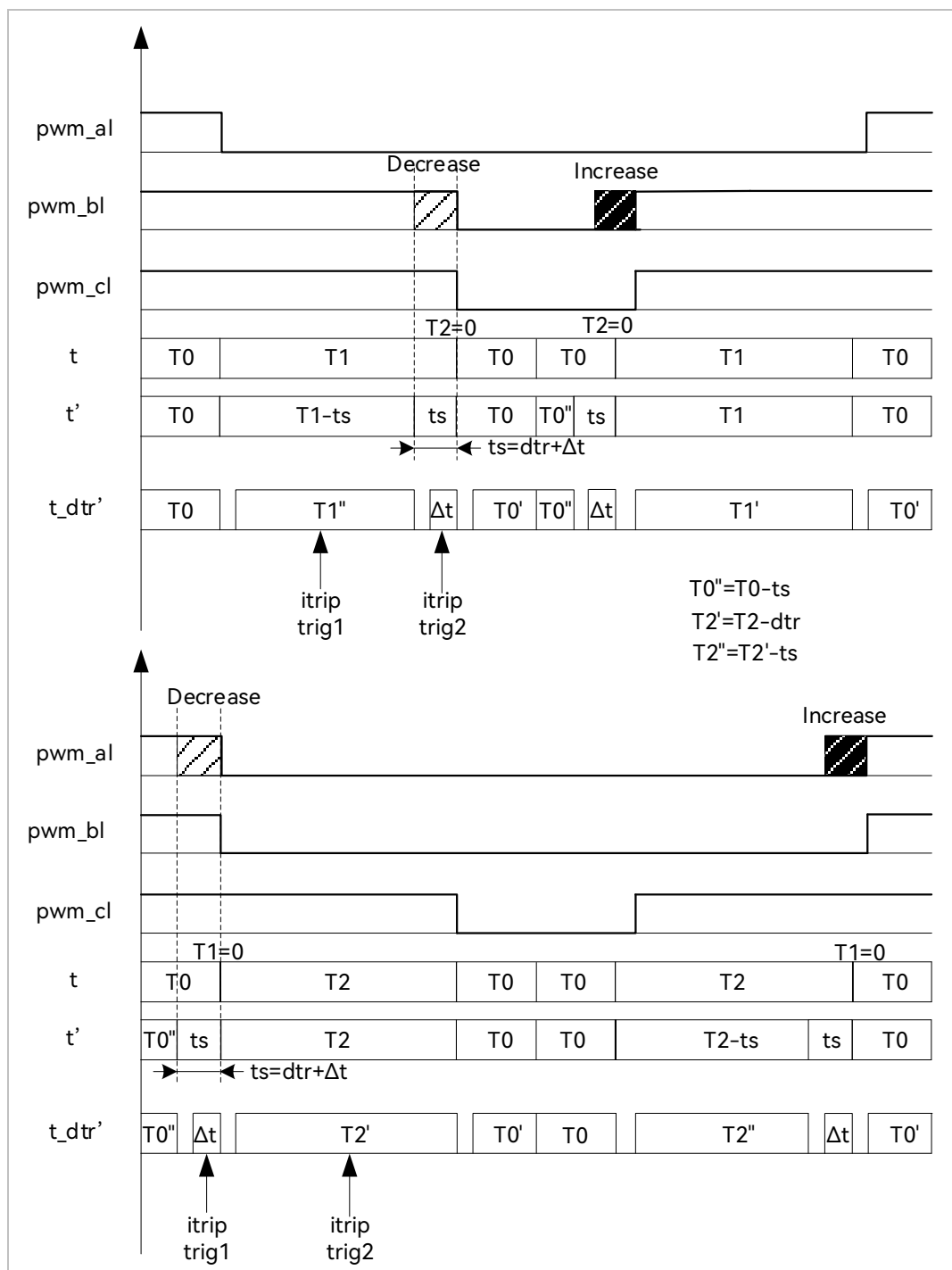


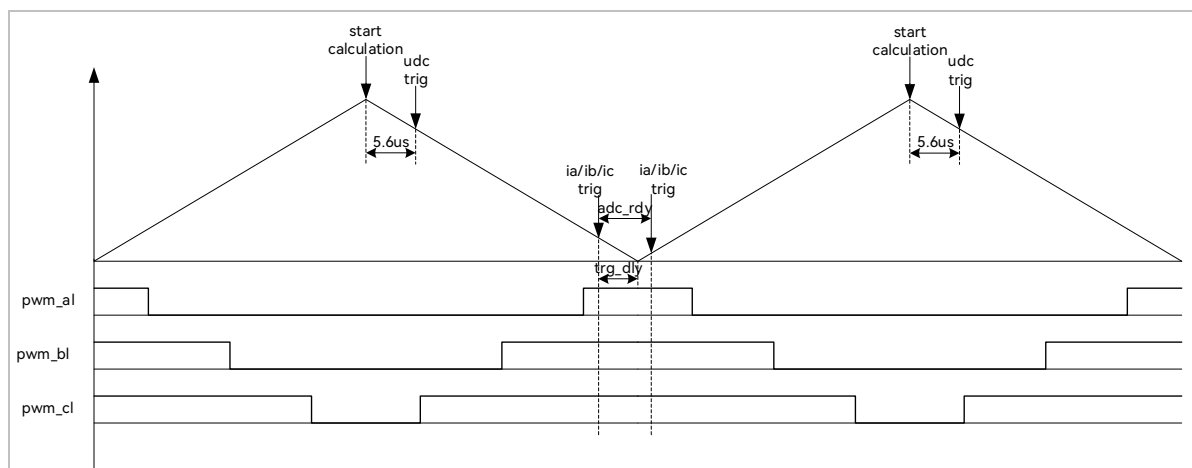
Figure 12-10 Single-shunt Current Sampling Time Compensation



The time of single-shunt current sampling window may be not enough to sample the current in low modulation index and sector switching area. PWM waveform shall be adjusted to ensure the minimum sampling window required in the case. FOC_TSMIN (FOC_TSMIN = minimum sampling window + deadtime) is used to configure the compensation value of deadtime, and FOC module adjusts the PWM waveform automatically.

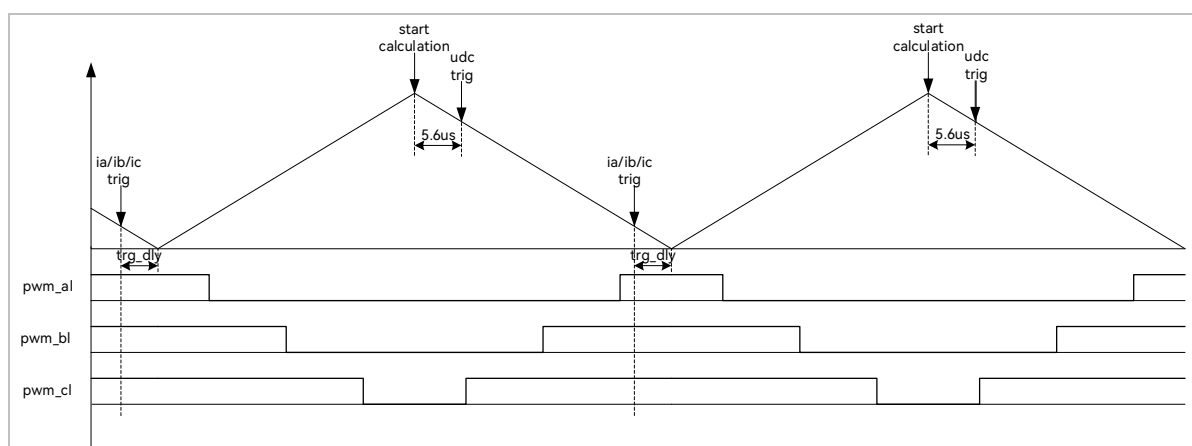
12.1.8.2 Dual/Triple-shunt Current Sampling Mode

Figure 12-11 Dual/Triple-shunt Sequential Current Sampling Mode



FOC_CR1[CSM] is set to “10/11” and FOC_CR2[DSS] to “0” to select dual/triple-shunt sequential current sampling mode. In triple-shunt sequential current sampling mode, FOC_TRGDLY is used to configure the sampling time of a phase current (ia/ib/ic is determined according to the sector), and other phases are sampled at the end of previous sampling. In dual-shunt sequential current sampling mode, FOC_TRGDLY is used to configure the sampling time of ia, and ib is sampled at the end of ia sampling. TRG_DLY shall be configured reasonably to ensure current sampling time is within zero voltage vector (000). For example, when FOC_TRGDLY = 0xB2 and FOC timer counts down, ia/ib/ic is sampled at $50 \times T = 2.08\mu\text{s}$ before an underflow event, and then the other phases of ia/ib/ic are sampled.

Figure 12-12 Dual/Triple-shunt Alternate Current Sampling Mode



FOC_CR1[CSM] is set to “10/11” and FOC_CR2[DSS] to “1” to select dual/triple-shunt alternating current

sampling mode. In this mode, FOC module performs calculation in every PWM cycle. However, only one phase current is sampled at each PWM cycle (ia/ib/ic is determined according to the sector). The first carrier cycle samples one phase of the ia/ib/ic, and the second carrier cycle samples the current of the other phase, so as to alternately sample the current of two phases in three phases. FOC_TRGDLY is used to configure the sampling time of ia (channel 0), ib (channel 1) and ic (channel 4). TRG_DLY shall be configured reasonably to ensure sampling time for the ia/ib/ic current is within zero voltage vector (000). For example, when FOC_TRGDLY = 0xB2 and FOC timer counts-down, phase current is sampled at $50 \times T = 2.08\mu s$ before an underflow event.

In dual/triple-shunt current sampling mode, bus voltage is sampled when driver timer is down-counting and FOC module completes the calculation.

12.1.8.3 Current Sampling Offset

The current sampling offset voltage shall be added to sample full range of current due to the existence of the positive and negative phase current. When phase current is 0, ADC result is the offset value. ADC result minus this value, 0x4000 default, is the sampling current. Since ADC reference voltage and hardware are nonideal, there is a deviation between the default value and the real value. Therefore, it is necessary to calibrate the offset. The calibration procedure is as follows. When there is no current in three phases, MCU starts to sample the corresponding channel several times, averages all the sampled value, and writes the averaged value to FOC_CSO. Providing ADC sampling range is 0 ~ 5V and the offset is 2.5V, $FOC\_CSO = 2.5V/5V \times 32768 = 16384$ (0x4000).

- > When FOC_CR2[CSOC] = 00/11, FOC_CSO is written to modify the offset of itrip and ic.
- > When FOC_CR2[CSOC] = 01, FOC_CSO is written to modify the offset of ia.
- > When FOC_CR2[CSOC] = 10, FOC_CSO is written to modify the offset of ib.

12.1.9 Angle Mode

Angle module includes angle estimation module, ramping module and estimated angle smooth switching module. The sources of angle are as follows:

- > Forced ramping angle
- > Forced pulling angle
- > Estimated angle of estimator

> Forced angle of estimator

Table 12-2 Sources of Angle

FOC_CR1[RFAE]	FOC_CR1[ANGM]	FOC_CR1[EFAE]	Source
1	X	X	Forced ramping angle
0	0	X	Forced pulling angle
0	1	0	Estimated angle of estimator
0	1	1	omega > FOC_EFREQMIN: Estimated angle of estimator omega < FOC_EFREQMIN: Forced angle of estimator

12.1.9.1 Forced Ramping Angle

Forced ramping angle is controlled by angle FOC_THETA, speed FOC_RTHERSTEP, acceleration FOC_RTHERACC and ramping counter FOC_RTHERCNT. The formula is:

$$\text{FOC\_RTHERSTEP (32-bit)} = \text{FOC\_RTHERSTEP (32-bit)} + \text{FOC\_RTHERACC (16 low-order bits)}$$

$$\text{THETA\_OL (16-bit)} = \text{THETA\_OL (16-bit)} + \text{FOC\_RTHERSTEP (16 high-order bits)}$$

Where, THETA_OL is an internal variable of the chip. In forced ramping angle mode, THETA_OL is written to FOC_THETA as the used angle. If the software writes a value to FOC_THETA, this value is written to THETA_OL as well.

Forced ramping angle has the highest priority. Configuring FOC_CR1[RFAE] to “1” enables the ramping feature. Ramping module makes a ramping operation in every PWM cycle and the counter is added by 1. When the value of the counter reaches the set value by FOC_RTHERCNT, FOC_CR1[RFAE] is cleared by hardware, and then the ramping is completed. Thereafter, according to the value of FOC_CR1[ANGM], the angle comes from estimator (FOC_CR1[ANGM] = 1) or forced pulling angle (FOC_CR1[ANGM] = 0).

12.1.9.2 Forced Pulling Angle

Forced pulling angle is controlled by angle FOC_THETA and speed FOC_RTHERSTEP. The formula is:

$$\text{THETA\_OL (16-bit)} = \text{THETA\_OL (16-bit)} + \text{FOC\_RTHERSTEP (16 high-order bits)}$$

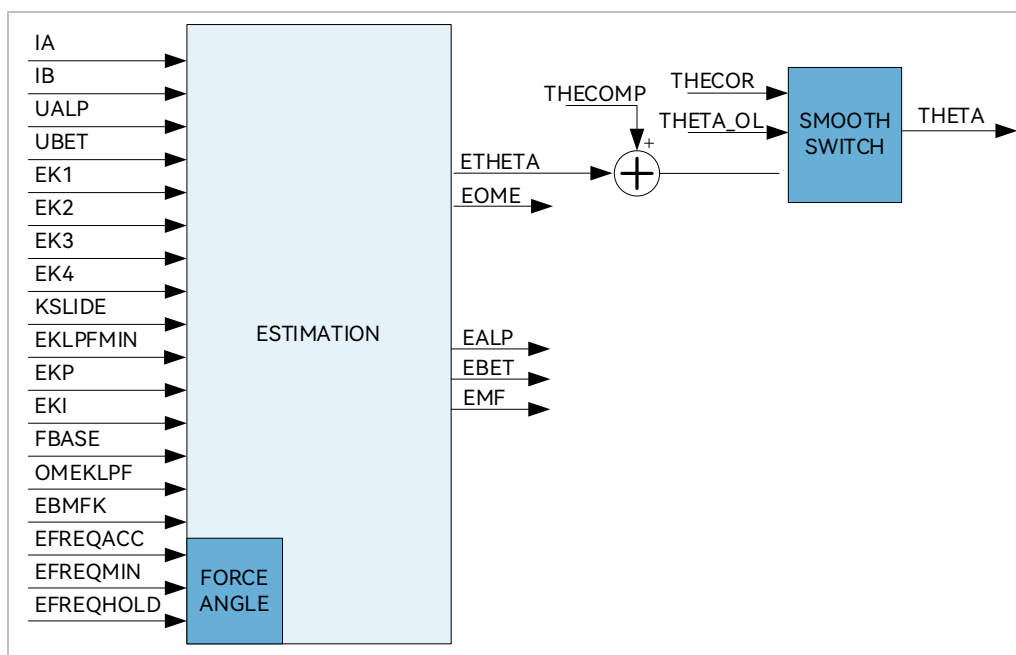
Where, THETA_OL is an internal variable of the chip. In forced pulling angle mode, THETA_OL is written to

FOC_THETA as the used angle. If the software writes a value to FOC_THETA, this value is written to THETA_OL as well.

- When FOC_CR1[RFAE] is set to “1” and FOC_CR1[ANGM] to “0”, MCU switches to forced pulling angle mode after forced ramping angle mode. The speed is the cumulative result after ramp force angle mode. This mode implements a forced uniform speed control.
- When FOC_CR1[RFAE] is set to “0” and FOC_CR1[ANGM] to “0”, the angle is the forced pulling angle and the speed FOC_RTHERSTEP is the initial speed written by software. Configuring FOC_RTHERSTEP to “0” enables the pre-position feature. The sensor-based FOC is implemented after the motor speed is set with FOC_RTHERSTEP. (Principle of Sensor-based FOC: The angle and speed are written to FOC_THETA and FOC_RTHERSTEP by software, and FOC module generates an angle in each PWM cycle based on the written values.)

12.1.9.3 Estimator Output Angle

Figure 12-13 Schematic Block Diagram of Estimator

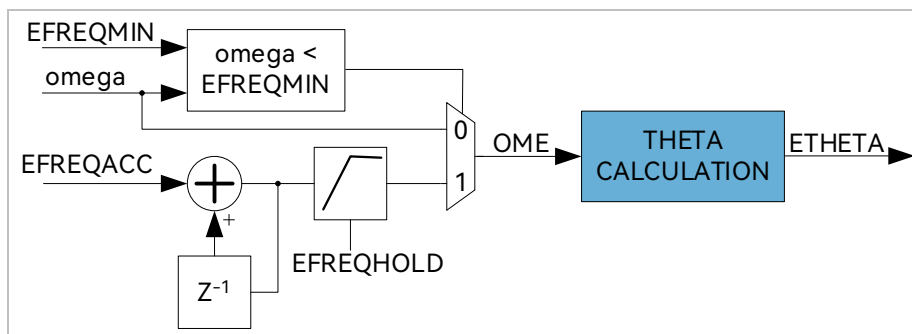


12.1.9.3.1 Estimated Angle of Estimator

The estimator builds the motor model based on the motor parameters and control parameters, and outputs the estimated angle based on the sampled current and voltage. The estimator works in PLL mode or SMO mode by configuring the FOC_CR2[ESEL] bit.

12.1.9.3.2 Forced Angle of Estimator

Figure 12-14 Schematic Diagram of Forced Angle of Estimator



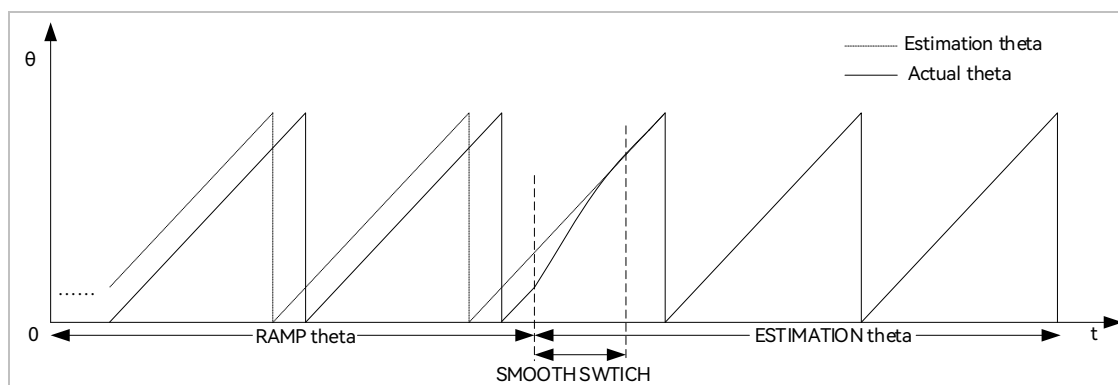
This feature is similar to the ramping feature. Due to the low speed at motor starting process, there may be a deviation in angle and speed estimation with the small effective signal, resulting in startup failure. In this case, the estimator outputs the forced angle to ensure the motor start normally.

The forced angle feature of the estimator is enabled when $FOC\_CR1[RFAE]$ is set to “0”, $FOC\_CR1[ANGM]$ to “1” and $FOC\_CR1[EFAE]$ to “1”. As shown in Figure 12-14, the estimator compares the value of real-time estimated speed (ω) and $FOC\_EFREQMIN$ to determine ω or forced speed (FOC_ETHETA) as the used speed (OME). When $\omega < FOC\_EFREQMIN$, the forced speed is selected as OME . The forced speed starts with 0 and increases by $FOC\_EFREQACC$ in each PWM cycle, with the maximum value $FOC\_EFREQHOLD$. When $\omega \geq FOC\_EFREQMIN$, ω is selected as OME .

Estimated speed of the estimator FOC_EOME is the low-pass filtering result of OME with the coefficient set by $FOC\_OMEKLPF$.

12.1.9.3.3 Angle Smooth Switching

Figure 12-15 Angle Smooth Switching Curve



When FOC_CR1[RFAE] is set to “1” and FOC_CR1[ANGM] to “1”, the motor starts with ramping feature, and it switches to estimator angle mode after the ramping. However, there is usually a deviation between the estimated angle and the forced ramping angle. If the angle is switched from forced ramping angle to estimated angle directly, motor jitter may occur due to such a sudden change. To deal with this problem, a smooth switching is preferred.

After ramping, if the deviation between FOC_ETHETA and THETA_OL is less than or equal to FOC_THECOR, FOC_ETHETA is selected as the output angle. But if the deviation is larger than FOC_THECOR, THETA_OL is modified smoothly with the step of FOC_THECOR at every PWM cycle until it is close to FOC_ETHETA. After the deviation is less than FOC_THECOR, FOC_ETHETA is selected as the output angle.

12.1.9.3.4 Angle Compensation

Angle compensation value FOC_THECOMP is used to compensate for the estimated angle FOC_ETHETA. If FOC_THECOMP is negative, the lag angle is compensated; if it is positive, the lead angle is compensated.

12.1.10 Motor Real-time Parameters

MCU monitors the state of motor using the following real time variables provided by FOC module:

- > Used angle FOC_THETA
- > Estimated angle FOC_ETHETA, Estimated speed FOC_EOME
- > d-axis voltage FOC_UD, q-axis voltage FOC_UQ
- > d-axis current FOC_ID, q-axis current FOC_IQ
- > α -axis voltage FOC_VALP, β -axis voltage FOC_VBET
- > Bus voltage FOC_UDCFLT
- > Phase current FOC_IA, FOC_IB, FOC_IC and maximum phase current FOC_IAMAX, FOC_IBMAX, FOC_ICMAX
- > α -axis current (equal to FOC_IA), β -axis current FOC_IBET
- > α -axis BEMF FOC_EALP, β -axis BEMF FOC_EBET
- > Magnitude of BEMF FOC_EMF
- > Motor power FOC_POW

12.1.10.1 Tailwind/headwind Detection

FOC module provides tailwind/headwind detection feature. FOC module starts to operate when FOC_CR0 [ESCMS] is set to “1”, FOC_IDREF to “0” and FOC_IQREF to “0”. Motor’s rotor state is detected by FOC_ETHETA and FOC_EOME. If FOC_ETHETA decreases or FOC_EOME is a negative value, the motor rotates in the headwind state and it is necessary to brake first and then start the motor with ramping forced angle mode. If FOC_ETHETA increases or FOC_EOME is a positive value, the motor rotates in the tailwind state and can be started using estimated angle directly.

12.1.10.2 BEMF Detection

Estimator estimates α -axis BEMF FOC_EALP and β -axis BEMF FOC_EBET with the motor parameters, and calculates the magnitude of FOC_EMF, which implements protection features, such as motor lock protection, phase loss protection, etc.

12.1.10.3 Motor Power

FOC module calculates motor power based on the sampling current, modulation index of SVPWM and bus voltage.

12.1.11 FG Output Generation

FG signal is generated by FOC module and Timer4. FOC module calculates an FG result based on frequency base fbase, low-pass filtered speed FOC_EOMELPF and FG coefficient FOC_KFG in every PWM cycle. The result is updated to TIM4_ARR automatically and half of the result (TIM4_ARR/2) to TIM4_DR by hardware. It shall be noted that Timer4 must work in Output Mode and the clock division factor of Timer4 shall be configured according to the motor maximum speed. FOC_KFG is computed using the following algorithm: $\text{FOC\_KFG} = \text{SYSCLK} / (2^{\text{TIM4\_CR0}[\text{T4PSC}] * \text{fbase} * x})$, where, x refers to the expected number of FG signal in one electric cycle. If the result exceeds 65535, the clock division factor TIM4_CR0[T4PSC] shall be adjusted.

When FOC_KFG = 0, this feature is disabled, and TIM4_ARR and TIM4_DR keeps unchanged.

12.2 FOC Registers

12.2.1 FOC_CR0 (0x409F)

Bit	7	6	5	4	3	2	1	0
Name	OMIF	OMAF	MERRS		UCSEL	OMAS	ESCMS	EDIS
Type	R	R	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	OMIF	omega < FOC_EFREQMIN flag. This bit is valid even if FOC_CR1 [EFAE] is 0. 0: omega ≥ FOC_EFREQMIN 1: omega < FOC_EFREQMIN
[6]	OMAF	omega > FOC_EFREQMIN Flag 0: omega ≤ FOC_EFREQMAX 1: omega > FOC_EFREQMAX
[5:4]	MERRS	The maximum error of SMO Algorithm Select bit 00: 0.5 01: 0.25 10: 0.125 11: 1.0
[3]	UCSEL	Bus Voltage UDC Sampling Channel After FOC mode and Driver module counter are enabled, the hardware automatically samples the bus voltage. FOC_CR0[UCSEL] decides ADC channel for sampling bus voltage. 0: ADC channel 2 1: ADC channel 14  Note It is not necessary to set the associated Enable Bit in ADC_MASK register to “1”
[2]	OMAS	Output selection when omega is too large When omega[15:8] > FOC_EFREQMAX, the output OME is set as: 0: FOC_EFREQMAX*256 1: FOC_EFREQHOLD
[1]	ESCMS	Angle Mode Select bit 0: Internal Test Mode 1: Recommended Mode
[0]	EDIS	FOC_EALP/FOC_EBET Auto-computation Disabled 0: Not forbid 1: Forbid

12.2.2 FOC_CR1 (0x40A0)

Bit	7	6	5	4	3	2	1	0
Name	OVM DL	EFAE	RFAE	ANGM	CSM		RSV	SVPWMEN
Type	R/W	R/W	R/W	R/W	R/W	R/W	-	R/W
Reset	0	0	0	0	0	0	-	0

Bit	Name	Description
[7]	OVM DL	Overmodulation Enable 0: Disable 1: Enable
[6]	EFAE	Forced Angle of Estimator Enable When this feature is enabled, angle mode is determined by the estimator, and it switches to estimated angle mode automatically. 0: Disable 1: Enable
[5]	RFAE	Forced Ramping Angle Enable When this feature is enabled, angle mode is determined by the ramping module. After ramping, it switches to estimated mode or forced pulling mode according to FOC_CR1[ANGM]. FOC_CR1[RFAE] is cleared to “0” by hardware as well. 0: Disable 1: Enable
[4]	ANGM	Angle Mode When FOC_CR1[RFAE] = 0, angle mode is determined by this bit. When FOC_CR1[RFAE] = 1, angle mode is determined by this bit after ramping. 0: Forced Pulling Angle Mode 1: Estimated Angle of Estimator Mode
[3:2]	CSM	Current Sampling Mode 00: Single-shunt Current Sampling 01: Dual-shunt Current Sampling 10: Advanced Single-shunt Sampling 11: Triple-shunt Current Sampling  Note The Advanced Single-shunt Sampling Mode works better in low duty cycles than high duty cycles. You can switch between Single-shunt Sampling Mode and Advanced Single-shunt Sampling Mode according to the duty cycle, and configure FOC_TSMIN accordingly
[1]	RSV	Reserved
[0]	SVPWMEN	SVPWM Module Enable 0: Disable 1: Enable

12.2.3 FOC_CR2 (0x40A1)

Bit	7	6	5	4	3	2	1	0
Name	ESEL	ICLR	F5SEG	DSS	CSOC		UQD	UDD
Type	R/W	R/W1	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	ESEL	Angle Estimator Mode Selection 0: SMO 1: PLL (phase-locked loop). FOC_KSILDE register is FOC_PLLKP of PI controller, and FOC_KLPFMIN register is FOC_PLLKI of PI controller.
[6]	ICLR	Clear FOC_IAMAX/FOC_IBMAX/FOC_ICMAX to “0” 0: No effect 1: The bit is automatically set to “0” after FOC_IAMAX/ FOC_IBMAX/ FOC_ICMAX are cleared to “0”.
[5]	F5SEG	SVPWM Mode Selection 0: Continuous SVPWM 1: Discontinuous SVPWM (cannot be selected in single-shunt current sampling mode)
[4]	DSS	Dual/Triple-shunt Current Sampling Mode 0: Sequential Sampling Mode, where current values of two phases are sampled in each carrier period. 1: Alternate Sampling Mode. FOC module completes the calculation in every PWM cycle. The current of one phase is sampled in each PWM cycle, and the current of two phases are sampled alternately in two adjacent PWM cycles.
[3:2]	CSOC	Current Sampling Offset Calibration This bit is written to select the offset of FOC_CSO. In single-shunt current sampling mode, “00” or “11” is written to calibrate itrip offset. In dual-shunt current sampling mode, “01” is written to calibrate ia offset and “10” to calibrate ib offset. In triple-shunt current sampling mode, “01” is written to calibrate ia offset, “10” to calibrate ib offset and “00” or “11” to calibrate ic offset. 00: itrip & ic 01: ia 10: ib 11: itrip & ic
[1]	UQD	q-axis PI controller disabled, where FOC_UQ value is no longer updated by the PI controller. 0: Not forbid 1: Forbid
[0]	UDD	d-axis PI controller disabled, where the FOC_UD value is no longer updated by the PI controller. 0: Not forbid 1: Forbid

12.2.4 FOC_CR3 (0x409E)

Bit	7	6	5	4	3	2	1	0
Name	EFAM	TAMD	MFP_EN	FOC_THECOMP_DIS	FOCFEN	HALL_PLL_EN	TSMINH9	TSMINH8
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	EFAM	OMEGA Startup Force Enable When FOC_CR1[EFAE] is set to “0” and FOC_CR3[EFAM] to “1”, FOC_OMEGA register is forced to stay as FOC_EFREQHOLD. 0: Disable 1: Enable
[6]	TAMD	Angle Calculation Method The angle derived from atan (ealpha/ebeta) is used as FOC_THETA. 0: Disable 1: Enable
[5]	MFP_EN	Adaptive Observer Enable 0: Disable 1: Enable
[4]	FOC_THECOMP_DIS	Algorithm w/o Compensation Angle Enable With this feature enabled, angle compensation of 26.5° is not executed even if the SMO or AO algorithm is selected. 0: Disable 1: Enable
[3]	FOCFEN	FOC Force Enable When DRV_CR[MESEL] is set to “1”, FOC module performs calculation even if DRV_CR[OCS] = 0. 0: Disable 1: Enable
[2]	HALL_PLL_EN	Hall Filter in PLL Mode Enable In Hall mode, Hall angle written to FOC_THETA bit is sent to other modules after smooth switching. 0: Disable 1: Enable
[1:0]	TSMINH	Scale up by two bits of FOC_TSMIN, forming 10-bit data with the 0x40A2 register

12.2.5 FOC_TSMIN (0x40A2)

Bit	7	6	5	4	3	2	1	0
Name	FOC_TSMIN							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	FOC_TSMIN	Single-shunt Sampling Mode: minimum window for sampling Dual/triple-shunt Sampling Mode: deadtime compensation Range [0, 255] TSMIN = sampling window T_{window} + deadtime T_{DT} Example: Assuming that $T_{\text{window}} = 1\mu\text{s}$, $T_{\text{DT}} = 1\mu\text{s}$, TSMIN = 2$\mu\text{s}$ and carrier period = 62.5μs, then $\text{FOC\_TSMIN} = (1 + 1)/62.5 \times 4096 = 131$. Advanced Single-shunt Sampling Mode: minimum window for current sampling TSMIN = sampling window T_{window} + deadtime T_{DT} Example: Assuming that $T_{\text{window}} = 1\mu\text{s}$, $T_{\text{DT}} = 1\mu\text{s}$ and TSMIN = 2μs, then $\text{FOC\_TSMIN} = (1 + 1) \times 24 = 48$.

12.2.6 FOC_TGLI (0x40A3)

Bit	7	6	5	4	3	2	1	0
Name	FOC_TGLI							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	FOC_TGLI	Narrow Pulse Elimination for High-side of the Bridge This feature is designed for high-voltage applications. The high-side of bridge must be longer than a certain time. After this bit is configured, high-side of the bridge is not turned on when the conducting time is less than this value. Range [0, 255] Example: Assuming that it is required to remove narrow pulses with less than 1μs width, deadtime $T_{\text{DT}} = 1\mu\text{s}$, and carrier period = 62.5μs, then $\text{FOC\_TGLI} = (1 + 1)/62.5 \times 4096 = 131$.

12.2.7 FOC_TBLO (0x40A4)

Bit	7	6	5	4	3	2	1	0
Name	FOC_TBLO							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	FOC_TBLO	Sampling Masking Time in Triple-shunt Current Sampling Mode If low-side of the bridge is turned on for less than FOC_TBLO, the current of this phase is not sampled and obtained through special process. Range [0, 255] Example: Assuming that the phase current is not sampled if the low-side is turned on for less than 1μs, then FOC_TBLO = 1000ns/41.67ns = 24.

12.2.8 FOC_TRGDLY (0x40A5)

Bit	7	6	5	4	3	2	1	0
Name	FOC_TRGDLY							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	FOC_TRGDLY	Time Configuration for Current Sampling When FOC_TRGDLY is set to "0", FOC module samples the current as follows. Single-shunt Sampling Mode: Midpoint between deadtime and applied time of active voltage vector Dual/Triple-shunt/Advanced Single-shunt Sampling Mode: Midpoint of vector 000 (Driver count value = 0) Range [-128, 127] Single-shunt Sampling Mode: If FOC_TRGDLY = 5, it delays by 5*T = 208ns to sample the current, and if FOC_TRGDLY = 0xFB (complement) or FOC_TRGDLY = -5, it advances by 5*T=208ns. Dual-shunt/Triple-shunt/Advanced Single-shunt Sampling Mode: If FOC_TRGDLY = 0x85 (the highest bit, and the remaining 7 bits are absolute values) and Driver timer counts down, it samples the current at 5*T = 208ns before an overflow event occurs. If OC_TRGDLY = 5 and Driver timer counts up, it samples the current at 5*T = 208ns after an overflow event occurs.

12.2.9 FOC_CSO (0x40A6, 0x40A7)

FOC_CSOH(0x40A6)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_CSO[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	1	0	0	0	0	0	0
FOC_CSOL(0x40A7)								

Bit	7	6	5	4	3	2	1	0
Name	FOC_CSO[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_CSO	Current Sampling Offset FOC_CR2[CSOC] is configured to select the current, and FOC_CSO is written to calibrate current sampling offset of itrip in single-shunt current sampling mode, ia, ib in dual-shunt current sampling mode and ia, ib and ic in triple-shunt current sampling mode. Range [0,32767]. The MSB is always 0 Example: Assuming that the ADC voltage falls within 0V ~ 5V with a reference value of 2.5V, then $FOC\_CSO = 2.5V/5V * 32768 = 16384(0x4000)$

12.2.10 FOC_RTHERSTEP (0x40A8, 0x40A9)

FOC_RTHERSTEP(0x40A8)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_RTHERSTEP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_RTHERSTEP(0x40A9)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_RTHERSTEP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_RTHERSTEP	Speed of Ramping Module FOC_RTHERSTEP is an internal 32-bit variable. MSB is sign bit. High-order 16 bits are written by software. Range [-32768,32767] $FOC\_RTHERSTEP(32\text{ bits}) = FOC\_RTHERSTEP(32\text{ bits}) + FOC\_RTHERACC(16\text{ low-order bits})$ $THETA\_OL(16\text{ bits}) = THETA\_OL(16\text{ bits}) + FOC\_RTHERSTEP(16\text{ high-order bits})$

12.2.11 FOC_RTHERACC (0x40AA, 0x40AB)

FOC_RTHERACC(0x40AA)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_RTHERACC[15:8]							
Type	W	W	W	W	W	W	W	W

Reset	0	0	0	0	0	0	0	0
FOC_RTHERACCL(0x40AB)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_RTHERACC[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_RTHERACC	Ramping acceleration, FOC_RTHERACC is an internal 32-bit variable. MSB is sign bit. Low-order 16 bits are written by software, and high-order 16 bits are always 0. Range [-32768,32767] FOC_RTHERSTEP (32 bits) = FOC_RTHERSTEP (32 bits) + FOC_RTHERACC (16 low-order bits) THETA_OL (16 bits) = THETA_OL (16 bits) + FOC_RTHERSTEP (16 high-order bits)

12.2.12 FOC_EOMELPF (0x40AA, 0x40AB)

FOC_EOMELPFH(0x40AA)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EOMELPF[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_EOMELPFL(0x40AB)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EOMELPF[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EOMELPF	Filtered Estimated Speed of Estimator The filter coefficient is FOC_EOMEKLPF, and the LPF frequency is the PWM cycle. Range [-32768, 32767]

12.2.13 FOC_RTHERCNT (0x40AC)

Bit	7	6	5	4	3	2	1	0
Name	FOC_RTHERCNT							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	FOC_RTHERCNT	爬坡次数上限 = FOC_RTHERCNT*256 爬坡功能使能后，每个载波周期进行一次爬坡运算，当爬坡次数达到 FOC_RTHERCNT*256 后，爬坡结束

12.2.14 FOC_THECOR (0x40AD)

Bit	7	6	5	4	3	2	1	0
Name	FOC_THECOR							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R
Reset	0	0	0	0	0	0	0	1

Bit	Name	Description
[7:0]	FOC_THECOR	Max. ramping counts = FOC_RTHERCNT*256 When ramping feature is enabled, the ramping angle increases in each PWM cycle. After FOC_RTHERCNT*256 times, ramping feature is disabled.

12.2.15 FOC_EMF (0x40AE, 0x40AF)

FOC_EMFH(0x40AE)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EMF[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_EMFL(0x40AF)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EMF[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EMF	Estimated BEMF of Estimator This value is the root of sum of square of FOC_EALP and square of FOC_EBET. Range [0, 32767]

12.2.16 FOC_THECOMP (0x40AE, 0x40AF)

FOC_THECOMP(0x40AE)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_THECOMP[15:8]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

FOC_THECOMPL(0x40AF)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_THECOMP[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_THECOMP	Angle Compensation Value The output angle FOC_THETA is derived from estimated angle of the estimator (FOC_ETHERA) + compensation value; the format is same as that of FOC_THETA. Range [-32768, 32767]

12.2.17 FOC_DMAX (0x40B0, 0x40B1)

FOC_DMAXH(0x40B0)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_DMAX[15:8]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

FOC_DMAXL(0x40B1)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_DMAX[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_DMAX	Max. output of d-axis PI controller. Range [-32768, 32767]

12.2.18 FOC_OMEEST (0x40B0, 0x40B1)

FOC_OMEESTH(0x40B0)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_OMEEST[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

FOC_OMEESTL(0x40B1)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_OMEEST[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_OMEEST	FOC Calculated Speed of Estimator. Range (0,32767)

12.2.19 FOC_DMIN (0x40B2, 0x40B3)

FOC_DMINH(0x40B2)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_DMIN[15:8]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0
FOC_DMINL(0x40B3)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_DMIN[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_DMIN	Min. output of d-axis PI controller Range [-32768, 32767]

12.2.20 FOC_ATAN_THETA (0x40B2, 0x40B3)

FOC_ATAN_THETAH(0x40B2)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_ATAN_THETA[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_ATAN_THETAL(0x40B3)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_ATAN_THETA[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_ATAN_THETA	Angle in ATAN mode, directly calculated by FOC_EALP/FOC_EBET Range (-32768,32767)

12.2.21 FOC_QMAX (0x40B4, 0x40B5)

FOC_QMAXH(0x40B4)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_QMAX[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0
FOC_QMAXL(0x40B5)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_QMAX[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_QMAX	Max. output of q-axis PI controller Range [-32768, 32767]

12.2.22 FOC_QMIN (0x40B6, 0x40B7)

FOC_QMINH(0x40B6)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_QMIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_QMINL(0x40B7)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_QMIN[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_QMIN	Min. output of q-axis PI controller Range [-32768, 32767]

12.2.23 FOC_UD (0x40B8, 0x40B9)

FOC_UDH(0x40B8)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_UD[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_UDL(0x40B9)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_UD[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_UD	d-axis voltage calculated by d-axis PI controller

Range [-32768, 32767]

12.2.24 FOC_UQ (0x40BA, 0x40BB)

FOC_UQH(0x40BA)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_UQ[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_UQL(0x40BB)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_UQ[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_UQ	q-axis voltage calculated by q-axis PI controller Range [-32768, 32767]

12.2.25 FOC_ID (0x40BC, 0x40BD)

FOC_IDH(0x40BC)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_ID[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_IDL(0x40BD)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_ID[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_ID	d-axis current from coordinate transformation. Range [-32768, 32767]

12.2.26 FOC_IQ (0x40BE, 0x40BF)

FOC_IQH(0x40BE)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_IQ[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_IQL(0x40BF)								

Bit	7	6	5	4	3	2	1	0
Name	FOC_IQ[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IQ	q-axis current from coordinate transformation Range [-32768, 32767]

12.2.27 FOC_IBET (0x40C0, 0x40C1)

FOC_IBETH(0x40C0)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_IBET[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

FOC_IBETL(0x40C1)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_IBET[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IBET	β -axis current from coordinate transformation Range [-32768, 32767]

12.2.28 FOC_IQ_LPFK (0x40C0)

Bit	7	6	5	4	3	2	1	0
Name	FOC_IQ_LPFK							
Type	W	W	W	W	W	W	W	W
Reset	1	1	1	1	1	1	1	1

Bit	Name	Description
[7:0]	FOC_IQ_LPFK	LPF coefficient of FOC_IQ, set to 0xFF by default Range (0,255)

12.2.29 FOC_ID_LPFK (0x40C1)

Bit	7	6	5	4	3	2	1	0
Name	FOC_IQ_LPFK							
Type	W	W	W	W	W	W	W	W
Reset	1	1	1	1	1	1	1	1

Bit	Name	Description
[7:0]	FOC_ID_LPFK	LPF coefficient of FOC_ID, set to 0xFF by default Range (0,255)

12.2.30 FOC_VBET (0x40C2, 0x40C3)

FOC_VBETH(0x40C2)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_VBET[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_VBETL(0x40C3)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_VBET[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_VBET	β -axis Output Voltage of FOC Module Range [-32768, 32767]

12.2.31 FOC_UDCPS (0x40C2, 0x40C3)

FOC_UDCPSH(0x40C2)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_UDCPS[15:8]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0
FOC_UDCPSL(0x40C3)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_UDCPS[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_UDCPS	d-axis Voltage Compensation Value The result of d-axis PI controller (FOC_UD) added to FOC_UDCPS is transferred to the next module. Range [-32768, 32767]

12.2.32 FOC_UQCPS (0x40C4, 0x40C5)

FOC_UQCPSH(0x40C4)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_UQCPS[15:8]							

Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0
FOC_UQCPSL(0x40C5)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_UQCPS[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_UQCPS	q-axis Voltage Compensation Value The result of q-axis PI controller (FOC_UD) added to FOC_UQCPS is transferred to the next module. Range [-32768, 32767]

12.2.33 FOC_VALP (0x40C4, 0x40C5)

FOC_VALPH(0x40C4)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_VALP[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_VALPL(0x40C5)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_VALP[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_VALP	α-axis Output Voltage of FOC Module Range [-32768, 32767]

12.2.34 FOC_FLUX (0x40C6, 0x40C7)

FOC_FLUXH(0x40C6)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_FLUX[15:8]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0
FOC_FLUXL(0x40C7)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_FLUX[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_FLUX	Magnetic flux of motor Range (0, 32767)

12.2.35 FOC_IC (0x40C6, 0x40C7)

FOC_ICH(0x40C6)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_IC[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_ICL(0x40C7)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_IC[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IC	Sampled C Phase Current Range [-32768, 32767]

12.2.36 FOC_LQ (0x40C8, 0x40C9)

FOC_LQH(0x40C8)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_LQ[15:8]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0
FOC_LQ(0x40C9)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_LQ[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_LQ	Q-axis Inductance Range (0, 32767)

12.2.37 FOC_IB (0x40C8, 0x40C9)

FOC_IBH(0x40C8)								
Bit	15	14	13	12	11	10	9	8

Name	FOC_IB[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_IBL(0x40C9)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_IB[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IB	Sampled B Phase Current Range [-32768, 32767]

12.2.38 FOC_LD (0x40CA, 0x40CB)

FOC_LDH(0x40CA)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_LD[15:8]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0
FOC_LD(0x40CB)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_LD[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_LD	D-axis Inductance Range (0, 32767)

12.2.39 FOC_IA (0x40CA, 0x40CB)

FOC_IAH(0x40CA)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_IA[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_IAL(0x40CB)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_IA[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IA	Sampled A Phase Current Range [-32768, 32767]

12.2.40 FOC_THETA (0x40CC, 0x40CD)

FOC_THETAH(0x40CC)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_THETA[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_THETAL(0x40CD)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_THETA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_THETA	Output Angle of FOC Module Range [-32768, 32767] The bit value -32768 ~ 32767 corresponds to angle range -180°~ 180°. Example: Assuming that FOC_THETA = 8192, the output angle is $8192/32768 \times 180^\circ = 45^\circ$.

12.2.41 FOC_ETHETA (0x40CE, 0x40CF)

FOC_ETHETAH(0x40CE)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_ETHETA[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_ETHETAL(0x40CF)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_ETHETA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_ETHETA	Read: Output Angle of Estimator (angle before FOC_THECOMP is applied); the format is same as that of FOC_THETA. Write: Start Angle of Estimator Range [-32768, 32767]

12.2.42 FOC_EALP (0x40D0, 0x40D1)

FOC_EALPH(0x40D0)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EALP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EALPL(0x40D1)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EALP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EALP	α -axis estimated BEMF Range [-32768, 32767]

12.2.43 FOC_EBET (0x40D2, 0x40D3)

FOC_EBETH(0x40D2)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EBET[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EBETL(0x40D3)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EBET[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EBET	β -axis estimated BEMF Range [-32768, 32767]

12.2.44 FOC_EOME (0x40D4, 0x40D5)

FOC_EOMEH(0x40D4)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EOME[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EOMEL(0x40D5)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EOME[7:0]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EOME	Output Speed of Estimator Range [-32768, 32767]

12.2.45 FOC_UQEX (0x40D6, 0x40D7)

FOC_UQEXH(0x40D6)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_UQEX[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_UQEXL(0x40D7)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_UQEX[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_UQEX	Overflow Value of q-axis PI Controller Equation: $FOC\_UQ - FOC\_QMAX$ FOC_UQEX is positive when $FOC\_UQ > FOC\_QMAX$ FOC_UQEX is negative when $FOC\_UQ < FOC\_QMAX$ FOC_UQEX can be used to realize weak magnetic flux control. Range [-32768, 32767]

12.2.46 FOC_KFG (0x40D6, 0x40D7)

FOC_KFGH(0x40D6)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_KFG[15:8]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0
FOC_KFGL(0x40D7)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_KFG[7:0]							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_KFG	Coefficient of FG Calculation

FOC module performs the calculation based on FOC_EOMELPF and FOC_KFG in each PWM cycle. The result is updated to TIM4_ARR and half of the result (TIM4_ARR/2) to TIM4_DR by hardware
See FG Output Generation for more details
Range [0,65535]

**Note**

The clock division factor TIM4_CR0[T4PSC] of Timer4 shall be adjusted if FOC_KFG overflows. When FOC_KFG = 0, this feature is disabled

12.2.47 FOC_POW (0x40D8, 0x40D9)

FOC_POWH(0x40D8)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_POW[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_POWL(0x40D9)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_POW[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_POW	Motor Power Range [-32768, 32767]

12.2.48 FOC_EOMEKLPF (0x40D8)

Bit	7	6	5	4	3	2	1	0
Name	FOC_EOMEKLPF							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	FOC_EOMEKLPF	LPF coefficient of estimated speed FOC_EOMELPF of the estimator LPF is calculated in every PWM cycle. Range [1, 255] mapping [1/32768,255/32768].

12.2.49 FOC_IAMAX (0x40DA, 0x40DB)

FOC_IAMAXH(0x40DA)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_IAMAX[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_IAMAXL(0x40DB)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_IAMAX[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IAMAX	Max. A Phase Current Recorded maximum value of A-phase current; This value may be unreliable unless the motor rotates in a full electrical period. This maximum value will not be cleared to “0” automatically unless FOC_CR2[ICLR] is set to “1”. Range [-32768, 32767]

12.2.50 FOC_IBMAX (0x40DC, 0x40DD)

FOC_IBMAXH(0x40DC)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_IBMAX[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_IBMAXL(0x40DD)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_IBMAX[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IBMAX	Max. B Phase Current Recorded maximum value of B-phase current. This value may be unreliable unless the motor rotates in a full electrical period. This value will not be cleared to “0” automatically unless FOC_CR2[ICLR] is set to “1”. Range [-32768, 32767]

12.2.51 FOC_ICMAX (0x40DE, 0x40DF)

FOC_ICMAXH(0x40DE)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_ICMAX[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_ICMAXL(0x40DF)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_ICMAX[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_ICMAX	Max. C Phase Current Recorded maximum value of C-phase current. This value may be unreliable unless the motor rotates in a full electrical period. This value will not be cleared to “0” automatically unless FOC_CR2[ICLR] is set to “1”. Range [-32768, 32767]

12.2.52 FOC_EFREQMAX (0x406F)

Bit	7	6	5	4	3	2	1	0
Name	FOC_EFREQMAX[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	1	1	1	1	1	1	1

Bit	Name	Description
[7:0]	FOC_EFREQMAX	Max. omega When omega[15:8] > FOC_EFREQMAX, the output speed OME is: FOC_CR0[OMAS] = 0: FOC_EFREQMAX*256 FOC_CR0[OMAS] = 1: FOC_EFREQHOLD Range [0, 127] 0 ~ 127 mapping the speed range 0~ 32767.  Note This bit is invalid when MSB = 1

12.2.53 FOC_DKP (0x4070, 0x4071)

FOC_DKPH(0x4070)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_DKP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_DKPL(0x4071)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_DKP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	Name		Description					
[15:0]	FOC_DKP		KP of D-axis PI Controller Range (0,32767); MSB is always 0; Q12 format					

12.2.54 FOC_EKP (0x4074, 0x4075)

FOC_EKPH(0x4074)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EKP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EKPL(0x4075)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EKP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	Name		Description					
[15:0]	FOC_EKP		KP of PI controller used for estimated angle of the estimator. MSB is always 0. Q12 format. Range [0, 32767]					

12.2.55 FOC_EKI (0x4076, 0x4077)

FOC_EKIH(0x4076)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EKI[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EKIL(0x4077)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EKI[7:0]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EKI	KI of PI controller used for estimated angle of the estimator; MSB is always 0; Q15 format. Range [0, 32767]

12.2.56 FOC_KSLIDE (0x4078, 0x4079)

FOC_KSLIDEH(0x4078)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_KSLIDE/FOC_PLLKP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_KSLIDEL(0x4079)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_KSLIDE/FOC_PLLKP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_KSLIDE/FOC_PLLKP	FOC_CR2[ESEL] = 0: SMO gain factor; Q15 format FOC_CR2[ESEL] = 1: KP of PI controller on PLL; Q12 format Range [0,32767]. MSB is always 0.

12.2.57 FOC_EKLPMIN (0x407A, 0x407B)

FOC_EKLPMINH(0x407A)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EKLPMIN/FOC_PLLKPI[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EKLPMINL(0x407B)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EKLPMIN/FOC_PLLKPI[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EKLPMIN/ FOC_PLLKI	FOC_CR2[ESEL] = 0: The minimum value of BEMF low pass filter factor. EKLPMIN is forced to be this value when it is lower than this value. Q15 format. FOC_CR2[ESEL] = 1: PI controller KI coefficient on PLL. Q15 format. Range [0, 32767], MSB is always 0.

12.2.58 FOC_DKI (0x407C, 0x407D)

FOC_DKIH(0x407C)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_DKI[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_DKIL(0x407D)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_DKI[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_DKI	KI of D-axis PI Controller Range (0, 32767). MSB is always 0. Q15 format

12.2.59 FOC_OMEKLPF (0x407E, 0x407F)

FOC_OMEKLPFH(0x407E)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_OMEKLPF[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_OMEKLPFL(0x407F)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_OMEKLPF[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_OMEKLPF	LPF factor of estimated speed of the estimator. MSB is always 0. Q15 format. Range [0, 32767]

12.2.60 FOC_FBASE (0x4080, 0x4081)

FOC_FBASEH(0x4080)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_FBASE[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_FBASEL(0x4081)								
Bit	7	6	5	4	3	2	1	0

Name	FOC_FBASE[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_FBASE	Frequency Base of Estimator Range [0, 32767] FOC_FBASE = fbase*Ts*32768 Example: Assuming that fbase = 200Hz, Ts = 62.5μs, then FOC_FBASE = 200*0.0000625*32768 = 409(0x199)

12.2.61 FOC_EFREQACC (0x4082, 0x4083)

FOC_EFREQACCH(0x4082)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EFREQACC[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EFREQACCL(0x4083)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EFREQACC[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EFREQACC	Speed Increment of the Forced Angle Mode. FOC_EFREQACC is an internal 24-bit variable and MSB is sign bit. Low-order 16 bits are written by software. Range [0, 65535] Example: Assuming that fbase = 200Hz and pp (Pole_Pairs) = 4, then speed_base = 60*fbase/pp = 3000rpm. If speed increment = 3rpm, then FOC_EFREQACC = 3rpm/speed_base*32768*256 = 8388(0x20C4).

12.2.62 FOC_EFREQMIN (0x4084, 0x4085)

FOC_EFREQMINH(0x4084)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EFREQMIN[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EFREQMINL(0x4085)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EFREQMIN[7:0]							

Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EFREQMIN	Switch Threshold of the Estimated Angle FOC_EFREQMIN is an internal 24-bit variable, and MSB is sign bit. High-order 16 bits are written by software. With Forced Angle of Estimator Mode enabled, FOC module outputs forced angle when the estimated angle is smaller than the bit value. Range [-32768, 32767] Example: Assuming that fbase = 200Hz and pp (Pole_Pairs) = 4, then speed_base = 60*fbase/pp = 3000rpm. Assuming that the minimum switching speed = 30rpm, then FOC_EFREQMIN = 30rpm/speed_base*32768 = 327(0x147).

12.2.63 FOC_EFREQHOLD (0x4086, 0x4087)

FOC_EFREQHOLDH(0x4086)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EFREQHOLD[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EFREQHOLDL(0x4087)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EFREQHOLD[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EFREQHOLD	Maximum Value of Forced Speed of the Estimator FOC_EFREQHOLD is an internal 24-bit variable, and MSB is sign bit. High-order 16 bits are written by the software. Range [-32768, 32767] Example: Assuming that fbase = 200Hz and pp (Pole_Pairs) = 4, then speed_base = 60*fbase/pp = 3000rpm. If max. forced speed = 60rpm, then FOC_EFREQHOLD = 60rpm/speed_base*32768 = 655(0x028F).

12.2.64 FOC_EK3 (0x4088, 0x4089)

FOC_EK3H(0x4088)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EK3[15:8]							
Type	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

FOC_EK3L(0x4089)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EK3[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EK3	The 3rd coefficient of the current model in estimator, and MSB is always 0. Q15 format. Range [0, 32767]

12.2.65 FOC_EK4 (0x408A, 0x408B)

FOC_EK4H(0x408A)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EK4[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

FOC_EK4L(0x408B)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EK4[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EK4	The 4th coefficient of the current model in estimator. Q15 format. Range [-32768, 32767]

12.2.66 FOC_EK1 (0x408C, 0x408D)

FOC_EK1H(0x408C)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EK1[15:8]							
Type	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

FOC_EK1L(0x408D)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EK1[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EK1	The 1st coefficient of the current model in estimator, and MSB is always 0.

Q15 format.
Range [0, 32767]

12.2.67 FOC_EK2 (0x408E, 0x408F)

FOC_EK2H(0x408E)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_EK2[15:8]							
Type	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_EK2L(0x408F)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_EK2[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_EK2	The 2nd coefficient of the current model in estimator, and MSB is always 0. Q15 format. Range [0, 32767]

12.2.68 FOC_IDREF (0x4090, 0x4091)

FOC_IDREFH(0x4090)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_IDREF[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_IDREFL(0x4091)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_IDREF[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IDREF	User-defined d-axis Current Range [-32768, 32767]

12.2.69 FOC_IQREF (0x4092, 0x4093)

FOC_IQREFH(0x4092)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_IQREF[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0
FOC_IQREFL(0x4093)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_IQREF[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_IQREF	User-defined q-axis Current Range [-32768, 32767]

12.2.70 FOC_QKP (0x4094, 0x4095)

FOC_QKPH(0x4094)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_QKP[15:8]							
Type	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_QKPL(0x4095)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_QKP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_QKP	KP coefficient of q-axis PI controller. MSB is always 0. Q12 format. Range [0, 32767] corresponds to range of Q12 [0, 8].

12.2.71 FOC_QKI (0x4096, 0x4097)

FOC_QKIH(0x4096)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_QKI[15:8]							
Type	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
FOC_QKIL(0x4097)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_QKI[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_QKI	KI coefficient of q-axis PI controller. MSB is always 0. Q15 format. .

The bit value range [0, 32767] corresponds to the Q15 value range [0,1].

12.2.72 FOC_UDCFLT (0x4098, 0x4099)

FOC_UDCFLTH(0x4098)								
Bit	15	14	13	12	11	10	9	8
Name	FOC_UDCFLT[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
FOC_UDCFLTL(0x4099)								
Bit	7	6	5	4	3	2	1	0
Name	FOC_UDCFLT[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	FOC_UDCFLT	Filtered Bus Voltage FOC module samples the bus voltage and filters it to obtain FOC_UDCFLT. ADC channel 2 (external voltage divider) or ADC channel 14 can be selected. Range [0, 32767] Example: The bus voltage is scaled down by 1/6 before feeding into the ADC module, ADC VREF = 5V (namely, the sampling range is [0V~30V]) and FOC_UDCFLT = 19661(0x4CCD), then bus voltage = $19661/32768 \times 5V \times 6 = 18V$.

13 Timer1

13.1 Timer1 Operations

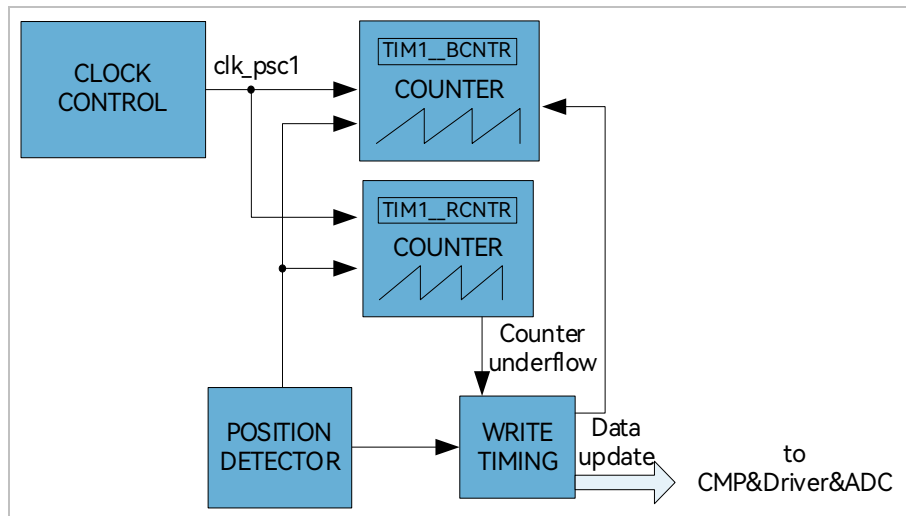
Timer1 consists of a 16-bit up-counting Base Timer and a 16-bit up-counting Reload Timer. Timer1 can be used in the applications of square-wave controlled BLDC motor drive.

Timer1 features as follows:

- The 16-bit up-counting Base Timer is used to record the time between twice position detected events or twice phases commutations (60-degree time) and also can be used for forced phase commutation control when phase detection fails.
- The 16-bit up-counting Reload Timer is used to control the time from position detected to phase commutation, as well as masking time for diode freewheeling after phase commutation (prohibit position detection time).
- The 3-bit programmable frequency prescaler divides the system clock. The divided clock is used as the clock source of the two timers.
- Configurable filtering signals and sampling delay for position detection
- Position detection module generates the position signal required for phase commutation according to the input signal
- 7 groups state register control comparator and pre-driver output
- 6 interrupt sources

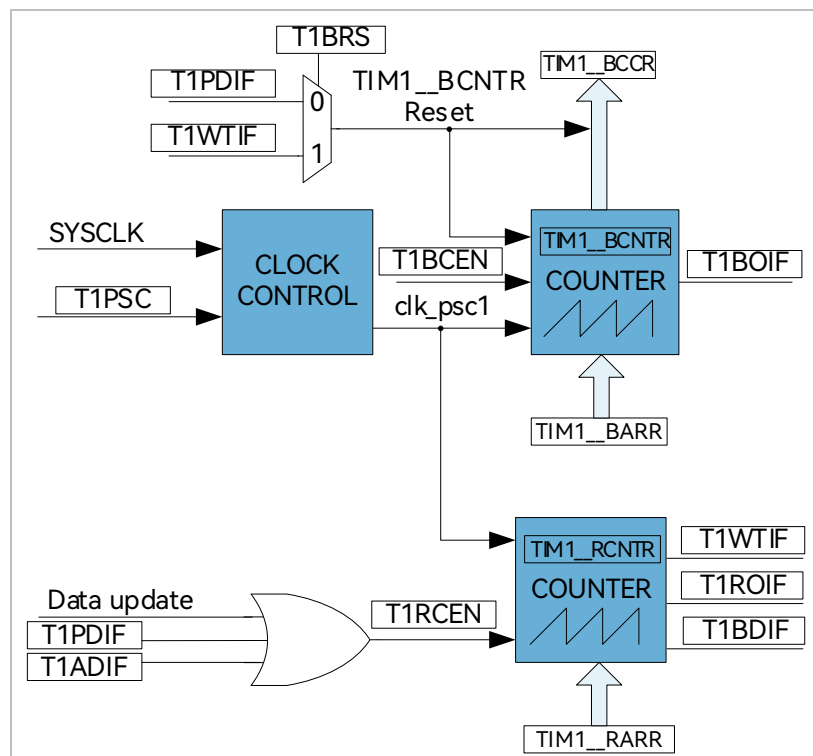
The internal structure of Timer1 is shown in Figure 13-1.

Figure 13-1 Timer1 Internal Structure



13.1.1 Timer1 Counter Module

Figure 13-2 Timer Counting Unit



Timer1 consists of a frequency prescaler, a 16-bit up-counting Base Timer and a 16-bit up-counting Reload Timer.

13.1.1.1 Prescaler

Prescaler divides the system clock frequency and generates the counter clock source for Base Timer and Reload Timer. It offers 8 division coefficients and can be selected through TIM1_CR3[T1PSC]. Since this register has no buffer, the clock rate is immediately updated after the division coefficient is written. Therefore, the division coefficient shall be configured when both the Basic Timer and Reload Timer are not working. The clock rate $\text{clk\_psc1} = \text{SYSCLK}/(2^{\text{TIM1\_CR3[T1PSC]}})$. The clock rate corresponding to TIM1_CR3[T1PSC] is shown in Table 13-1.

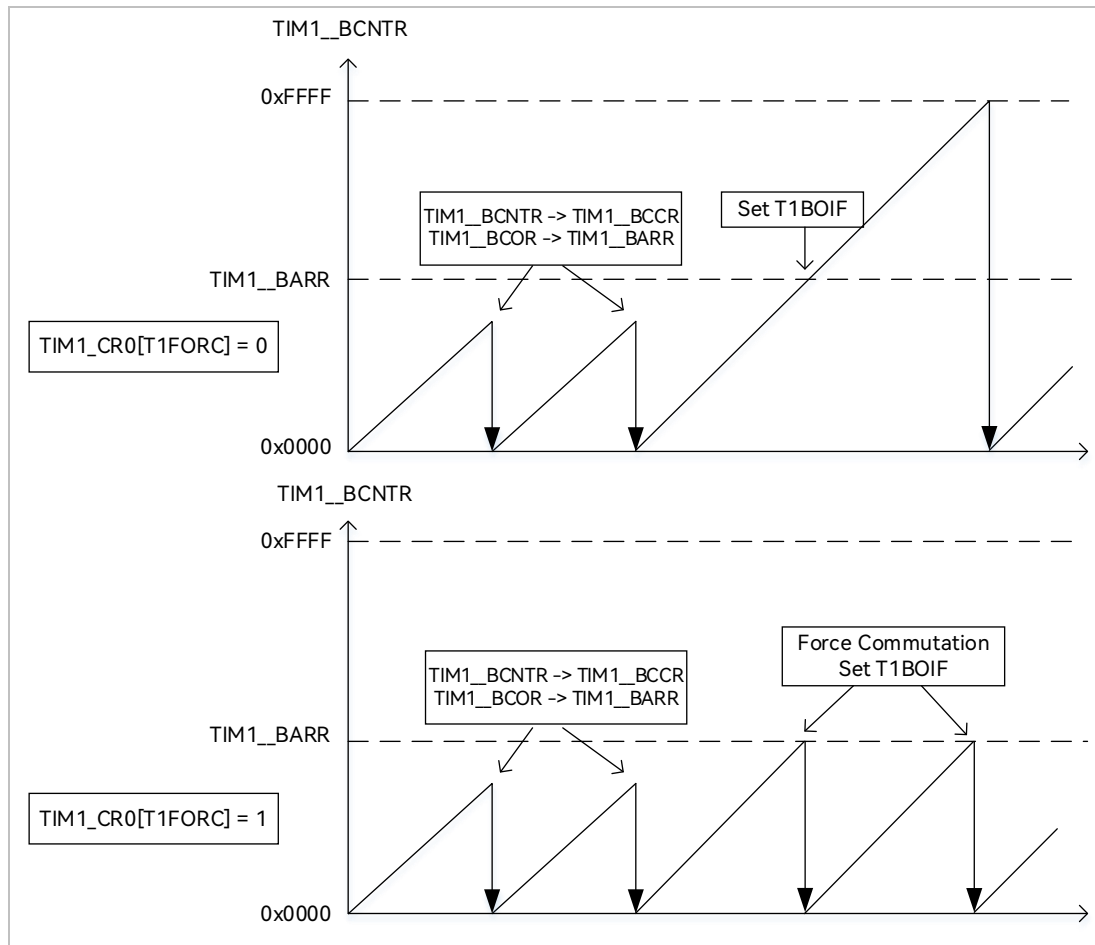
Table 13-1 Mapping between Clock Rate and TIM1_CR3[T1PSC] Bit

TIM1_CR3[T1PSC]	Division Factor	clk_psc1(Hz)	TIM1_CR3[T1PSC]	Division Factor	clk_psc1(Hz)
000	1	24M	100	16	1.5M
001	2	12M	101	32	750k
010	4	6M	110	64	375k
011	8	3M	111	128	187.5k

13.1.1.2 Base Timer

The Base Timer is a 16-bit up timer with its count value held in the TIM1_BCNT register. TIM1_BCNT value is loaded into Capture Register TIM1_BCCR upon a Position Detected Interrupt TIM1_SR[T1PDIF] or a Write Timing Interrupt TIM1_SR[T1WTIF] (selected by TIM1_CR2[T1BRS] bit). Meanwhile, TIM1_BCNT bit is cleared to “0” and restarts the counter cycle. TIM1_BCCR captures the time between two Position Detected Interrupts or two Write Timing Interrupts (i.e. 60° commutation time). These time inputs are averaged multiple times (programmed by the TIM1_CR0[T1CFLT] bit) before loading the average as a 60° commutation base into the TIM1_BCOR register. When Auto-load Register TIM1_BARR is enabled (TIM1_CR1[BAPE] is set to “1”), TIM1_BARR loads the value of TIM1_BCOR by hardware. When count value of TIM1_BCNT increases to TIM1_BARR, overflow interrupt flag TIM1_SR[T1BOIF] of the Basic Timer is set to “1”. If forced commutation feature is enabled, phase commutation occurs and the Basic Timer Register is cleared to “0”. Otherwise, the Basic Timer Register will not be cleared until it counts up to 0xFFFF and becomes overflowed.

Figure 13-3 Waveform of Base Timer

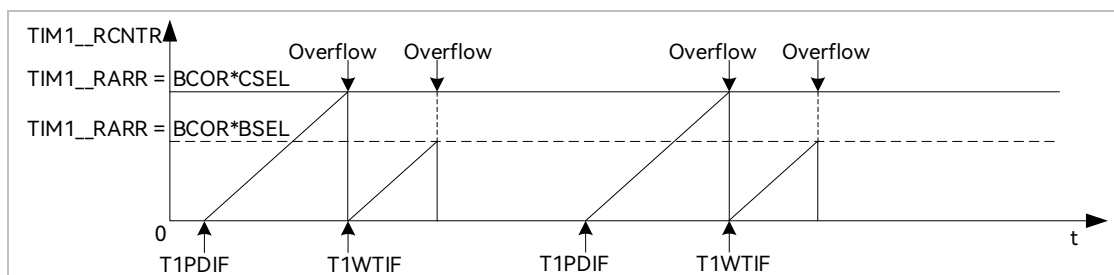


In Manual mode ($\text{TIM1\_IER}[\text{T1MAME}] = 1$), TIM1_BCNTR is cleared by Base Timer Overflow event instead of $\text{TIM1\_CR2}[\text{T1BRS}]$.

13.1.1.3 Reload Timer

The Reload Timer is a 16-bit up timer with its count value held in TIM1_RCNTR . The timer overflows when TIM1_RCNTR increases to TIM1_RARR . It stops counting when $\text{TIM1\_SR}[\text{T1ROIF}]$ (overflow interrupt flag of the reload counter) is set to “1”, and TIM1_RCNTR and $\text{TIM1\_CR0}[\text{T1RCEN}]$ are cleared to “0”. $\text{TIM1\_CR0}[\text{T1RCEN}]$ is set to “1” to restart Reload Timer when position detection interrupt or write timing interrupt is generated.

Figure 13-4 Waveform of Reload Timer

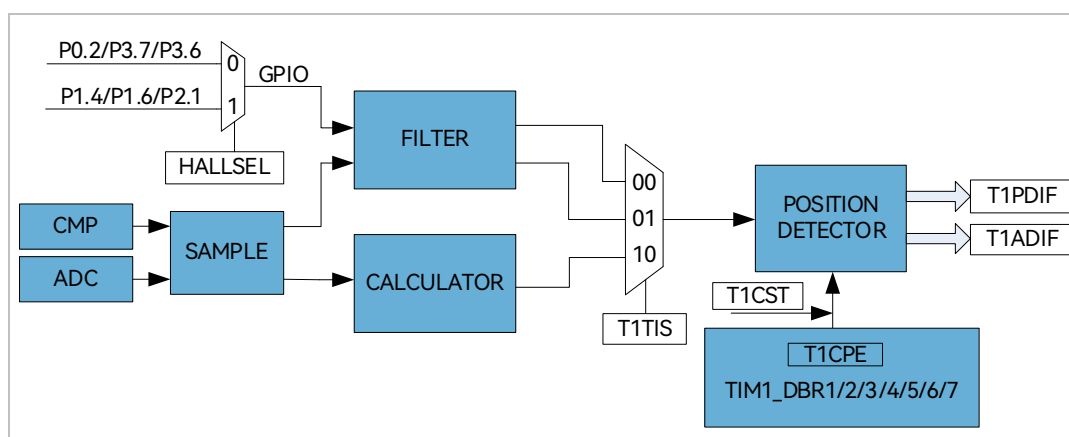


13.1.2 Position Detection

13.1.2.1 Position Detection Signal

The TIM1_CR3[T1TIS] bit selects the sources of Position Detection signal, including CMP0/1/2, (CMP Position Detection), GPIO (Hall Sensor Position Detection) or ADC (ACD Position Detection). HALL_CR[HALLSEL] bit is used to configure GPIO sourced by P1.4/P1.6/P2.1 (Hall signal input after function switching) or P0.2/P3.7/P3.6. TIM1_CR3[T1INM] bit decides whether CMP/GPIO signal is filtered. A Position Detected Interrupt is generated upon the completion of position detection. Position Detected Interrupts are divided into CMP/GPIO Position Detected Interrupt and ADC Position Detected Interrupt.

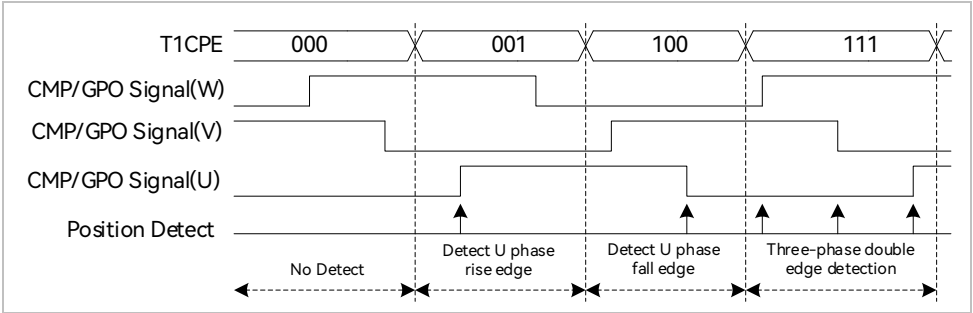
Figure 13-5 Functional Block Diagram of Position Detection



13.1.2.2 CMP/GPIO Position Detection Event

The register bank TIM1_DBR1/2/3/4/5/6/7[T1CPE] is configured to select the active edge of position detection signal. When an active edge of CMP/GPIO Position Detection signal is detected, it indicates the position detection is successfully done, allowing the CMP/GPIO Position Detected Interrupt Flag TIM1_SR[T1PDIF] bit to become "1". TIM1_CR4[T1CST] bit selects TIM1_DBR1/2/3/4/5/6/7[T1CPE] timing.

Figure 13-6 Timing Diagram of CMP/GPIO Position Detection



The relation between active edge and TIM1_DBR1/2/3/4/5/6/7[T1CPE] is shown in Table 13-2.

Table 13-2 Mapping between Active Edge and TIM1_DBR1/2/3/4/5/6/7[T1CPE]

T1CPE	Description	T1CPE	Description
000	0	100	U-phase corresponding comparator is enabled when falling edge of U-phase is detected.
001	U-phase corresponding comparator is enabled when rising edge of U-phase is detected.	101	W-phase corresponding comparator is enabled when rising edge of W-phase is detected.
010	W-phase corresponding comparator is enabled when falling edge of W-phase is detected.	110	V-phase corresponding comparator is enabled when falling edge of V-phase is detected.
011	V-phase corresponding comparator is enabled when rising edge of V-phase is detected.	111	U+W+V-phase corresponding comparator is enabled when rising or falling edge of U+W+V-phase is detected.

13.1.2.3 ADC Position Detection Event

TIM1_CR3[T1TIS] is configured to select the position detection signal from ADC. Timer1 controls ADC to sample the voltage of active phase and floating phase, which are calculated in the following equation:

$$TIM1\_URES = K \times TIM1\_UCOP - TIM1\_UFLP$$

Where,

K: ADC Position Detection Coefficient

TIM1_UCOP: ADC sampled value of active phase

TIM1_UFLP: ADC sampled value of floating phase

K/TIM1_UCOP/TIM1_UFLP definitions are determined by TIM1_DBR1/2/3/4/5/6/7[T1CPE] bit, as detailed in Table 13-3.

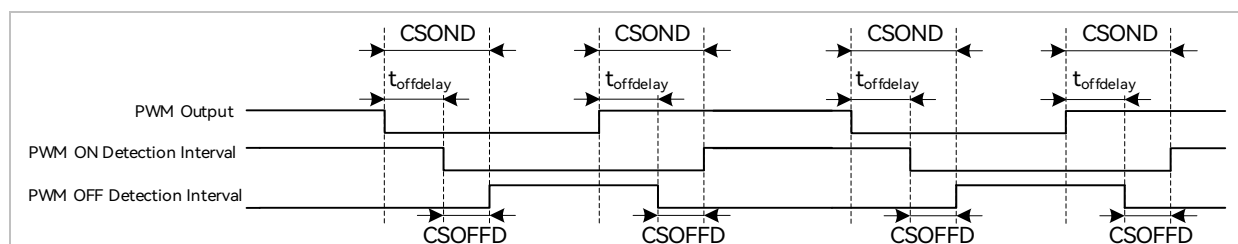
Table 13-3 Relation Between TIM1_DBR1/2/3/4/5/6/7[T1CPE] and K, *TIM1_UCOP* and *TIM1_UFLP*

T1CPE	Description
000	Reserved
001	TIM1_KR for K, W-phase voltage for TIM1_UCOP, and U-phase voltage for TIM1_UFLP
010	TIM1_KF for K, U-phase voltage for TIM1_UCOP, and W-phase voltage for TIM1_UFLP
011	TIM1_KR for K, U-phase voltage for TIM1_UCOP, and V-phase voltage for TIM1_UFLP
100	TIM1_KF for K, V-phase voltage for TIM1_UCOP, and U-phase voltage for TIM1_UFLP
101	TIM1_KR for K, V-phase voltage for TIM1_UCOP, and W-phase voltage for TIM1_UFLP
110	TIM1_KF for K, W-phase voltage for TIM1_UCOP, and V-phase voltage for TIM1_UFLP
111	Reserved

When TIM1_URES has a negative step or a positive step, an ADC Position Detected Interrupt is generated and TIM1_SR[T1ADIF] (Position Detected Interrupt Flag) is set to “1”. The position at which ADC Position Detected Interrupt is generated is controlled by setting the coefficient K. In this case, the phase commutation degree can be controlled flexibly.

13.1.2.4 Sampling

Figure 13-7 Timing Diagram of Sampling

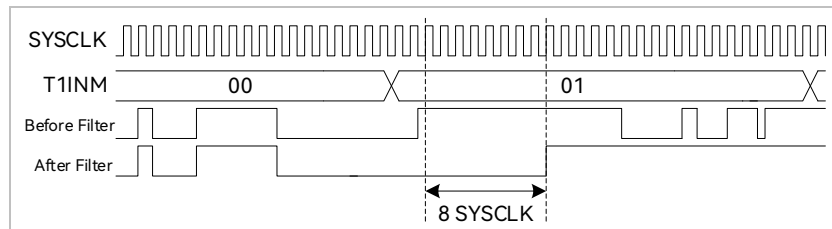


Affected by switching rate of the power device, BEMF signal lags behind PWM output. CMP_SAMR[CSOFFD], CMP_SAMR[CSOND] and CMP_CR4[FAEN] bits shall be set reasonably to adjust the sampling interval and obtain the valid position detection signal. When TIM1_CR3[T1TIS] = 01 or 10, Timer1 enables CMP0/1/2 to output the compare results between phase BEMF and neutral point, or starts ADC module to sample floating voltage.

See section 28.1.4.

13.1.2.5 Filtering

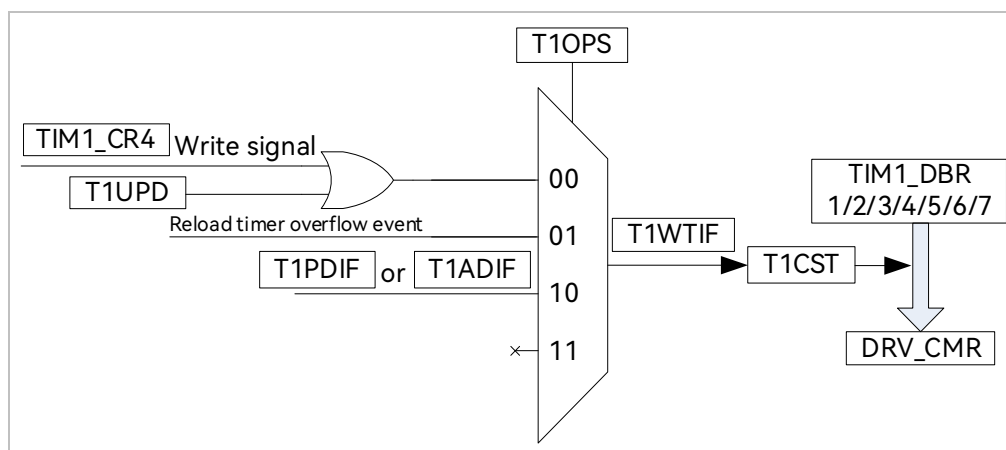
Figure 13-8 Timing Diagram of Filtering Module



According to **TIM1_CR3[T1INM]** and **CMP_CR4[FAEN]**, the filtered pulse width of input noise can be selected as 8/16/24/32/64/96 system clock. After this feature is enabled, the signal is lagged behind about 8/16/24/32/64/96 system clocks.

13.1.3 Write Timing Interrupt

Figure 13-9 Write Timing Interrupt



When the control logic, predefined in **TIM1_DBR1/2/3/4/5/6/7**, is sent to driver register **DRV_CMR**, a writing sequence interrupt is generated. The triggered source is selected by the configuration of **TIM1_CR0[T1OPS]**, and software, Reload Timer overflow event or position detected event can be selected. When a writing sequence interrupt is generated, writing sequence interrupt flag **TIM1_SR[T1WTIF]** is set to "1". If **TIM1_CR4[T1CST]** ranges in 001~110, **TIM1_CR4[T1CST]** adds 1 automatically.

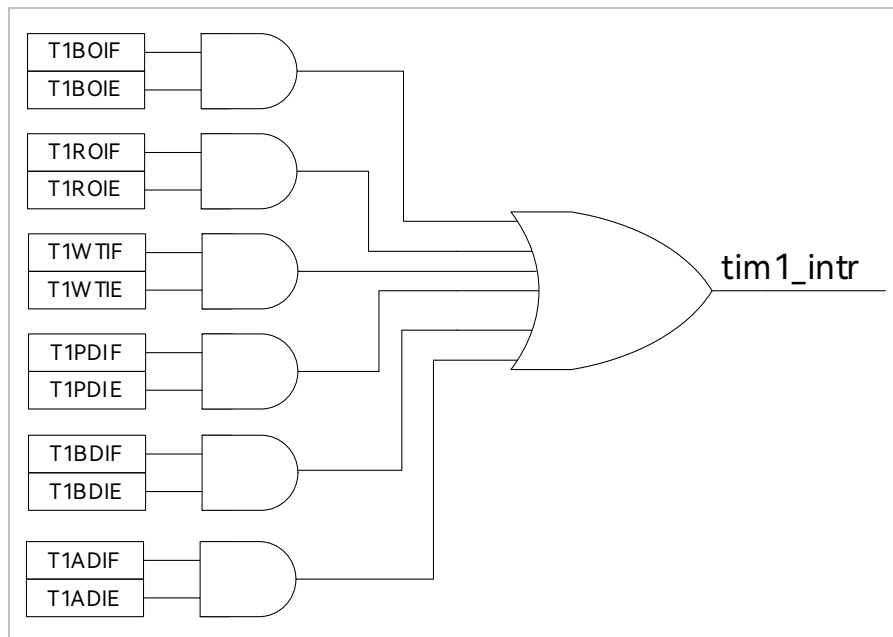
13.1.4 Timer1 Interrupt

Timer1 supports 6 interrupt sources:

- > Base Timer overflow interrupt
- > Reload Timer overflow interrupt

- > Writing sequence interrupt
- > Diode Freewheeling End Interrupt
- > CMP/GPIO Position Detected Interrupt
- > ADC Position Detected Interrupt

Figure 13-10 Timer1 Interrupt Sources



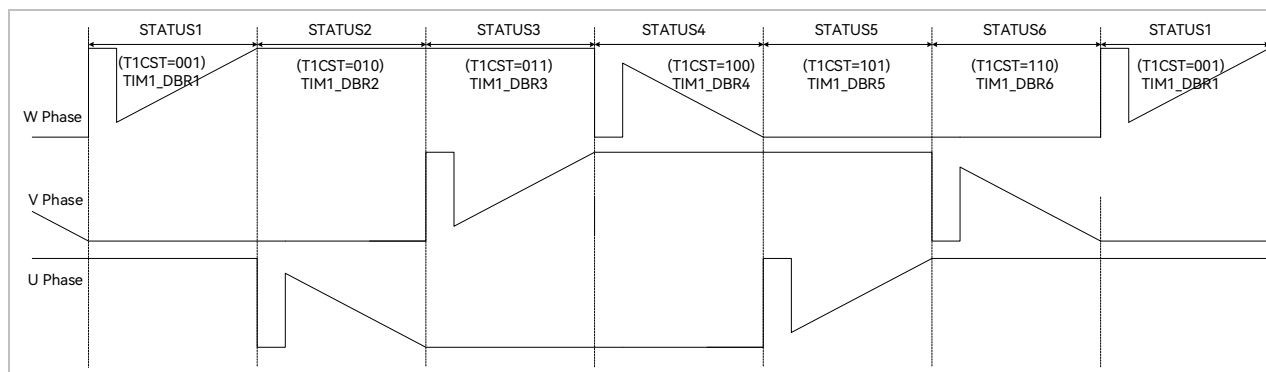
13.2 Square-wave Control Based BLDC Motor

For BLDC motor square-wave control application, Timer1 works with CMP0/1/2 and Driver module to achieve the following features:

- > Automatic record of 60-degree time, filtered as 60-degree reference time
- > Automatic forced phase commutation when position signal is not detected
- > Automatic diode freewheeling masking, i.e., stopping comparator sampling during diode freewheeling
- > Automatic control of the time from position detected to phase commutation to achieve automatic commutation
- > Take over CMP_CR2[CMP0SEL] to control CMP0/1/2 automatically
- > Comparator signal can be set to avoid ringing at the switch node on power IC, and the signal can be configured to be filtered after sampling
- > Take over DRV_CMCR register to control six PWM outputs automatically

13.2.1 Six-step Phase Commutation of Square Wave Control

Figure 13-11 Diagram of Six-step Phase Commutation of Square Wave Control

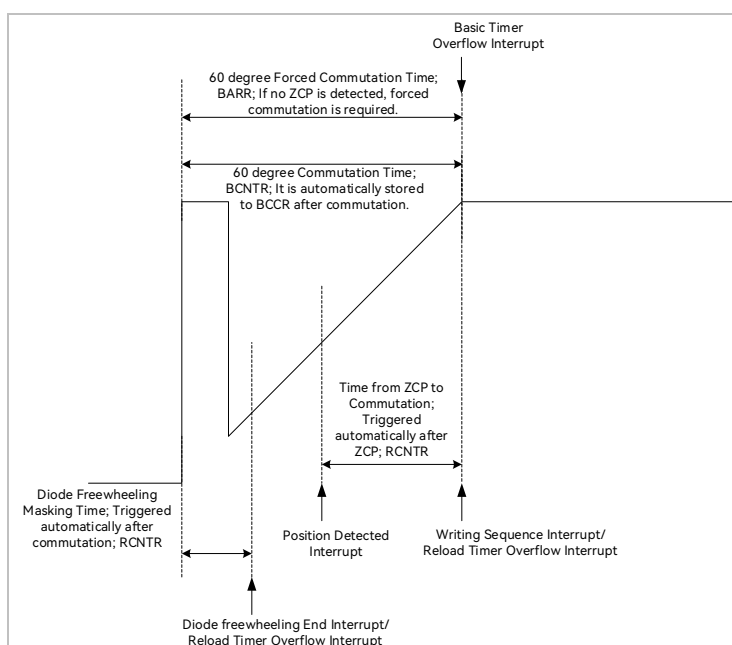


TIM1_CR4[T1CST] is the commutation state machine. Among them, state 0 is used to output off state, and state 7 is customizable for braking, pre-charging, pre-positioning, startup, etc. States 1~6 are used for six-step automatic commutation, and the state machine TIM1_CR4[T1CST] automatically adds 1 after phase commutation.

The states 1~7 maps to the TIM1_DBR1~7. When writing sequence interrupt occurs, TIM1_DBRx corresponding to the current state is automatically transferred to DRV_CMRR and CMP_CR2[CMP0SEL] for phase commutation and position detection.

13.2.2 Square-wave Control Working Principle

Figure 13-12 Square-wave Control Working Principle



13.2.2.1 60° Commutation Base Time

TIM1_BCCR captures the time of last 60 degree. TIM1_CR2[T1BRS] is set to “0” to capture the time between two writing sequence interrupts and TIM1_CR2[T1BRS] to “1” to capture the time between two position detected interrupts.

TIM1_BCOR is the filtered 60-degree time, i.e., 60-degree base time. TIM1_CR0[T1CFLT] can select the last 1/2/4/8 TIM1_BCCR averaged to obtain TIM1_BCOR.

In square-wave control mode, the diode freewheeling masking time, the time from position detected to commutation, and the time to forced commutation are determined by the 60-degree base time TIM1_BCOR.

When Base Timer is auto-load enabled (TIM1_CR1[T1BAPE] = 1), and is reset due to a position detection interrupt or a write timing interrupt, TIM1_BCOR is transferred to TIM1_BARR to control the forced phase commutation.

13.2.2.2 Forced Commutation at 60°

When the motor rotates smoothly, ZCP is generally detected after 30 degrees of rotation after a phase commutation and a position detection interrupt is generated. If ZCP is not detected in 60 degrees after the phase commutation, position detection fails and a forced phase commutation is required.

In this case, TIM1_CR0[T1FORC] is set to “1” to enable the forced commutation feature. During previous commutation, the timer TIM1_BCNTNTR is cleared to “0” by timing interrupt and restarts counting, while TIM1_BCCR captures the count value held in TIM1_BCNTNTR, which is filtered and stored in TIM1_BCOR as the 60 degree base time. When auto-load feature is enabled (TIM1_CR1[T1BAPE] = 1), the value held in TIM1_BCOR is loaded into TIM1_BARR after the Base Timer is cleared. If no ZCP is detected in 60 degree after commutation (TIM1_BCNTNTR matches TIM1_BARR), TIM1_SR[T1BOIF] (overflow interrupt flag of the Basic Timer) is set to “1” for forced phase commutation, and the timer TIM1_BCNTNTR is cleared to “0”.



Note

If an ZCP is detected within 60 degrees after phase commutation, even when TIM1_BCNTNTR > TIM1_BARR, the forced commutation will not be triggered and TIM1_SR[T1BOIF] will not be set to “1”.

When forced commutation feature is disabled ($TIM1\_CR0[T1FORC] = 0$) and $TIM1\_BCNTR > TIM1\_BARR$, the interrupt flag $TIM1\_SR[T1BOIF]$ is set to “1” and no forced phase commutation is automatically performed. Phase commutation can be performed manually by Basic Timer overflow interrupt flag and the position detected interrupt flag.

13.2.2.3 Diode Freewheeling Masking

After the commutation, inductance energy of the phase is released to the power supply or ground through the diode since the original active phase becomes a floating phase. During diode freewheeling, the floating phase BEMF signal cannot be measured. By masking comparator signal or ADC sampling value during diode freewheeling time, wrong commutation caused by wrong signal generated by the freewheeling is avoided. After freewheeling masking, the freewheeling masking end interrupt flag $TIM1\_SR[T1BDIF]$ is generated.

Freewheeling masking time is set by $TIM1\_CR1[BSEL]$ with the formula: Masking angle = $TIM1\_CR1[BSEL]/128 \times 60^\circ$.

13.2.2.4 Angle of Position Detected to Commutation

After commutation, a ZCP is detected (generating a position detected interrupt) and the hardware starts counting according to the software-set time between ZCP and the commutation. After the counting ends, the hardware automatically implements phase commutation and generates the writing sequence interrupt flag $TIM1\_SR[T1WTIF]$.

The time between ZCP and commutation is set by $TIM1\_CR2[CSEL]$ with the formula: Commutation angle = $TIM1\_CR2[CSEL]/128 \times 60^\circ$.

13.2.2.5 Cycle-by-cycle Current Limiting

See section 28.1.1.2.

13.3 Timer1 Registers

13.3.1 TIM1_CR0 (0x4068)

Bit	7	6	5	4	3	2	1	0
Name	T1RWEN	T1CFLT		T1FORC	T1OPS		T1BCEN	T1RCEN
Type	W1	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	T1RWEN	Write to TIM1_CR0[T1RCEN] Enable 0: No effect 1: When TIM1_CR0 is updated, TIM1_CR0[T1RWEN] and TIM1_CR0[T1RCEN] shall be configured simultaneously to enable or disable TIM1_CR0[T1RCEN]. A write of “0x81” to TIM1_CR0 enables TIM1_CR0[T1RCEN], and “0x80” to disables TIM1_CR0[T1RCEN].
[6:5]	T1CFLT	60 Degree Base Time Filtering Selection The average of previous x times 60 degree (TIM1_BCCR) is used as the base time (TIM1_BCOR). 00: 1 times 60 degree 01: 2 times 60 degree 10: 4 times 60 degree 11: 8 times 60 degree
[4]	T1FORC	Forced Phase Commutation at 60° Enable 0: Disable 1: Enable  Note If a ZCP is detected, forced phase commutation will not be implemented even if this bit is enabled
[3:2]	T1OPS	Commutation Trigger Signal Select The bit selects the trigger signal for TIM1_DBRx to transfer data to DRV_CMx. 00: The transfer is triggered upon a write of “1” to TIM1_IER[T1UPD] in software or on a write to TIM1_CR4[T1CST]. 01: The transfer is triggered upon an overflow interrupt of reload timer commutation counter. 10: The transfer is triggered upon a Position Detected Interrupt. 11: Reserved
[1]	T1BCEN	Base Timer Enable 0: Disable 1: Enable

[0]	T1RCEN	Reload Timer Enable When TIM1_CR0 is updated, TIM1_CR0[T1RWEN] and TIM1_CR0[T1RCEN] must be configured simultaneously to enable or disable TIM1_CR0[T1RCEN]. A write of “0x81” to TIM1_CR0 enables TIM1_CR0[T1RCEN] and “0x80” disables TIM1_CR0[T1RCEN]. TIM1_CR0[T1RCEN] is automatically enabled upon a Position Detected Interrupt and a Write Timing Interrupt. TIM1_CR0[T1RCEN] is cleared to “0” by hardware upon a Reload Timer Overflow Interrupt. TIM1_CR0[T1RCEN] cannot be automatically enabled or disabled by hardware in Manual mode. 0: Disable 1: Enable

13.3.2 TIM1_CR1 (0x4069)

Bit	7	6	5	4	3	2	1	0
Name	T1BAPE	BSEL						
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	T1BAPE	TIM1_BARR Register Auto-load Enable With this bit enabled, TIM1_BCOR is written to TIM1_BARR when Basic Timer is reset due to a Position Detected Interrupt or a Write Timing Interrupt. It is used for forced phase commutation at 60° when no ZCP is detected. Setting the device in Manual mode has no effect on TIM1_BARR Register auto-load feature. 0: Disable 1: Enable
[6:0]	BSEL	Diode Freewheeling Masking Angle Selection The bit is used to configure the angle of diode freewheeling masking after phase commutation. Position is not detected during diode freewheeling masking. Equation: Diode freewheeling masking angle = $\text{TIM1\_CR1[BSEL]}/128 \times 60^\circ$  Note This bit is invalid in Manual mode.

13.3.3 TIM1_CR2 (0x406A)

Bit	7	6	5	4	3	2	1	0
Name	T1BRS	CSEL						
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	T1BRS	Base Timer Reset Source Select This bit is invalid in Manual mode (TIM1_IER[T1MAME] = 1). TIM1_BCNTR can only be cleared by a BCNTR Overflow Interrupt. 0: Write Timing Reset 1: Position Detected Interrupt Reset
[6:0]	CSEL	Phase Commutation Angle Select After a position detected event, phase commutation is implemented after the degree configured by TIM1_CR2[CSEL]. Equation: Commutation angle = TIM1_CR2[CSEL]/128*60°

13.3.4 TIM1_CR3 (0x406B)

Bit	7	6	5	4	3	2	1	0
Name	T1COM_MD	T1PSC			T1TIS		T1INM	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	1	0	0

Bit	Name	Description
[7]	T1COM_MD	Position detection signal select CMP0/1/2 output: Position Detection Trigger Condition Select 0: Effective level detected 1: Effective edge detected Position detection signal select ADC output: Position Detection Trigger Condition Select 0: When DRV_CR[DDIR] = 0, effective edge is detected. When DRV_CR[DDIR] = 1, effective level is detected. 1: When DRV_CR[DDIR] = 0, effective level is detected. When DRV_CR[DDIR] = 1, effective edge is detected. Position detection signal select GPIO output: No effect
[6:4]	T1PSC	Timer Clock Source Frequency Select These bits are configured to divide the system clock as the clock source for Base Timer and Reload Timer. The clock source frequency of the two timers: 000: 24MHz 001: 12MHz 010: 6MHz 011: 3MHz 100: 1.5MHz 101: 750kHz 110: 375kHz 111: 187.5kHz
[3:2]	T1TIS	Position Detection Signal Select Flag 00: GPIO (select P1.4, P1.6, P2.1 or P0.2, P3.6, P3.7 according to HALL_CR[HALLSEL] bit) 01: Output signal of CMP0/1/2 10: Output signal of ADC

		11: Reserved
[1:0]	T1INM	Filter Pulse Width for Position Detection Signal Select. When pulse width of the input signal is less than the set value, it is filtered as noise. The filtering time changes according to CMP_CR4[FAEN]. When CMP_CR4[FAEN] = 0: 00: 4 system clock cycles 01: 8 system clock cycles 10: 16 system clock cycles 11: 24 system lock cycles When CMP_CR4[FAEN] = 1: 00: 32 system clock cycles 01: 64 system clock cycles 10: 96 system clock cycles 11: 128 system clock cycles

13.3.5 TIM1_CR4 (0x406C)

Bit	7	6	5	4	3	2	1	0
Name	RSV					T1CST		
Type	-	-	-	-	-	R/W	R/W	R/W
Reset	-	-	-	-	-	0	0	0

Bit	Name	Description																				
[7:3]	RSV	Reserved																				
[2:0]	T1CST	Commutation State Machine																				
		The state machine corresponds to different TIM1_DBRx at different states.																				
		When TIM1_CR4[T1CST] reads 001~111, Timer1 automatically enables or disables CMP0/1/2 according to the TIM1_DBRx[T1CPE].																				
		When TIM1_CR4[T1CST] reads 001~110, Timer1 automatically adds by “1” each cycle upon a Write Timing Interrupt.																				
		Table 13-4 Mapping Between TIM1_CR4[T1CST] and TIM1_DBRx																				
		<table><tr><th>TIM1_CR4[T1CST]</th><th>TIM1_DBRx</th><th>TIM1_CR4[T1CST]</th><th>TIM1_DBRx</th></tr><tr><td>000</td><td>0</td><td>100</td><td>TIM1_DBR4</td></tr><tr><td>001</td><td>TIM1_DBR1</td><td>101</td><td>TIM1_DBR5</td></tr><tr><td>010</td><td>TIM1_DBR2</td><td>110</td><td>TIM1_DBR6</td></tr><tr><td>011</td><td>TIM1_DBR3</td><td>111</td><td>TIM1_DBR7</td></tr></table>	TIM1_CR4[T1CST]	TIM1_DBRx	TIM1_CR4[T1CST]	TIM1_DBRx	000	0	100	TIM1_DBR4	001	TIM1_DBR1	101	TIM1_DBR5	010	TIM1_DBR2	110	TIM1_DBR6	011	TIM1_DBR3	111	TIM1_DBR7
TIM1_CR4[T1CST]	TIM1_DBRx	TIM1_CR4[T1CST]	TIM1_DBRx																			
000	0	100	TIM1_DBR4																			
001	TIM1_DBR1	101	TIM1_DBR5																			
010	TIM1_DBR2	110	TIM1_DBR6																			
011	TIM1_DBR3	111	TIM1_DBR7																			

13.3.6 TIM1_IER (0x406D)

Bit	7	6	5	4	3	2	1	0
Name	T1UPD	T1MAME	T1ADIE	T1BOIE	T1ROIE	T1WTIE	T1PDIE	T1BDIE
Type	W1	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	T1UPD	When TIM1_CR0[T1OPS] = 00, a write of “1” to this bit enables data transfer. This bit is cleared to “0” by hardware after “1” is written.
[6]	T1MAME	Manual Mode Enable With this bit enabled, Basic Timer and Reload Timer acts as separate counters. Details: TIM1_BCNTNTR of the Basic Timer is cleared by a Base Timer Overflow Interrupt, instead of TIM1_CR2[T1BRS] TIM1_CR0[T1RCEN] of the Reload Timer cannot be cleared to “0” or set to “1” automatically, and is operated by software only. TIM1_RCNTNTR of the Reload Timer can be cleared to “0” upon a Reload Timer Overflow Interrupt only. TIM1_RARR of the Reload Timer cannot be updated automatically, and is operated by software only. 0: Disable 1: Enable
[5]	T1ADIE	ADC Position Detected Interrupt Enable 0: Disable 1: Enable
[4]	T1BOIE	Base Timer Overflow Interrupt Enable 0: Disable 1: Enable
[3]	T1ROIE	Reload Timer Overflow Interrupt Enable 0: Disable 1: Enable
[2]	T1WTIE	Write Timing Interrupt Enable 0: Disable 1: Enable
[1]	T1PDIE	CMP/GPIO Position Detected Interrupt Enable 0: Disable 1: Enable
[0]	T1BDIE	Diode Freewheeling Masking Interrupt Enable 0: Disable 1: Enable

13.3.7 TIM1_SR (0x406E)

Bit	7	6	5	4	3	2	1	0
Name	RSV		T1ADIF	T1BOIF	T1ROIF	T1WTIF	T1PDIF	T1BDIF
Type	-	-	R/W0	R/W0	R/W0	R/W0	R/W0	R/W0

Reset	-	-	0	0	0	0	0	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5]	T1ADIF	ADC Position Detected Interrupt Flag A Position Detected Interrupt is generated when TIM1_DBRx[T1CPE] matches ACD Position Detection signal. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: No effect
[4]	T1BOIF	Base Timer Overflow Interrupt Flag An overflow event occurs when Basic Timer counts up and TIM1_BCNTN matches with TIM1_BARR. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: No effect
[3]	T1ROIF	Reload Timer Overflow Interrupt Flag An overflow event occurs and TIM1_RCNTN is cleared to “0” when TIM1_RCNTN matches TIM1_RARR. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: No effect
[2]	T1WTIF	Writing Sequence Interrupt Flag Writing Sequence Interrupt is generated when TIM1_DBRx is transferred to DRV_CMN. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: No effect.
[1]	T1PDIF	CMP/GPIO Position Detected Interrupt Flag A position detected interrupt is generated when CMP/GPIO Position Detection matches TIM1_DBRx[T1CPE]. Read:

		0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0". 1: No effect
[0]	T1BDIF	Diode Freewheeling Masking End Interrupt Flag Diode freewheeling masking starts after phase commutation and an interrupt is generated at end. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0". 1: No effect

13.3.8 TIM1_BCOR (0x4070, 0x4071)

TIM1_BCORH(0x4070)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_BCOR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM1_BCORL(0x4071)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_BCOR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_BCOR	The bit is configured to capture filtered count values held in the Base Timer. TIM1_BCCR holds the filtered count value, i.e., 60 Degree Base Time.

13.3.9 TIM1_CR5 (0x4072)

Bit	7	6	5	4	3	2	1	0
Name	T1POP	T1WTS	RSV		ITRIP_DIS	UCOP_DIS	T1AFL	
Type	R/W	R/W	-	-	R/W	R/W	R/W	R/W
Reset	0	0	-	-	0	0	0	0

Bit	Name	Description
[7]	T1POP	Data Transfer Triggered by Driver Counter Overflow This bit is valid only when TIM_CR0[T1OPS] = 00. With it enabled, data transfer is triggered by Driver Counter Overflow, namely, commuting

		the phase once every PWM cycle 0: Disable 1: Enable
[6]	T1WTS	Commutation Enable to Cancel Narrow Pulse in PWM OFF Mode PWM Synchronization Enable 0: Disable 1: Enable
[5:4]	RSV	Reserved
[3]	ITRIP_DIS	Bus Current Sampling Disable 0: Enable 1: Disable
[2]	UCOP_DIS	Active Phase Voltage Sampling Disable 0: Enable 1: Disable
[1:0]	T1AFL	ADC Sampled Voltage Calculation Filtering Counts 00: 1 01: 2 10: 4 11: 8

13.3.10 TIM1_DBRx (x = 1 ~ 7)(0x4072 + 2*x, 0x4073 + 2*x)

TIM1_DBRx (x = 1 ~ 7) corresponds to data when T1CST = 1/2/3/4/5/6 respectively. The TIM1_DBRx register is described below using TIM1_DBR1 as an example.

TIM1_DBR1H(0x4072 + 2*x)								
Bit	15	14	13	12	11	10	9	8
Name	RSV	T1CPE			T1WHP	T1WLP	T1VHP	T1VLP
Type	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	-	0	0	0	0	0	0	0
TIM1_DBR1L(0x4073 + 2*x)								
Bit	7	6	5	4	3	2	1	0
Name	T1UHP	T1ULP	T1WHE	T1WLE	T1VHE	T1VLE	T1UHE	T1ULE
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15]	RSV	Reserved
[14:12]	T1CPE	Position Detection Input Edge Polarity and Comparator Enable Select This bit is used to define the edge of Position Detection Input and enable or disable the associated comparators. The detected edge in input signal, corresponding to the configuration, generates a position detected interrupt.

		See CMP/GPIO Position Detection Event and Table 13-2
[11]	T1WHP	High-side Output Polarity of W-phase 0: Active High 1: Active Low
[10]	T1WLP	Low-side Output Polarity of W-phase 0: Active High 1: Active Low
[9]	T1VHP	High-side Output Polarity of V-phase 0: Active High 1: Active Low
[8]	T1VLP	Low-side Output Polarity of V-phase 0: Active High 1: Active Low
[7]	T1UHP	High-side Output Polarity of U-phase 0: Active High 1: Active Low
[6]	T1ULP	Low-side Output Polarity of U-phase 0: Active High 1: Active Low
[5]	T1WHE	High-side Output Enable of W-phase 0: Disable 1: Enable
[4]	T1WLE	Low-side Output Enable of W-phase 0: Disable 1: Enable
[3]	T1VHE	High-side Output Enable of V-phase 0: Disable 1: Enable
[2]	T1VLE	Low-side Output Enable of V-phase 0: Disable 1: Enable
[1]	T1UHE	High-side Output Enable of U-phase 0: Disable 1: Enable
[0]	T1ULE	Low-side Output Enable of U-phase 0: Disable 1: Enable

**Note**

The high-side and low-side outputs of W, V and U-phases are complementary and deadtime is automatically added (same for TIM1_DBR2~TIM1_DBR7) when TIM1_DBR1[T1WLE] and TIM1_DBR1[T1WHE], TIM1_DBR1[T1VLE] and TIM1_DBR1[T1VHE] or TIM1_DBR1[T1ULE] and TIM1_DBR1[T1UHE] are set to “1”

13.3.11 TIM1_BCNTR (0x4082, 0x4083)

TIM1_BCNTRH(0x4082)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_BCNTR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	0	0	0	0	0	0	0
TIM1_BCNTRL(0x4083)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_BCNTR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_BCNTR	This bit holds count values of the Base Timer and is used for clocking commutation at 60°. Auto mode: TIM1_BCNTR register selects the reset source according to TIM1_CR2[T1BRS], and TIM1_BCNTR does not restart when TIM1_BCNTR overflow interrupt is generated. Manual mode: TIM1_BCNTR restarts when TIM1_BCNTR overflow interrupt is generated.

13.3.12 TIM1_BCCR (0x4084, 0x4085)

TIM1_BCCRH(0x4084)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_BCCR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM1_BCCRL(0x4085)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_BCCR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_BCCR	The bit is configured to capture count values held in Base Timer. Auto mode: When the Base Timer is reset on a Position Detected Interrupt or a Write Timing Interrupt, the count values before the reset are stored into TIM1_BCCR. Manual mode: When the Base Timer is reset on an Overflow Interrupt, the count values before the reset are stored into TIM1_BCCR.

13.3.13 TIM1_BARR (0x4086, 0x4087)

TIM1_BARRH(0x4086)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_BARR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM1_BARRL(0x4087)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_BARR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_BARR	When the count value of the Base Timer equals to TIM1_BARR value, an overflow interrupt is generated and the counter is cleared to “0”.

13.3.14 TIM1_RARR (0x4088, 0x4089)

TIM1_RARRH(0x4088)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_RARR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM1_RARRL(0x4089)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_RARR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_RARR	Auto-Reload Value in Reload Timer When count of the Reload Timer is equal to TIM1_RARR, an overflow interrupt is generated and the value of the timer is cleared to “0”. Auto mode: The value of diode freewheeling masking angle held in TIM1_CR1[BSEL] is updated to TIM1_RARR when a Write Sequence Interrupt is generated. The value of commutation angle held in TIM1_CR2[CSEL] is updated to TIM1_RARR when a Position Detected Interrupt occurs. Manual mode: TIM1_RARR is not updated automatically.

13.3.15 TIM1_RCNTR (0x408A, 0x408B)

TIM1_RCNTRH(0x408A)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_RCNTR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1
TIM1_RCNTRL(0x408B)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_RCNTR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

Bit	Name	Description
[15:0]	TIM1_RCNTR	Count value of the Reload Timer for counting numbers of diode freewheeling masking and ZCP to phase commutation.  Note In Manual mode, TIM1_RCNTR is cleared to “0” only by a Reload Timer overflow interrupt

13.3.16 TIM1_UCOP (0x408C, 0x408D)

TIM1_UCOPH(0x408C)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_UCOP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM1_UCOPL(0x408D)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_UCOP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_UCOP	ADC Sampled Value of active phase voltage (second-highest bit alignment)

13.3.17 TIM1_UFLP (0x408E, 0x408F)

TIM1_UFLPH(0x408E)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_UCOP[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM1_UFLPL(0x408F)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_UCOP[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_UFLP	ADC Sampled Value of floating phase voltage (second-highest bit alignment)

13.3.18 TIM1_URES (0x4090, 0x4091)

TIM1_URESH(0x4090)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_URES[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM1_URESL(0x4091)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_URES[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_URES	Result of ADC Position Detection formula; Q15 format

13.3.19 TIM1_KRMAX (0x4092)

Bit	7	6	5	4	3	2	1	0
Name	TIM1_KRMAX							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description

[7:0]	TIM1_KRMAX	Max. Coefficient of Raising Edge Range [0, 255]

13.3.20 TIM1_KFMIN (0x4093)

Bit	7	6	5	4	3	2	1	0
Name	TIM1_KFMIN							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	TIM1_KFMIN	Min. Coefficient of Falling Edge Range [0, 255]

13.3.21 TIM1_KF (0x4094, 0x4095)

TIM1_KFH(0x4094)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_KF[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

TIM1_KFL(0x4095)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_KF[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_KF	ADC Position Detection Coefficient when floating phase voltage drops. Range [0, 32767]

13.3.22 TIM1_KR (0x4096, 0x4097)

TIM1_KRH(0x4096)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_KR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

TIM1_KRL(0x4097)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_KR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_KR	ADC Position Detection Coefficient when floating phase voltage rises Range [0, 32767]

13.3.23 TIM1_ITRIP (0x4098, 0x4099)

TIM1_ITRIPH(0x4098)								
Bit	15	14	13	12	11	10	9	8
Name	TIM1_ITRIP[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
TIM1_ITRIPL(0x4099)								
Bit	7	6	5	4	3	2	1	0
Name	TIM1_ITRIP[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM1_ITRIP	Filtered Bus Current When DRV_CNTR = 0, the hardware automatically samples the bus current and filters it for software application. The default channel is ADC channel 4. Range [0, 32767]  Note The value is obtained by averaging the instantaneous current values of 8 samples

14 Timer2

14.1 Timer2 Instructions

Timer2 has the following 5 working modes:

- > Output mode: PWM generation
- > Input capture mode: Detect the duration of high and low level of input PWM
- > Input counter mode: Detect input time of the set PWM wave numbers
- > QEP & RSD mode: Quadrature Encoder Pulse & Rotating State Detection (tailwind/headwind detection) mode
- > Step Mode: Detect rotation direction, position and speed of step motor

Timer2 features:

- > 3-bit programmable prescaler divides the system clock
- > 16-bit up-counting Base Timer; Counting clock source serves as the output of prescaler
- > 16-bit up/down-counting special timer for Input Count Mode, QEP&RSD Mode and Step Mode, with external input signal selected as clock source.
- > Input filter module
- > Edge detection module
- > PWM generation module
- > Interrupt event

14.1.1 Prescaler

Prescaler divides the system clock frequency and generates clock source for Base Timer. 8 frequency division coefficients of prescaler are available and can be selected by TIM2_CR0[T2PSC]. Since this register has no buffer, the clock source frequency is updated immediately after TIM2_CR0[T2PSC] is written. Therefore, the frequency division coefficients shall be configured when Basic Timer is not working. The clock source frequency formula is: $\text{clk\_psc2} = \text{SYSCLK} / (2^{\text{TIM2\_CR0[T2PSC]}})$. The clock rate corresponding to different TIM2_CR0[T2PSC] value as shown in .

Table 14-1 Mapping between Clock Rate and TIM2_CR0[T2PSC]

TIM2_CR0[T2PSC]	Division Factor	clk_psc2(Hz)	TIM2_CR0[T2PSC]	Division Factor	clk_psc2(Hz)
000	1	24M	100	16	1.5M
001	2	12M	101	32	750k
010	4	6M	110	64	375k
011	8	3M	111	128	187.5k

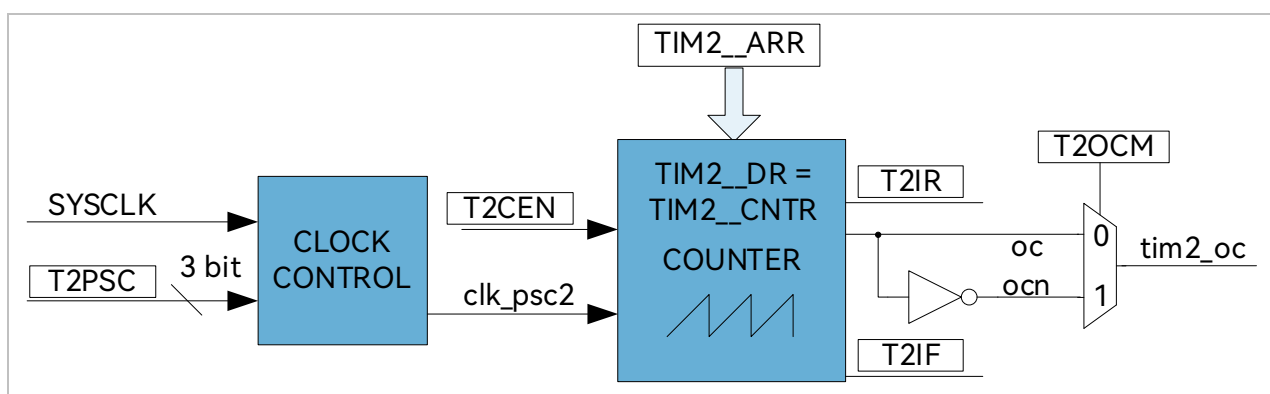
14.1.2 Reading, Writing, and Counting of TIM2_CNTR

When TIM2_CR1[T2CEN] = 1, TIM2_CNTR starts to count. The write operation to TIM2_CNTR directly changes the value of the register, so Base Timer shall be disabled before the write operation. When reading TIM2_CNTR, the software reads the high-order bits first, and the hardware synchronously caches the low-order bits. When reading the low-order bits, the software reads the cached data.

14.1.3 Output Mode

When TIM2_CR0[T2MOD] = 01, Timer2 is operating in output mode.

Figure 14-1 Output Mode Block Diagram



The output mode generates output signals according to TIM2_CR0[T2OCM], and the comparison results between TIM2_CNTR and registers TIM2_DR, TIM2_ARR. Meanwhile, corresponding interrupts events are generated.

14.1.3.1 Reading and Writing of TIM2_ARR/TIM2_DR

In output mode, TIM2_ARR/TIM2_DR contains preload registers and shadow registers. When the software writes TIM2_ARR/TIM2_DR register, the data is saved in the preload register. When the overflow event TIM2_CR1[T2IF] is generated or the Base Timer stops working (TIM2_CR1[T2CEN] = 0), the set value is

transferred to the shadow register.

TIM2_ARR/TIM2_DR is a 16-bit register, which requires to write the high byte first and then the low byte. The hardware ensures that the data in the preload register is not transferred to the shadow register after the high byte is written or before the low byte is written.

For example, TIM2_DR is a preload register and DR_SH is a shadow register. PWM is generated by comparing TIM2_CNTR with DR_SH. When software writes TIM2_DR, TIM2_DR is not updated to DR_SH immediately, and is updated to TIM2_DR at the end of a PWM (TIM2_CNTR overflow event).

14.1.3.2 High/Low Level Output

When $TIM2\_CR0[T2OCM] = 0$, if $TIM2\_DR > TIM2\_ARR$, the output signal is always low. When $TIM2\_CR0[T2OCM] = 1$, if $TIM2\_DR > TIM2\_ARR$, the output signal is always high.

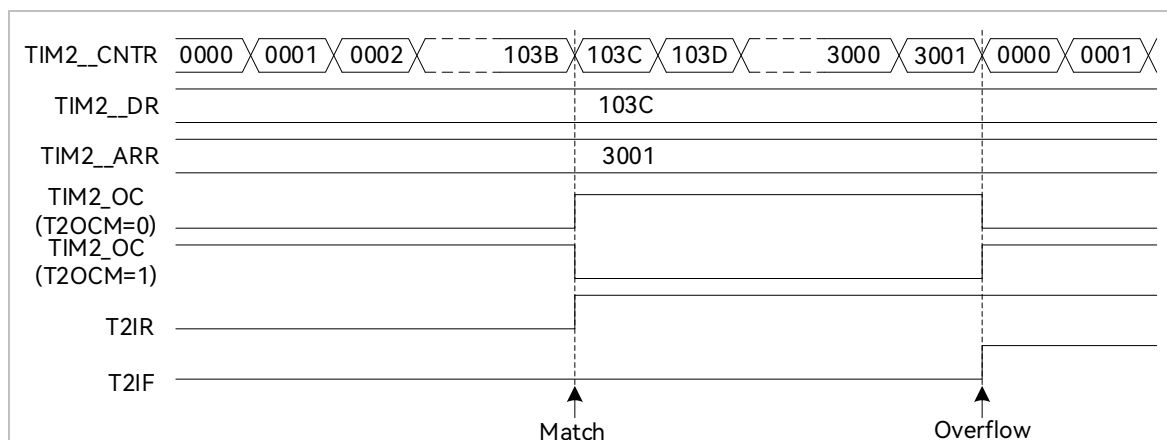
14.1.3.3 PWM Generation

In PWM generation mode, TIM2_ARR determines PWM cycle, TIM2_DR determines duty cycle, and duty cycle = $TIM2\_DR/TIM2\_ARR \times 100\%$. If $TIM2\_CR0[T2OCM] = 0$, the low level is output when $TIM2\_CNTR < TIM2\_DR$, and the high level is output when $TIM2\_CNTR \geq TIM2\_DR$. If $TIM2\_CR0[T2OCM] = 1$, the high level is output when $TIM2\_CNTR < TIM2\_DR$, and the low level is output when $TIM2\_CNTR \geq TIM2\_DR$. When TIM2_CNTR is increased to TIM2_ARR, the output signal is reversed.

14.1.3.4 Interrupts

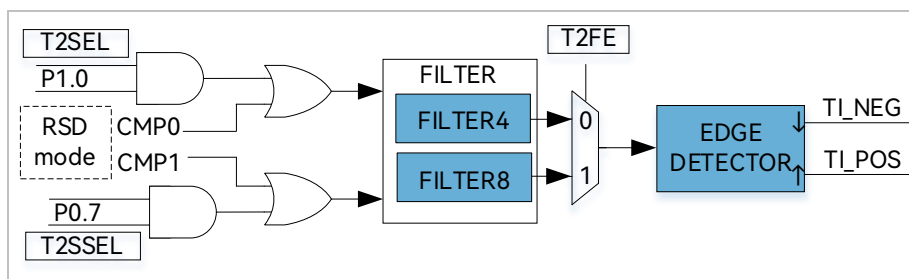
- > When $TIM2\_CNTR = TIM2\_DR$, a compare match event is generated and the interrupt flag bit TIM2_CR1[T2IR] is set to “1”. The timer continues.
- > When $TIM2\_CNTR = TIM2\_ARR$, an overflow event is generated, and the interrupt flag bit TIM2_CR1[T2IF] is set to “1”. The timer is cleared to “0” and then restarts.

Figure 14-2 Output Mode Waveform



14.1.4 Input Signal Filtering and Edge Detection

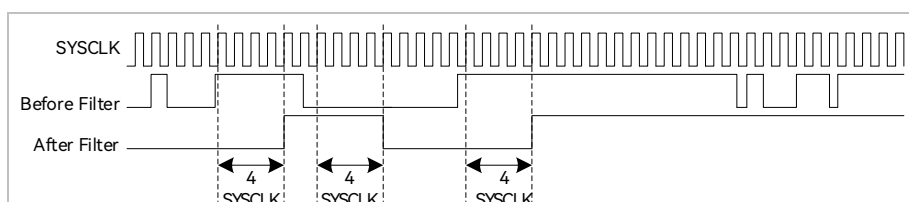
Figure 14-3 Block Diagram of Input Signal Filtering and Edge Detection



The input signal of Timer2 comes from P0.7 or P1.0, set by PH_SEL[T2SEL] and PH_SEL [T2SSEL] (see section 21.3.17). The filter of input signal is optional.

The filtering circuit filters out the input noise below 4/8 SYSCLK cycles. The filtering period is selected by setting TIM2_CR1[T2FE]. When TIM2_CR1[T2FE] is set to “0”, filtering circuit filters signals every 4 system cycles; and when TIM2_CR1[T2FE] is set to “1”, filtering circuit filters signals every 8 system cycles. The filtered signal is 4/8 clock cycles later than the signal before filtering. TIM2_CR0[T2CES] determines the active edge to count.

Figure 14-4 Timing Diagram of Filter Module

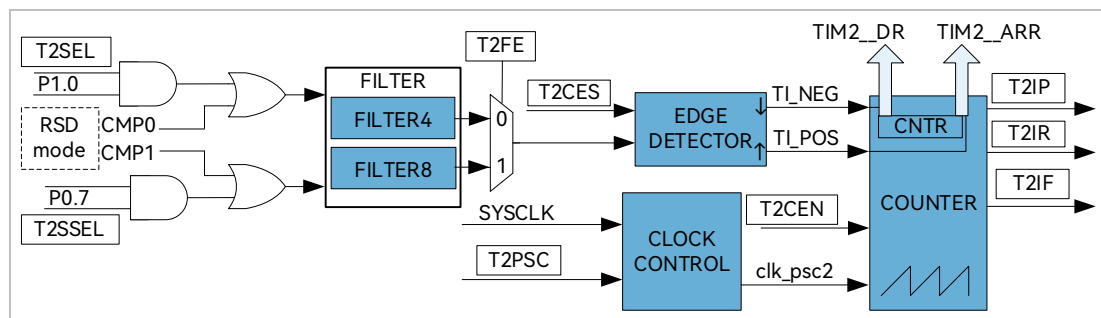


The edge detection module detects filtered input signals and records rising edge and falling edge for input capture mode or input counting modes.

14.1.5 Input Capture Mode

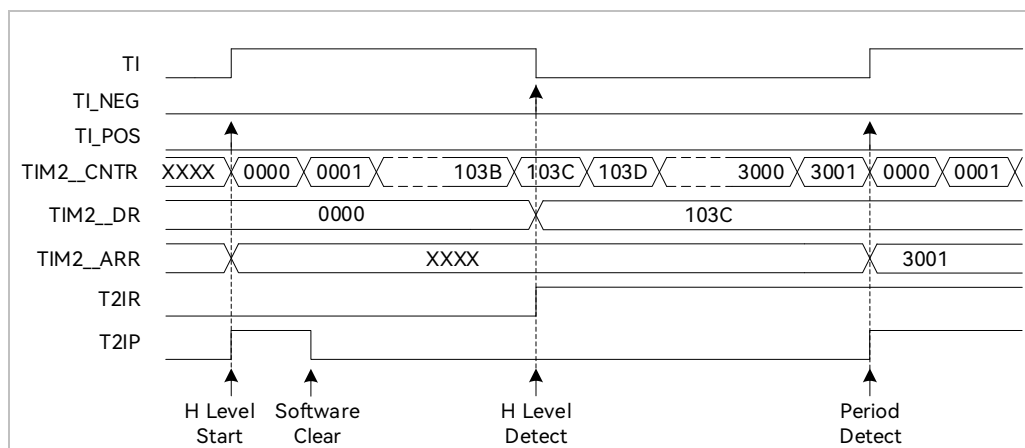
When TIM2_CR0[T2MOD] = 00, Timer2 is operating in input capture mode

Figure 14-5 Schematic Diagram of Input Capture Mode



The input capture mode detects duty cycle and period of the PWM signal. When TIM2_CR0[T2CES] = 0, the time between two adjacent rising edges forms one cycle, and the time from rising edge to falling edge forms the pulse width (HIGH). When TIM2_CR0[T2CES] = 1, the time between two adjacent falling edges forms one cycle, and the time from falling edge to rising edge forms the pulse width (LOW). When the predefined edge arrives, the count value TIM2_CNTR is stored in TIM2_DR and TIM2_ARR respectively to calculate the period and duty cycle of PWM waveform.

Figure 14-6 Timing Diagram of Input Capture Mode (TIM2_CR0[T2CES] = 0)



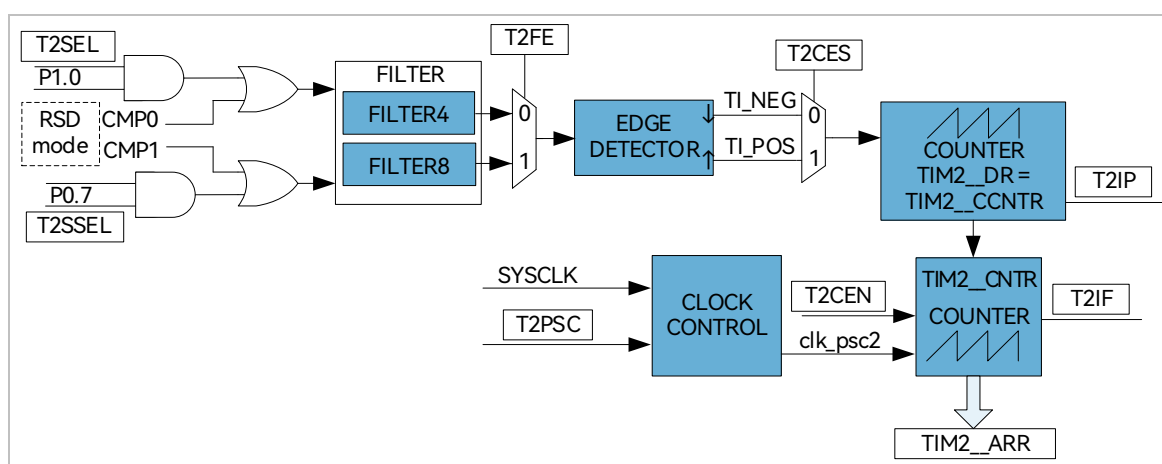
For example, when TIM2_CR0[T2CES] = 0, TIM2_CR1[T2CEN] is set to “1” to enable the Base Timer. When the first rising edge of the input (falling edge is invalid) is detected, TIM2_CNTR is cleared and restarts. When falling edge of the input is detected, the value of TIM2_CNTR is stored in TIM2_DR, while the interrupt flag TIM2_CR1[T2IR] is set to “1”, and TIM2_CNTR continues to count. When the second rising edge of input is detected, the value of TIM2_CNTR is stored in TIM2_ARR. Meanwhile, the interrupt flag TIM2_CR1[T2IP] is set to “1”, and TIM2_CNTR is cleared to “0” and restarts.

An overflow event occurs if Timer2 does not detect the second rising edge of the input and TIM2_CNTR reaches 0xFFFF. In this case, the interrupt flag TIM2_CR1[T2IF] is set to “1”, and TIM2_CNTR is cleared to “0” and restarts. At this point, TIM2_ARR value is 0xFFFF, and the TIM2_DR value is determined by the input level and TIM2_CR0[T2OCM] XOR.

14.1.6 Input Counter Mode

When TIM2_CR0[T2MOD] = 10, Timer2 is operating in input counter mode.

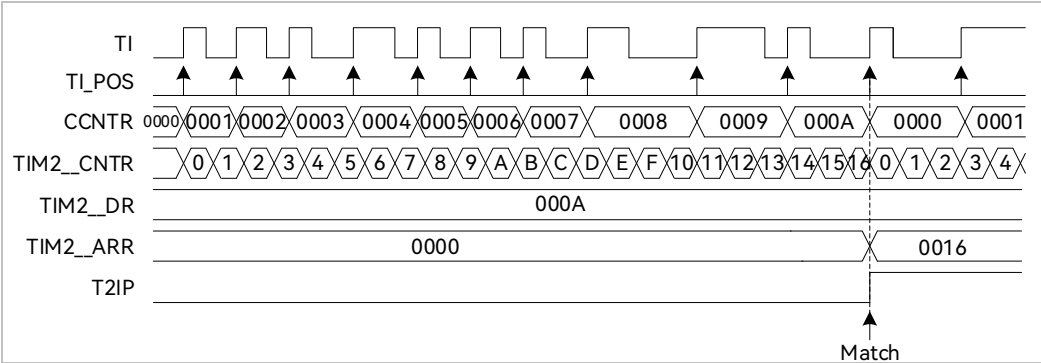
Figure 14-7 Schematic Diagram of Input Counter Mode



In input counter mode, TIM2_DR includes preload register and shadow register. When the software writes TIM2_DR register, the data is saved in the preload register first, and then sent to the shadow register in case of compare match event (TIM2_CR1[T2IP] = 1), overflow event (TIM2_CR1[T2IF] = 1) or special timer disable (TIM2_CR1[T2CEN] = 0). TIM2_DR is a 16-bit register, which requires the software writes the high-order byte first and then the low-order byte. The hardware ensures that the data in the preload register is not updated to the shadow register after the high-order byte is written and before the low-order byte is written.

The input counter mode is used to detect the time to input the set PWM wave. When the number of input PWM counted by the special timer CCNTR reaches the set value (TIM2_DR), TIM2_CNTR of the Base Timer is stored in TIM2_ARR. When TIM2_CR0[T2CES] is set to “1”, the rising edge of the input PWM signal serves as the active counting edge of the special timer; when TIM2_CR0[T2CES] is set to “0”, the falling edge of the input signal as the active edge.

Figure 14-8 Timing Diagram of Input Counter Mode



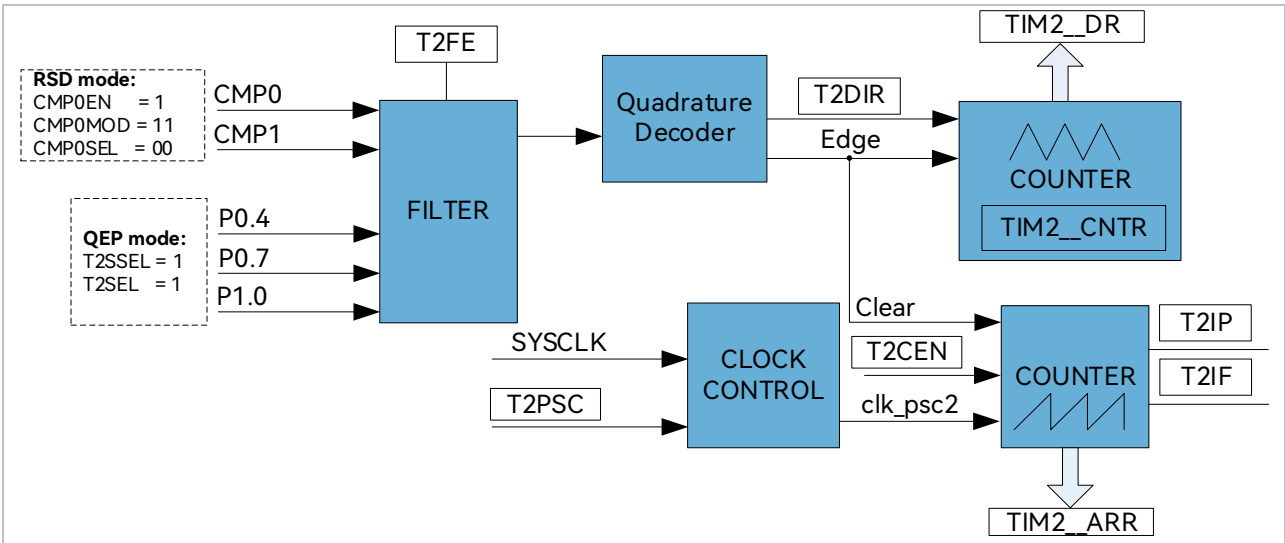
The Basic Timer is enabled when TIM2_CR1[T2CEN] is set to “1”. If the first active edge of the input signal is detected, TIM2_CNTR is cleared to “0” and restarts. Whenever active edge of the input signal arrives, one is added to the count value of the special timer CCNTR. When the count value reaches TIM2_DR, TIM2_CNTR is stored in TIM2_ARR. When TIM2_CR1[T2IP] is set to “1”, TIM2_CNTR and CCNTR are cleared to “0” and restart.

When the number of input PWM does not reach the set value and TIM2_CNTR reaches 0xFFFF, an overflow event generates, and the interrupt flag TIM2_CR1[T2IF] is set to “1”. TIM2_CNTR is cleared to “0” with CCNTR uncleared. TIM2_CNTR starts counting from 0, and CCNTR continues counting with the previous value.

14.1.7 QEP&RSD Mode

When TIM2_CR0[T2MOD] = 11, Timer2 is operating in QEP & RSD mode.

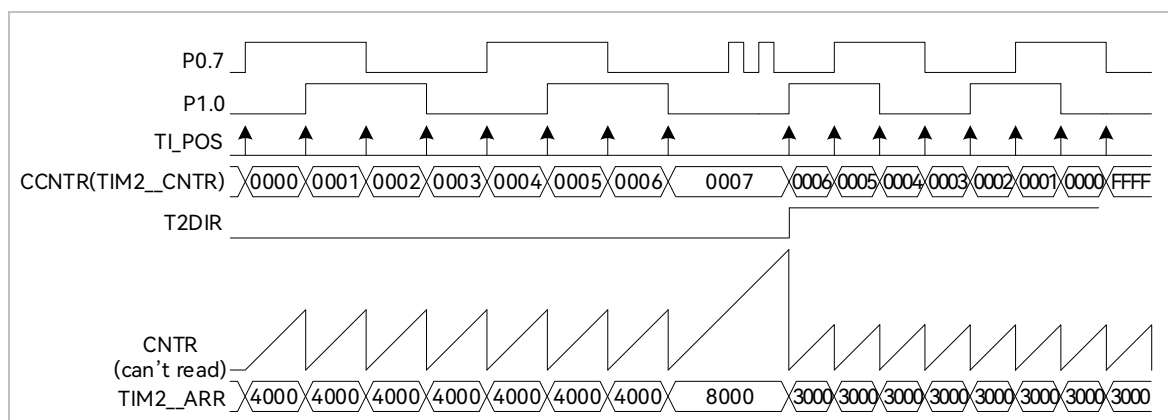
Figure 14-9 Schematic Diagram of QEP&RSD Mode



QEP & RSD mode obtains relative position, direction and speed of the motor by detecting orthogonal signals

on two channels. P0.7 and P1.0 (QEP mode) or CMP0, CMP1 (RSD mode) are the input signal sources, which are sent to the quadrature decoding module from the filtering module to obtain active edge and direction (TIM2_CR1[T2DIR]).

Figure 14-10 Timing Diagram of QEP&RSD Mode

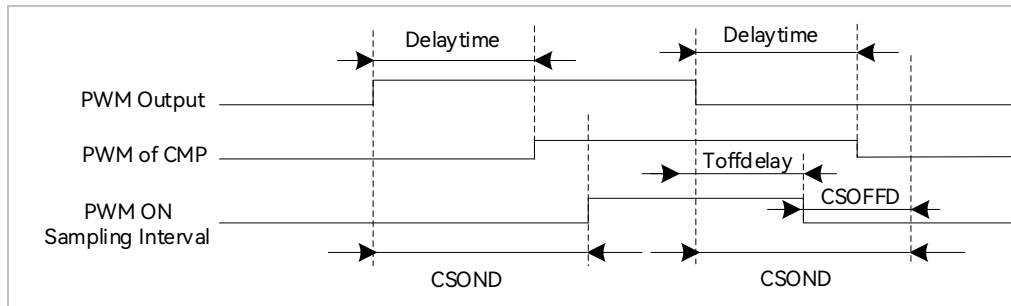


The special timer is an up/down counter, and the signal source is the active edge from orthogonal decoding module. If TIM2_CR1[T2DIR] = 0, the direction is positive, and special timer counts upward. When the active edge arrives, the timer increases by one. If TIM2_CR1[T2DIR] = 1, the direction is reverse and special timer counts down. When the active edge arrives, the timer decreases by one. In QEP Mode, after configuring the code value held in TIM2_DR, the count-up timer is cleared to “0” and restarts when it reaches TIM2_DR, and the count-down timer is reloaded with TIM2_DR when it decrements up to 0. The mechanical zero signal (“Z signal”) of QEP encoder is input from P0.4 and generates the TIM2_CR1[T2IR] interrupt event flag.

The Base Timer is an up-counter used to record the time of two active counting edges. The clock source frequency can be divided. When the counting edge arrives, the value of Base Timer is stored in TIM2_ARR and cleared to “0”, and TIM2_CR1[T2IP] interrupt flag bit is set to “1”. When Base Timer counts to 0xFFFF, the count overflows and TIM2_CR1[T2IF] interrupt flag is generated.

14.1.7.1 RSD Comparator Sampling

Figure 14-11 PWM ON Sampling Mode

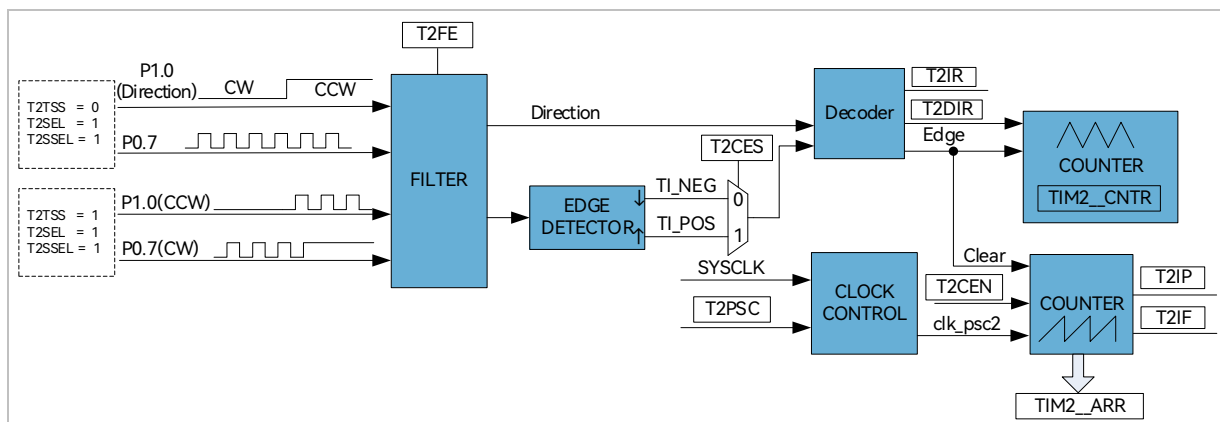


The Start of Sampling (“SoS”) time delay and End of Sampling (“EoS”) time advance must be set in order to sample correct BEMF comparison signals in RSD Sampling mode.

See section 28.1.4 for details.

14.1.8 Step Mode

Figure 14-12 Step Mode Schematic Diagram



In step mode, relative position, direction and speed of the step motor are obtained by detecting inputs of the two channels. P1.0 is direction input, and P0.7 is pulse input. Setting TIM2_CR0[T2CES] to select the rising edge or falling edge as the active edge. The input signals are sent to decoding module from the filtering module to obtain the active edge and direction TIM2_CR1[T2DIR].



Note

TIM2_CR1[T2DIR] will not change unless transition occurs at P1.0 and active edge is detected at P0.7. To generate an interrupt immediately after P1.0 changes, use INT1

Figure 14-13 Timing Diagram of Step Mode

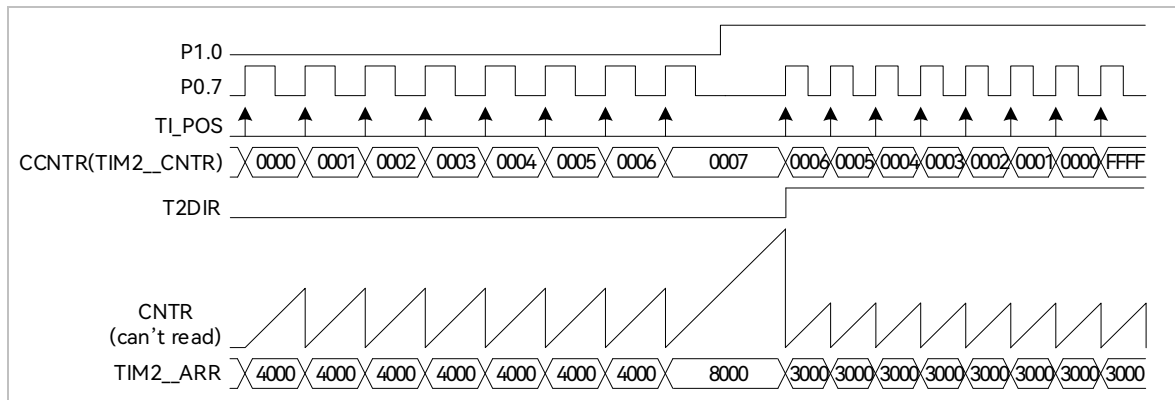
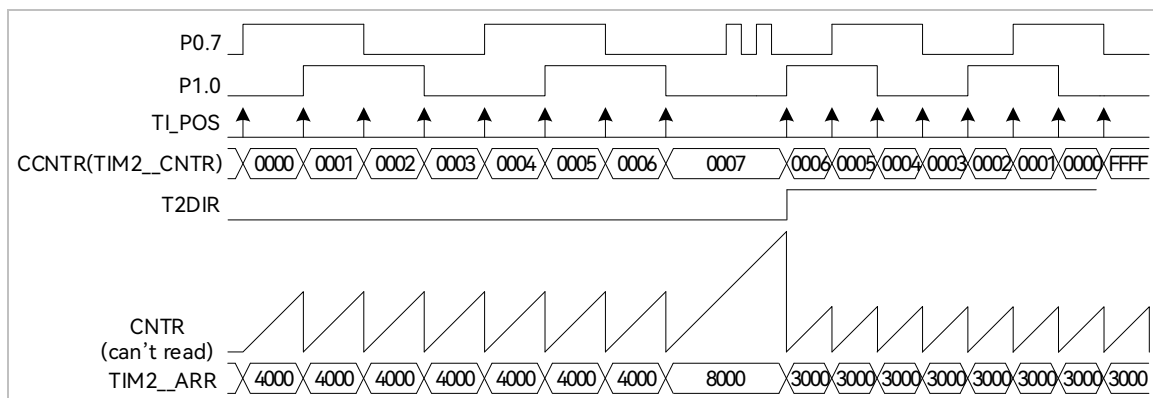


Figure 14-14 Timing Diagram of Positive + Negative Pulse Input State in Step Mode

(Raising Edge Selected as Active Edge)



The special timer is an up/down-counter, and the signal source is active edge of the encoding module. When $P1.0 = 0$, $TIM2\_CR1[T2DIR] = 0$, the direction is forward. If active edge of P0.7 arrives, the special timer CCNTR increases by 1. When $P1.0 = 1$, $TIM2\_CR1[T2DIR] = 1$ and the direction is reverse. If active edge of P0.7 arrives, CCNTR decreases by 1. If count value of the special timer reaches 65535 from 0, it is automatically cleared to "0". If it decreases from 65535 to 0, it is automatically set to 65535. TIM2_CNTR is read to obtain the value of special timer.

The Base Timer is an up counter, which uses the output of prescaler as the clock source to record the time between two active counting edges. When active counting edge arrives, the value of Basic Timer is stored in TIM2_ARR and then cleared to "0", and TIM2_CR1[T2IP] interrupt flag bit is set to "1". When Base Timer counts to 0xFFFF, the count overflows and TIM2_CR1[T2IF] interrupt flag is generated.

14.2 Timer2 Registers

14.2.1 TIM2_CR0 (0xA1)

Bit	7	6	5	4	3	2	1	0
Name	T2PSC			T2OCM	T2IRE	T2CES	T2MOD	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description								
[7:5]	T2PSC	Base Timer Clock Prescaler Selection It is configured to divide the system clock frequency and generate the clock source for Base Timer. The prescaled clock rates are configured as follows: <table><tr><td>000: 24MHz</td><td>001: 12MHz</td></tr><tr><td>010: 6MHz</td><td>011: 3MHz</td></tr><tr><td>100: 1.5MHz</td><td>101: 750kHz</td></tr><tr><td>110: 375kHz</td><td>111: 187.5kHz</td></tr></table>	000: 24MHz	001: 12MHz	010: 6MHz	011: 3MHz	100: 1.5MHz	101: 750kHz	110: 375kHz	111: 187.5kHz
000: 24MHz	001: 12MHz									
010: 6MHz	011: 3MHz									
100: 1.5MHz	101: 750kHz									
110: 375kHz	111: 187.5kHz									
[4]	T2OCM	Output Mode: Output Mode Selection 0: Output “0” when TIM2_CNTR < TIM2_DR; output “1” when TIM2_CNTR ≥ TIM2_DR 1: Output “1” when TIM2_CNTR < TIM2_DR; output “0” when TIM2_CNTR ≥ TIM2_DR Input Count Mode: No effect Input Capture Mode: TIM2_DR indicates the input level to be selected when timer TIM2_CNTR becomes overflowed. 0: TIM2_DR is reset to “0” by hardware for low-level input upon an overflow interrupt and is set to “0xFFFF” for high-level input upon an overflow interrupt. 1: TIM2_DR is reset to “0” by hardware for high-level input upon an overflow interrupt and is set to “0xFFFF” for low-level output upon an overflow interrupt. QEP&RSD Mode or Step Mode Selection 0: QEP&RSD Mode 1: Step Mode								
[3]	T2IRE	Output Mode: Match Interrupt Enable Input Capture Mode: Pulse Width Detection Interrupt Enable Input Count Mode: No effect QEP Mode: QEP Encoder Z Signal Interrupt Enable Step Mode: No effect 0: Disable 1: Enable								

[2]	T2CES	Output Mode: No effect Input Capture Mode: Counting Edge Selection 0: The time between two adjacent raising edges forms one cycle, and the time from rising edge to falling edge forms the pulse width (HIGH). The time between two adjacent falling edges forms one cycle, and the time from falling edge to raising edge forms the pulse width (LOW). Input Count Mode: Active Edge Selection 0: Falling Edge Count 1: Raising Edge Count QEP&RSD Mode: Enable Pulse Counter Cleared upon Z Signal Interrupt INT1 0: Disable 1: Enable Step Mode: Active Edge Selection 0: Falling Edge Count 1: Raising Edge Count
[1:0]	T2MOD	Mode Selection 00: Input Capture Mode 01: Output Mode 10: Input Count Mode 11: QEP&RSD Mode or Step Mode

14.2.2 TIM2_CR1 (0xA9)

Bit	7	6	5	4	3	2	1	0
Name	T2IR	T2IP	T2IF	T2IPE	T2IFE	T2FE	T2DIR	T2CEN
Type	R/W0	R/W0	R/W0	R/W	R/W	R/W	R	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	T2IR	Output Mode: Match Interrupt Flag Input Capture Mode: Pulse Width Detection Interrupt Flag Input Count Mode: No effect QEP Mode: QEP Encoder Z Signal Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0" 1: No effect
[6]	T2IP	Output Mode: No effect

		Input Capture Mode: PWM Cycle Detection Interrupt Flag Input Count Mode: PWM Input Count Match Interrupt Flag QEP&RSD Mode and Step Mode: Active Edge Detection Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: No effect
[5]	T2IF	Output Mode: Base Timer Overflow Interrupt Flag, which is set to “1” when TIM2_CNTR matches TIM2_ARR. Input Capture Mode: Base Timer Overflow Interrupt Flag, which is set to “1” when the Timer has not detected an input PWM cycle but the timer TIM2_CNTR value reaches 0xFFFF. Input Count Mode: Special-purpose timer overflow Interrupt Flag, which is set to “1” when the input PWM cycle has not reached the preset TIM2_DR value but the Base Timer TIM2_CNTR value reaches 0xFFFF. QEP&RSD Mode and Step Mode: Base Timer Overflow Interrupt Flag, which is set to “1” and Basic Timer is cleared to “0” when Basic Timer reaches to 0xFFFF. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: No effect
[4]	T2IPE	Output Mode: No effect Input Capture Mode: PWM Cycle Detection Interrupt Enable Input Count Mode: PWM Input Count Match Interrupt Enable QEP&RSD Mode and Step Mode: Active Edge Detection Interrupt Enable 0: Disable 1: Enable
[3]	T2IFE	Output Mode: Base Timer Overflow Interrupt Enable Input Capture Mode: Base Timer Overflow Interrupt Enable Input Count Mode: Base Timer Overflow Interrupt Enable QEP&RSD Mode and Step Mode: Base Timer Overflow Interrupt Enable 0: Disable 1: Enable
[2]	T2FE	Input Signal Filter Selection

		When TIM2_CR1[T2FE] = 1, input signals are filtered out as noise if the pulse width is less than 4/8 clock cycle. Assuming that the system clock runs at 24MHz (41.67ns), then the pulse width for filtering is 166.67/333.34ns. 0: Signals filtered on every 4 clock cycles 1: Signals filtered on every 8 clock cycles
[1]	T2DIR	QEP&RSD Mode: Indicator of Motor Rotation Direction Rotation direction of the motor is determined according to the phase relationship of the two input signals. Step Mode: Indicator of Motor Rotation Direction Rotation direction of the motor is determined according to the direction signal P1.0. 0: Forward 1: Backward
[0]	T2CEN	Base Timer Enable 0: Disable 1: Enable

14.2.3 TIM2_CNTR (0xAA, 0xAB)

TIM2_CNTRH(0xAB)								
Bit	15	14	13	12	11	10	9	8
Name	TIM2_CNTR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM2_CNTRL(0xAA)								
Bit	7	6	5	4	3	2	1	0
Name	TIM2_CNTR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM2_CNTR	Output Mode/Input Capture Mode/Input Count Mode: Count values held in the Base Timer QEP&RSD Mode and Step Mode: count values held in the special timer

14.2.4 TIM2_DR (0xAC, 0xAD)

TIM2_DRH(0xAD)								
Bit	15	14	13	12	11	10	9	8
Name	TIM2_DR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0
TIM2_DRL(0xAC)								
Bit	7	6	5	4	3	2	1	0
Name	TIM2_DR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM2_DR	Output Mode: Compare match value (written by software) Input Capture Mode: Count value of the detected input pulse width (written by hardware) Input Count Mode: PWM cycles to be counted (written by software) QEP Mode: Encoder value Step Mode: No effect

14.2.5 TIM2_ARR (0xAE, 0xAF)

TIM2_ARRH(0xAF)								
Bit	15	14	13	12	11	10	9	8
Name	TIM2_ARR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIM2_ARRL(0xAE)								
Bit	7	6	5	4	3	2	1	0
Name	TIM2_ARR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIM2_ARR	Output Mode: PWM cycle (written by software) Input Capture Mode: Count value held in Base Timer of a PWM cycle (written by hardware) Input Count Mode: Count value held in Base Timer when the input PWM count matches (written by hardware) QEP&RSD Mode and Step Mode: Count value held in Base Timer when the input signal is detected as an active edge (written by hardware)

15 Timer3/Timer4

15.1 Timer3/Timer4 Instructions

Timer3/Timer4 support output and input modes:

- > Output mode: Generate PWM
- > Input capture mode: Detect the duration of high and low level of input PWM, which can be used to calculate PWM duty cycle

Timer3/Timer4 features:

- > 3-bit programmable prescaler divides system clock as the clock source for Base Timer (clock source of Timer3 can be doubled to 48MHz in input capture mode)
- > 16-bit up-counting Base Timer; The output of the prescaler serves as the counting clock source
- > Input signal filtering
- > Input signal edge detection
- > Output PWM signal, single compare output
- > Interrupt event

15.1.1 Prescaler

Prescaler divides the system clock frequency and generates counter clock source for Base Timer. 8 frequency division coefficients of prescaler are available and can be selected by TIMx_CR0[TxPSC]. Since this register has no buffer, the clock source frequency is updated immediately after TIMx_CR0[TxPSC] is written. Therefore, the frequency division coefficients shall be configured when Basic Timer is not working. The clock source frequency formula is: $clk\_psc = SYSCLK / (2^{TxPSC})$. The clock rate corresponding to different TIMx_CR0[TxPSC] value as shown in Table 15-1.

Table 15-1 Mapping between Clock Rate and TIMx_CR0[TxPSC]

TIMx_CR0[TxPSC]	Division Factor	clk_psc(Hz)	TIMx_CR0[TxPSC]	Division Factor	clk_psc(Hz)
000	0x1	24M	100	0x10	1.5M
001	0x2	12M	101	0x20	750k

010	0x4	6M	110	0x40	375k
011	0x8	3M	111	0x80	187.5k

**Note**

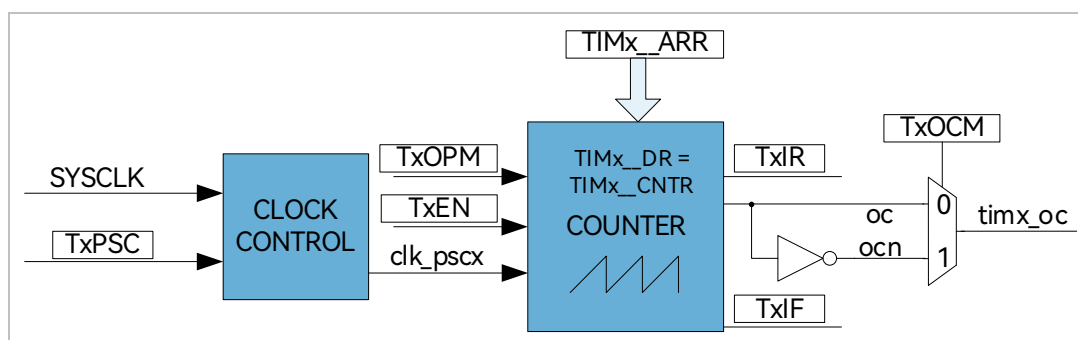
In Input Capture Mode of Timer3, the clock rate is 48MHz when TIM3_CR0[T3PSC] = 111

15.1.2 Reading, Writing and Counting of TIMx_CNTR

TIMx_CNTR starts when TIMx_CR1[TxEN] = 1. The write operation to TIMx_CNTR directly changes the value of the register, so it is required to disable the timer before the write operation. When reading TIMx_CNTR, the software reads high-order bits first and then low-order bits, and the hardware caches the low-order bits simultaneously. When reading the low-order bits, the software reads the cached data.

15.1.3 Output Mode

Figure 15-1 Output Mode Block Diagram



The output mode generate output signals according to TIMx_CR0[TxOCM], and the comparison results between TIMx_CNTR and registers TIMx_DR, TIMx_ARR. Meanwhile, corresponding interrupts is generated.

15.1.3.1 High-/Low-level Output Mode

When TIMx_CR0[TxOCM] = 0 and TIMx_DR > TIMx_ARR, the output signals are always low. When TIMx_CR0[TxOCM] = 1 and TIMx_DR > TIMx_ARR, the output signals are always high.

15.1.3.2 PWM Generation

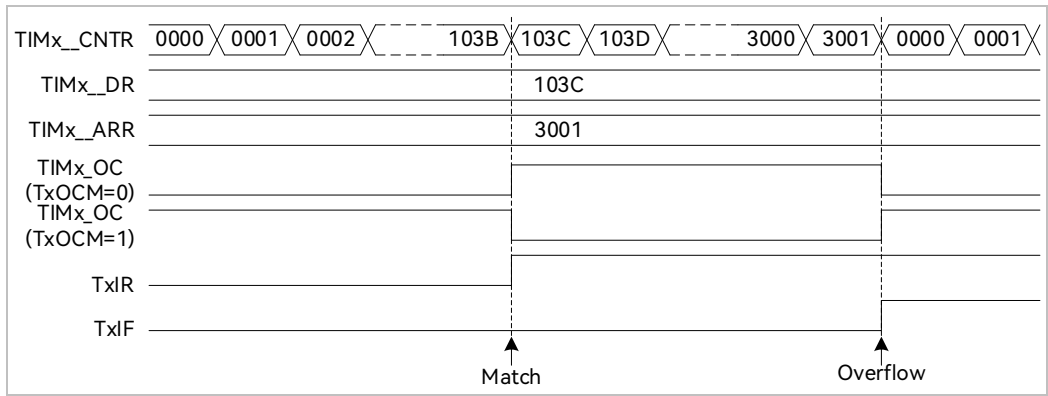
In PWM generation mode, TIMx_ARR determines PWM cycle, and TIMx_DR determines the duty cycle, and $\text{duty cycle} = \text{TIMx\_DR} / \text{TIMx\_ARR} * 100\%$. If TIMx_CR0[TxOCM] = 0, the low level is output when TIMx_CNTR < TIMx_DR, and the high level is output when TIMx_CNTR ≥ TIMx_DR. If TIMx_CR0[TxOCM] = 1, the high level is output when TIMx_CNTR < TIMx_DR, and low level is output when TIMx_CNTR ≥ TIMx_DR. When

TIMx_CNTR > TIMx_ARR, the output signal is reversed.

15.1.3.3 Interrupt Event

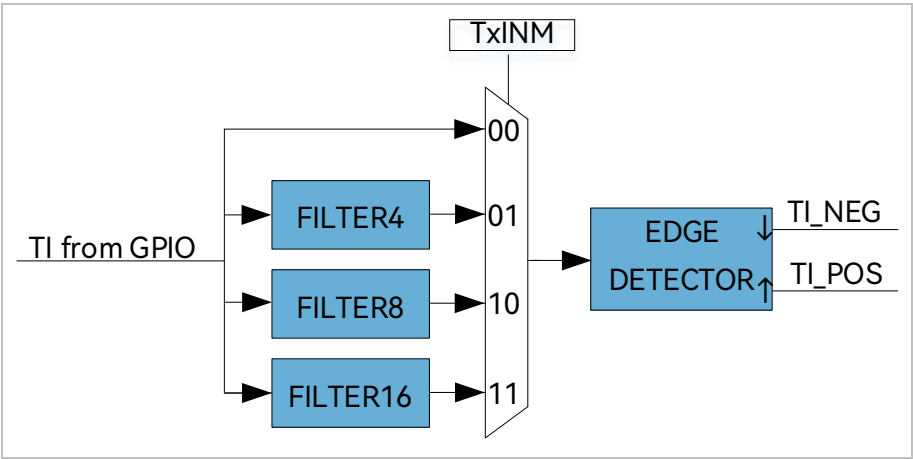
- When TIMx_CNTR = TIMx_DR, a compare match interrupt is generated. The interrupt flag TIMx_CR1[TxIR] is set to “1”, and the timer continues.
- When TIMx_CNTR = TIMx_ARR, an overflow event is generated. The interrupt flag TIMx_CR1[TxIF] is set to “1”, and the timer is cleared to “0”. TIMx_CR0[TxOPM] determines whether the timer recounts. The timer stops when TIMx_CR0[TxOPM]= 1, and restarts when TIMx_CR0[TxOPM]= 0.

Figure 15-2 Output Waveform of Output Mode



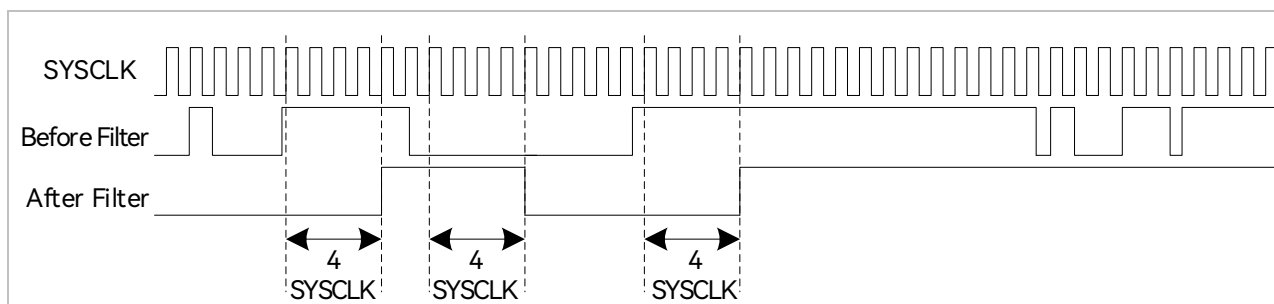
15.1.4 Input Signal Filtering and Edge Detection

Figure 15-3 Block Diagram of Input Signal Filtering and Edge Detection



The input signals of Timer3/Timer4 come from GPIO pin. TIMx_CR1[TxINM] is configured to disable the filtering circuit or filter out the input noise below 4/8/16 system clock cycles. The filtered signal is 4/8/16 system clock cycles delayed than the signal before filtering.

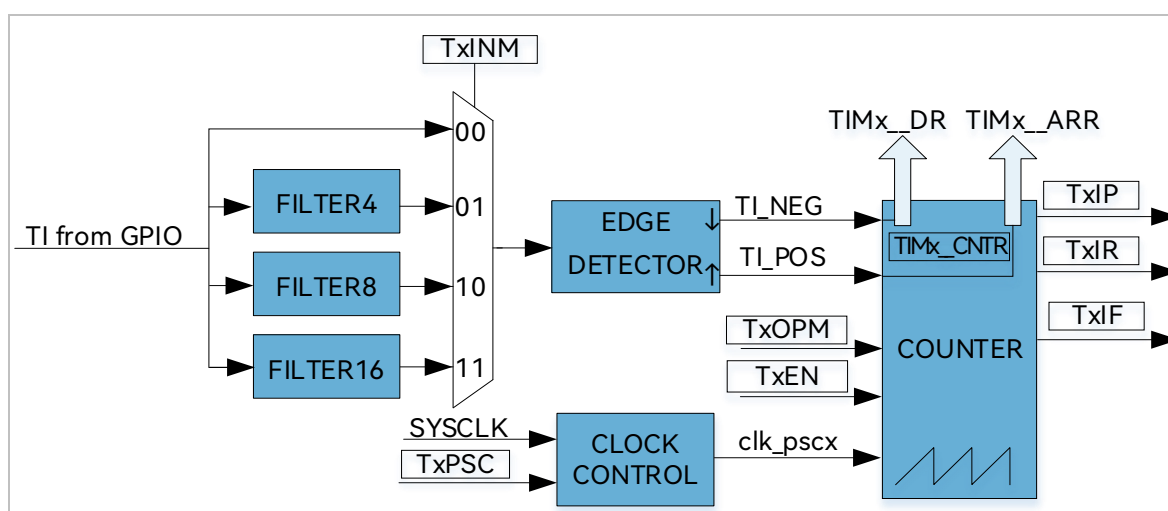
Figure 15-4 Timing Diagram of Filter Module



The edge detection module detects the filtered input signal from filtering module, and records the rising edge and falling edge for input capture mode

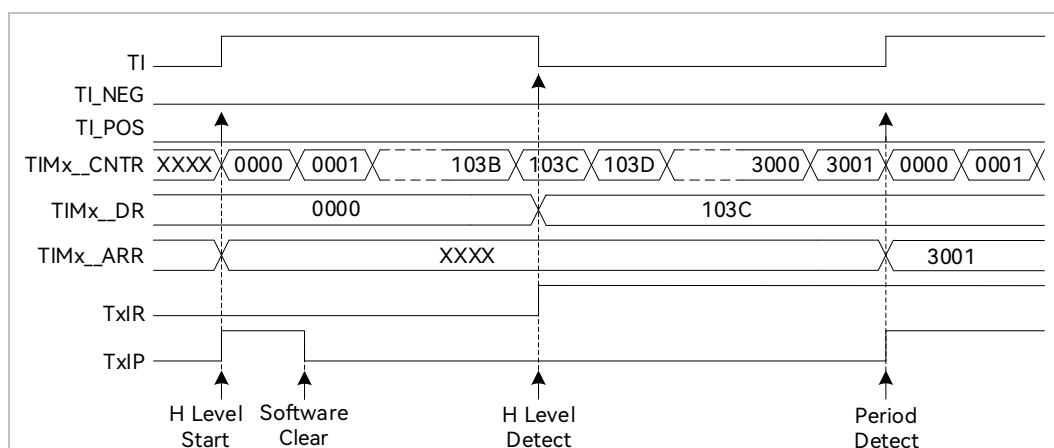
15.1.5 Input Capture Mode

Figure 15-5 Schematic Diagram of Input Capture Mode



The Input Capture Mode detects pulse width and waveform period of the input PWM signals. When $TIMx\_CR0[TxOCM] = 0$, the time between two adjacent rising edges forms one cycle, and the time from rising edge to falling edge forms the pulse width (HIGH). When $TIMx\_CR0[TxOCM] = 1$, the time between two adjacent falling edges forms one cycle, and the time from falling edge to rising edge forms the pulse width (LOW). The pulse width and the period obtained by $TIMx\_CNTR$ are stored in $TIMx\_DR$ and $TIMx\_ARR$ respectively.

Figure 15-6 Timing Diagram of Input Capture Mode (TIMx_CR0[TxOCM] = 0)



For example, when TIMx_CR0[TxOCM] = 0, TIMx_CR1[TxEN] is set to “1” to enable the timer. The Base Timer is cleared to “0” and restarts when the first raising edge is detected. When the falling edge is detected, the value of TIMx_CNTR is stored into TIMx_DR. Meanwhile, the interrupt flag TIMx_CR1[TxIR] is set to “1”, and TIMx_CNTR continues to count. When the second rising edge is detected, the value of TIMx_CNTR is saved into TIMx_ARR. The interrupt flag TIMx_CR1[TxIP] is set to “1” and TIMx_CNTR is cleared to “0”. TIMx_CR0[TxOPM] determines whether the timer restarts. If TIMx_CR0[TxOPM] = 1, the timer stops; and if TIMx_CR0[TxOPM] = 0, it restarts.

An overflow event occurs if Timer3/Timer4 does not detect the second rising edge of the input and TIMx_CNTR reaches 0xFFFF. In this case, the interrupt flag bit TIMx_CR1[TxIF] is set to “1”, and TIMx_CNTR is cleared to “0”. TIMx_CR0[TxOPM] determines whether the timer restarts. If TIMx_CR0[TxOCM] = 1, the timer stops counting, and if TIMx_CR0[TxOPM] = 0, it restarts. At this point, TIMx_ARR is 0xFFFF, and TIMx_DR is determined by the input level and TIMx_CR0[TxOCM] XOR.

15.1.6 Timer4 FG Output Mode

See FG Output Generation.

15.2 Timer3/Timer4 Registers

15.2.1 TIMx_CR0 (0x9C/0x9E) (x = 3/4)

Bit	7	6	5	4	3	2	1	0
Name	TxPSC			TxOCM	TxIRE	RSV	TxOPM	TxMOD
Type	R/W	R/W	R/W	R/W	R/W	-	R/W	R/W
Reset	0	0	0	0	0	-	0	0

Bit	Name	Description
[7:5]	TxPSC	Base TimerClock Prescaler Selection It is configured to divide the system clock frequency and generate the clock source for Base Timer. The prescaled clock rates are configured as follows: 000: 24MHz 001: 12MHz 010: 6MHz 011: 3MHz 100: 1.5MHz 101: 750kHz 110: 375kHz 111: 187.5kHz  Note In Input Capture Mode of Timer3, the clock rate is 48MHz when the bit is set to “111”
[4]	TxOCM	Output Mode: Output Mode Selection 0: Output “0” when TIMx_CNTR < TIMx_DR; output “1” when TIMx_CNTR ≥ TIMx_DR 1: Output “1” when TIMx_CNTR < TIMx_DR; output “0” when TIMx_CNTR ≥ TIMx_DR Input Capture Mode: TIMx_DR indicates the input level to be selected when the active edge is detected or the timer becomes overflowed. Active Edge Selection 0: The time between two adjacent raising edges forms one cycle, and the time from rising edge to falling edge forms the pulse width (HIGH). 1: The time between two adjacent falling edges forms one cycle, and the time from falling edge to raising edge forms the pulse width (LOW). TIMx_DR indicates the input level to be selected when the timer becomes overflowed. 0: TIMx_DR is reset to “0” by hardware for low-level input upon an overflow interrupt and is set to “0xFFFF” by hardware for high-level input upon an overflow interrupt. 1: TIMx_DR is reset to “0” by hardware for high-level input upon an overflow interrupt and is set to “0xFFFF” for low-level input upon an overflow interrupt.
[3]	TxIRE	Output Mode: Compare Match Interrupt Enable Input Capture Mode: Pulse Width Detection Interrupt Enable 0: Disable 1: Enable

[2]	RSV	Reserved
[1]	TxOPM	Single Mode Base Timer stops in any of the following events: Output Mode: Base Timer overflow event Input Capture Mode: PWM Cycle Detection or Base Timer overflow event 0: Base Timer does not stop 1: Base Timer stops (TIMx_CR1[TxEN] is reset to “0”)
[0]	TxMOD	Working Mode Selection 0: Input Capture Mode 1: Output Mode

15.2.2 TIMx_CR1 (0x9D/0x9F) (x = 3/4)

Bit	7	6	5	4	3	2	1	0
Name	TxLR	TxIP	TxIF	TxIPE	TxIFE	TxINM		TxEN
Type	R/W0	R/W0	R/W0	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	TxLR	Output Mode: Compare Match Interrupt Flag Input Capture Mode: Pulse Width Detection Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: No effect
[6]	TxIP	Output Mode: No effect Input Capture Mode: PWM Cycle Detection Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: No effect
[5]	TxIF	Output Mode: Base Timer Overflow Interrupt Flag, which is set to “1” when TIMx_CNTR matches TIMx_ARR. Input Capture Mode: Base Timer Overflow Interrupt Flag, which is set to “1” when the Timer does not detect an input PWM cycle but TIMx_CNTR reaches 0xFFFF. Read: 0: No Interrupt Pending 1: Interrupt Pending Write:

		0: This bit is cleared to “0” 1: No effect
[4]	TxIPE	Output Mode: No effect Input Capture Mode: PWM Cycle Detection Interrupt Enable 0: Disable 1: Enable
[3]	TxIFE	Output Mode: Base Timer Overflow Interrupt Input Capture Mode: Base Timer Overflow Interrupt Enable 0: Disable 1: Enable
[2:1]	TxINM	Input Signal Filtering Pulse Width Selection Input signals are filtered as noise if pulse width is less than the defined value. 00: Not to filter signals 01: Filtered on every 4 SYSCLK cycles 10: Filtered on every 8 SYSCLK cycles 11: Filtered on every 16 SYSCLK cycles
[0]	TxEN	Base Timer Enable 0: Disable 1: Enable

15.2.3 TIMx_CNTR (0xA2, 0xA3/0x92, 0x93) (x = 3/4)

TIMx_CNTRH(0xA3/0x93)								
Bit	15	14	13	12	11	10	9	8
Name	TIMx_CNTR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIMx_CNTRL(0xA2/0x92)								
Bit	7	6	5	4	3	2	1	0
Name	TIMx_CNTR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIMx_CNTR	Count values held in Base Timer

15.2.4 TIMx_DR (0xA4, 0xA5/0x94, 0x95) (x = 3/4)

TIMx_DRH(0xA5/0x95)								
Bit	15	14	13	12	11	10	9	8
Name	TIMx_DR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0
TIMx_DRL(0xA4/0x94)								
Bit	7	6	5	4	3	2	1	0
Name	TIMx_DR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIMx_DR	Output Mode: Compare match values (written by software) Input Capture Mode: Count value of the detected input pulse width (written by hardware)

15.2.5 TIMx_ARR (0xA6, 0xA7/0x96, 0x97) (x = 3/4)

TIMx_ARRH(0xA7/0x97)								
Bit	15	14	13	12	11	10	9	8
Name	TIMx_ARR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
TIMx_ARRL(0xA6/0x96)								
Bit	7	6	5	4	3	2	1	0
Name	TIMx_ARR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	TIMx_ARR	Output Mode: Reload value (written by hardware) See FG Output Generation for details. Input Capture Mode: Count value of a detected PWM cycle (written by hardware)

16 Systick

16.1 Systick Instructions

The chip can generate Systick interrupts at a fixed interval, and the interrupt cycle is controlled by SYST_ARR. Systick interrupt is enabled when DRV_SR[SYSTIE] is set to “1”, and the interrupts are accessed by P10.

16.2 Systick Registers

16.2.1 DRV_SR (0x4061)

Bit	7	6	5	4	3	2	1	0
Name	SYSTIF	SYSTIE	FGIF	DCIF	FGIE	DCIP	DCIM	
Type	R/W0	R/W	R/W0	R/W0	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	SYSTIF	Systick Interrupt Flag Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: No effect
[6]	SYSTIE	Systick Interrupt Enable 0: Disable 1: Enable
[5]	FGIF	FG Interrupt Flag When FOC Drive/Square Wave Drive is enabled, an FGIF Interrupt is generated in each rotation cycle (electrical cycle). Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: No effect
[4]	DCIF	Driver Match Interrupt Flag When the Driver counter value is equal to DRV_COMR, the system decides whether to generate an interrupt according to the counting direction set by DRV_SR[DCIM].

		Read: 0: No interrupt occurs 1: Interrupt occurs Write: 0: Cleared 1: No effect
[3]	FGIE	FG Interrupt Enable When FOC Drive/Square Wave Drive is enabled, an FG Interrupt is generated in each rotation cycle (electrical cycle) 0: Disable 1: Enable
[2]	DCIP	Number of PWM cycles required to generate a Driver Match Interrupt 0: 1 interrupt in 1 PWM cycle 1: 1 interrupt in 2 PWM cycles
[1:0]	DCIM	Driver Match Interrupt Mode Selection The system decides whether to generate an interrupt according to DRV_SR[DCIM] when Driver counter value is equal to DRV_COMR value. 00: No interrupt is generated. 01: An interrupt is generated when the counter counts up 10: An interrupt is generated when the counter counts down 11: An interrupt is generated when the counter counts up/down

16.2.2 SYST_ARR (0x4064, 0x4065)

SYST_ARRH(0x4064)								
Bit	15	14	13	12	11	10	9	8
Name	SYST_ARR[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	1	0	1	1	1	0	1
SYST_ARRL(0x4065)								
Bit	7	6	5	4	3	2	1	0
Name	SYST_ARR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	0	1	1	1	1	1	1

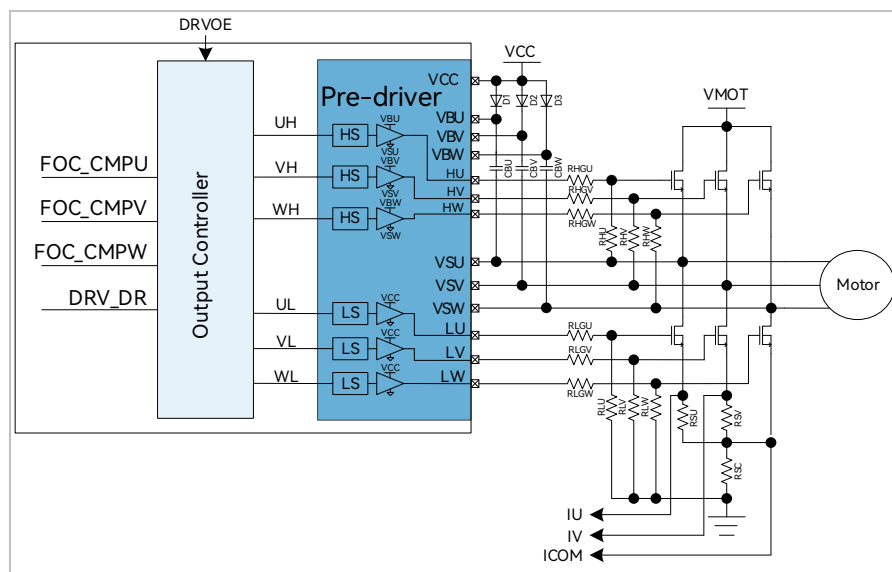
Bit	Name	Description
[15:0]	SYST_ARR	Systick Reloaded Value This bit determines the cycle at which Systick interrupts are generated, which defaults to 1ms. Calculation formula is as follows: Systick interrupt rate = SYSCLK/(SYST_ARR[15:0] + 1) Range [0, 65535]

17 Driver

17.1 Driver Instructions

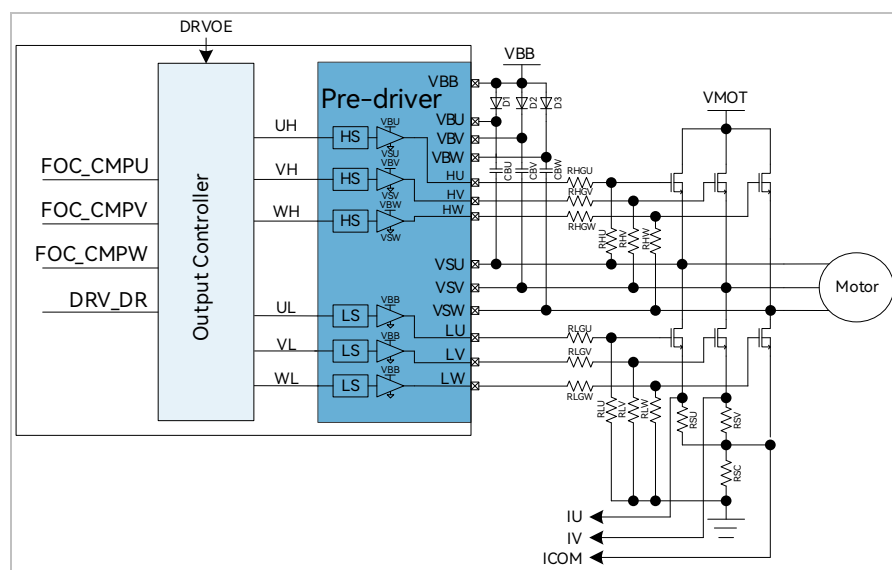
17.1.1 Driver Introduction of FU6572 / FU6562

Figure 17-1 Block Diagram of FU6572 / FU6562 Driver Module



17.1.2 FU6565 / FU6563 Driver Introduction

Figure 17-2 Block Diagram of FU6565 / FU6563 Driver Module



FOC_CMPU/V/W is the three-way comparison value output by FOC module, and DRV_DR is the comparison value set by the software. The above comparison value outputs three sets of level signals U/V/W to pre-driver after passing through the output control module to control BLDC motor.

In this mode, DRV_CR[DRVOE] is the enable signal of Pre-driver. The output of Pre-driver is connected to 6 NMOS and drives the U/V/W phase respectively.

Table 17-1 Pre-driver Signal Truth Table for FU6572 / FU6563 / FU6562

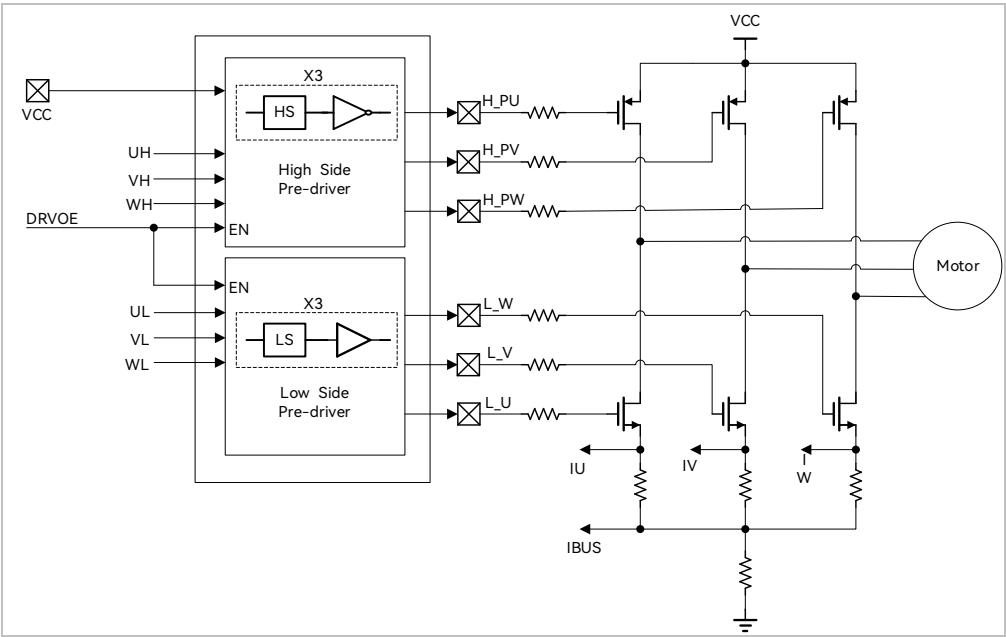
Input		Output	
UH/VH/WH	UL/VL/WL	HU/HV/HW	LU/LV/LW
L	L	L	L
L	H	L	H
H	L	H	L
H	H	L	L

Table 17-2 Pre-driver Signal Truth Table for FU6565

Input		Output	
UH/VH/WH	UL/VL/WL	HU/HV/HW	LU/LV/LW
L	L	L	L
L	H	L	H
H	L	H	L
H	H	H	H

17.1.3 Driver Introduction of FU6532

Figure 17-3 Block Diagram of FU6532 Driver Module

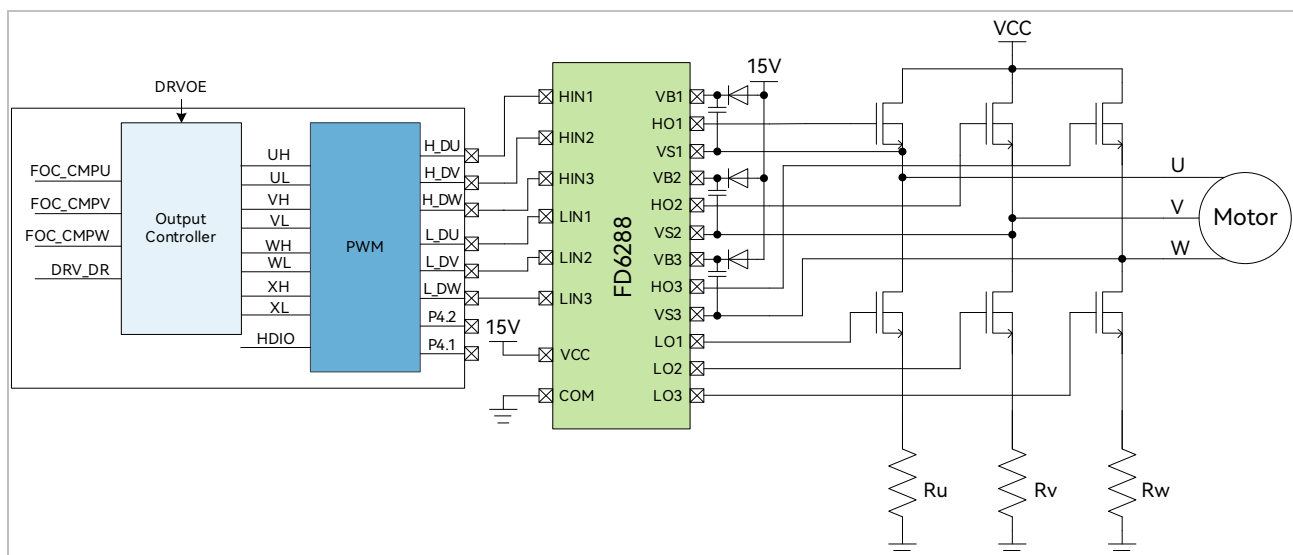


The driver module of 3P3N Pre-driver is shown in Figure 17-2, UH/VH/WH and UL/VL/WL 3-phase PWM signals are input signals of Pre-driver (FU6532) and H_PU/H_PV/H_PW and L_U/L_V/L_W pins are Pre-driver output signals. Note that H_PU/H_PV/H_PW signals and internal signals UH/VH/WH are inverse. DRV_CR[DRVOE] is the enable bit of Pre-driver.

Configure DRV_CR[DRVOE] = 1 to enable Pre-driver output. UH/VH/WH are respectively send to H_PU/H_PV/H_PW pin to drive the grid of PMOS inversely. UL/VL/WL are used to drive NMOS. The output voltages of PMOS and NMOS are used to driver the motor.

17.1.4 Driver Introduction of FU6522

Figure 17-4 Block Diagram of FU6522 Driver Module

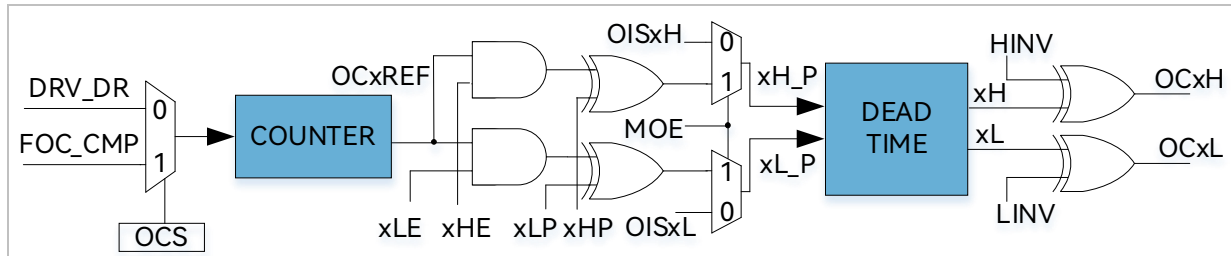


FOC_CMPU/V/W is the three-channel comparison value of the FOC output and DRV_DR is the comparison value of the software. Four groups' signals U/V/W/X are generated to PWM output after FOC_CMPU/V/W and DRV_DR are output. It is for step motor control.

In the mode, DRV_CR[DRVOE] is the enable signal of PWM, and PWM outputs to HVIC to drive the gate of the MOS.

17.1.5 Output Control Module

Figure 17-5 Block Diagram of Output Control Module



Before Driver module works, **DRV_CR[MESEL]** is set to “1” to select FOC mode or to “0” to select square-wave control mode.

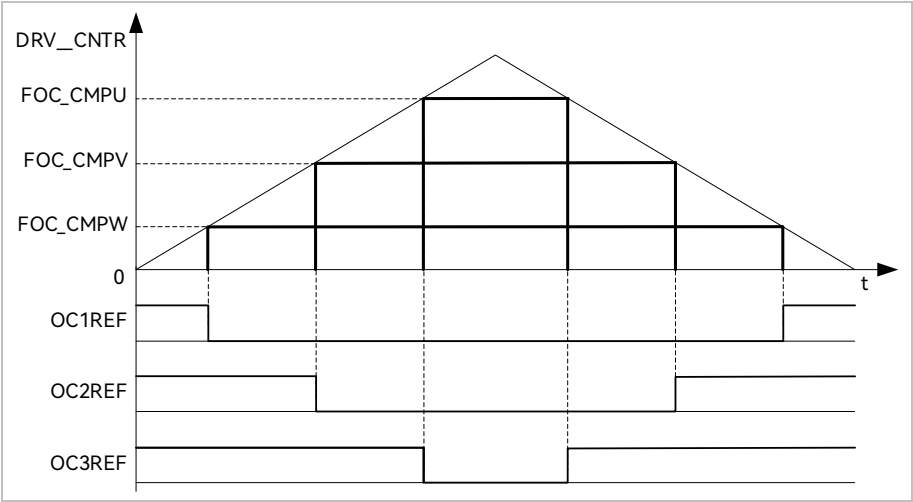
If **DRV_CR[OCS]** = 0, comparison value of PWM comes from **DRV_DR**. Otherwise, it comes from **FOC_CMP** and U/V/W output signals (**OCxREF**) are generated. **DRV_CMR[xHE]**, **DRV_CMR[xLE]**, polarity control bits **DRV_CMR[xHP]** and **DRV_CMR[xLP]** are configured for logic processing of **OCxREF** signal. Enabling **DRV_OUT[MOE]** outputs PWM waveform, otherwise, the idle level. **xH_P** and **xL_P** output signals are transferred to the deadtime module to generate **xH** and **xL** signals. The **PI_CR[HINV]** and **PI_CR[LINV]** bits are configured to output PWM drive signals required by the high and low levels.

17.1.5.1 Count and Compare Module

DRV_CR[OCS] is configured to select the comparison value of PWM from **FOC_CMP** U/V/W of FOC module or **DRV_DR** set by software. The comparison value is sent to the counter for comparison to obtain the 3-phase original PWM signal **OCxREF**, and **DRV_DR** is used for motor pre-charging, braking and square-wave control. If **DRV_CNTR** is smaller than the comparison value, **OCxREF** outputs high-level signal, and if **DRV_CNTR** is larger than **DRV_DR**, **OCxREF** outputs low-level signal.

When **DRV_CR[OCS]** = 1, **FOC_CMP** U/V/W is compared with the count value to generate the duty cycle **OC1REF/OC2REF/OC3REF**.

Figure 17-6 PWM Generation



When $DRV\_CR[OCS] = 0$, DRV_DR set by software is compared with the count value to generate $OC1REF/OC2REF/OC3REF$ with the same duty cycle. Duty cycle = $DRV\_DR/DRV\_ARR*100\%$.

17.1.5.2 Enable and Polarity of Output Signals

$DRV\_CMR[xHE]$ and $[xLE]$ are configured by software to enable high and low sides of the bridge, and $DRV\_CMR[xHP]$ and $[xLP]$ to select the polarity of output. DRV_DR , DRV_ARR and DRV_CMR can be configured to implement pre-charging brake, etc.

Figure 17-7 Pre-charge Waveform

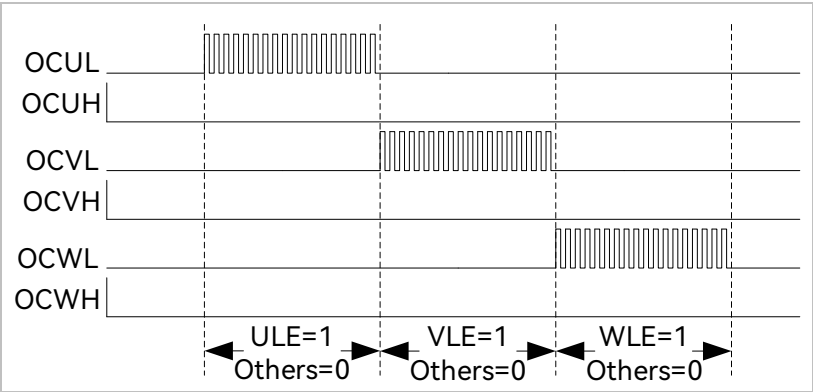
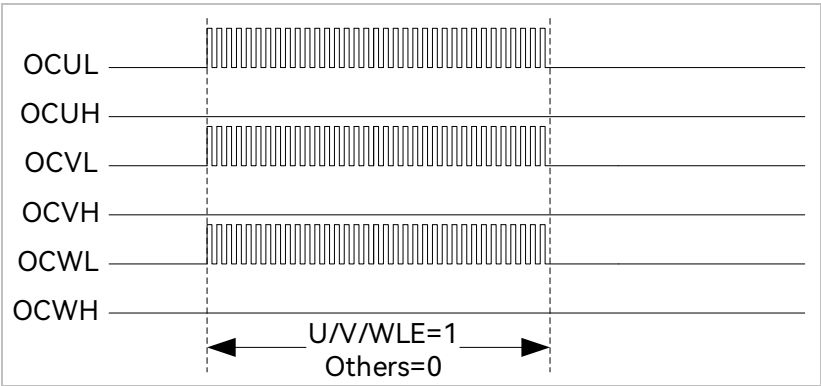
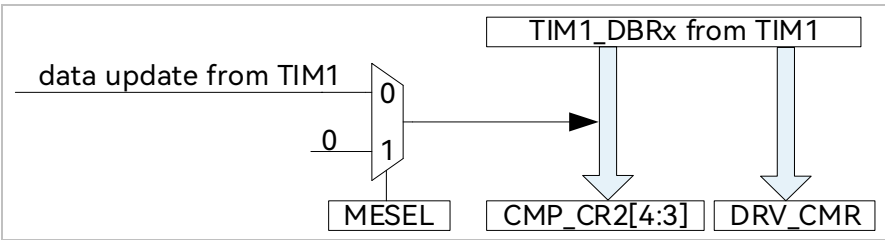


Figure 17-8 Brake Waveform



For square-wave control, Timer1 automatically controls DRV_CM_R to implement phase commutation. Configuring DRV_CR[MESEL] = 0 enables the Square Wave Drive Mode. After Timer1 generates a write timing, the data stored in the corresponding TIM1_DBR_x are transferred to the DRV_CM_R register.

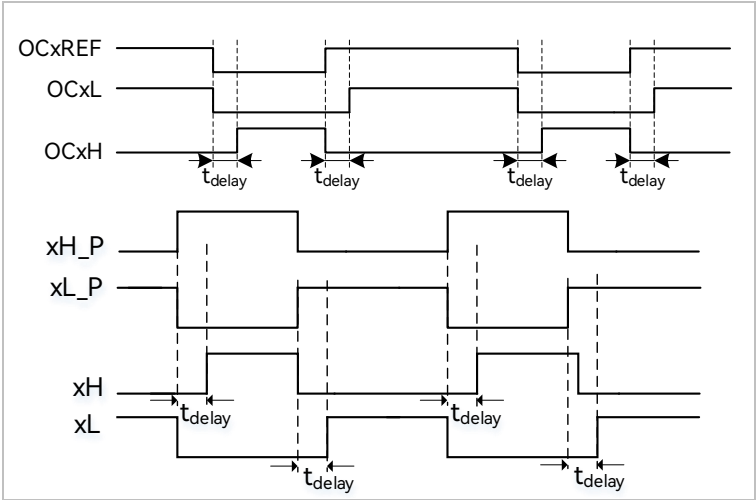
Figure 17-9 Timer1 Automatic Control of DRV_CM_R and CMP_CR2[4:3]



17.1.5.3 Deadtime Module

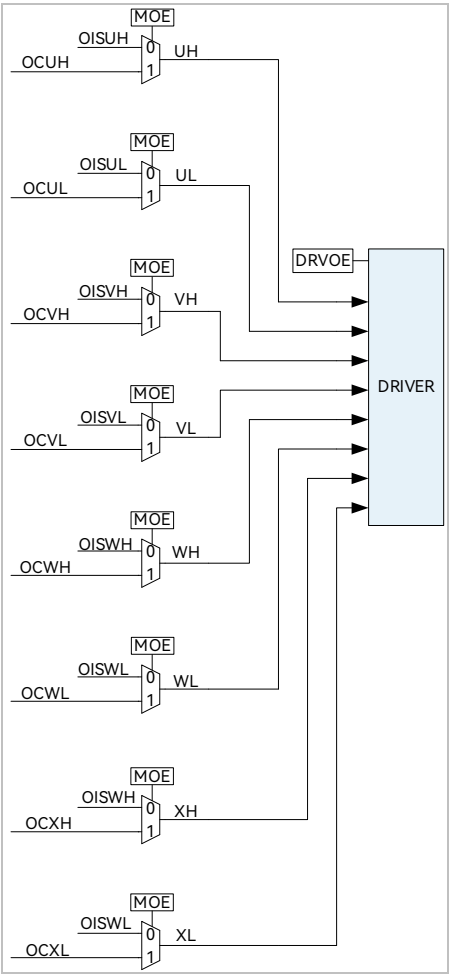
xH_P and xL_P signals are available for deadtime insertion. For complementary outputs, the deadtime insertion is enabled when DRV_DTR is not “0”. Each channel has an 8-bit deadtime generator, and three channels have the same deadtime, which is set by DRV_DTR. When rising edge signals are detected, output high level of xH and xL is delayed for a period of time set in DRV_DTR; if the delayed time is greater than the output pulse width, the associated channel pulse width is not delayed.

Figure 17-10 Complementary Outputs with Deadtime Insertion



17.1.5.4 Main Output Enable (MOE)

Figure 17-11 Block Diagram of the Output Control Module (Rear Stage)



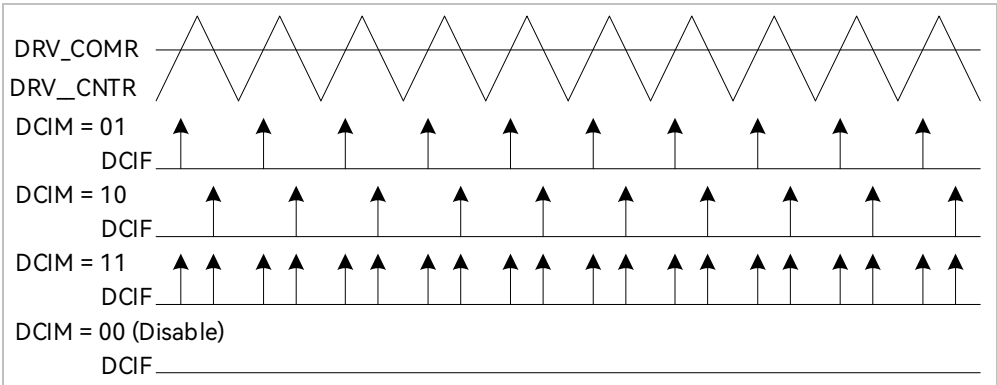
Enable DRV_OUT[MOE] to output PWM waveform for driving motors. After disabling DRV_OUT[MOE], the output is set to the idle level configured by software, and motor drive is stopped.

17.1.5.5 Interrupt

17.1.5.5.1 Compare Match Interrupt

The generation conditions and time for compare match interrupt are configured by DRV_SR[DCIM] and DRV_COMR respectively. When the timer reaches the value set in DRV_COMR and the conditions set by DRV_SR[DCIM] are met, a compare match interrupt is generated and the interrupt flag DRV_SR[DCIF] is set to “1” by hardware.

Figure 17-12 Driver Compare Match Interrupt



17.1.5.5.2 FG Interrupt

FG interrupt is enabled when DRV_SR[FGIE] is set to “1”. The motor generates an interrupt for every electrical cycle.

17.2 Driver Registers

17.2.1 PI_CR (0xF9)

Bit	7	6	5	4	3	2	1	0
Name	T2TSS	RSV				DRV_MD	HINV	LINV
Type	R/W	-	-	-	-	R/W	R/W	R/W
Reset	0	-	-	-	-	0	0	0

Bit	Name	Description
[7]	T2TSS	Input Mode Selection of Timer2 Step Motor 0: Direction + Pulse Input Mode. P1.0 for direction input, and P0.7 for pulse input 1: Bidirectional Pulse Input Mode. P1.0 for backward pulse input, and P0.7 for forward pulse input
[6:3]	RSV	Reserved
[2]	DRV_MD	Count Mode 0: Triangular Wave Mode 1: Sawtooth Wave Mode (FOC disabled)
[1]	HINV	High Side Reverse Enable 0: Disable 1: Enable
[0]	LINV	Low Side Reverse Enable 0: Disable 1: Enable

17.2.2 DRV_CR (0x4062)

Bit	7	6	5	4	3	2	1	0
Name	DRVEN	DDIR	FOCEN	DRPE	OCS	MESEL	RSV	DRVOE
Type	R/W	R/W	R/W	R/W	R/W	R/W	-	R/W
Reset	0	0	0	0	0	0	-	0

Bit	Name	Description
[7]	DRVEN	Counter Enable 0: Disable 1: Enable
[6]	DDIR	Output Direction (Forward/Reverse) Switch motor rotation directions; Valid in both square-wave drive and FOC drive modes. In sensorless FOC mode, setting this bit changes motor rotation. In sensed FOC mode, it is also required to modify the angle by the software. In square-wave control mode, parameters related to Timer1 shall be configured.

		0: Forward 1: Reverse
[5]	FOCEN	FOC Module Enable 0: Disable 1: Enable
[4]	DRPE	DRV_DR Pre-load Enable When preload is enabled, the data written to DRV_DR is updated after a timer underflow event occurs. When preload is disabled, the data written to DRV_DR is updated immediately. 0: Disable 1: Enable
[3]	OCS	Comparison Source Selection 0: DRV_DR 1: FOC Module
[2]	MESEL	ME Operating Mode Selection 0: Square Wave Drive 1: FOC Drive
[1]	RSV	Reserved
[0]	DRVOE	Driver Enable 0: Disable 1: Enable

17.2.3 DRV_SR (0x4061)

Bit	7	6	5	4	3	2	1	0
Name	SYSTIF	SYSTIE	FGIF	DCIF	FGIE	DCIP	DCIM	
Type	R/W0	R/W	R/W0	R/W0	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	SYSTIF	Systick Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: No effect
[6]	SYSTIE	Systick Interrupt Flag 0: Disable 1: Enable
[5]	FGIF	FG Interrupt Flag Read 0: No Interrupt Pending

		1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: No effect
[4]	DCIF	Driver Match Interrupt Flag When the Driver count value is equal to DRV_COMR, the system decides whether to generate an interrupt according to DRV_SR[DCIM]. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: No effect
[3]	FGIE	FG Interrupt Enable After the interrupt feature is enabled, an FG Interrupt is generated in each electric cycle under FOC/square-wave control mode. 0: Disable 1: Enable
[2]	DCIP	Number of PWM cycles to generate a Compare Match Interrupt 0: 1 PWM cycle 1: 2 PWM cycles
[1:0]	DCIM	Compare Match Interrupt Mode Selection When the Driver count value is equal to DRV_COMR, the system decides whether to generate an interrupt according to DRV_SR[DCIM]. 00: No interrupt is generated. 01: An interrupt is generated when the timer counts up. 10: An interrupt is generated when the timer counts down. 11: An interrupt is generated when the timer counts up/down.

17.2.4 DRV_OUT (0xF8)

Bit	7	6	5	4	3	2	1	0
Name	MOE	RSV	OISWL	OISWH	OISVL	OISVH	OISUL	OISUH
Type	R/W	–	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	–	0	0	0	0	0	0

Bit	Name	Description
[7]	MOE	Main Output Enable This bit selects the sources for high and low sides of the bridge of 3-phase output signals. It can be set to “1” and “0” by software. When bus current protection occurs, it is automatically cleared to “0” to turn off the output (see section 28.1.1.1)).

		0: Disable, with output sourced from the idle levels set by DRV_OUT[OISUH]/DRV_OUT[OISVH]/DRV_OUT[OISWH] and DRV_OUT[OISUL]/DRV_OUT[OISVL]/DRV_OUT[OISWL]. 1: Enable, with output sourced from the comparison value of the timer.
[6]	RSV	Reserved
[5]	OISWL	Output idle level of WL/XL See descriptions on OISUH register.  Note DRV_OUT[OISWL] bit is configured as WL/XL output in IDLE state
[4]	OISWH	Output idle level of WH/XH See descriptions on OISUH register.  Note DRV_OUT[OISWH] bit is configured as WH/XH output in IDLE state
[3]	OISVL	Output idle level of VL See descriptions on OISUH register
[2]	OISVH	Output idle level of VH See descriptions on OISUH register.
[1]	OISUL	Output idle level of UL See descriptions on OISUH register.
[0]	OISUH	Output idle level of UH This bit sets the UH output in IDLE state. When DRV_OUT[MOE] = 0, it outputs idle level to disable MOS. 0: Low 1: High

17.2.5 DRV_CMR (0x405C, 0x405D)

DRV_CMRH(0x405C)								
Bit	15	14	13	12	11	10	9	8
Name	XHP	XLP	XHE	XLE	WHP	WLP	VHP	VLP
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
DRV_CMRL(0x405D)								
Bit	7	6	5	4	3	2	1	0
Name	UHP	ULP	WHE	WLE	VHE	VLE	UHE	ULE
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15]	XHP	High-side Polarity Control of X-phase 0: Active High 1: Active Low
[14]	XLP	Low-side Polarity Control of X-phase 0: Active High 1: Active Low
[13]	XHE	High-side Output Enable of X-phase 0: Disable 1: Enable
[12]	XLE	Low-side Output Enable of X-phase 0: Disable 1: Enable
[11]	WHP	High-side Polarity Control of W-phase 0: Active High 1: Active Low
[10]	WLP	Low-side Polarity Control of W-phase 0: Active High 1: Active Low
[9]	VHP	High-side Polarity Control of V-phase 0: Active High 1: Active Low
[8]	VLP	High-side Polarity Control of V-phase 0: Active High 1: Active Low
[7]	UHP	High-side Polarity Control of U-phase 0: Active High 1: Active Low
[6]	ULP	Low-side Polarity Control of U-phase 0: Active High 1: Active Low
[5]	WHE	High-side Output Enable of W-phase 0: Disable 1: Enable
[4]	WLE	Low-side Output Enable of W-phase 0: Disable 1: Enable
[3]	VHE	High-side Output Enable of V-phase 0: Disable 1: Enable

[2]	VLE	Low-side Output Enable of V-phase 0: Disable 1: Enable
[1]	UHE	High-side Output Enable of U-phase 0: Disable 1: Enable
[0]	ULE	Low-side Output Enable of U-phase 0: Disable 1: Enable

**Note**

- > When DRV_CMR[W/V/ULE] and DRV_CMR[W/V/UHE] are set to “1”, high-side and low-side outputs of W/V/U-phases are complementary to generate PWM signals with deadtime insertion
- > For square-wave control, Timer1 automatically controls DRV_CMR register

17.2.6 DRV_ARR (0x405E, 0x405F)

DRV_ARRH(0x405E)								
Bit	15	14	13	12	11	10	9	8
Name	RSV		DRV_ARR[13:8]					
Type	-	-	R/W	R/W	R/W	R/W	R/W	R/W
Reset	-	-	0	0	0	0	0	0
DRV_ARRL(0x405F)								
Bit	7	6	5	4	3	2	1	0
Name	DRV_ARR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:14]	RSV	Reserved
[13:0]	DRV_ARR	Timer reload value, which determines PWM frequency (center-aligned) Driver timer up-counts from 0 to DRV_ARR/2 - 1 and an overflow event occurs. Then it down-counts to 0. Calculation formula: $f_{\text{carrier}} = 48\text{MHz}/\text{DRV\_ARR}$ DRV_ARR value is calculated using 48MHz clock rate, which falls within the range [0, 16383]. Note > The LSB is always 0, and a write of “1” is meaningless. > 48MHz is twice of the system clock frequency.

17.2.7 DRV_COMR (0x405A, 0x405B)

DRV_COMRH(0x405A)								
Bit	15	14	13	12	11	10	9	8
Name	RSV				DRV_COMR[11:8]			
Type	-	-	-	-	R/W	R/W	R/W	R/W
Reset	-	-	-	-	0	0	0	0
DRV_COMRL(0x405B)								
Bit	7	6	5	4	3	2	1	0
Name	DRV_COMR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:12]	RSV	Reserved
[11:0]	DRV_COMR	Timer Compare Match Value The compare match interrupt is generated when the count value is equal to DRV_COMR and the conditions set in DRV_SR[DCIM] are met. The clock rate for the calculation is 12MHz. Duty cycle at the match point = $\text{DRV\_COMR} \times 4 / \text{DRV\_ARR} \times 100\%$ DRV_COMR value is calculated using 12MHz clock rate, which falls within the range [0, 4095].

17.2.8 DRV_DR (0x4058, 0x4059)

DRV_DRH(0x4058)								
Bit	15	14	13	12	11	10	9	8
Name	RSV		DRV_DR[13:8]					
Type	-	-	R/W	R/W	R/W	R/W	R/W	R/W
Reset	-	-	0	0	0	0	0	0
DRV_DRL(0x4059)								
Bit	7	6	5	4	3	2	1	0
Name	DRV_DR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:14]	RSV	Reserved
[13:0]	DRV_DR	PWM Duty Cycle Setting in Software Duty cycle = $\text{DRV\_DR} / \text{DRV\_ARR} \times 100\%$ DRV_DR value is calculated using 48MHz clock rate, which falls within the range [0, 16383].
		 Note

- > When this register is used as a comparison source, PWM is referenced to high side of the bridge and a deadtime is inserted in the complementary output of the low side of bridge.
- > 48MHz is twice of the system clock frequency.

17.2.9 DRV_DTR (0x4060)

Bit	7	6	5	4	3	2	1	0
Name	DRV_DTR							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	DRV_DTR	Deadtime Setting Deadtime = (DRV_DTR + 1)*T Example: If DRV_DTR is configured to “11”, the deadtime = 12*41.67ns = 500ns.  Note If DRV_DTR is configured to “0”, deadtime insertion is disabled

17.2.10 DRV_CNTR (0x4066, 0x4067)

DRV_CNTRH(0x4066)								
Bit	15	14	13	12	11	10	9	8
Name	RSV				DRV_CNTR[11:8]			
Type	-	-	-	-	R/W	R/W	R/W	R/W
Reset	-	-	-	-	0	0	0	0

DRV_CNTRL(0x4067)								
Bit	7	6	5	4	3	2	1	0
Name	DRV_CNTR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:12]	RSV	Reserved
[11:0]	DRV_CNTR	Count Value of Timer The clock rate for the calculation is 12MHz, and Driver duty cycle = $\text{DRV\_CNTR} \times 4 / \text{DRV\_ARR} \times 100\%$ Range [0, 4095]  Note The DRV_CNTR register is writable only when DRV_CR[DRVEN] = 1

18 System clock

18.1 Clock Introduction

The clock system comprises two modules: the internal high-speed clock and the internal low-speed clock. The system clock operates on the internal high-speed clock, while the internal low-speed clock serves as the watchdog timer clock, with configurable overflow time.

18.2 Clock Calibration Introduction

Clock calibration is a feature that uses internal slow clock to calibrate the internal fast clock. Working principles: A 13-bit timer is used to count the length of 8 slow clock cycles with the fast clock as the clock source.

Calibration operations:

1. Set `CAL_CR[CAL_STA] = 1` in software to start the calibration;
2. Read `CAL_CR[CAL_BUSY]` flag bit to check if the calibration process is completed;
3. When the calibration is completed (`CAL_CR[CAL_BUSY] = 0`), the readout of `CAL_CR[CAL_ARR]` is the value of the length of counting 8 slow clock cycles.

18.3 Registers

18.3.1 CAL_CR (0x4044, 0x4045)

CAL_CRH(0x4044)								
Bit	15	14	13	12	11	10	9	8
Name	CAL_STA/ CAL_BUSY	RSV		CAL_ARR[12:8]				
Type	R/W1	-	-	R/W	R/W	R/W	R/W	R/W
Reset	1	-	-	0	0	0	0	0
CAL_CRL(0x4045)								
Bit	7	6	5	4	3	2	1	0
Name	CAL_ARR[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15]	CAL_STA/ CAL_BUSY	Clock Calibration Enable Read: 0: Calibration is completed. 1: Calibration is in progress. Write: 0: No effect 1: Clock Calibration starts.
[14:13]	RSV	Reserved
[12:0]	CAL_ARR	Calibration Counts The count values of the fast clock to continuously count eight slow clock cycles.  Note When this value is 0, it indicates that no corresponding slow clock input exists, and when this value is 0x1FFF, it indicates that the count overflows (slow clock is too slow or fast clock is too fast)

19 WDT

The watchdog timer (WDT) is a timer that works on the internal slow clock to monitor the master program operation and prevent the MCU running out. Watchdog works as follows: After watchdog operates, WDT starts counting. When WDT overflows, watchdog sends a signal to reset the MCU and the program restarts running from address 0. During the operation of master program, WDT has to be initialized at regular intervals to prevent WDT overflowing.

After being enabled, WDT starts counting from 0. When it reaches 0xFFFFC, watchdog outputs a signal that is 4 internal slow clock cycles wide to reset MCU, and the program starts running from address 0. WDT has to be initialized at regular intervals during operation, and WDT rolls over to WDT_ARR and restart counting.

19.1 WDT Notes

- When MCU enters standby or sleep mode, WDT stops counting, but the count values are retained.
- WDT is automatically disabled during emulation.
- RST_SR[RSTWDT] is set to “1” when MCU is reset by WDT timer overflow.

19.2 WDT Instructions

3. Set CCFG1[WDT_EN] = 1 to start WDT, which then starts counting from 0;
4. Set WDT_ARR (this operation can also be performed before starting WDT);
5. Set WDT_CR[WDTRF] = 1 in the running of program, and WDT rolls over to WDT_ARR setting.

19.3 WDT Registers

19.3.1 WDT_CR (0x4026)

Bit	7	6	5	4	3	2	1	0
Name	RSV							WDTRF
Type	-	-	-	-	-	-	-	R/W
Reset	-	-	-	-	-	-	-	0

Bit	Name	Description
[7:1]	RSV	Reserved
[0]	WDTRF	WDT Initialization 0: No effect 1: WDT rolls over to WDT_ARR setting and restarts counting.

19.3.2 WDT_ARR (0x4027)

Bit	7	6	5	4	3	2	1	0
Name	WDT_ARR							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	WDT_ARR	WDT Reload Timer This bit sets 8 high-order bits of the initialized value of WDT.

19.3.3 CCFG1 (0x401E)

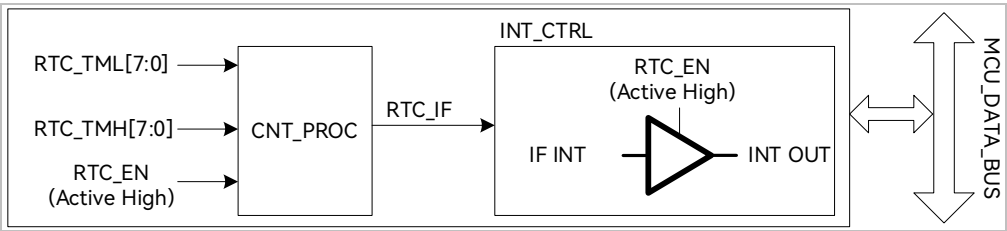
Bit	7	6	5	4	3	2	1	0
Name	LVW_EN_B	LVW_IE	WDT_EN	RSV				
Type	R/W	R/W	R/W	-	-	-	-	-
Reset	0	0	0	-	-	-	-	-

Bit	Name	Description
[7]	LVW_EN_B	VDD5 Low-voltage Warning Enable 0: Disable 1: Enable
[6]	LVW_IE	LVW Detection Interrupt Enable 0: Disable 1: Enable
[5]	WDT_EN	WDT Enable 0: Disable 1: Enable
[4:0]	RSV	Reserved

20 RTC

20.1 RTC Functional Block Diagram

Figure 20-1 RTC Functional Block Diagram



20.2 RTC Operations

A write to RTC_TM sets RTC reload value. RTC is enabled when RTC_STA[RTC_EN] is set to “1”.

20.3 RTC Registers

20.3.1 RTC_TM (0x402C, 0x402D)

RTC_TMH(0x402C)								
Bit	15	14	13	12	11	10	9	8
Name	RTC_TM[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1
RTC_TML(0x402D)								
Bit	7	6	5	4	3	2	1	0
Name	RTC_TM[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

Bit	Name	Description
[15:0]	RTC_TM	RTC Count Register Read: Instantaneous value of the timer Write: RTC timer up-counts at a rate of 32768Hz from 0 to the written value and becomes overflowed. Meanwhile, an interrupt request is generated, causing the timer to be cleared and restart counting.

20.3.2 RTC_STA (0x402E)

Bit	7	6	5	4	3	2	1	0
Name	RTC_EN	RTC_IF	RSV	ISOSCEN	RSV			
Type	R/W	R/W0	-	R/W	-	-	-	-
Reset	0	0	-	0	-	-	-	-

Bit	Name	Description
[7]	RTC_EN	RTC Enable 0: Disable 1: Enable
[6]	RTC_IF	RTC Interrupt Flag This bit is set to “1” when the timer value matches RTC_TM setting. Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: No effect
[5]	RSV	Reserved
[4]	ISOSCEN	Internal Slow Clock Enable 0: Disable 1: Enable
[3:0]	RSV	Reserved

21 IO

21.1 IO Introduction

- FU6572L has up to 31 GPIOs, including P0.0 ~ P0.7, P1.0 ~ P1.7, P2.1 ~ P2.2, P2.4 ~ P2.6, P3.0 ~ P3.7, P4.5 and P4.7.
- FU6572N has up to 24 GPIOs, including P0.0 ~ P0.1, P0.5 ~ P0.6, P1.1 ~ P1.7, P2.1 ~ P2.2, P2.4 ~ P2.6, P3.0~P3.1, P3.3~P3.6, P4.5 and P4.7.
- FU6572T has up to 13 GPIOs, including P0.1, P1.2, P1.4, P1.6, P2.1, P2.4, P2.6, P3.0~P3.1, P3.3~P3.5 and P4.7.
- FU6565N has up to 23 GPIOs, including P0.0 ~ P0.1, P0.5 ~ P0.6, P1.1 ~ P1.7, P2.1 ~ P2.2, P2.4 ~ P2.6, P3.0 ~ P3.1, P3.3 ~ P3.5, P4.5, and P4.7.
- FU6565T has up to 12 GPIOs, including P0.1, P1.2, P1.6, P2.1, P2.4, P2.6, P3.0 ~ P3.1, P3.3 ~ P3.5, and P4.7.
- FU6563N has up to 15 GPIOs, including P0.0 ~ P0.1, P1.1 ~ P1.2, P1.4, P1.6, P2.1, P2.4, P2.6, P3.0 ~ P3.1, P3.3 ~ P3.5, and P4.7.
- FU6562L has up to 22 GPIOs, including P0.1, P0.5 ~ P0.7, P1.2 ~ P1.7, P2.1 ~ P2.2, P2.4, P2.6~P2.7, P3.0~P3.1, P3.3~P3.5, P4.5 and P4.7.
- FU6562LA has up to 22 GPIOs, including P0.1, P0.5 ~ P0.7, P1.2 ~ P1.7, P2.1 ~ P2.2, P2.4, P2.6~P2.7, P3.0~P3.1, P3.3~P3.5, P4.5 and P4.7.
- FU6562Q has up to 22 GPIOs, including P0.1, P0.5 ~ P0.7, P1.2 ~ P1.7, P2.1 ~ P2.2, P2.4, P2.6 ~ P2.7, P3.0 ~ P3.1, P3.3 ~ P3.5, P4.5 and P4.7.
- FU6562S has up to 9 GPIOs, including P0.1, P1.2, P1.6, P2.1, P2.4, P3.0 ~ P3.1, P3.4 and P4.7.
- FU6562T has up to 9 GPIOs, including P0.1, P1.2, P1.6, P2.1, P2.4, P3.0 ~ P3.1, P3.4 and P4.7.
- FU6532N has up to 23 GPIOs, including P0.0 ~ P0.1, P0.5 ~ P0.7, P1.1 ~ P1.7, P2.1 ~ P2.2, P2.4 ~ P2.6, P3.0 ~ P3.2, P3.4 ~ P3.5 and P4.7.
- FU6532T has up to 19 GPIOs, including P0.0 ~ P0.1, P0.5 ~ P0.6, P1.0, P1.2 ~ P1.7, P2.1 ~ P2.2, P2.4, P3.0 ~ P3.1 and P3.4 ~ P3.5.
- FU6522L has up to 40 GPIOs, including P0.0 ~ P0.7, P1.0 ~ P1.7, P2.0 ~ P2.7, P3.0 ~ P3.7, P4.1 ~ P4.7 and P5.1.
- FU6522N has up to 24 GPIOs, including P0.0 ~ P0.1, P0.5 ~ P0.7, P1.0 ~ P1.7, P2.0 ~ P2.4, P2.7, P3.0 ~ P3.2,

P3.4 and P4.7.

- FU6522T has up to 20 GPIOs, including P0.0 ~ P0.1, P0.5 ~ P0.6, P1.1 ~ P1.2, P1.4 ~ P1.7, P2.1 ~ P2.2, P2.4, P2.6, P3.0~P3.1, P3.3~P3.4, P4.5 and P4.7.

21.2 IO Operations

Each GPIO port pin has relevant registers to meet different application requirements. For example, P0.0 is mapped to register P0, and P1.0 to register P1. P0_OE and P1_OE registers are configured for digital input and output.

The chip cannot perform external reset in IO port mode.

- The signal frequency in IO port mode must be less than 100kHz.
- P4.7 is a fixed port for input, and works in FICEK mode by default. If you want it to work in IO port mode, deselect FICEK_MOD in the configuration tool.
- The enable bits of pull-up resistors and pull-down resistors are configured to “1”. See 21.3.11 P0_PU (0x4053) ~ 21.3.16 P5_PU (0x4048)
- See 5.3 GPIO Electrical Characteristics for the values of pull-up resistors and pull-down resistors.
- The relevant bits of Px_AN register is configured to “1” to activate analog signal mode. See 0

- P1_AN (0x4050) ~ 21.3.10 P4_AN(0x4047) for port pins and registers. After the port pins are configured to analog mode, all their digital features are disabled and the port state is 0 by reading relevant bits in P1, P2 and P3 registers.
- Pull-up resistors are automatically disabled when the port pins are configured as analog mode.

21.3 IO Registers

21.3.1 P0_OE (0xFC)

Bit	7	6	5	4	3	2	1	0
Name	P0_OE							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P0_OE	P0.7 ~ P0.0 Digital I/O Selection 0: Input 1: Output

21.3.2 P1_OE (0xFD)

Bit	7	6	5	4	3	2	1	0
Name	P1_OE							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P1_OE	P1.7 ~ P1.0 Digital I/O Selection 0: Input 1: Output

21.3.3 P2_OE (0xFE)

Bit	7	6	5	4	3	2	1	0
Name	P27_OE	P26_OE	P25_OE	P24_OE	P23_OE	P22_OE	P21_OE	P20_OE
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P2_OE	P2.7 ~ P2.0 Digital I/O Selection 0: Input 1: Output

21.3.4 P3_OE (0xFF)

Bit	7	6	5	4	3	2	1	0
Name	P3_OE							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P3_OE	P3.7 ~ P3.0 Digital I/O Selection 0: Input 1: Output

21.3.5 P4_OE (0xE9)

Bit	7	6	5	4	3	2	1	0
Name	RSV	P46_OE	P45_OE	P44_OE	P43_OE	P42_OE	P41_OE	P40_OE
Type	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	-	0	0	0	0	0	0	0

Bit	Name	Description
[7]	RSV	Reserved
[6:0]	P4_OE	P4.6 ~ P4.0 Digital I/O Selection 0: Input 1: Output

21.3.6 P5_OE (0xFB)

Bit	7	6	5	4	3	2	1	0
Name	RSV				P53_OE	P52_OE	P51_OE	P50_OE
Type	-	-	-	-	R/W	R/W	R/W	R/W
Reset	-	-	-	-	0	0	0	0

Bit	Name	Description
[7:4]	RSV	Reserved
[3]	P53_OE	P5.3 Digital I/O Selection 0: Input 1: Output
[2]	P52_OE	P5.2 Digital I/O Selection 0: Input 1: Output
[1]	P51_OE	P5.1 Digital I/O Selection 0: Input 1: Output
[0]	P50_OE	P5.0 Digital I/O Selection 0: Input 1: Output

21.3.7 P1_AN (0x4050)

Bit	7	6	5	4	3	2	1	0
Name	P1_AN				HBMOD	HDIO	ODE1	ODE0
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description															
[7:4]	P1_AN	P1.7 ~ P1.4 Analog Mode Enable 0: Disable 1: Enable															
[3]	HBMOD	P1.3 mode configuration, which determines the functional mode of P1.3 in combination with P1_OE[3], as shown in Table 21-1 Table 21-1 P1.3 Mode Setting <table> <tr> <th>HBMOD</th><th>P1_OE[3]</th><th>P1.3 Pin Mode</th></tr> <tr> <td>0</td><td>0</td><td>Digital Input</td></tr> <tr> <td>0</td><td>1</td><td>Digital Output</td></tr> <tr> <td>1</td><td>0</td><td>Analog Mode</td></tr> <tr> <td>1</td><td>1</td><td>Digital enhanced drive output mode. The maximum output current of high-level output can be up to 20mA for Hall bias power supply. The drive mode of low-level output is the same as that of the digital output mode.</td></tr> </table>	HBMOD	P1_OE[3]	P1.3 Pin Mode	0	0	Digital Input	0	1	Digital Output	1	0	Analog Mode	1	1	Digital enhanced drive output mode. The maximum output current of high-level output can be up to 20mA for Hall bias power supply. The drive mode of low-level output is the same as that of the digital output mode.
HBMOD	P1_OE[3]	P1.3 Pin Mode															
0	0	Digital Input															
0	1	Digital Output															
1	0	Analog Mode															
1	1	Digital enhanced drive output mode. The maximum output current of high-level output can be up to 20mA for Hall bias power supply. The drive mode of low-level output is the same as that of the digital output mode.															
[2]	HDIO	IO Driver Capability for PWM Output. It is valid for L_DU, L_DV, L_DW, H_DU, H_DV and H_DW. 0: Normal drive capability 1: High drive capability															
[1]	ODE1	P0.1 Collector Open-Drain Output Enable 0: Disable 1: Enable															
[0]	ODE0	P0.0 Collector Open-Drain Output Enable 0: Disable 1: Enable															

21.3.8 P2_AN (0x4051)

Bit	7	6	5	4	3	2	1	0
Name	P2_AN							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description

[7:0]	P2_AN	P2.7 ~ P2.0 Analog Mode Enable 0: Disable 1: Enable

21.3.9 P3_AN (0x4052)

Bit	7	6	5	4	3	2	1	0
Name	P11_PL	P01_PL	P3_AN					
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	P11_PL	P1.1 Pull-down Resistor Enable 0: Disable 1: Enable  Note The pull-up resistor and pull-down resistor of P1.1 pin cannot be enabled at the same time
[6]	P01_PL	P0.1 Pull-down Resistor Enable 0: Disable 1: Enable  Note The pull-up resistor and pull-down resistor of P0.1 pin cannot be enabled at the same time
[5:0]	P3_AN	P3.5 ~ P3.0 Analog Mode Enable 0: Disable 1: Enable

21.3.10 P4_AN(0x4047)

Bit	7	6	5	4	3	2	1	0
Name	RSV	P46_AN	P45_AN	RSV				
Type	-	R/W	R/W	-	-	-	-	-
Reset	-	0	0	-	-	-	-	-

Bit	Name	Description
[7]	RSV	Reserved
[6]	P46_AN	P4.6 Analog Mode Enable 0: Disable 1: Enable
[5]	P45_AN	P4.5 Analog Mode Enable 0: Disable 1: Enable

[4:0]	RSV	Reserved

21.3.11 P0_PU (0x4053)

Bit	7	6	5	4	3	2	1	0
Name	P0_PU							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P0_PU	P0.7 ~ P0.0 Pull-up Resistor Enable 0: Disable 1: Enable

21.3.12 P1_PU (0x4054)

Bit	7	6	5	4	3	2	1	0
Name	P1_PU							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P1_PU	P1.7 ~ P1.0 Pull-up Resistor Enable 0: Disable 1: Enable

21.3.13 P2_PU (0x4055)

Bit	7	6	5	4	3	2	1	0
Name	P2_PU							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P2_PU	P2.7 ~ P2.0 Pull-up Resistor Enable 0: Disable 1: Enable

21.3.14 P3_PU (0x4056)

Bit	7	6	5	4	3	2	1	0
Name	P3_PU							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P3_PU	P3.7 ~ P3.0 Pull-up Resistor Enable 0: Disable 1: Enable

21.3.15 P4_PU (0x4057)

Bit	7	6	5	4	3	2	1	0
Name	P4_PU							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	P4_PU	P4.7 ~ P4.0 Pull-up Resistor Enable 0: Disable 1: Enable

21.3.16 P5_PU (0x4048)

Bit	7	6	5	4	3	2	1	0
Name	RSV			P47_PL	P53_PU	P52_PU	P51_PU	P50_PU
Type	-	-	-	R/W	R/W	R/W	R/W	R/W
Reset	-	-	-	0	0	0	0	0

Bit	Name	Description
[7:5]	RSV	Reserved
[4]	P47_PL	P4.7 Pull-down Resistor Enable 0: Disable 1: Enable
[3]	P53_PU	P5.3 Pull-up Resistor Enable 0: Disable 1: Enable
[2]	P52_PU	P5.2 Pull-up Resistor Enable 0: Disable 1: Enable
[1]	P51_PU	P5.1 Pull-up Resistor Enable 0: Disable 1: Enable
[0]	P50_PU	P5.0 Pull-up Resistor Enable 0: Disable 1: Enable

21.3.17 PH_SEL (0x404C)

Bit	7	6	5	4	3	2	1	0
Name	SPITMOD	UART1EN	UART2EN	T4SEL	T3SEL	T2SEL	T2SSEL	XOE
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	SPITMOD	MISO port status after SPI slave device completes transmission 0: Output State 1: High-impedance State
[6]	UART1EN	Port multiplexed as RXD, TXD and UART1 enabled 0: Disable 1: P0.5, P0.6 and P0.6 pins multiplexed as TXD, RXD and UART1 enabled
[5]	UART2EN	Port multiplexed as RXD2, TXD2 and UART2 enabled 0: Disable 1: P3.7, P1.2 and P0.0 pins multiplexed as TXD2; P3.6, P4.7 and P0.1 pins multiplexed as RXD2; and UART2 enabled
[4]	T4SEL	Port pins multiplexed as Timer4 or Timer4S 0: Disable 1: P0.1 or P0.0 or P1.2(PH_SEL1[T4CT1] = 1 and PH_SEL1[T4CT0] = 0) multiplexed as Timer4 I/O pins
[3]	T3SEL	Port pins multiplexed as Timer3 or Timer3S 0: Disable 1: P1.1 or P0.1 multiplexed as Timer3 I/O pins
[2]	T2SEL	Port pins multiplexed as Timer2 0: Disable 1: P1.0 pin multiplexed as Timer2 I/O pins
[1]	T2SSEL	Port pins multiplexed as Timer2S 0: Disable 1: P0.7 pin multiplexed as Timer2 I/O pins
[0]	XOE	X-phase Output Enable 1: Output enabled, with P4.1 configured as the X-phase low-side PWM output pin and P4.2 configured as the X-phase high-side PWM output pin 0: Disable

21.3.18 PH_SEL1 (0x404D)

Bit	7	6	5	4	3	2	1	0
Name	UART2CH 1	UART2CH 0	RSV	SPIC0	T4CT1	T4CT0	T3CT1	T3CT0
Type	R/W	R/W	-	R/W	R/W	R/W	R/W	R/W
Reset	0	0	-	0	0	0	0	0

Bit	Name	Description
[7:6]	UART2CH	UART2 Function Switching 00: P3.6 serving as RXD, and P3.7 as TXD (P3.6 is an I/O pin of single-wire mode) 01: P4.7 serving as RXD, and P1.2 serving as TXD (P1.2 is an I/O pin of single-wire mode) 1X: P0.1 serving as RXD, and P0.0 as TXD (P0.1 is an I/O pin in single-wire mode)
[5]	RSV	Reserved
[4]	SPICT0	Debug Function Switching of SPI in Single-wire Mode Configure with PH_SEL2[SPICT1] PH_SEL2[SPICT1]:PH_SEL1[SPICT0] 00: No function switching, with P0.5 serving as SPI debug output X1: Function switching, with P0.0 serving as SPI debug output 10: Function switching, with P3.4 pin serving as SPI debug output
[3:2]	T4CT	Timer4 Function Switching 00: Timer4 I/O pin switched to P0.1 X1: Timer4 I/O pin switched to P0.0 10: Timer4 I/O pin switched to P1.2
[1:0]	T3CT	Timer3 Function Switching 00: Timer3 I/O pin switched to P1.1 X1: Timer3 I/O pin switched to P0.1 10: Timer3 input pin switched to P4.7

21.3.19 PH_SEL2 (0x4049)

Bit	7	6	5	4	3	2	1	0
Name	RSV		ADC_SCYCH[7:4]				RSV	SPICT1
Type	-	-	R/W	R/W	R/W	R/W	-	R/W
Reset	-	-	0	0	1	1	-	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5:2]	ADC_SCYCH[7:4]	See PH_SEL2 (0x4049) in chapter ADC for details
[1]	RSV	Reserved
[0]	SPICT1	Debug Function Switching of SPI in Single-wire Mode Configure with PH_SEL1[SPICT0] PH_SEL2[SPICT1]: PH_SEL1[SPICT0] 00: No function switching, with P0.5 serving as SPI debug output X1: Function switching, with P0.0 serving as SPI debug output 10: Timer3 input pin switched to P4.7

21.3.20 P0 (0x80)

Port output register P0/1/2/3/4/5 supports read and write access. RMW commands are used to access the register value (see Table 21-2 for RMW commands), and other commands are used to access PORT pin.

Bit	7	6	5	4	3	2	1	0
Name	GP07	GP06	GP05	GP04	GP03	GP02	GP01	GP00
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	GP07	GP07 pin
[6]	GP06	GP06 pin
[5]	GP05	GP05 pin
[4]	GP04	GP04 pin
[3]	GP03	GP03 pin
[2]	GP02	GP02 pin
[1]	GP01	GP01 pin
[0]	GP00	GP00 pin

21.3.21 P1 (0x90)

Bit	7	6	5	4	3	2	1	0
Name	GP17	GP16	GP15	GP14	GP13	GP12	GP11	GP10
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	GP17	GP17 pin
[6]	GP16	GP16 pin
[5]	GP15	GP15 pin
[4]	GP14	GP14 pin
[3]	GP13	GP13 pin
[2]	GP12	GP12 pin
[1]	GP11	GP11 pin
[0]	GP10	GP10 pin

21.3.22 P2 (0xA0)

Bit	7	6	5	4	3	2	1	0
Name	GP27	GP26	GP25	GP24	GP23	GP22	GP21	GP20
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	GP27	GP27 pin
[6]	GP26	GP26 pin
[5]	GP25	GP25 pin
[4]	GP24	GP24 pin
[3]	GP23	GP23 pin
[2]	GP22	GP22 pin
[1]	GP21	GP21 pin
[0]	GP20	GP20 pin

21.3.23 P3 (0xB0)

Bit	7	6	5	4	3	2	1	0
Name	GP37	GP36	GP35	GP34	GP33	GP32	GP31	GP30
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	GP37	GP37 pin
[6]	GP36	GP36 pin
[5]	GP35	GP35 pin
[4]	GP34	GP34 pin
[3]	GP33	GP33 pin
[2]	GP32	GP32 pin
[1]	GP31	GP31 pin
[0]	GP30	GP30 pin

21.3.24 P4 (0xB8)

Bit	7	6	5	4	3	2	1	0
Name	GP47	GP46	GP45	GP44	GP43	GP42	GP41	GP40
Type	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	GP47	GP47 pin
[6]	GP46	GP46 pin
[5]	GP45	GP45 pin
[4]	GP44	GP44 pin
[3]	GP43	GP43 pin

[2]	GP42	GP42 pin
[1]	GP41	GP41 pin
[0]	GP40	GP40 pin

21.3.25 P5 (0xC0)

Bit	7	6	5	4	3	2	1	0
Name	RSV				GP53	GP52	GP51	GP50
Type	-	-	-	-	R/W	R/W	R/W	R/W
Reset	-	-	-	-	0	0	0	0

Bit	Name	Description
[7:4]	RSV	Reserved
[3]	GP53	GP53 pin
[2]	GP52	GP52 pin
[1]	GP51	GP51 pin
[0]	GP50	GP50 pin

Table 21-2 RMW Commands

Command	Function Descriptions
ANL	Bitwise logical AND operation
ORL	Bitwise logical OR operation
XRL	Bitwise logical XOR operation
JBC	Jump if the bit is set to “1” and then cleared to “0”
CPL	Bitwise logical converse operation
INC,DEC	+1, -1 logical operation
DJNZ	Jump if the bit is not “0”
MOV Px,y,C	Assign carry bit C to Px,y
CLR Px,y	Px,y is cleared to “0”
SETB Px,y	Px,y is set to “1”

22 ADC

22.1 ADC Introduction

The ADC module is a 12-bit successive approximation register ADC with 16 channels inside. The sampling mode supports sequential sampling (that is, from ADC Channel 0 to ADC channel 15 in sequence) and trigger sampling (including FOC triggered sampling mode and TIMER1 triggered sampling mode). The results of sequential sampling are stored in ADCx_DR ($x = 0 \sim 15$) in a right-aligned or left-second-high-aligned format. The result of triggered sampling is sent to FOC module or TIMER1 module instead of ADCx_DR for motor control. The relevant registers of the FOC module or TIMER1 module are always left-second-high-aligned to store the triggered sample results. Triggered sampling is done automatically by hardware, and sequential sampling is controlled by software. The priority of triggered sampling is higher than that of sequential sampling. If both triggered sampling and sequential sampling are applied at the same time, the triggered sampling is performed first, and ADC automatically stores sequential sampling mode upon completion of triggered sampling.

The clock source of ADC sampling time is at a rate of 12MHz and the sampling time is set by PH_SEL2[5:2], DAC_CR[5:2] and ADC_SCYC. See ADC Electrical Characteristics for sample time and conversion time.

22.2 ADC Functional Block Diagram

Figure 22-1 ADC Multiplexer Block Diagram

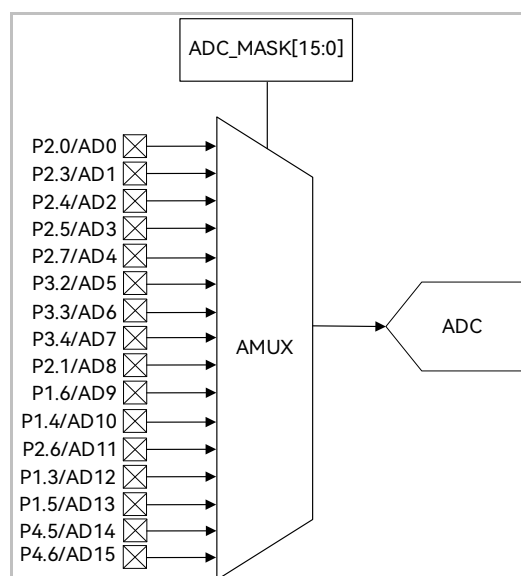
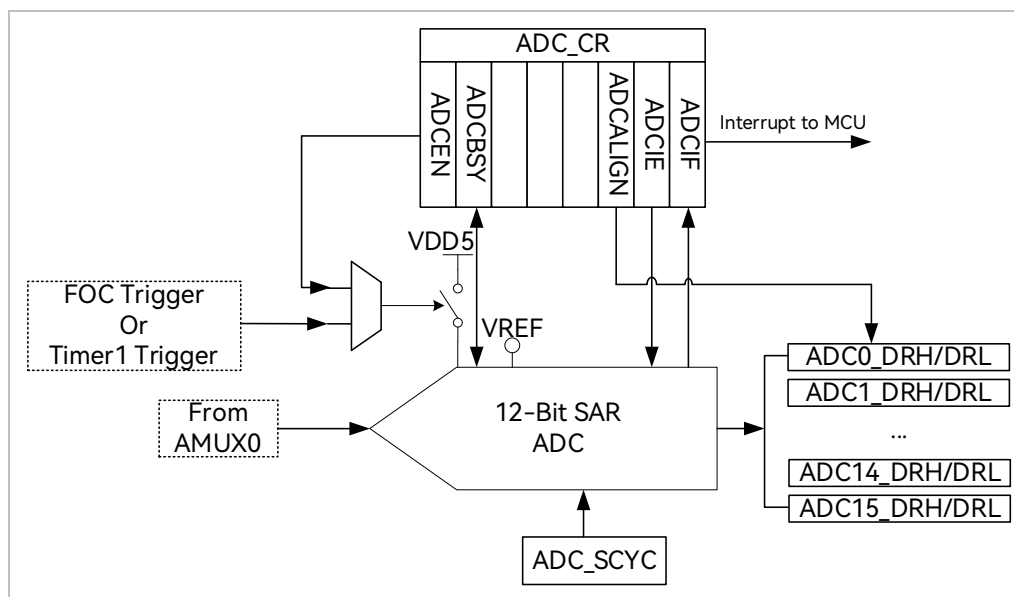


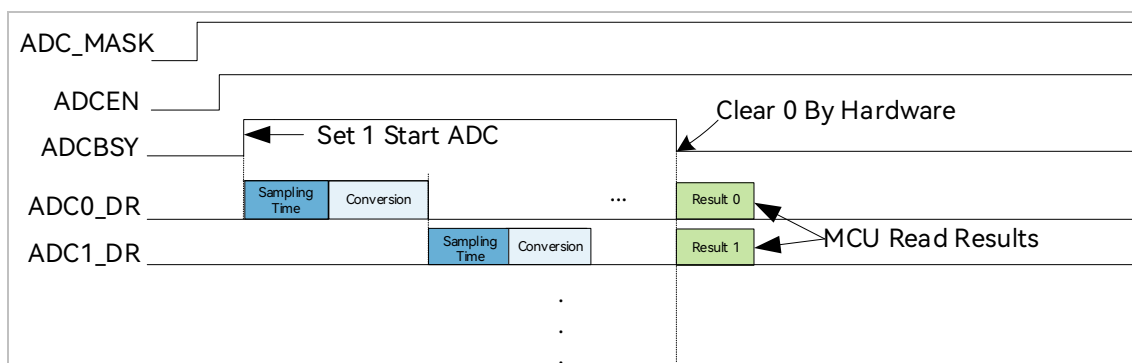
Figure 22-2 ADC Functional Block Diagram



22.3 ADC Operations

22.3.1 Sequential Sampling Mode

Figure 22-3 ADC Sequential Sampling Mode



ADC operations:

1. Set the appropriate ADC VREF;
2. Configure ADC_MASK to enable the corresponding channel required to sample;
3. Configure ADC_SCYC (minimum value is 3) to select the sampling period of each channel;
4. Configure ADC_CR[ADCEN] = 1 to enable ADC;
5. Configure ADC_CR[ADCB SY] = 1 to start ADC;

6. When `ADC_CR[ADCBSY] = 0`, ADC results are read by `ADCx_DR`.



Note

The ADC conversion sequence is from low to high based on the enabled channel (i.e., when channel 2/3/4 is enabled, the signal is sampled in order of 2/3/4, and then a single conversion result is read after confirming `ADC_CR[ADCBSY] = 0`)

22.3.2 Triggered Sampling Mode

When FOC module is enabled, ADC channel 0/1/2/14 can be used to FOC trigger sampling. Configuring `FOC_CR0[UCSEL]` to select channel 2 or channel 14 for bus voltage trigger sampling. In single-shunt current sampling mode, channel 4 is used for itrip sampling. In dual-shunt current sampling mode, channel 0 is used for ia sampling and channel 1 for ib sampling. In triple-shunt current sampling mode, channel 0 is used for ia sampling, channel 1 for ib sampling, and channel 4 for ic sampling.

When Timer1 is enabled, channel 4 is used for bus current sampling. `TIM1_CR3[T1TIS]` is configured to select the input source of position detection as ADC. When `CMP0_CR4[CMP0_FS] = 0`, channel 10 is used for U-phase voltage sampling, channel 9 for V-phase voltage sampling, and channel 8 for W-phase voltage sampling. When `CMP0_CR4[CMP0_FS] = 1`, channel 10 is used for U-phase voltage sampling, channel 12 for V-phase voltage sampling, and channel 13 for W-phase voltage sampling.

22.3.3 Output Data Format

Registers `ADCx_DRH` and `ADCx_DRL` contain the high-order bits and the low-order bits of ADC sampling results. Data can be right-aligned or left-second-high-aligned by configuring `ADC_CR[ADCALIGN]`. When input voltage ranges from 0 to `VREF`, the relation between the input voltage and result data is shown in Table 22-1. The bits, which are not used in `ADCx_DRH` and `ADCx_DRL`, are set to “0”.

Table 22-1 Relation between Input Voltage and Result Data

Input Voltage	Right-aligned	Left-second-high-aligned
0	0x0000	0x0000
<code>VREF/2</code>	0x0800	0x4000
<code>VREF</code>	0x0FFF	0x7FF8

22.4 ADC Registers

22.4.1 ADC_CR (0x4039)

Bit	7	6	5	4	3	2	1	0
Name	ADCEN	ADCBSY	RSV	ADCTM		ADCALIGN	ADCIE	ADCIF
Type	R/W	R/W1	-	R/W	R/W	R/W	R/W	R/W0
Reset	0	0	-	0	0	0	0	0

Bit	Name	Description
[7]	ADCEN	ADC Enable 0: Disable 1: Enable
[6]	ADCBSY	ADC Start & ADC Busy Flag Read: 0: ADC Idle 1: ADC Busy Write: 0: No effect 1: ADC conversion starts  Note Writing “1” to this bit has no effect when ADC_MASK = 0
[5]	RSV	Reserved
[4:3]	ADCTM	DRV Trigger ADC Startup Mode 00: Not triggered 01: Rising edge triggered 10: Falling edge triggered 11: Dual-edge triggered
[2]	ADCALIGN	ADC Data Format Selection 0: ADC output is right-aligned, and ADC result = ADCx_DR[11:0] 1: ADC output is left-second-high-aligned, and ADC result = ADCx_DR[14:3]  Note The results of triggered sampling mode are always left-second-high-aligned
[1]	ADCIE	ADC Interrupt Enable (excluding triggered sampling mode interrupt) 0: Disable 1: Enable
[0]	ADCIF	ADC Interrupt Flag This bit is set to “1” by hardware when ADC conversion is completed. Read:

		0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0". 1: No effect

22.4.2 ADC_MASK (0x4036, 0x4037)

ADC_MASKH(0x4036)								
Bit	15	14	13	12	11	10	9	8
Name	CH15EN	CH14EN	CH13EN	CH12EN	CH11EN	CH10EN	CH9EN	CH8EN
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
ADC_MASKL(0x4037)								
Bit	7	6	5	4	3	2	1	0
Name	CH7EN	CH6EN	CH5EN	CH4EN	CH3EN	CH2EN	CH1EN	CH0EN
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15]	CH15EN	ADC Channel 15 Enable
[14]	CH14EN	ADC Channel 14 Enable
[13]	CH13EN	ADC Channel 13 Enable
[12]	CH12EN	ADC Channel 12 Enable
[11]	CH11EN	ADC Channel 11 Enable
[10]	CH10EN	ADC Channel 10 Enable
[9]	CH9EN	ADC Channel 9 Enable
[8]	CH8EN	ADC Channel 8 Enable
[7]	CH7EN	ADC Channel 7 Enable
[6]	CH6EN	ADC Channel 6 Enable
[5]	CH5EN	ADC Channel 5 Enable
[4]	CH4EN	ADC Channel 4 Enable
[3]	CH3EN	ADC Channel 3 Enable
[2]	CH2EN	ADC Channel 2 Enable
[1]	CH1EN	ADC Channel 1 Enable
[0]	CH0EN	ADC Channel 0 Enable



Note

In triggered sampling mode, it is not required to configure ADC_MASK

22.4.3 PH_SEL2 (0x4049)

Bit	7	6	5	4	3	2	1	0
Name	RSV		ADC_SCYCH[7:4]				RSV	SPICT1
Type	-	-	R/W	R/W	R/W	R/W	-	R/W
Reset	-	-	0	0	0	0	-	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5:2]	ADC_SCYCH[7:4]	ADC sampling cycle for ADC Channel 2 ADC_SCYCH[7] = 0: The sampling cycle is ADC_SCYCH[6:4] ADC clock cycles. ADC_SCYCH[7] = 1: The sampling cycle is (ADC_SCYCH[6:4]*8 + 7) ADC clock cycles.
[1]	RSV	Reserved
[0]	SPICT1	See PH_SEL2 (0x4049) in chapter IO

22.4.4 DAC_CR (0x4035)

Bit	7	6	5	4	3	2	1	0
Name	DAC0_1EN	DACMOD	ADC_SCYCH[3:0]				RSV	
Type	R/W	R/W	R/W	R/W	R/W	R/W	-	-
Reset	0	0	0	0	1	1	-	-

Bit	Name	Description
[7]	DAC0_1EN	See DAC_CR (0x4035) in chapter ADC
[6]	DACMOD	见 DAC 章节 DAC_CR (0x4035)说明
[5:2]	ADC_SCYCH[3:0]	ADC Sampling Cycle for ADC Channel 8~13 ADC_SCYCH[3] = 0: The sampling cycle is ADC_SCYCH[2:0] ADC clock cycles. ADC_SCYCH[3] = 1: The sampling cycle is (ADC_SCYCH[2:0]*8 + 7) ADC clock cycles.
[1:0]	RSV	Reserved

22.4.5 ADC_SCYC (0x4038)

Bit	7	6	5	4	3	2	1	0
Name	ADC_SCYC[7:4]				ADC_SCYC[3:0]			
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	1	1	0	0	1	1

Bit	Name	Description
[7:4]	ADC_SCYC[7:4]	ADC Sampling Cycle for ADC Channel 5 ~ 7, 14, and 15 ADC_SCYC[7] = 0: The sampling cycle is ADC_SCYC[6:4] ADC clock cycles.

		ADC_SCYC[7] = 1: The sampling cycle is (ADC_SCYC[6:4]*8 + 7) ADC clock cycles.
[3:0]	ADC_SCYC[3:0]	ADC Sampling Cycle for ADC Channel 0, 1, 3 and 4 ADC_SCYC[3] = 0: The sampling cycle is ADC_SCYC[2:0] ADC clock cycles. ADC_SCYC[3] = 1: The sampling cycle is (ADC_SCYC[2:0]*8 + 7) ADC clock cycles.

22.4.6 ADC0_DR (0x0FD8, 0x0FD9)

ADC0_DRH(0x0FD8)								
Bit	15	14	13	12	11	10	9	8
Name	ADC0_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC0_DRL(0x0FD9)								
Bit	7	6	5	4	3	2	1	0
Name	ADC0_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC0_DR	The conversion results of ADC channel 0 upon completion of ADC conversion in the Sequential Sampling Mode The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.7 ADC1_DR (0x0FDA, 0x0FDB)

ADC1_DRH(0x0FDA)								
Bit	15	14	13	12	11	10	9	8
Name	ADC1_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC1_DRL(0x0FDB)								
Bit	7	6	5	4	3	2	1	0
Name	ADC1_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description

[15:0]	ADC1_DR	The conversion results of ADC channel 1 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.8 ADC2_DR (0x0FDC, 0x0FDD)

ADC2_DRH(0x0FDC)								
Bit	15	14	13	12	11	10	9	8
Name	ADC2_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC2_DRL(0x0FDD)								
Bit	7	6	5	4	3	2	1	0
Name	ADC2_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC2_DR	The conversion results of ADC channel 2 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.9 ADC3_DR (0x0FDE, 0x0FDF)

ADC3_DRH(0x0FDE)								
Bit	15	14	13	12	11	10	9	8
Name	ADC3_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC3_DRL(0x0FDF)								
Bit	7	6	5	4	3	2	1	0
Name	ADC3_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description

[15:0]

ADC3_DR

The conversion results of ADC channel 3 upon completion of ADC conversion in the Sequential Sampling Mode.
The data is aligned according to ADC_CR[ADCALIGN].



Note

ADC results of Triggered Sampling Mode are not updated to this register

22.4.10 ADC4_DR (0x0FE0, 0x0FE1)

ADC4_DRH(0x0FE0)

Bit	15	14	13	12	11	10	9	8
Name	ADC4_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

ADC4_DRL(0x0FE1)

Bit	7	6	5	4	3	2	1	0
Name	ADC4_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC4_DR	The conversion results of ADC channel 4 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.11 ADC5_DR (0x0FE2, 0x0FE3)

ADC5_DRH(0x0FE2)

Bit	15	14	13	12	11	10	9	8
Name	ADC5_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

ADC5_DRL(0x0FE3)

Bit	7	6	5	4	3	2	1	0
Name	ADC5_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description

[15:0]

ADC5_DR

The conversion results of ADC channel 5 upon completion of ADC conversion in the Sequential Sampling Mode.
The data is aligned according to ADC_CR[ADCALIGN].



Note

ADC results of Triggered Sampling Mode are not updated to this register

22.4.12 ADC6_DR (0x0FE4, 0x0FE5)

ADC6_DRH(0x0FE4)

Bit	15	14	13	12	11	10	9	8
Name	ADC6_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

ADC6_DRL(0x0FE5)

Bit	7	6	5	4	3	2	1	0
Name	ADC6_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC6_DR	The conversion results of ADC channel 6 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.13 ADC7_DR (0x0FE6, 0x0FE7)

ADC7_DRH(0x0FE6)

Bit	15	14	13	12	11	10	9	8
Name	ADC7_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

ADC7_DRL(0x0FE7)

Bit	7	6	5	4	3	2	1	0
Name	ADC7_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC7_DR	The conversion results of ADC channel 7 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.14 ADC8_DR (0x0FE8, 0x0FE9)

ADC8_DRH(0x0FE8)								
Bit	15	14	13	12	11	10	9	8
Name	ADC8_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC8_DRL(0x0FE9)								
Bit	7	6	5	4	3	2	1	0
Name	ADC8_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC8_DR	The conversion results of ADC channel 8 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.15 ADC9_DR (0x0FEA, 0x0FEB)

ADC9_DRH(0x0FEA)								
Bit	15	14	13	12	11	10	9	8
Name	ADC9_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC9_DRL(0x0FEB)								
Bit	7	6	5	4	3	2	1	0
Name	ADC9_DR[7:0]							

Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC9_DR	The conversion results of ADC channel 9 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.16 ADC10_DR (0x0FEC, 0x0FED)

ADC10_DRH(0x0FEC)								
Bit	15	14	13	12	11	10	9	8
Name	ADC10_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC10_DRL(0x0FED)								
Bit	7	6	5	4	3	2	1	0
Name	ADC10_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC10_DR	The conversion results of ADC channel 10 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.17 ADC11_DR (0x0FEE, 0x0FEF)

ADC11_DRH(0x0FEE)								
Bit	15	14	13	12	11	10	9	8
Name	ADC11_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC11_DRL(0x0FEF)								
Bit	7	6	5	4	3	2	1	0
Name	ADC11_DR[7:0]							

Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC11_DR	The conversion results of ADC channel 11 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.18 ADC12_DR (0x0FF0, 0x0FF1)

ADC12_DRH(0x0FF0)								
Bit	15	14	13	12	11	10	9	8
Name	ADC12_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC12_DRL(0x0FF1)								
Bit	7	6	5	4	3	2	1	0
Name	ADC12_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC12_DR	The conversion results of ADC channel 12 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.19 ADC13_DR (0x0FF2, 0x0FF3)

ADC13_DRH(0x0FF2)								
Bit	15	14	13	12	11	10	9	8
Name	ADC13_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC13_DRL(0x0FF3)								
Bit	7	6	5	4	3	2	1	0
Name	ADC13_DR[7:0]							

Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC13_DR	The conversion results of ADC channel 13 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.20 ADC14_DR (0x0FF4, 0x0FF5)

ADC14_DRH(0x0FF4)								
Bit	15	14	13	12	11	10	9	8
Name	ADC14_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC14_DRL(0x0FF5)								
Bit	7	6	5	4	3	2	1	0
Name	ADC14_DR[7:0]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC14_DR	The conversion results of ADC channel 14 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

22.4.21 ADC15_DR (0x0FF6, 0x0FF7)

ADC15_DRH(0x0FF6)								
Bit	15	14	13	12	11	10	9	8
Name	ADC15_DR[15:8]							
Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0
ADC15_DRL(0x0FF7)								
Bit	7	6	5	4	3	2	1	0
Name	ADC15_DR[7:0]							

Type	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:0]	ADC15_DR	The conversion results of ADC channel 15 upon completion of ADC conversion in the Sequential Sampling Mode. The data is aligned according to ADC_CR[ADCALIGN].  Note ADC results of Triggered Sampling Mode are not updated to this register

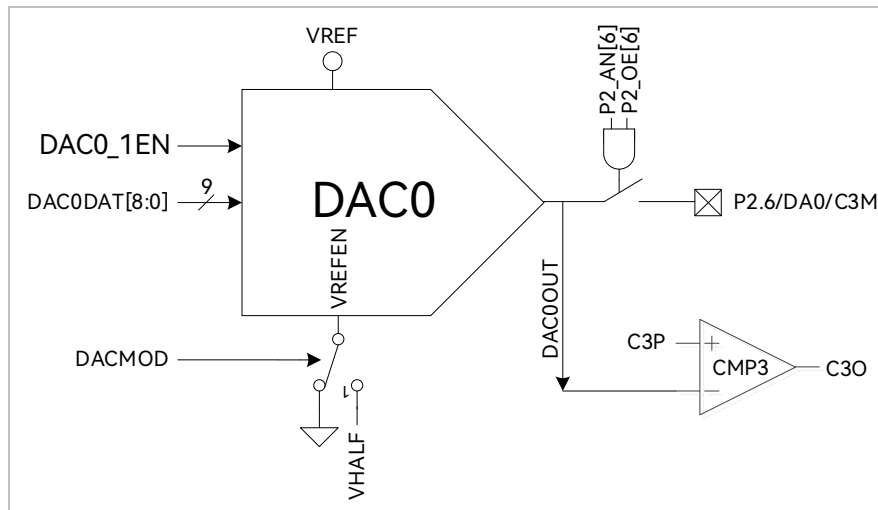
23 DAC

23.1 DAC Introduction

The chip integrates two DAC modules, where DAC0 is a 9-bit digital-to-analog converter, DAC1 is a 6-bit digital-to-analog converter.

23.2 DAC0 Functional Block Diagram

Figure 23-1 DAC0 Functional Block Diagram



As shown in Figure 23-1, DAC0 converts 9-bit digital data into analog voltage and sends the voltage to CMP3 negative input for bus over-current protection. P2.6 pin can be configured as the analog output.



Note

DAC0 output has no current drive capability and can only carry capacitive load. To carry resistive load, operational amplifiers are used to follow the voltage output

DAC0 operations are as follows:

1. Configure $P2\_AN[6] = 1$ and $P2\_OE[6] = 1$, and DAC0 output to P2.6 pin;
2. Configure $VREF\_VHALF\_CR[VREFEN] = 1$ and $DAC\_CR[DAC0\_1EN] = 1$, and VREF is used as DAC0 reference voltage;

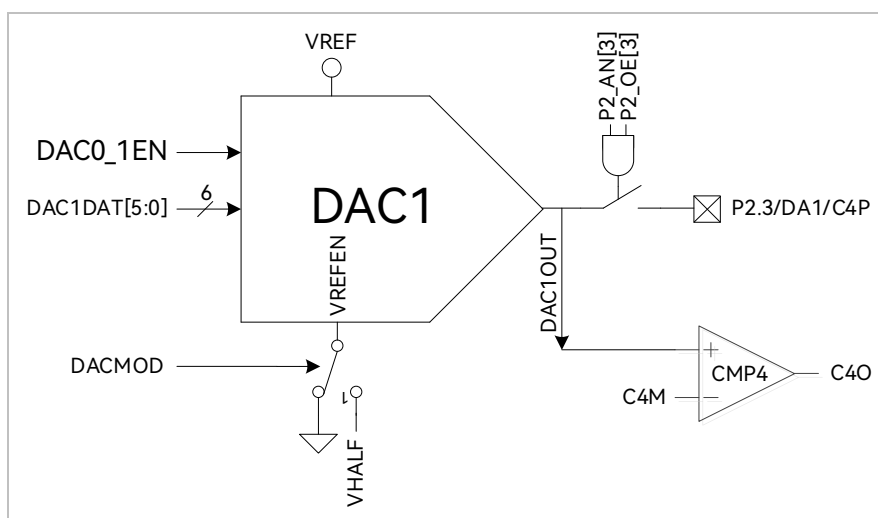
3. The range of output voltage is set by DAC_CR[DACMOD]. When DAC_CR[DACMOD] = 0, full-voltage output mode is active, and the range of output voltage is 0~VREF. When DAC_CR[DACMOD] = 1, half-voltage output mode is active, the range of output voltage is VHALF~VREF. Output voltage of DAC0DAT under different configuration is shown in Table 23-1.

Table 23-1 Output Voltage of DAC0 under Different Configurations

DAC0DAT[8:0]	DAC Output Voltage (DAC_CR[DACMOD] = 0)	DAC Output Voltage (DAC_CR[DACMOD] = 1)
0x000	0	VHALF
0x100	VREF/2	(VREF - VHALF)/2 + VHALF
0x1FF	VREF*511/512	(VREF - VHALF)*511/512 + VHALF

23.3 DAC1 Functional Block Diagram

Figure 23-2 DAC1 Functional Block Diagram



As shown in Figure 23-2, DAC1 converts 6-bit digital data into analog voltage, and sends the voltage to CMP4 positive input for cycle-by-cycle current limiting. P2.3 can be configured as the output pin.



Note

DAC1 output has no current drive capability and can only carry capacitive load. To carry resistive load, operational amplifiers are used to follow the voltage output

DAC1 operations are as follows:

Configure P2_AN[3] = 1 and P2_OE[3] = 1, and DAC1 output to P2.3 pin;

Configure $VREF\_VHALF\_CR[VREFEN] = 1$ and $DAC\_CR[DAC0\_1EN] = 1$, and $VREF$ is used as DAC1 reference voltage;

1. The range of output voltage is set by $DAC\_CR[DACMOD]$. When $DAC\_CR[DACMOD] = 0$, full-voltage output mode is active, and the range of output voltage is $0 \sim VREF$. When $DAC\_CR[DACMOD] = 1$, half-voltage output mode is active, and the range of output voltage is $VHALF \sim VREF$. Output voltage of DAC1 under different configurations is shown in Table 23-1.

Table 23-2 Output Voltage of DAC1 under Different Configurations

DAC1DAT[5:0]	DAC Output Voltage ($DAC\_CR[DACMOD] = 0$)	DAC Output Voltage ($DAC\_CR[DACMOD] = 1$)
0x00	0	VHALF
0x20	$VREF/2$	$(VREF - VHALF)/2 + VHALF$
0x3F	$VREF * 63/64$	$(VREF - VHALF) * 63/64 + VHALF$

23.4 DAC Registers

23.4.1 DAC_CR (0x4035)

Bit	7	6	5	4	3	2	1	0
Name	DAC0_1EN	DACMOD	ADC_SCYCH[3:0]				RSV	
Type	R/W	R/W	R/W	R/W	R/W	R/W	-	-
Reset	0	0	0	0	1	1	-	-

Bit	Name	Description
[7]	DAC0_1EN	DAC0, DAC1 Enable 0: Disable 1: Enable
[6]	DACMOD	DAC Mode Setting 0: Full-voltage Output Mode 1: Half-voltage Output Mode
[5:2]	ADC_SCYCH[3:0]	See DAC_CR (0x4035) in chapter ADC
[1:0]	RSV	Reserved

23.4.2 DAC0_DR (0x404B)

Bit	7	6	5	4	3	2	1	0
Name	DAC0DAT[8:1]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	DAC0DAT[8:1]	8 high-order bits input of DAC0 controller

23.4.3 DAC1_DR (0x404A)

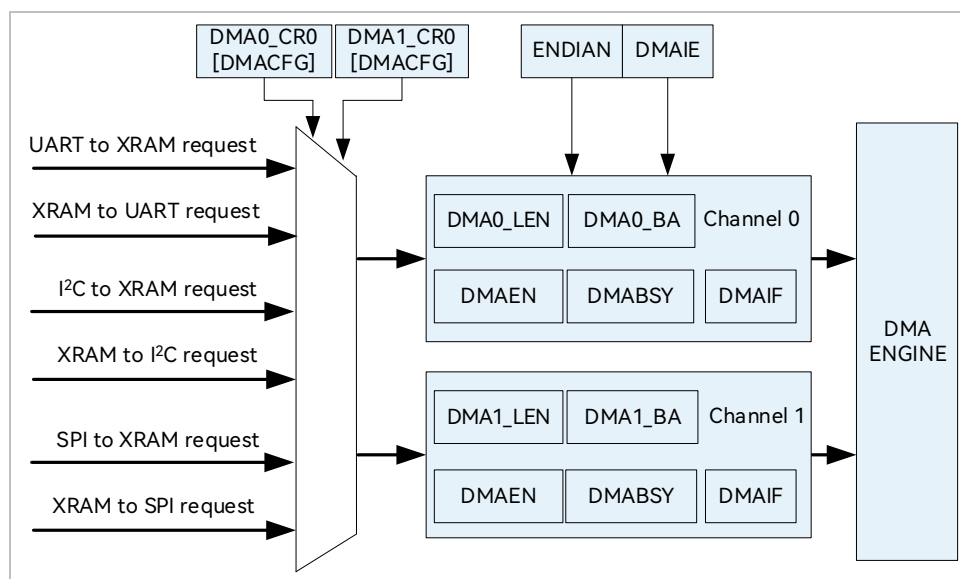
Bit	7	6	5	4	3	2	1	0
Name	DAC0_DR_0	RSV	DAC1DAT					
Type	R/W	-	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	-	0	0	0	0	0	0

Bit	Name	Description
[7]	DAC0_DR_0	LSB input of DAC0 controller
[6]	RSV	Reserved
[5:0]	DAC1DAT	6-bit data input of DAC1 controller

24 DMA

24.1 DMA Instructions

Figure 24-1 DMA Functional Block Diagram



The DMA module is a dual-channel DMA controller, which performs direct data transfer between peripherals (SPI, UART, I2C) and XRAM (IRAM data invalid). DMA accessing to XRAM does not interfere with the normal CPU read/write operation to XRAM. The length of the transferred data and the start address of XRAM access is configurable. Data transfer mode is configurable and interrupt can be enabled.

DMA instructions are as follows:

1. Configure and enable the peripheral, and set input and output channels taken over by DMA by `DMAx_CR0[DMACFG]`;
2. Configure DMA interrupt enable, transfer order, transfer length and XRAM start address. Write “1” to `DMAx_CR0[DMAEN]` and `DMAx_CR0[DMABSY]` to start DMA;
3. After data transfer, the interrupt flag bit `DMAx_CR0[DMAIF]` is set to “1” by hardware and it is cleared to “0” by software;
4. Set `DMAx_CR0[DMABSY]` to “1” to start DMA again.

24.2 DMA Registers

24.2.1 DMA0_CR0 (0x403A)

Bit	7	6	5	4	3	2	1	0
Name	DMAEN	DMABSY	DMACFG			DMAIE	ENDIAN	DMAIF
Type	R/W	R/W1	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	DMAEN	DMA Channel 0 Enable 0: Disable 1: Enable
[6]	DMABSY	DMA Channel 0 Start/Busy Flag Read: 0: Channel 0 Idle 1: Channel 0 Busy Write: 0: No effect 1: Channel 0 starts for data transfer
[5:3]	DMACFG	DMA Channel 0 Peripherals and Transfer Direction Selection 000: From UART1 to XRAM 001: From XRAM to UART1 010: From I2C to XRAM 011: From XRAM to I2C 100: From SPI to XRAM 101: From XRAM to SPI 110: From UART2 to XRAM 111: From XRAM to UART2
[2]	DMAIE	DMA Channel 0 Interrupt Enable 0: Disable 1: Enable
[1]	ENDIAN	DMA Data Transfer Sequence 0: High bytes are received or sent first 1: Low bytes are received or sent first  Note This bit is set for 16-bit data mode, and shall be configured to “0” for 8-bit data mode. It cannot be configured when Channel 0 or 1 is busy
[0]	DMAIF	DMA Channel 0 Transfer Interrupt Event Flag Bit Read: 0: No Interrupt Pending

		1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: The interrupt event is generated.

24.2.2 DMA1_CR0 (0x403B)

Bit	7	6	5	4	3	2	1	0
Name	DMAEN	DMABSY	DMACFG			DBGSW	DBGEN	DMAIF
Type	R/W	R/W1	R/W	R/W	R/W	R/W	R/W	R/W0
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	DMAEN	DMA Channel 1 Enable 0: Disable 1: Enable
[6]	DMABSY	DMA Channel 1 Start/Busy Read: 0: Channel 1 Idle 1: Channel 1 Busy Write: 0: No effect 1: Channel 1 starts for data transfer
[5:3]	DMACFG	DMA Channel 1 Peripherals and Direction Selection 000: From UART1 to XRAM 001: From XRAM to UART1 010: From I2C to XRAM 011: From XRAM to I2C 100: From SPI to XRAM 101: From XRAM to SPI 110: From UART2 to XRAM 111: From XRAM to UART2  Note It cannot be configured when Channel 1 is busy
[2]	DBGSW	Sector Targeted in Debug Mode 0: XSFR as the Debug area 1: XRAM as the Debug area
[1]	DBGEN	Debug Mode Enable DMA works in Debug mode when DMA1_CR0[DMACFG] is set to “101” and DMA1_CR0[DBGEN] to “1”. After SPI is enabled, DMA automatically sends relevant data in the sector defined by DMA1_CR0[DBGSW] via MOSI. DMA1_BA/DMA1_LEN defines the start address and range of the relevant data.

		0: Disable 1: Enable  Note DMA Channel 1 Interrupt is automatically disabled in Debug mode
[0]	DMAIF	DMA Channel 1 Interrupt Event Flag Bit Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0”. 1: The interrupt event is generated.  Note DMA1_CR0[2:1] = 10 when DMA Channel 1 Interrupt is enabled

24.2.3 DMA0_LEN (0x403C)

Bit	7	6	5	4	3	2	1	0
Name	RSV		DMA0_LEN					
Type	-	-	R/W	R/W	R/W	R/W	R/W	R/W
Reset	-	-	0	0	0	0	0	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5:0]	DMA0_LEN	Transfer Length of DMA Channel 0 Read: The number of the byte that is currently transferred by DMA Channel 0 (0 denotes the first byte) Write: XRAM data transfer length of DMA Channel 0  Note It cannot be configured when Channel 0 is busy. When DMA0_CR0[ENDIAN] = 1 (low bytes are received or transmitted first), it is recommended that DMA0_LEN be set to an odd number

24.2.4 DMA0_BA (0x403E, 0x403F)

DMA0_BAH(0x403E)								
Bit	15	14	13	12	11	10	9	8
Name	RSV				DMA0_BA[11:8]			
Type	-	-	-	-	R/W	R/W	R/W	R/W
Reset	-	-	-	-	0	0	0	0

DMA0_BAL(0x403F)								
Bit	7	6	5	4	3	2	1	0
Name	DMA0_BA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:12]	RSV	Reserved
[11:0]	DMA0_BA	Start address of data transfer by DMA Channel 0 Start address of XRAM data transfer by DMA Channel 0 It cannot be configured when Channel 0 is busy.  Note XRAM address space for data transfer by Channel 0: DMA0_BA[11:0] ~ (DMA0_BA[11:0] + DMA0_LEN[5:0])

24.2.5 DMA1_LEN (0x403D)

Bit	7	6	5	4	3	2	1	0
Name	RSV		DMA1_LEN					
Type	-	-	R/W	R/W	R/W	R/W	R/W	R/W
Reset	-	-	0	0	0	0	0	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5:0]	DMA1_LEN	Transfer length of DMA Channel 1 Read: The number of the bytes that is currently transferred by DMA Channel 1 (0 denotes the first byte) Write: XRAM data transfer length of DMA Channel 1  Note It cannot be configured when Channel 1 is busy. When DMA0_CR0[ENDIAN] = 1 (low bytes are received or transmitted first), it is recommended that DMA1_LEN be set to an odd number

24.2.6 DMA1_BA (0x4040, 0x4041)

DMA1_BAH(0x4040)								
Bit	15	14	13	12	11	10	9	8
Name	RSV				DMA1_BA[11:8]			

Type	-	-	-	-	R/W	R/W	R/W	R/W
Reset	-	-	-	-	0	0	0	0
DMA1_BAL(0x4041)								
Bit	7	6	5	4	3	2	1	0
Name	DMA1_BA[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[15:12]	RSV	Reserved
[11:0]	DMA1_BA	Start address of data transfer by DMA Channel 1 Start address of XRAM data transfer by DMA Channel 1 It cannot be configured when Channel 1 is busy.  Note XRAM address space for data transfer by Channel 1: DMA1_BA[11:0] ~ (DMA1_BA[11:0] + DMA1_LEN[5:0])



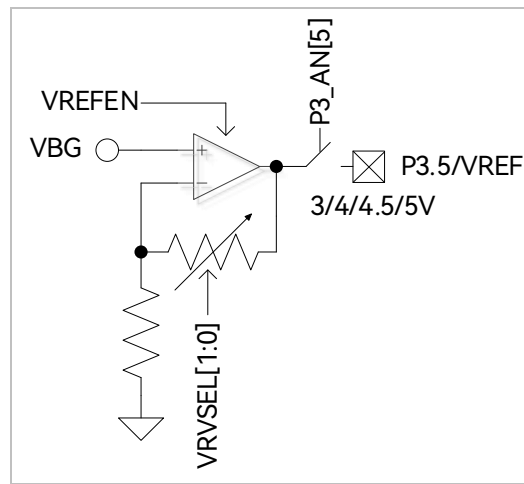
Note

When I2C is selected as DMA channel peripherals (including from I2C to XRAM and from XRAM to I2C) , START + Address interrupt of I2C communication still requires to be cleared to “0” by MCU software. In I2C slave mode, if STOP is received, I2C_SR[I2CSTP] = 0 is configured to clear I2C interrupt and restart the DMA transfer.

25 VREF

25.1 VREF Instructions

Figure 25-1 I/O Pins of VREF Module



The input and output ports of the VREF module are shown in Figure 25-1. VREF is the voltage reference generation block that provides internal voltage reference to ADC and DAC modules. VBG is the voltage supplied by the chip internally.

VREF is enabled when VREF_VHALF_CR[VREFEN] is set to “1”. The output voltage is selected by configuring VREF_VHALF_CR[VRVSEL]. When P3_AN[5] = 1, VREF is output to P3.5 pin.

25.2 VREF Registers

25.2.1 VREF_VHALF_CR (0x404F)

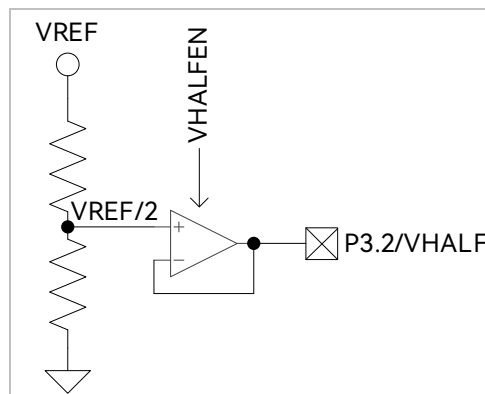
Bit	7	6	5	4	3	2	1	0
Name	VRVSEL		RSV	VREFEN	RSV	VHALFSEL		VHALFEN
Type	R/W	R/W	-	R/W	-	R/W	R/W	R/W
Reset	0	0	-	0	-	1	1	0

Bit	Name	Description
[7:6]	VRVSEL	VREF Module Output Voltage Selection 00: 4.5V 01: 5V 10: 3V 11: 4V
[5]	RSV	Reserved
[4]	VREFEN	VREF Module Enable 0: Disable. P3_AN[5] is set to “1”, and external VREF is input from P3.5 pin 1: Enable. P3_AN[5] is set to “1”, and internal VREF is output to P3.5 pin. R + C is connected to VSS in series externally, with R = 33Ω, C = 1μF ~ 4.7μF.
[3]	RSV	Reserved
[2:1]	VHALFSEL	Reserved
[0]	VHALFEN	VHALF Operating Voltage Selection (VREF Coefficient) 00: 1/8 01: 1/4 10: 25/64 11: 1/2 (Default)

26 VHALF

26.1 VHALF Instructions

Figure 26-1 I/O Pins of VHALF Module



The input and output ports of VHALF module are shown in Figure 26-1. This module generates the voltage reference. Its voltage value is controlled by register VREF_CR[VHALFSEL], as detailed: 00: VREF/8; 01: VREF/4; 10: VREF*25/64; 11: VREF/2 (Default)

VHALF is enabled when VREF_VHALF_CR[VHALFEN] is set to “1”, and the voltage is output to P3.2. A 1μF external capacitor is added.

26.2 VHALF Registers

See VREF_VHALF_CR (0x404F) for details.

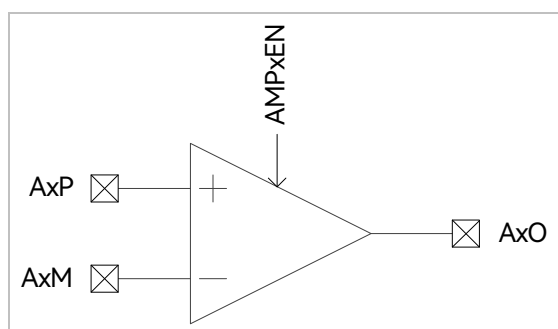
27 Operational Amplifier

27.1 Operational Amplifier Introduction

The chip integrates four high-speed independent operational amplifiers, AMP0, AMP1, AMP2 and AMP3. Each operational amplifier has a separate enable bit, and can be configured as PGA.

Each OA operates in two modes: normal mode and PGA differential input mode.

Figure 27-1 Schematic Diagram of Operational Amplifier Module

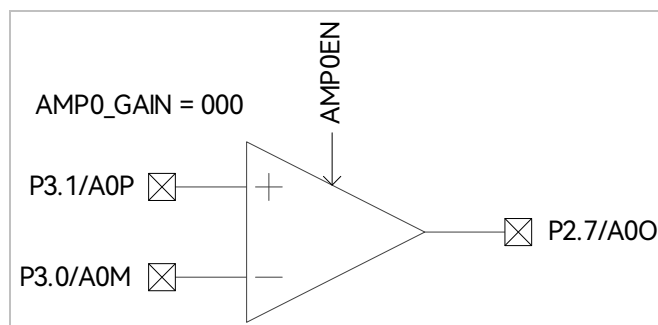


27.2 Operational Amplifier Instructions

27.2.1 Bus Current Sampling Operational Amplifier (AMP0)

27.2.1.1 AMP0 Normal Mode

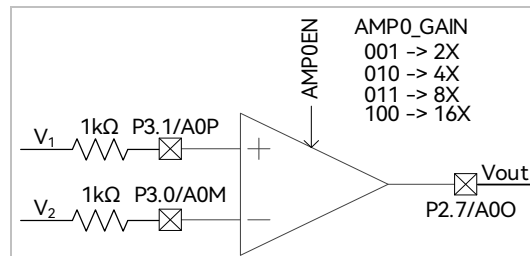
Figure 27-2 Bus Current AMP0



The I/O pins of AMP0 are shown in Figure 27-2. AMP0 is enabled when $\text{AMP\_CR0}[\text{AMP0EN}] = 1$, and P2.7, P3.0 and P3.1 are automatically configured to analog signal mode by the hardware.

27.2.1.2 AMP0 PGA Differential Input Mode

Figure 27-3 AMP0 Operating in PGA Differential Input Mode



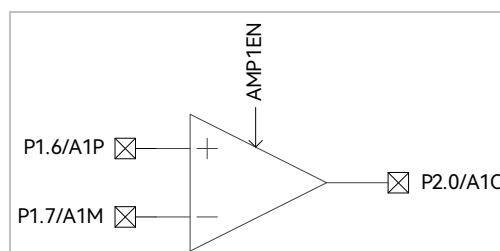
As shown in Figure 27-3, positive and negative inputs of AMP0 are connected with a 1kΩ resistor in the external circuit respectively.

When PGA differential Input Mode is selected for AMP0, the amplification gain is set by AMP_CR1[AMP0_GAIN], and AMP0 is enabled when AMP_CR0[AMP0EN] = 1. The relation between output and input of operational amplifier: $V_{out} = V_{HALF} + (V_1 - V_2) \cdot AMP0\_GAIN$.

27.2.2 Phase Current Operational Amplifier (AMP1/AMP2)

27.2.2.1 AMP1 Normal Mode

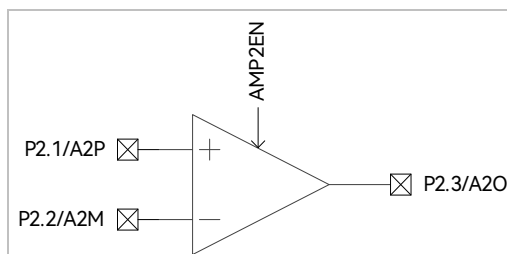
Figure 27-4 AMP1 I/O Pins



The I/O pins of AMP1 are shown in Figure 27-4. AMP1 is enabled when AMP_CR0[AMP1EN] = 1. P1.6, P1.7 and P2.0 pins are automatically configured to analog signal mode by the hardware. P1_AN[7:6] is set to “11” and P2_AN[0] to “1”.

27.2.2.2 AMP2 Normal Mode

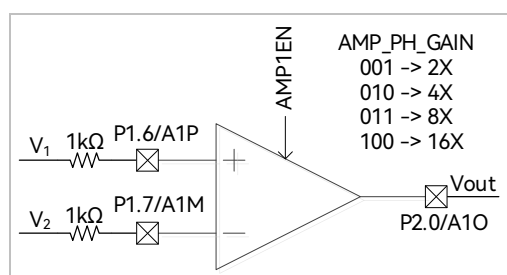
Figure 27-5 AMP2 I/O Pins



The I/O pins of AMP2 are shown in Figure 27-5. AMP2 is enabled when $\text{AMP\_CR0}[\text{AMP2EN}] = 1$. P2.1, P2.2 and P2.3 are automatically configured to analog signal mode by the hardware. P2_AN[3:1] is set to “111”.

27.2.2.3 AMP1 PGA Differential Input Mode

Figure 27-6 AMP1 Operating in PGA Differential Input Mode

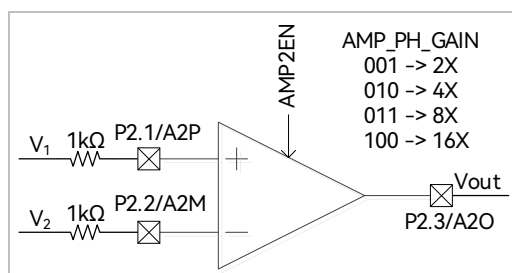


As shown in Figure 27-6, positive and negative inputs of AMP1 are connected with a 1kΩ resistor in the external circuit respectively.

When PGA Differential Input Mode is selected for AMP1, the amplification gain is set by $\text{AMP\_CR1}[\text{AMP\_PH\_GAIN}]$, and AMP1 is enabled when $\text{AMP\_CR0}[\text{AMP1EN}] = 1$. The relation between output and input of operational amplifier: $V_{\text{out}} = V_{\text{HALF}} + (V_1 - V_2) * \text{AMP\_PH\_GAIN}$.

27.2.2.4 AMP2 PGA Differential Input Mode

Figure 27-7 AMP2 Operating in PGA Differential Input Mode



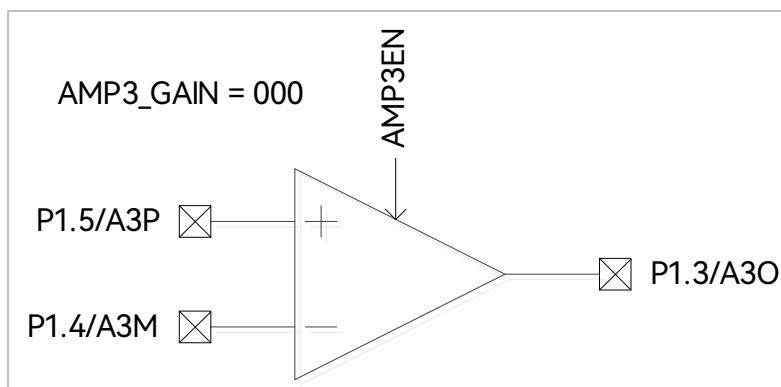
As shown in Figure 27-7, positive and negative inputs of AMP2 are connected with a 1kΩ resistor in the external circuit respectively.

When PGA Differential Input Mode is selected for AMP2, the amplification gain is set by AMP_CR1[AMP_PH_GAIN]. AMP2 is enabled when AMP_CR0[AMP2EN] = 1. The relation between output and input of operational amplifier: $V_{out} = V_{HALF} + (V_1 - V_2) * AMP\_PH\_GAIN$.

27.2.3 Operational Amplifier AMP3

27.2.3.1 AMP3 Normal Mode

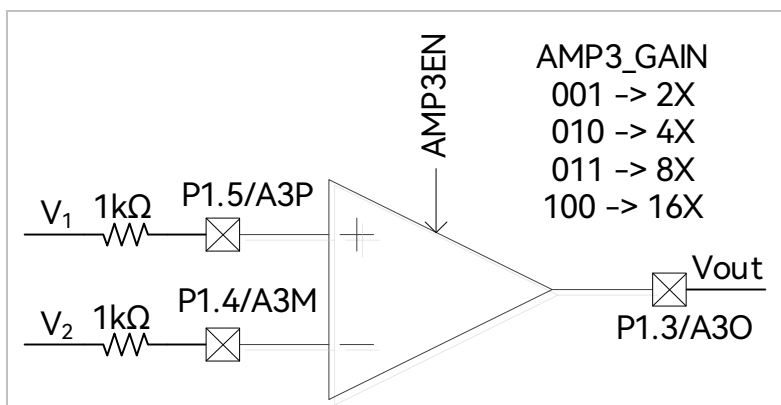
Figure 27-8 AMP3 I/O Pins



The I/O pins of AMP3 are shown in Figure 27-8. AMP3 is enabled when AMP_CR0[AMP3EN] = 1, and P1.5, P1.4 and P1.3 are automatically configured to analog input mode by the hardware. P1_AN[5:4] is set to “11”, P1_AN[HBMOD] to “1”, and P1_OE[3] to “0”.

27.2.3.2 AMP3 PGA Differential Input Mode

Figure 27-9 AMP3 Operating in PGA Differential Input Mode



As shown in Figure 27-9, positive and negative inputs of AMP3 are connected with a 1kΩ resistor in the external circuit respectively.

When PGA Single-ended Input Mode is selected for AMP3, the amplification gain is set by AMP_CR2[AMP3_GAIN], and AMP3 is enabled when AMP_CR0[AMP3EN] = 1. The relation between output and input of operational amplifier: $V_{out} = V_{HALF} + (V_1 - V_2) * AMP3\_GAIN$.

27.3 Operational Amplifier Registers

27.3.1 AMP_CR0 (0x404E)

Bit	7	6	5	4	3	2	1	0
Name	RSV	CP_EN	RSV		AMP3EN	AMP2EN	AMP1EN	AMP0EN
Type	-	R/W	-	-	R/W	R/W	R/W	R/W
Reset	-	0	-	-	0	0	0	0

Bit	Name	Description
[7]	RSV	Reserved
[6]	CP_EN	Constant Power Config Enable 0: Disable 1: Enable  Note When it is enabled, AMP0 output (P2.7) is routed to P3.4 pin. P3.4 pin must be provided with an external 1μF capacitor for bus average current sampling
[5:4]	RSV	Reserved
[3]	AMP3EN	AMP3 Enable 0: Disable 1: Enable
[2]	AMP2EN	AMP2 Enable 0: Disable 1: Enable
[1]	AMP1EN	AMP1 Enable 0: Disable 1: Enable
[0]	AMP0EN	AMP0 Enable 0: Disable 1: Enable

27.3.2 AMP_CR1 (0x4034)

Bit	7	6	5	4	3	2	1	0
Name	AMP_PH_GAIN			RSV		AMP0_GAIN		
Type	R/W	R/W	R/W	-	-	R/W	R/W	R/W
Reset	0	0	0	-	-	0	0	0

Bit	Name	Description
[7:5]	AMP_PH_GAIN	Gain setting for AMP1&AMP2, see descriptions on AMP_CR1[AMP0_GAIN] bit in section AMP_CR1 (0x4034)
[4:3]	RSV	Reserved
[2:0]	AMP0_GAIN	AMP0 Amplification Gain Setting 000: The gain is configured by external circuit 001: 2x 010: 4x 011: 8x 100: 16x 101: Reserved 110: Reserved 111: Reserved  Note The built-in amplification is isotropic amplification. When the difference of input voltage is 0, the output voltage is VHALF. For other applications, AMP0_GAIN is set to "000" to select external circuit to configure the gain

27.3.3 AMP_CR2 (0x4046)

Bit	7	6	5	4	3	2	1	0
Name	RSV					AMP3_GAIN		
Type	-	-	-	-	-	R/W	R/W	R/W
Reset	-	-	-	-	-	0	0	0

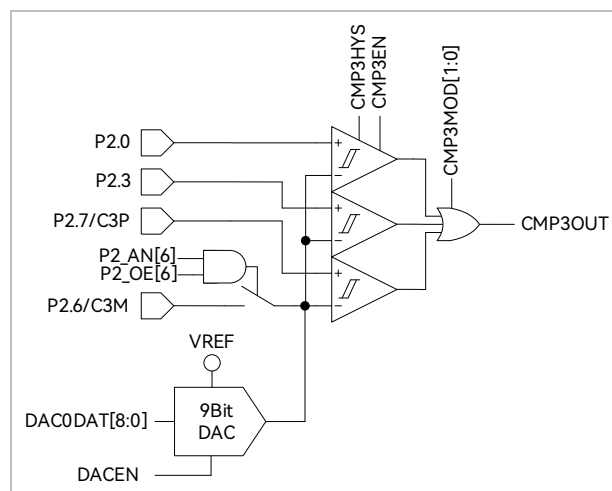
Bit	Name	Description
[7:3]	RSV	Reserved
[2:0]	AMP3_GAIN	Amplification gain for AMP3. See descriptions on AMP_CR1[AMP0_GAIN] bit in section AMP_CR1 (0x4034)

28 Comparator

28.1 Comparator Operations

28.1.1 Comparator CMP3

Figure 28-1 CMP3 I/O Pins



The I/O pins of CMP3 are shown in Figure 28-1.

CMP3 configurations are as follows:

1. The negative input VREF source can be external input voltage or on-chip DAC0 output voltage, details are as follows:
 - Select external circuit input voltage: Configure P2_AN[6] = 1 and P2_OE[6] = 1, the CMP3 negative signal is inputted via P2.6;
 - DAC0 output voltage: Enable DAC0 by configuring DAC_CR[DAC0_1EN] = 1;



Note

Select DAC0 as output voltage and configure P2_AN[6] = 1 and P2_OE[6] = 1 to keep stable voltage and an external capacitor is connected between P2.6 and GND (with 100pF capacitance and the voltage is stable after DAC0 output for a while)

2. Configure CMP_CR1[CMP3MOD] to select single-comparator input, dual-comparator input, or triple-comparator input mode
 - When CMP_CR1[CMP3MOD] = 00, CMP3 works in Single-comparator Input Mode. The connection of input

and output pins are shown in Figure 28-2.

- When $\text{CMP\_CR1}[\text{CMP3MOD}] = 01$, CMP3 works in Dual-comparator Input Mode. The connection of input and output pins are shown in Figure 28-3.
 - When $\text{CMP\_CR1}[\text{CMP3MOD}] = 1X$, CMP3 works in Triple-comparator Input Mode. The connection of input and output pins are as shown in Figure 28-4.
3. Configure $\text{CMP\_CR1}[\text{CMP3HYS}]$ to enable or disable hysteresis;
 4. Set $\text{CMP\_CR1}[\text{CMP3EN}] = 1$ to enable CMP3.

Figure 28-2 Single-comparator Input Mode

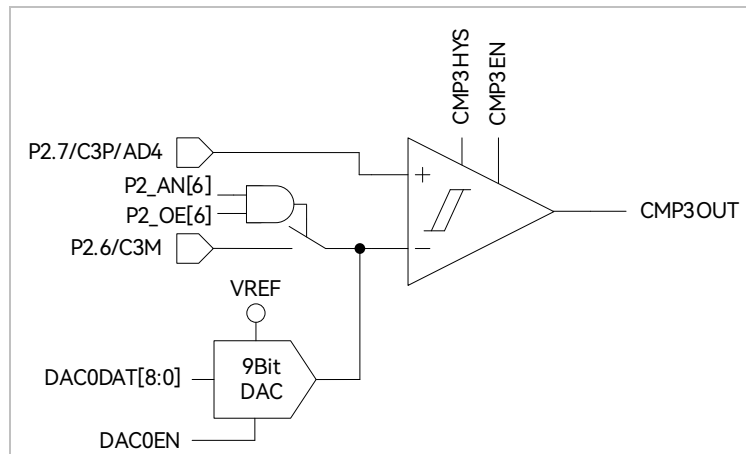


Figure 28-3 Dual-comparator Input Mode

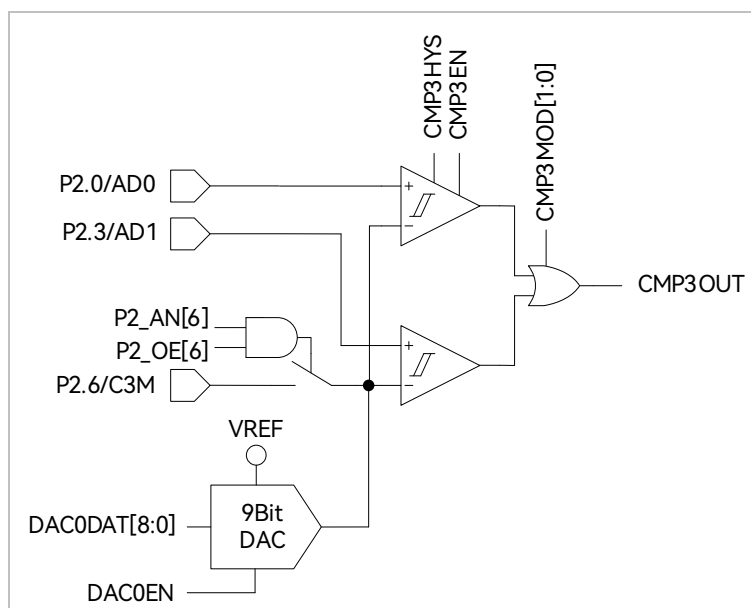
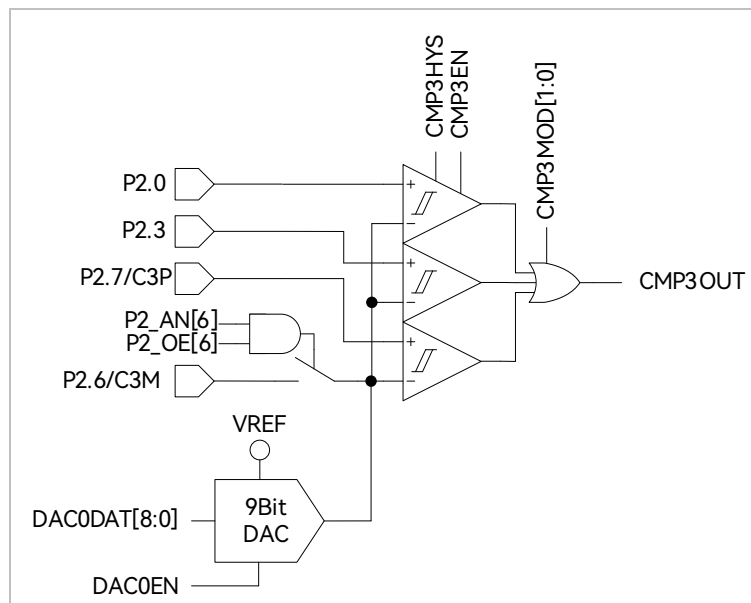


Figure 28-4 Triple-comparator Input Mode



28.1.1.1 Overcurrent Protection

When an over-current protection signal is generated, DRV_OUT[MOE] is automatically cleared by hardware to output idle voltage to stop motor drive for chip and motor protection. OCP feature is enabled when EVT_FILT[MOEMD] = 01, which automatically turns off the output and generates an OCP interrupt request if the current exceeds the threshold. When EVT_FILT[MOEMD]=00, the output is not automatically turned off if the current exceeds the threshold. However, an OCP request is generated by the hardware.

The source of OCP interrupt is selected by configuring EVT_FILT[MOEMD] ≠ 00 and EVT_FILT[INT0_MOE_EN] = 1, namely CMP3 interrupt or external interrupt INT0. When EVT_FILT[INT0_MOE_EN]=1, TCON[IT0] bit is programmed to select the trigger edge of the external interrupt INT0 which generates an OCP output. At this time, the source of OCP interrupt is INT0. When EVT_FILT[INT0_MOE_EN] = 0 and CMP_CR0[CMP3IM] = 01, the OCP output is generated on the raising edge of CMP3. At this time, the source of OCP interrupt is CMP3. In triple-shunt current sampling mode, CMP_CR1[CMP3MOD] is configured to select triple-comparator input mode. When current of any phase is over the threshold, CMP3 generates an OCP signal. For other sampling modes, CMP_CR1[CMP3MOD] is configured to choose single-comparator input mode. When bus current is over the threshold, CMP3 generates an OCP signal.

Configuring EVT_FILT[EFDIV] enables the filtering of interrupt signals for OCP, and programming EVT_FILT[EFDIV] = 01/10/11 selects filter width of 6/12/24 clock cycles. When the filtering feature is enabled,

the filtered signal is delayed by 6/12/24 clock cycles compared to the signal before filtering.

28.1.1.2 Cycle-by-cycle Current Limiting

The cycle-by-cycle current limiting feature is applied to square-wave-based drive control of BLDC motors. When an OCP event occurs, DRV_OUT[MOE] is set to “1” after it has been cleared to “0” for a period of time, so that the motor drive is automatically restored. When CMP_CR0[CMP3IM] = 11, DRV_OUT[MOE] is cleared to “0” on the rising edge of CMP3OUT to protect the motor. When EVT_FILT[MOEMD] = 10, the outputs are automatically turned off upon an OCP interrupt. DRV_OUT[MOE] is enabled automatically upon Driver timer overflow/underflow events or after 10μs to restore motor drive. When EVT_FILT[MOEMD] = 11, the outputs are automatically turned off upon an OCP interrupt, DRV_OUT[MOE] is enabled automatically upon Driver timer overflow/underflow events or after 5μs to restore motor drive.

Figure 28-5 Cycle-by-cycle Current Limiting Waveform ($t_2 - t_1 = 10\mu\text{s}$) when EVT_FILT[MOEMD] = 10

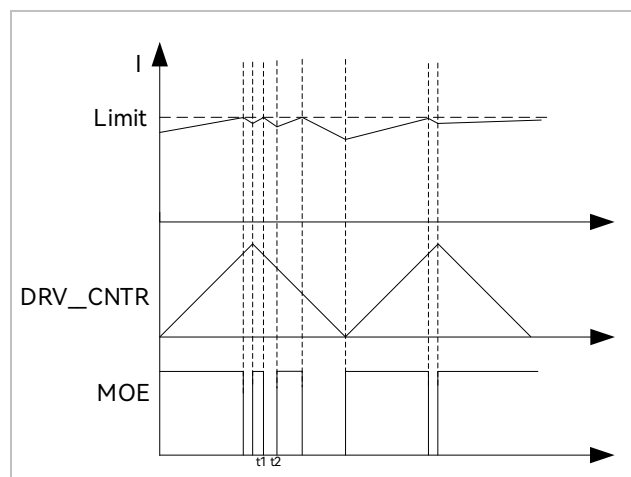
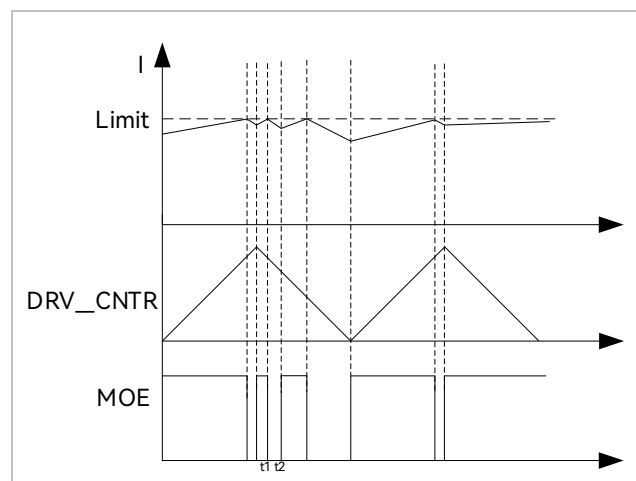


Figure 28-6 Cycle-by-cycle Current Limiting Waveform ($t_2 - t_1 = 5\mu\text{s}$) when EVT_FILT[MOEMD] = 11



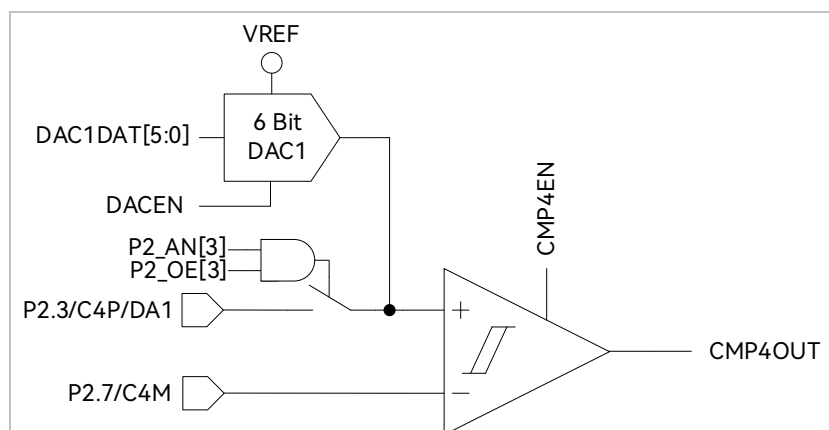
28.1.2 Comparator CMP4

CMP4OUT can be read by software or reversed on external interrupt INT0. When CMP3 is used for cycle-by-cycle current limiting protection, CMP4 is used for bus current protection. When bus current OCP feature of CMP4 is triggered, output must be turned off by software.

CMP4 configurations are as follows:

1. Select the reference voltage for the positive input of CMP4. The voltage source can be on-chip DAC1 output or external circuit input:
 - > For the external circuit input, configure P2_AN[3] = 1 and P2_OE[3] = 1 to apply the external voltage via P2.3 as the reference voltage for the positive input of CMP4;
 - > For DAC1 output, configure DAC_CR[DAC0_1EN] = 1 to enable DAC1;
-  **Note**
- When DAC1 is enabled, you can also configure P2_AN[3] = 1 and P2_OE[3] = 1, and connect a 100pF external capacitor (recommended) between P2.3 and GND. This helps stabilize DAC1 output voltage over time
2. Configure P2_AN[7] = 1 to assign P2.7 pin to analog signal;
 3. CMP_CR2[CMP4EN] = 1 to enable CMP4;
 4. Clear INT0 flag bit to enable INT0;
 5. Set LVSR[EXT0CFG] = 111 to select CMP4 as the source of INT0;
 6. Configure TCON[IT0] = 01 to select falling edge triggered INT0.

Figure 28-7 Schematic Diagram of CMP4 Module



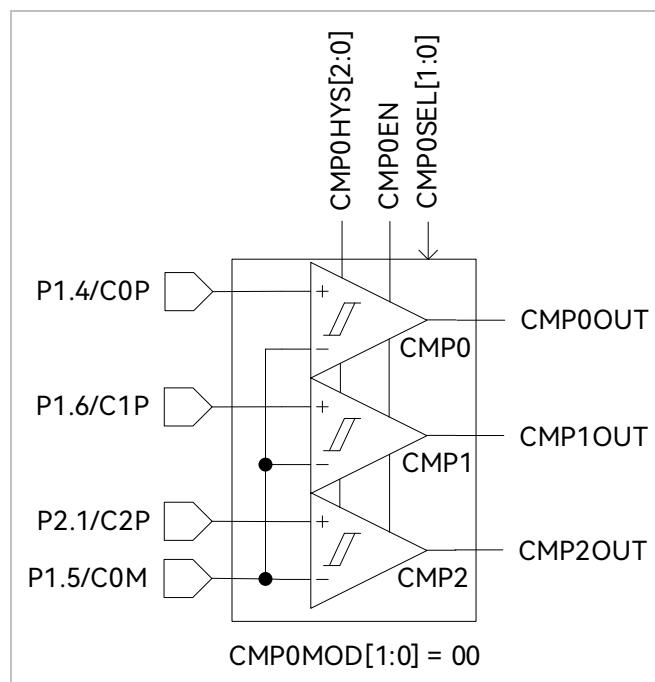
28.1.3 Comparator Group CMPG

Comparator Group (CMPG) is a collection of CMP0, CMP1 and CMP2, with multiple comparison modes for different applications.

28.1.3.1 CMPG Mode with Three Comparators (Without Built-in Resistor)

When $\text{CMP\_CR2}[\text{CMP0MOD}] = 00$, CMPG works in the mode of three comparators without built-in resistor. The I/O pins are shown in Figure 28-8. It is used for BEMF detection with the external virtual neutral point resistors. The negative inputs of the three comparators are connected together to P1.5 pin, and the positive inputs are connected to P1.4, P1.6 and P2.1 respectively. The outputs are CMP0OUT, CMP1OUT and CMP2OUT respectively. The number of comparators working in this mode is defined by $\text{CMP\_CR2}[\text{CMP0SEL}]$. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 00$, CMP0, CMP1 and CMP2 work simultaneously, which is the recommended configuration. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 01$, only CMP0 works. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 10$, only CMP1 works. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 11$, only CMP2 works.

Figure 28-8 CMPG Mode with Built-in Three Comparators
(without Built-in Resistor)

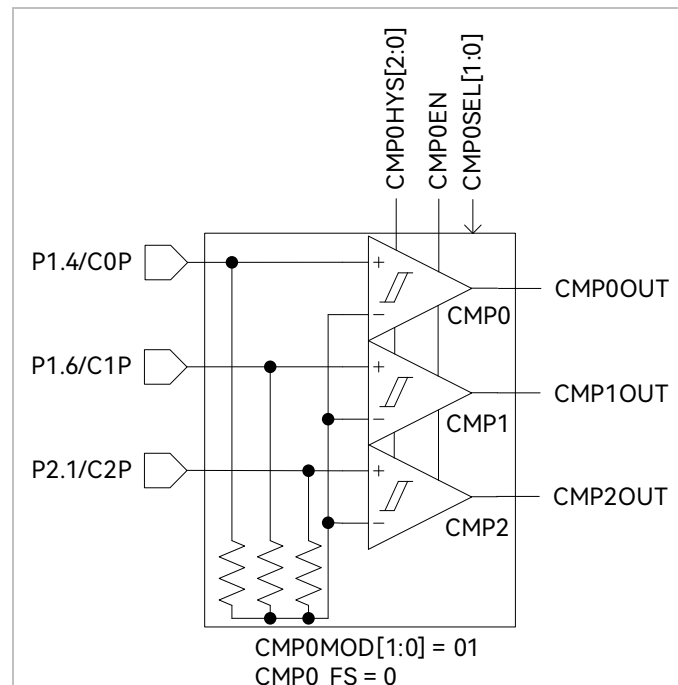


28.1.3.2 CMPG Mode with Three Comparators and Built-in Resistors

When $\text{CMP\_CR2}[\text{CMP0MOD}] = 01$, CMPG works in the mode of three comparators with built-in resistors. It is used for BEMF detection with the internal virtual neutral point resistors. The input port is selected by setting the function switching bit $\text{CMP\_CR4}[\text{CMP0\_FS}]$. The number of comparators operating in this mode is defined by $\text{CMP\_CR2}[\text{CMP0SEL}]$. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 00$, CMP0, CMP1 and CMP2 work simultaneously, which is the recommended configuration. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 01$, only CMP0 works. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 10$, only CMP1 works. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 11$, only CMP2 works.

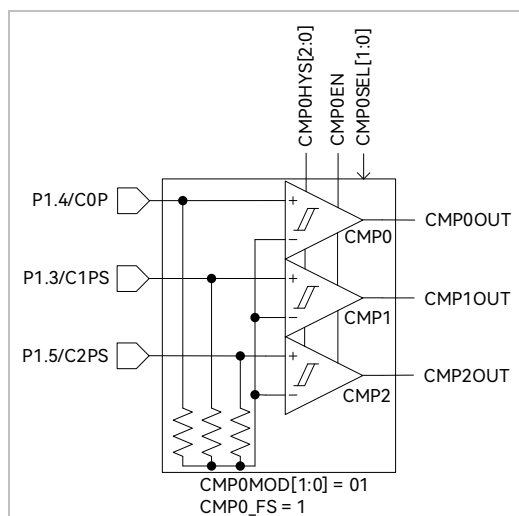
When $\text{CMP\_CR4}[\text{CMP0\_FS}] = 0$, the I/O pins are shown in Figure 28-9. The negative inputs of the three comparators are connected together to the center point of the built-in resistor. The positive inputs are connected to P1.4, P1.6 and P2.1 respectively, and the outputs are CMP0OUT, CMP1OUT and CMP2OUT respectively.

Figure 28-9 CMPG Mode with Built-in Three Comparators and Resistors (without Function Switching)



When $\text{CMP\_CR4}[\text{CMP0\_FS}] = 1$, the I/O pins are shown in Figure 28-10. The negative inputs of the three comparators are connected together to the center point of the built-in resistor. The positive inputs are connected to P1.4, P1.3 and P1.5 respectively, and the outputs are CMP0OUT, CMP1OUT and CMP2OUT respectively.

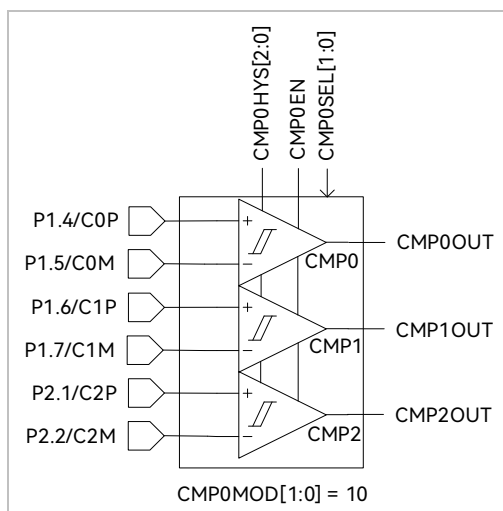
Figure 28-10 CMPG Mode with Built-in Three Comparators (with Function Switching)



28.1.3.3 CMPG Mode with Three Differential Comparators

When $\text{CMP\_CR2}[\text{CMP0MOD}] = 10$, CMPG mode with three differential comparators is selected for the differential Hall sensor to detect the motor rotor position. The input and output pins are shown in Figure 28-11. The negative inputs of the three comparators are respectively connected to P1.5, P1.7 and P2.2, and the positive inputs are respectively connected to P1.4, P1.6 and P2.1. The outputs are CMP0OUT, CMP1OUT and CMP2OUT respectively. The number of comparators working in this mode is defined by $\text{CMP\_CR2}[\text{CMP0SEL}]$. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 00$, CMP0, CMP1 and CMP2 work simultaneously, which is the recommended configuration. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 01$, only CMP0 works. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 10$, only CMP1 works. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 11$, only CMP2 works.

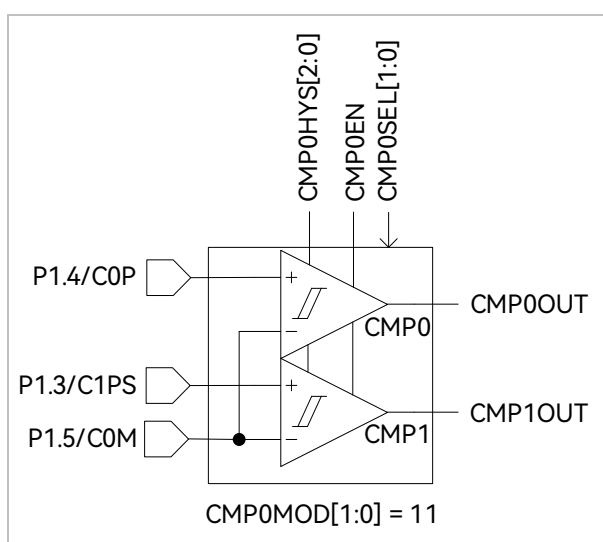
Figure 28-11 CMPG Mode with Three Differential Comparators



28.1.3.4 CMPG Mode with Dual-comparators

When $\text{CMP\_CR2}[\text{CMP0MOD}] = 11$, CMPG mode with two comparators is selected for motor speed detection. The I/O pins are shown in Figure 28-12. The negative inputs of the two comparators are connected together to P1.5, and the positive inputs are connected to P1.4 and P1.3 respectively. The outputs are CMP0OUT and CMP1OUT respectively. The number of comparators in this mode is defined by $\text{CMP\_CR2}[\text{CMP0SEL}]$. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 00$, CMP0 and CMP1 work simultaneously, which is the recommended configuration. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 01$, only CMP0 works. When $\text{CMP\_CR2}[\text{CMP0SEL}] = 10$, only CMP1 works.

Figure 28-12 CMPG Mode with Dual-comparators

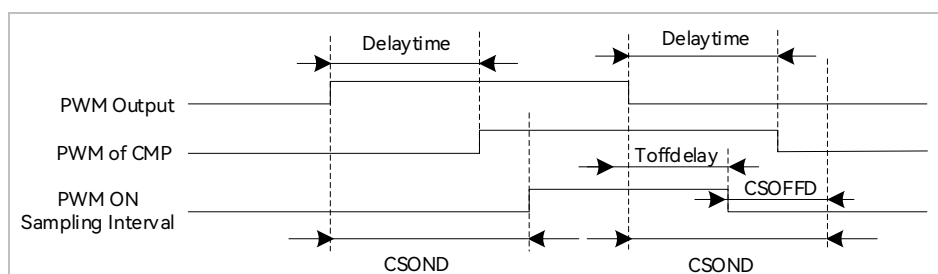


The output signals of CMP0/CMP1/CMP2 are sent to Timer1 after filtering and sampling modules.

28.1.4 Comparator Sampling

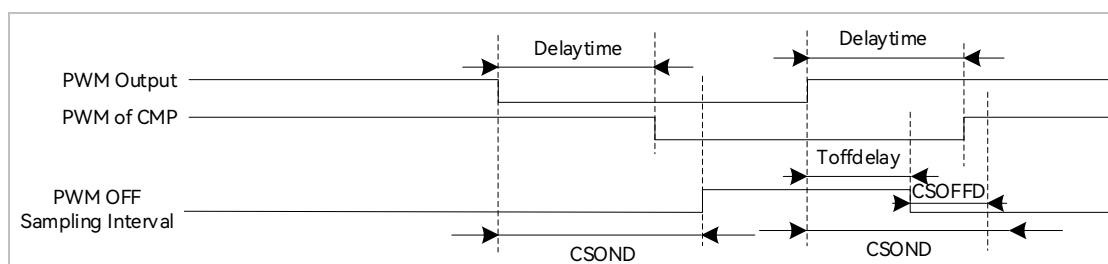
The comparator sampling feature is mainly used for the square-wave control and RSD (tailwind/headwind detection), which eliminates the switching interference from driving circuit. See section 13.1.2.3 for square-wave control and section 14.1.7.1 for RSD.

Figure 28-13 PWM ON Sampling Mode



There is a delay from the PWM output to the output of the comparator, which is mainly affected by the following factors: resistance value of drive resistor, switching speed of the power device, and input delay and hysteresis settings of the comparator. As shown in Figure 28-13, the Delaytime is from the chip output to the comparator output. When high-level sampling is performed, the sampling interval shall be enveloped by actual high-level output of the comparator. First, the sampling ON-delayed time $CMP\_SAMR[CSOND]$ is set to overcome the output delay and avoid ringing at the switch node on power IC. At the end of the sampling interval, $CMP\_SAMR[CSOND]$ is delayed after the falling edge of PWM, at which time the actual sampling window has exceeded the corresponding high-level interval. The sampling OFF-lead time $CMP\_SAMR[CSOFFD]$ is set to stop sampling $T_{offdelay}$ after the PWM output falling edge, where $T_{offdelay} = CMP\_SAMR[CSOND] - CMP\_SAMR[CSOFFD]$. By configuring $CMP\_SAMR[CSOND]$ and $CMP\_SAMR[CSOFFD]$, the sampling interval can be located in the high-level interval of the actual output of the comparator.

Figure 28-14 PWM OFF Sampling Mode



Similarly, when low-level sampling is performed, the sampling ON-delayed time $CMP\_SAMR[CSOND]$ and the sampling OFF-lead time $CMP\_SAMR[CSOFFD]$ are set reasonably to ensure that the actual sampling interval is located in the low-level output interval of the comparator.

Method for measuring the delay of PWM output to comparator: Set $CMP\_CR3[SAMSEL] = 00$ to disable the comparator sampling delay feature. Enable the PWM output and comparator, manually rotate the motor to change the comparator value, and measure the delay between the PWM output and the comparator output.

28.2 Comparator Registers

28.2.1 CMP_CR0 (0xD5)

Bit	7	6	5	4	3	2	1	0
Name	CMP3IM		CMP2IM		CMP1IM		CMP0IM	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:6]	CMP3IM	CMP3 Interrupt Mode 00: No interrupt is generated. 01: An interrupt is generated upon rising edge. 10: An interrupt is generated upon falling edge. 11: When a rising edge is detected, DRV_OUT[MOE] is cleared to “0”, and the interrupt event flag bit CMP_SR[CMP3IF] is set to “1”. However, the interrupt is disabled.  Note In the Cycle-by-cycle Current Limiting mode, EVT_FILT[MOEMD] must be set to 10/11
[5:4]	CMP2IM	CMP2 Interrupt Mode See descriptions on CMP_CR0[CMP0IM]
[3:2]	CMP1IM	CMP1 Interrupt Mode See descriptions on CMP_CR0[CMP0IM]
[1:0]	CMP0IM	CMP0 Interrupt Mode 00: No interrupt is generated. 01: An interrupt is generated upon rising edge. 10: An interrupt is generated upon falling edge. 11: An interrupt is generated upon both rising/falling edges.

28.2.2 CMP_CR1 (0xD6)

Bit	7	6	5	4	3	2	1	0
Name	RSV	CMP3MOD		CMP3EN	CMP3HYS	RSV	CMP0HYS	
Type	-	R/W	R/W	R/W	R/W	-	R/W	R/W
Reset	-	0	0	0	0	-	0	0

Bit	Name	Description
[7]	RSV	Reserved
[6:5]	CMP3MOD	CMP3 Mode Selection Negative input is connected to P2.6 or DAC0 output 00: Single-comparator mode, where P2.7 is connected to the positive input, as shown in Figure 28-2. 01: Dual-comparator mode, where P2.0 and P2.3 are connected to the positive input, as shown in Figure 28-3. 1X: Three-comparator mode, where P2.0, P2.3 and P2.7 are connected to the positive input, as shown in Figure 28-4.
[4]	CMP3EN	CMP3 Enable 0: Disable 1: Enable
[3]	CMP3HYS	CMP3 Hysteresis Voltage Selection 0: No hysteresis 1: 15mV
[2]	RSV	Reserved
[1:0]	CMP0HYS	CMP0/1/2 Hysteresis Voltage Selection: 00: No hysteresis 01: $\pm 3\text{mV}$ 10: $+ 6\text{mV}$ 11: $\pm 12\text{mV}$

28.2.3 CMP_CR2 (0xDA)

Bit	7	6	5	4	3	2	1	0
Name	CMP4EN	CMP0MOD		CMP0SEL		CMP0CSEL		CMP0EN
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	CMP4EN	CMP4 Enable 0: Disable 1: Enable

[6:5]	CMP0MOD	CMPG Mode Setting 00: CMPG Mode with built-in three comparators (without built-in resistor), as shown in Figure 28-8. 01: CMPG Mode with built-in three comparators and resistors, where function switching is selected by configuring CMP_CR4[CMP0_FS], as shown in Figure 28-9 and Figure 28-10. 10: CMPG Mode with three differential comparators, as shown in Figure 28-11. 11: CMPG Mode with two comparators , where only CMP0 and CMP1 work, as shown in Figure 28-12.																	
[4:3]	CMP0SEL	CMPG Pin Combination Selection, used with CMP_CR2[CMP0MOD] bit. It is set to 00 by default. In square-wave drive application, TIM1_DBRx[T1CPE] automatically controls CMP_CR2[CMP0SEL] to enable or disable each comparator. Table 28-1 Function Description of CMPG Port and CMP_CR2[CMP0MOD] Combination <table border="1"> <thead> <tr> <th>CMP0MOD</th><th>CMP0SEL</th><th>Function Descriptions</th></tr> </thead> <tbody> <tr> <td rowspan="4">00</td><td>00</td><td>CMP0/1/2 work simultaneously, as shown in Figure 28-8. The negative input of these comparators are connected to C0M. The hardware automatically compares the positive inputs C0P, C1P and C2P with C0M, and the output results are transferred to CMP0OUT, CMP1OUT and CMP2OUT respectively.</td></tr> <tr> <td>01</td><td>Only CMP0 works. The positive input is connected to C0P, and the negative input to C0M. The output results are transferred to CMP0OUT.</td></tr> <tr> <td>10</td><td>Only CMP1 works. The positive input is connected to C1P, and the negative input to C0M. The output results are transferred to CMP1OUT.</td></tr> <tr> <td>11</td><td>Only CMP2 works. The positive input is connected to C2P, and the negative input to C0M. The output results are transferred to CMP2OUT.</td></tr> <tr> <td rowspan="2">01</td><td>00</td><td>CMP0/1/2 work simultaneously, as shown in Figure 28-9 and Figure 28-10. The negative inputs of these 3 comparators are connected to the center of built-in resistor. When CMP_CR4[CMP0_FS] = 0, the hardware automatically compares the positive inputs C0P, C1P and C2P with C0M. When CMP_CR4[CMP0_FS] = 1, the hardware automatically compares the positive inputs C0P, C1PS and C2PS with C0M. The output results are transferred to CMP0OUT, CMP1OUT and CMP2OUT respectively.</td></tr> <tr> <td>01</td><td>Only CMP0 works. The positive input is connected</td></tr> </tbody> </table>	CMP0MOD	CMP0SEL	Function Descriptions	00	00	CMP0/1/2 work simultaneously, as shown in Figure 28-8. The negative input of these comparators are connected to C0M. The hardware automatically compares the positive inputs C0P, C1P and C2P with C0M, and the output results are transferred to CMP0OUT, CMP1OUT and CMP2OUT respectively.	01	Only CMP0 works. The positive input is connected to C0P, and the negative input to C0M. The output results are transferred to CMP0OUT.	10	Only CMP1 works. The positive input is connected to C1P, and the negative input to C0M. The output results are transferred to CMP1OUT.	11	Only CMP2 works. The positive input is connected to C2P, and the negative input to C0M. The output results are transferred to CMP2OUT.	01	00	CMP0/1/2 work simultaneously, as shown in Figure 28-9 and Figure 28-10. The negative inputs of these 3 comparators are connected to the center of built-in resistor. When CMP_CR4[CMP0_FS] = 0, the hardware automatically compares the positive inputs C0P, C1P and C2P with C0M. When CMP_CR4[CMP0_FS] = 1, the hardware automatically compares the positive inputs C0P, C1PS and C2PS with C0M. The output results are transferred to CMP0OUT, CMP1OUT and CMP2OUT respectively.	01	Only CMP0 works. The positive input is connected
CMP0MOD	CMP0SEL	Function Descriptions																	
00	00	CMP0/1/2 work simultaneously, as shown in Figure 28-8. The negative input of these comparators are connected to C0M. The hardware automatically compares the positive inputs C0P, C1P and C2P with C0M, and the output results are transferred to CMP0OUT, CMP1OUT and CMP2OUT respectively.																	
	01	Only CMP0 works. The positive input is connected to C0P, and the negative input to C0M. The output results are transferred to CMP0OUT.																	
	10	Only CMP1 works. The positive input is connected to C1P, and the negative input to C0M. The output results are transferred to CMP1OUT.																	
	11	Only CMP2 works. The positive input is connected to C2P, and the negative input to C0M. The output results are transferred to CMP2OUT.																	
01	00	CMP0/1/2 work simultaneously, as shown in Figure 28-9 and Figure 28-10. The negative inputs of these 3 comparators are connected to the center of built-in resistor. When CMP_CR4[CMP0_FS] = 0, the hardware automatically compares the positive inputs C0P, C1P and C2P with C0M. When CMP_CR4[CMP0_FS] = 1, the hardware automatically compares the positive inputs C0P, C1PS and C2PS with C0M. The output results are transferred to CMP0OUT, CMP1OUT and CMP2OUT respectively.																	
	01	Only CMP0 works. The positive input is connected																	

				to C0P, and the negative input to the center of BEMF built-in resistor. The output results are transferred to CMP0OUT.
			10	Only CMP1 works. When CMP_CR4[CMP0_FS] = 0, the positive input is connected to C1P, and when CMP_CR4[CMP0_FS] = 1, it is connected to C1PS. The negative input is connected to the center of BEMF built-in resistor. The output results are transferred to CMP1OUT.
			11	Only CMP2 works. When CMP_CR4[CMP0_FS] = 0, the positive input is connected to C2P, and when CMP_CR4[CMP0_FS] = 1, it is connected to C2PS. The negative input is connected to the center of BEMF built-in resistor. The output results are transferred to CMP2OUT.
		10	00	CMP0/1/2 work simultaneously, as shown in Figure 28-11. The positive inputs of these comparators are connected to C0P, C1P and C2P respectively, and the negative inputs are connected to C0M, C1M and C2M respectively. The output results are transferred to CMP0OUT, CMP1OUT and CMP2OUT respectively.
			01	Only CMP0 works. The positive input is connected to C0P, and the negative input to C0M, and the output results are transferred to CMP0OUT.
			10	Only CMP1 works. The positive input is connected to C1P, and the negative input to C1M. The output results are transferred to CMP1OUT.
			11	CMPG selects the associated CMP2 pin combinations. The positive input is connected to C2P, and the negative input to C2M. The output results are transferred to CMP2OUT.
		11	00	CMP0/1 work simultaneously, as shown in Figure 28-12. The positive inputs are connected to C0P and C1PS respectively, and the negative inputs to C0M. The outputs results are transferred to CMP0OUT and CMP1OUT respectively.

			01	Only CMP0 works. The positive input is connected to C0P, and the negative input to C0M. The output results are transferred to CMP0OUT.
			10	Only CMP1 works. The positive input is connected to C1PS, and the negative input to C0M. The output results are transferred to CMP1OUT.
			11	Reserved
[2:1]	CMP0CSEL	CMP0/1/2 Rolling Speed Selection 00: Normal Speed 01: Fast Speed 10: Medium Speed 11: Low Speed		
[0]	CMP0EN	CMP0/1/2 Enable 0: Disable 1: Enable		

28.2.4 CMP_CR3 (0xDC)

Bit	7	6	5	4	3	2	1	0
Name	CMPDTEN	DBGSEL		SAMSEL		RSV		
Type	R/W	R/W	R/W	R/W	R/W	-	-	-
Reset	0	0	0	0	0	-	-	-

Bit	Name	Description
[7]	CMPDTEN	Comparator Deadtime Sampling Enable 0: Disable 1: Enable
[6:5]	DBGSEL	Debug Output Selection, connected to P0.1 pin 00: Debug Output Disable 01: Freewheeling shielding is completed and ZCP signal is detected 10: ADC Trigger Signal 11: Comparator Sampling Interval
[4:3]	SAMSEL	Sampling delay enable of CMP0, CMP1, CMP2 and ADC in PWM ON/OFF modes 00: Sampling at both PWM ON and OFF modes without time delay 01: Sampling at PWM OFF mode, with time delay according to CMP_SAMR 10: Sampling at PWM ON mode, with time delay according to CMP_SAMR 11: Sampling at both PWM ON and OFF, with time delay according to CMP_SAMR
[2:0]	RSV	Reserved

28.2.5 CMP_CR4 (0xE1)

Bit	7	6	5	4	3	2	1	0
Name	CMP4OUT	RSV		CMP3P4M_FS	RSV	FAEN	CMP0_FS	RSV
Type	R	-	-	R/W	-	R/W	R/W	-
Reset	1	-	-	0	-	0	0	-

Bit	Name	Description
[7]	CMP4OUT	CMP4 Output
[6:5]	RSV	Reserved
[4]	CMP3P4M_FS	C3P and C4M are switched to output at P3.4. It is used to directly transfer the sampled bus current (bus current operational amplifier AMP00 output to P3.4) to OCP comparator. 0: No function switching. 1: Function switching to output at P3.4 pin, where CMP3 has only one input channel at the positive input.
[3]	RSV	Reserved
[2]	FAEN	Filtered Signal Sampling Coefficient Scale-up Enable With it enabled, base clock rates of TIM1_CR3[T1INM] and CMP_SAMR are scaled up by 4 times. 0: Disable 1: Enable
[1]	CMP0_FS	CMP1/CMP2 Function Switching 0: No function switching, as shown in Figure 28-9 1: Function switching, valid only when CMP_CR2[CMP0_MOD] = 01, as shown in Figure 28-10.
[0]	RSV	Reserved

28.2.6 CMP_SAMR (0x40AD)

Bit	7	6	5	4	3	2	1	0
Name	CSOND				CSOFFD			
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	1

Bit	Name	Description
[7:4]	CSOND	CMP0/CMP1/CMP2 ON-delayed Sampling Time When PWM module switches from OFF to ON or from ON to OFF, turn-on/off of the power device affects input signal of the comparator. In this case, CMP_SAMR[CSOND] is configured to delay the sampling of CMP0/CMP1/CMP2. The On-delayed sampling time can be multiplied by 4 times by setting CMP_CR4[FAEN]. CMP_CR4[FAEN] = 0: ON-delayed sampling time = 8 * CMP_SAMR[CSOND] * T

		$\text{CMP\_CR4[FAEN]} = 1$: ON-delayed sampling time = $32 * \text{CMP\_SAMR[CSOND]} * T$  Note > CMP_SAMR[CSOND] must be greater than or equal to CMP_SAMR[CSOFFD]. > See section Sampling for BLDC drive application. > See section RSD Comparator Sampling for RSD application
[3:0]	CSOFFD	CMP0/CMP1/CMP2 OFF-lead Sampling Time CMP_SAMR[CSOND] is configured to end the sampling CMP_SAMR[CSOND] - CMP_SAMR[CSOFFD] after the back edge of PWM output to ensure sampling interval is enveloped by the PWM interval. OFF-lead sampling time can be multiplied by 4 times by setting CMP_CR4[FAEN]. $\text{CMP\_CR4[FAEN]} = 0$: OFF-lead sampling time = $8 * \text{CMP\_SAMR[CSOFFD]} * T$ $\text{CMP\_CR4[FAEN]} = 1$: OFF-lead sampling time = $32 * \text{CMP\_SAMR[CSOFFD]} * T$  Note > CMP_SAMR[CSOND] must be greater than or equal to CMP_SAMR[CSOFFD] > See section Sampling for BLDC drive application. > See section RSD Comparator Sampling for RSD application

28.2.7 CMP_SR (0xD7)

Bit	7	6	5	4	3	2	1	0
Name	CMP3IF	CMP2IF	CMP1IF	CMP0IF	CMP3OUT	CMP2OUT	CMP1OUT	CMP0OUT
Type	R/W0	R/W0	R/W0	R/W0	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7]	CMP3IF	CMP3 Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0" 1: No effect
[6]	CMP2IF	CMP2 Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0" 1: No effect
[5]	CMP1IF	CMP1 Interrupt Flag

		Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0" 1: No effect
[4]	CMP0IF	CMP0 Interrupt Flag: Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to "0" 1: No effect
[3]	CMP3OUT	CMP3 comparison result
[2]	CMP2OUT	CMP2 comparison result
[1]	CMP1OUT	CMP1 comparison result
[0]	CMP0OUT	CMP0 comparison result

28.2.8 HALL_CR (0xE2)

Bit	7	6	5	4	3	2	1	0
Name	HALL_IF	HALL_IE	RSV		HALLSEL	HALL2	HALL1	HALL0
Type	R/W0	R/W	-	-	R/W	R	R	R
Reset	0	0	-	-	0	0	0	0

Bit	Name	Description
[7]	HALL_IF	Hall Interrupt Flag 0: No Hall edge change is detected. 1: Hall edge change is detected.
[6]	HALL_IE	Hall Interrupt Enable 0: Disable 1: Enable
[5:4]	RSV	Reserved
[3]	HALLSEL	Hall Input Selection 0: P0.2/P3.6/P3.7 1: P1.4/P1.6/P2.1
[2]	HALL2	Hall2 Level 0: Hall2 level = 0 1: Hall2 level = 1
[1]	HALL1	Hall1 Level 0: Hall1 level = 0 1: Hall1 level = 1
[0]	HALL0	Hall0 Level

0: Hall0 level = 0
1: Hall0 level = 1

28.2.9 EVT_FILT (0xD9)

Bit	7	6	5	4	3	2	1	0
Name	RSV			MOEMD		INT0_MOE_EN	EFDIV	
Type	-	-	-	R/W	R/W	R/W	R/W	R/W
Reset	-	-	-	0	0	0	0	0

Bit	Name	Description
[7:5]	RSV	Reserved
[4:3]	MOEMD	MOE Cleared and Enabled by Hardware MOE is cleared and enabled by hardware upon over-/under-current protection event. 00: MOE is not automatically cleared. 01: MOE is automatically cleared. 10: MOE is automatically cleared and enabled by hardware upon Driver timer overflow/underflow events or after 10 μ s (for square-wave drive). 11: MOE is automatically cleared and enabled automatically upon Driver timer overflow/underflow events or after 5 μ s (for square-wave drive).
[2]	INT0_MOE_EN	MOE OFF triggered by INT0 Interrupt 0: Disable 1: Enable
[1:0]	EFDIV	Filter Width for Current Protection 00: Not to filter 01: 6 system clock cycles 10: 12 system clock cycles 11: 24 system clock cycles

28.2.10 TSD_CR (0x402F)

Bit	7	6	5	4	3	2	1	0
Name	TSDEN	RSV			TSDADJ			
Type	R/W	-	-	-	R/W	R/W	R/W	R/W
Reset	0	-	-	-	0	1	1	0

Bit	Name	Description
[7]	TSDEN	Temperature Detection Feature Enable 0: Disable 1: Enable
[6:4]	RSV	Reserved
[3:0]	TSDADJ	Overtemperature Value (Chip Junction Temperature) 0000: 154°C

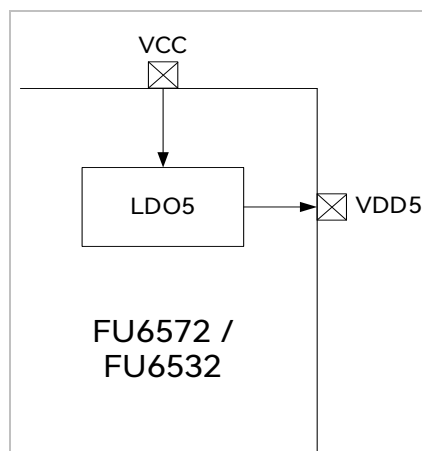
		0001: 147°C 0010: 141°C 0011: 134°C 0100: 128°C 0101: 122°C 0110: 116°C 0111: 110°C 1000: 105°C 1001: 99°C 1010: 94°C 1011: 89°C 1100: 84°C 1101: 79°C 1110: 74°C 1111: 69°C

29 Power Supply

29.1 LDO

29.1.1 LDO Operations (for FU6572 / FU6532)

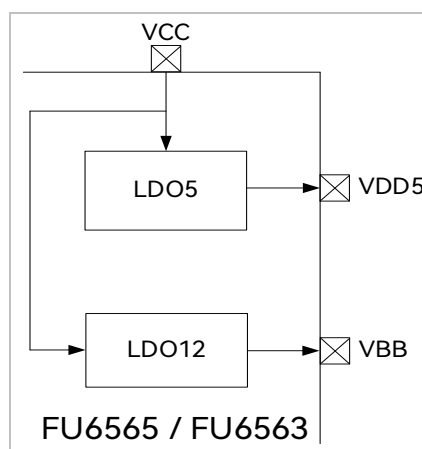
Figure 29-1 Functional Block Diagram of Power Supply



The I/O pins of FU6572 / FU6532 LDO module is shown above. The LDO module converts the input supply voltage to 5V (VDD5) as the power supply for built-in analog module.

29.1.2 LDO Operations (for FU6565 / FU6563)

Figure 29-2 Functional Block Diagram of Power Supply



The I/O pins of FU6565 / FU6563 LDO module is shown above. The LDO5 module converts the input supply voltage to 5V (VDD5) as the power supply for built-in analog module. The LDO12 module converts the input

supply voltage to 12V (VBB) as the power supply for Pre-driver.

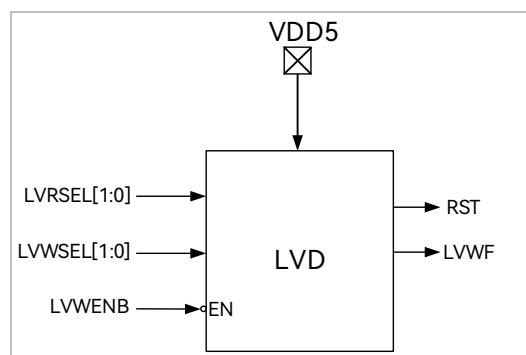
29.2 Low Voltage Detection (LVD)

29.2.1 LVD Introduction

The low voltage detector has two main features: low voltage warning and low voltage reset.

29.2.2 LVD Operations

Figure 29-3 LVD Detection Module

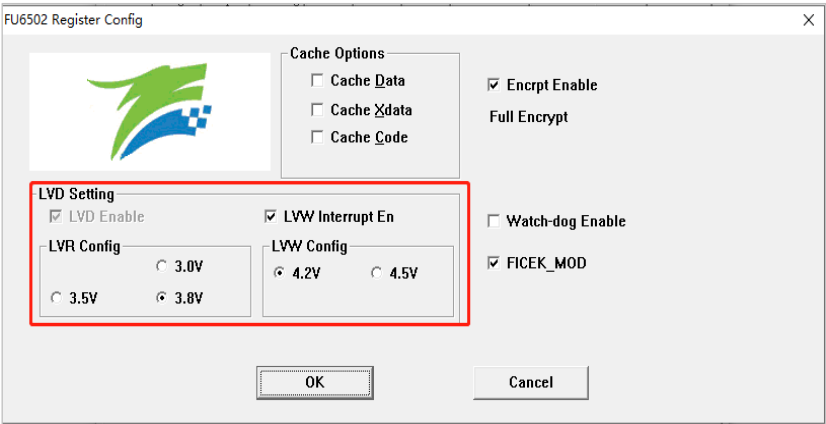


The operating instructions for LVD are as follows:

- > LV warning and LV reset are always enabled by default.
- > 4.2/4.5V can be selected for LV warning threshold. When the interrupt feature is enabled, an interrupt is triggered if VDD5 voltage is lower than the LV warning threshold.
- > 3.0/3.5/3.8V can be selected for the LV reset threshold. The chip resets when VDD5 voltage is lower than the LV reset voltage threshold.
- > LV warning threshold, interrupt settings and LV reset threshold are configured through the debug tool, as shown in Figure 29-4.

LVR Config sets low voltage reset threshold, LVW Interrupt En enables low voltage interrupt, and LVW Config sets low voltage warning threshold.

Figure 29-4 Configurations of LV Warning Threshold, LV Interrupt and LV Reset Threshold



29.2.3 LVD Registers

29.2.3.1 LVSR (0xDB)

Bit	7	6	5	4	3	2	1	0
Name	RSV		EXT0CFG			TSDf	LVWF	LVWIF
Type	-	-	R/W	R/W	R/W	R	R	R/W0
Reset	-	-	0	0	0	0	0	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5:3]	EXT0CFG	INT0 Pin Selection 000: P0.0 001: P0.1 010: P0.2 011: P0.3 100: P1.1 101: P0.5 110: P0.6 111: CMP4 Output
[2]	TSDf	Over Temperature State Indicator 0: The current temperature does not exceed the threshold 1: The current temperature exceeds the threshold  Note This flag bit often works with TSD interrupt flag TCON[5]
[1]	LVWF	VDD5 Low Voltage(LV) Flag

		This bit indicates whether the chip is in the low voltage state. 0: The chip is not in the LV warning state. 1: The chip is in the LV warning state.
[0]	LVWIF	VDD5 LV Interrupt Flag Read: 0: No Interrupt Pending 1: Interrupt Pending Write: 0: This bit is cleared to “0” 1: No effect  Note This bit is not set to “1” by hardware when LVD interrupt is disabled

30 Flash

30.1 Flash Introduction

The chip provides 32k bytes of Flash space. It supports page erasure; page pre-programming and write.

Main features:

- 128 sectors in total, each with a size of 256 bytes
- 16 pages in total, each with 8 sectors
- Last sector (address range: 0x7F00~0x7FFF) cannot be erased at any time
- 120ms~150ms for page erase
- Programming is enabled when FLA_CR [FLAEN] is set to “1”, where page pre-programming, page erase or write and other Flash operations are activated with MOVX instructions.

30.2 Flash Operations

- Flash memory must be unlocked before erase and programming operations. The Flash software programming feature is activated after “0x5A” and “0x1F” are written to register FLA_KEY in sequence. If the sequence is incorrect or other values are written, Flash space is frozen until the next reset. After unlocking, any write to the FLA_CR register causes the FLA_KEY to be locked again.
- CRC results change if Flash memory is rewritten during program execution.
- Page pre-programming must be done before page erase.
- Configuring FLA_CR=0x23 enables page erase, FLA_CR=0x25 enables page pre-programming and FLA_CR=0x21 enables write operations.



Note

All interrupts must be disabled before self-programming to ensure the security of Flash operations and avoid mis-operation of Flash using MOVX instruction during interrupt processing

30.3 Flash Registers

30.3.1 FLA_CR (0x85)

Bit	7	6	5	4	3	2	1	0
Name	RSV		PAGE_EN	FLAERR	RSV	FLAPRE	FLAERS	FLAEN
Type	-	-	R/W	R	-	R/W	R/W	R/W
Reset	-	-	0	0	-	0	0	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5]	PAGE_EN	Page Operation Enable 0: Disable 1: Enable
[4]	FLAERR	Programming Error Flag 0: Programming or pre-programming succeeds. 1: Programming or pre-programming fails.
[3]	RSV	Reserved
[2]	FLAPRE	Pre-programming Enable 0: Disable 1: Enable  Note FLA_CR[FLAPRE] is valid only when FLA_CR[FLAEN] = 1
[1]	FLAERS	Erase Enable 0: Disable 1: Enable  Note FLA_CR[FLAERS] is valid only when FLA_CR[FLAEN] = 1
[0]	FLAEN	Programming Enable 0: Disable 1: Enable

30.3.2 FLA_KEY (0x84)

Bit	7	6	5	4	3	2	1	0
Name	FLA_KEY							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	FLA_KEY	Write: Write “0x5A” and “0x1F” in sequence to unlock Flash operations; Write any value to FLA_CR bit to lock Flash operations.

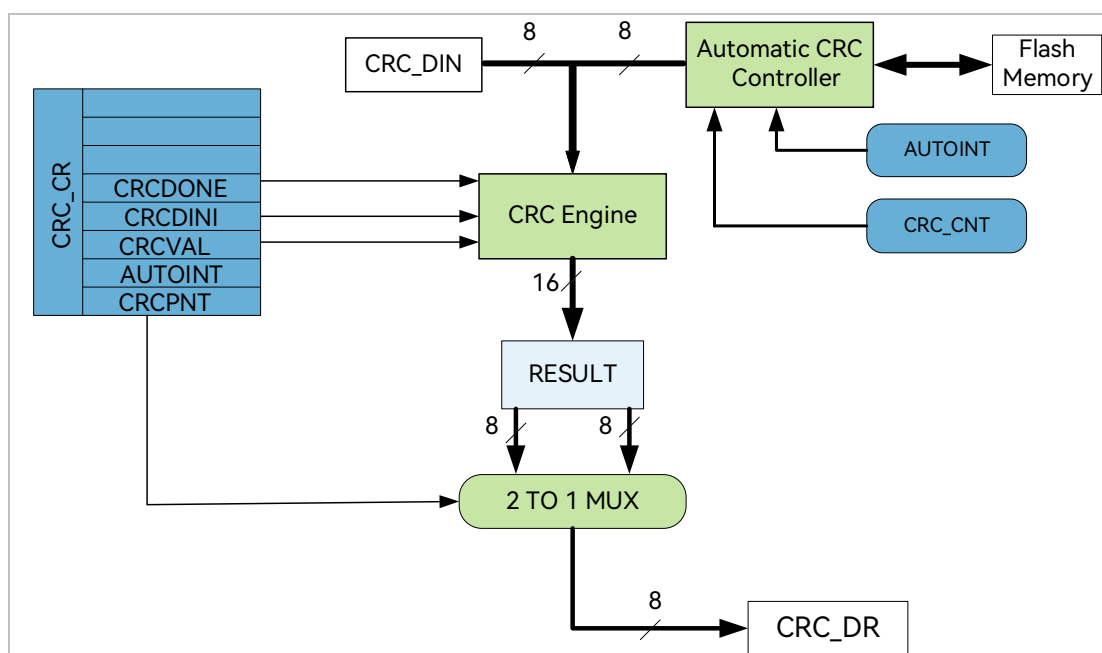
Bit	7	6	5	4	3	2	1	0
Name	RSV						FLAKSTA	
Type	-	-	-	-	-	-	R	R
Reset	-	-	-	-	-	-	0	0

Bit	Name	Description
[7:2]	RSV	Reserved
[1:0]	FLAKSTA	Read: Flash Release Status 00: Locked 01: Write of 0x5A is done, waiting for 0x1F 10: Frozen 11: Released

31 CRC

31.1 CRC Functional Block Diagram

Figure 31-1 CRC Functional Block Diagram



CRC module outputs the result of CRC calculation for any 8-bit data based on a fixed polynomial. As shown in Figure 31-1, CRC receives the 8-bit data from CRC_DIN and sends the 16-bit result to the internal register after the calculation is completed. The result can be indirectly accessed through CRC_CR[CRCPNT] and CRC_DR.

31.2 CRC16 Polynomial

The chip uses CRC16-CCITT-FALSE polynomial.

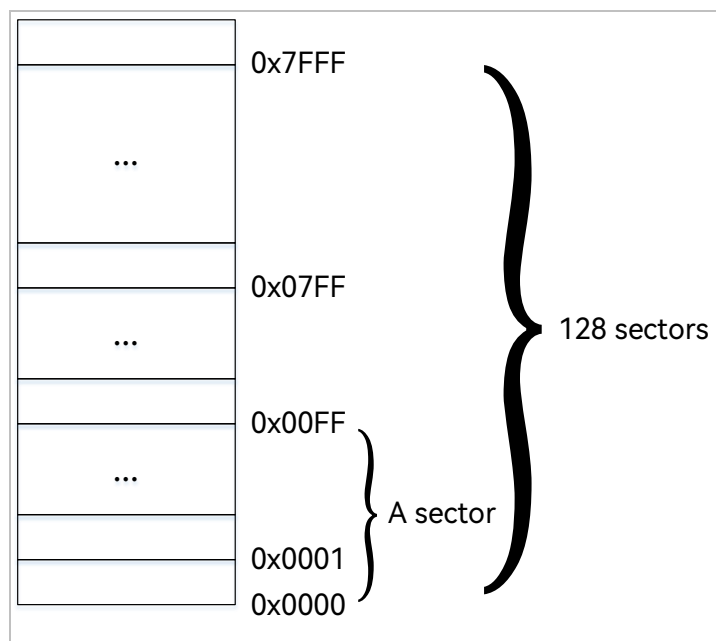
Table 31-1 CRC Criteria and Polynomials

CRC Criteria	Polynomial	Hexadecimal Representation
CRC16-CCITT-FALSE	$x^{16}+x^{12}+x^5+1$	0x1021

31.3 CRC16 Logic Diagram

The schematic diagram of CRC16 is shown in Figure 31-2. The chip implementation is based on parallel algorithm. For each input byte, MCU calculates the results within one system clock cycle.

Figure 31-3 ROM Sector



As shown in Figure 31-3, ROM contains 32k bytes and is divided into 128 sectors, numbered from sector0 to sector127. Each sector contains 256 bytes. For CRC calculation of sectors, the value of CRC_BEG (the starting sector) can be any value falling between 0x00 and 0xFF, including 0x00 and 0x7F. The CRC_CNT (total number of sectors to be calculated) can be any value between 0x00~0x7F, including 0x00 and 0xFF.

As CRC_BEG increases, CRC_CNT decreases accordingly. For example, if CRC_BEG is 0x7F, CRC_CNT can be 0x00 only, i.e., the CRC value of the data in the last sector is calculated. In this case, if CRC_CNT is large, CRC controller will automatically limit the number of sectors to be calculated. Finally, CRC module only calculates CRC value of the last sector.

31.5 CRC Registers

31.5.1 CRC_CR (0x4022)

Bit	7	6	5	4	3	2	1	0
Name	RSV			CRCDONE	CRCDINI	CRCVAL	AUTOINT	CRCPNT
Type	-	-	-	R	W1	R/W	W1	R/W
Reset	-	-	-	1	0	0	0	0

Bit	Name	Description
[7:5]	RSV	Reserved
[4]	CRCDONE	CRC Sector Calculation Completion Flag During the calculation, this bit is automatically set to “0” and the software program stops. In other cases, this bit is automatically set to “1” by the hardware, so the software always returns “1” when reading this bit.
[3]	CRCDINI	CRC Result Initialization Trigger 0: No effect 1: CRC result initialization is triggered.
[2]	CRCVAL	CRC Result Initialization Selection 0: CRC result is initialized to 0x0000. 1: CRC result is initialized to 0xFFFF.
[1]	AUTOINT	CRC Sector Calculation Launch 0: No effect 1: Launch CRC Batch calculation See section CRC Calculation of ROM Sector.
[0]	CRCPNT	CRC Result Pointer 0: Read CRC_DR to access 8 low-order bits of the 16-bit CRC result 1: Read CRC_DR to access 8 high-order bits of the 16-bit CRC result



Note

CRC_CR[AUTOINT] is set to “0” to perform single-byte CRC checksum

31.5.2 CRC_DIN (0x4021)

Bit	7	6	5	4	3	2	1	0
Name	CRC_DIN							
Type	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	CRC_DIN	CRC Input Data Each time a data frame is written to this register, CRC module automatically calculates a new CRC result based on the existing CRC result, and overwrites the original one.

**Note**

It is a virtual register, so the written data is not saved. 0x00 is returned when the address is accessed

31.5.3 CRC_DR (0x4023)

Bit	7	6	5	4	3	2	1	0
Name	CRC_DR							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	Name	Description
[7:0]	CRC_DR	CRC Result Output Each time this register is read or written, the configuration of CRC_CR[CRCPNT] determines whether to access the high or low 8 bits of the CRC result.

31.5.4 CRC_BEG (0x4024)

Bit	7	6	5	4	3	2	1	0
Name	RSV	CRC_BEG						
Type	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	-	0	0	0	0	0	0	0

Bit	Name	Description
[7]	RSV	Reserved
[6:0]	CRC_BEG	First ROM Sector Pending Automatic CRC Calculation Example: If CRC_BEG is set to "1", CRC calculation starts from location 1*256 = 256, or rather from the first byte of sector 2.

31.5.5 CRC_CNT (0x4025)

Bit	7	6	5	4	3	2	1	0
Name	RSV	CRC_CNT						
Type	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	-	0	0	0	0	0	0	0

Bit	Name	Description
[7]	RSV	Reserved
[6:0]	CRC_CNT	Offset of Sector Pending Automatic CRC Calculation This bit defines the offset of ROM sector for CRC calculation and determines the last sector pending CRC calculation.

32 Sleep Mode

32.1 Introduction

The chip operates in three modes: normal mode, standby mode and sleep mode. These modes are selected by setting PCON[IDLE] and PCON[STOP].

The operating states of the module under different power modes are summarized in Table 32-1

Table 32-1 Power Consumption Modes

Power Mode	Description	Wakeup Source	Power Consumption Performance
Normal	All modules work at full speed except for peripherals that are disabled	NA	High power consumption with best performance
Standby	CPU clock stops and other functional modules are either enabled or disabled depending on their control bit setting. WDT stops.	Any interrupt; Reset/Debug on external interrupt	Low power performance with flexible performance
Sleep	Flash Deep Sleep. The analog fast clock circuit is disconnected and MCU software shall ensure that ADC, FOC, and driver modules are disabled before the chip enters the Sleep Mode. WDT is disabled.	External interrupt; RTC interrupt; Level changes of P4.7 in IO mode; Reset/Debug on external interrupt	Extremely low power performance with flexible performance



Note

It is recommended to insert 3 null statements in the Sleep mode

```
PCON = 0x02;  
_nop_();  
_nop_();  
_nop_();
```


32.2 Sleep Mode Registers

32.2.1 PCON(0x87)

Bit	7	6	5	4	3	2	1	0
Name	RSV		GF3	GF2	GF1	RSV	STOP	IDLE
Type	-	-	R/W	R/W	R/W	-	R/W	R/W
Reset	-	-	0	0	0	-	0	0

Bit	Name	Description
[7:6]	RSV	Reserved
[5]	GF3	General-purpose flag bit 3
[4]	GF2	General-purpose flag bit 2
[3]	GF1	General-purpose flag bit 1
[2]	RSV	Reserved
[1]	STOP	A write of “1” makes the chip enter the sleep mode. The bit is automatically cleared to “0” by hardware after wakeup.
[0]	IDLE	A write of “1” makes the chip enter the standby mode. The bit is automatically cleared to “0” by hardware after wakeup.

Power Consumption Mode PCON[STOP:IDLE]:

00: Normal

01: Standby

1X: Sleep

33 Code Protection

33.1 Instructions

The chip supports Flash space encryption to protect your software intellectual property and avoid unauthorized access. When Flash memory is encrypted, the data inside cannot be read, and data consistency can be evaluated by CRC check module only.

33.2 Operating Instructions

Figure 33-1 Code Protection Configurations

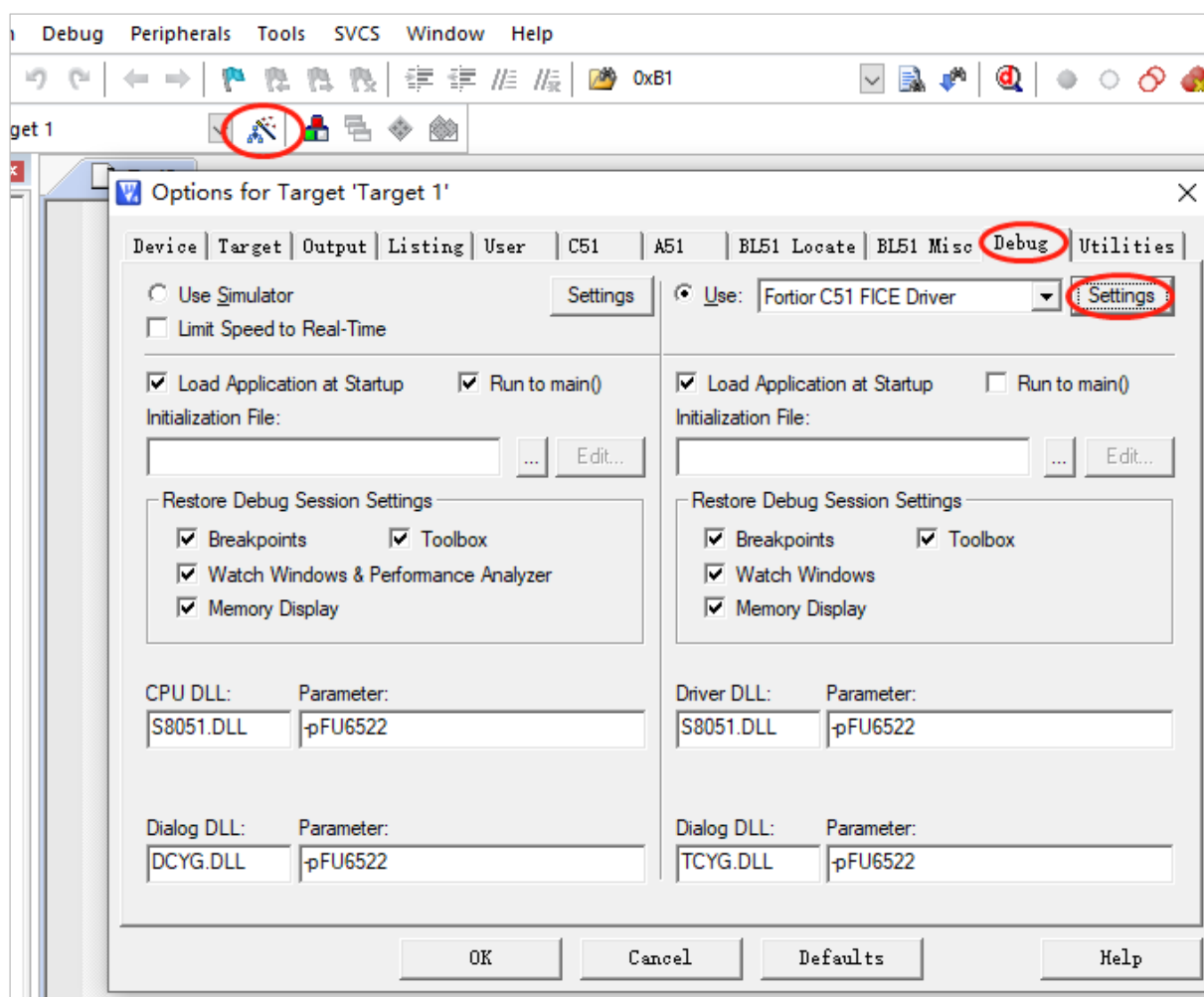
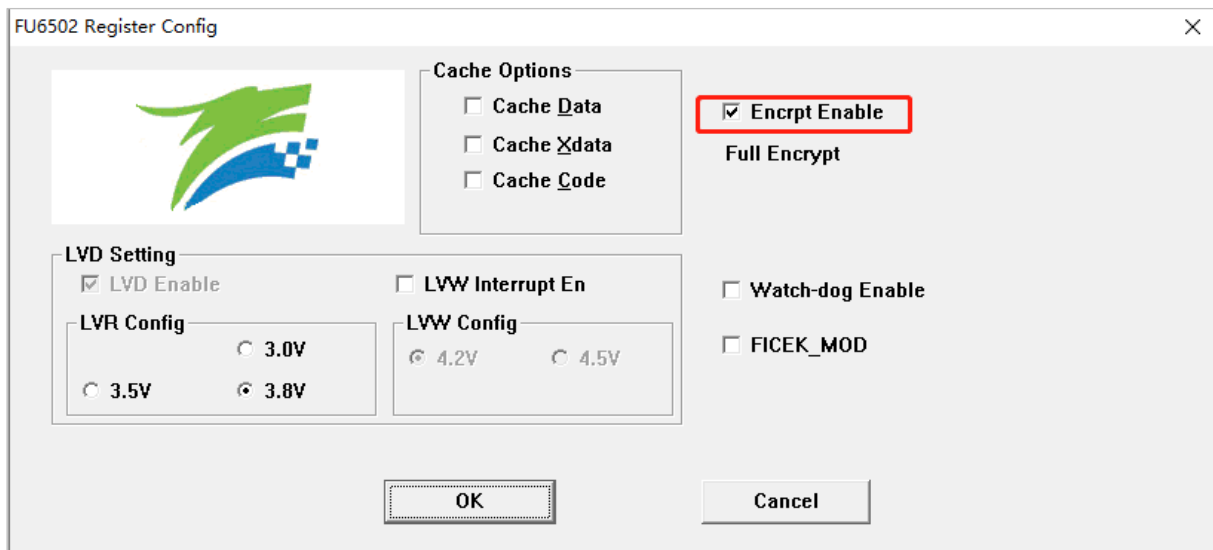


Figure 33-2 Full Code Protection Mode



Operation steps are as follows:

1. Start 8051 IDE, enter Target Options and select Debug tab. As shown in Figure 33-1, click Settings to proceed with the setting;
2. Select the options as shown in Figure 33-2, and click OK. Then compile the project and download it. Get the BIN file and program it to Flash.

34 Revision History

Rev.	Description	Date	Prepared By
V4.1	1. First release, translated from Chinese version 4.1.	2023/09/18	Eric Deng
V5.0	1. Added chip model FU6562L; 2. Corrected the description "...FU6572T: FOC module supports single/dual/triple-shunt current sampling" as "...FU6572T: FOC module supports single-shunt current sampling" in section 1.1 Features; 3. Corrected "AD...13/14" as "AD...13~15" in Figure 1-6 FU6522L Functional Block Diagram; 4. Added TSD functional block in Figure 1-7 FU6522T Functional Block Diagram; 5. Updated chapter 2 Pin Definitions; 6. Updated chapter 3 Package Information; 7. Added parameters High-side Floating Voltage $V_{BU,BV,BW}$ and High-side Floating Offset Voltage $V_{SU,SV,SW}$ in section 6N Pre-driver IO Electrical Characteristics (FU6572L, FU6572N, FU6572T, FU6562L and FU6562T); 8. Corrected register names PI2_MAX and PI2_MIN as PI2_UKMAX and PI2_UKMIN respectively in section 11.4.84 PI2_UKMAX (0x0F68, 0x0F69) and 11.4.85 PI2_UKMIN (0x0F6A, 0x0F6B); 9. Modified names of the bits [5], [3], [2], [1] and [0] as "RSV" in section 19.3.2 RTC_STA (0x402E); 10. Corrected name of the bit [2] from "RSV" as "HDIO" in section 21.3.7 P1_AN (0x4050); 11. Deleted P3_OE[5] in Figure 25-1 I/O Pins of VREF Module and the description "P3_OE[5] = 1" in section 25.1 VREF Instructions; 12. Deleted P3_AN[2] in Figure 26-1 I/O Pins of VREF Module; 13. Standardized the document format.	2023/11/13	Eric Deng
V6.0	1. Added chip model FU6522N; 2. Deleted section 20 Temperature Sensor; 3. Updated Figure 21-2 ADC Functional Block Diagram; 4. Modified some descriptions.	2024/01/12	Eric Deng
V6.1	Added parameters "Operating Ambient Temperature T_A ($V_{CC} \leq 15V$ & $I_{VCC} \leq 30mA$)" and its descriptions in section 5.2 Global Electrical Characteristics;	2024/11/09	Freya Fu
V7.0	1. Added FU6562Q;	2025/01/16	Freya Fu

Rev.	Description	Date	Prepared By
	2. Added FU6532T; 3. Updated 1.4 Functional Block Diagram; 4. Added "P5_OE" to "0xFB" and "P5" to "0xC0" in section 1.5.3 SFR; 5. Added description of SPI debug to P0.0, P0.5 and P3.4; 6. Added "configurable as INT0 input" to P0.3 in section 2.1 FU6572L LQFP48; 7. Modified external capacitance 22Ω to 33Ω in P3.5 of FU6562L; 8. Updated UART interface and timers and deleted inappropriate external timer in section 4 Ordering Information; 9. Modified "25V" as "22V" of "VCC to VSS voltage" of FU6572 in section 5.1 Absolute Maximum Ratings; 10. Deleted "VBU,VBW,VBW Floating Voltage" and its Max. "90V" in section 5.4 6N Pre-driver IO Electrical Characteristics; 11. Modified the "Test Conditions" of "Output Source Current", "Output Sink Current", and "Output Falling Time" in 5.5.2 FU6522N PWM IO Electrical Characteristics; 12. ADC is divided to transformation time and sample time; 13. Add 00, 10, and 11 gears to section 5.7 VREF and VHALF Electrical Characteristics; 14. Modified "VREF_CR" as "VREF_VHALF_CR"; 15. Add the second note to section 5.8 Operational Amplifier Electrical Characteristics; 16. Modified "[5]MCDIE" as "RSV" in section 7.5.1 IE (0x48); 17. Deleted section 12.1.4.2 Inverse Clarke Transformation; 18. Modified "[6] FOC_EFREQMIN" as "[6] FOC_EFREQMAX" in section 12.2.1 FOC_CR0 (0x409F); 19. Deleted built-in differential voltage; 20. Modified type "W" as "R" in section 12.2.33 FOC_VALP (0x40C4, 0x40C5); 21. Updated Figure 13-6; 22. Updated Figure 13-11; 23. Modified "[7]RSV" as "T1COM_MD" in section 13.3.4 TIM1_CR3 (0x406B); 24. Modified Type "W" of [7] as "R" in section 13.3.6 TIM1_IER (0x406D); 25. Modified Type "R" of [7:6] T1POP and T1WTS in section 13.3.9 TIM1_CR5 (0x4072); 26. Modified 14 Timer2 as "14 Timer2 (FU6572L, FU6562L, FU6562Q,		

Rev.	Description	Date	Prepared By
	FU6532T, FU6522L and FU6522N”; 27. Updated Figure 17-1 Block Diagram of FU6572/FU6562 Driver Module and Figure 17-10 Block Diagram of 6N Pre-driver Mode; 28. Added descriptions of “[5]” in section 17.2.4 DRV_OUT (0xF8); 29. Modified “XHL” as “XLP” of [14] in 17.2.5 DRV_CMR (0x405C, 0x405D); 30. Modified “[7]RSV” as “LVW_EN_B” in section 18.3.3 CCFG1 (0x401E); 31. Updated analog signal description in 20.2 IO Operations; 32. Added P20_OE, P23_OE and P27_OE in section 20.3.3 P2_OE (0xFE); 33. Added P40~P44_OE and P46~P47_OE in section 20.3.5 P4_OE (0xE9); 34. Modified “RSV” of [3], [2] and [0] as “P53_OE”, “P52_OE” and “P50_OE” in section 20.3.6 P5_OE (0xFB); 35. Added “FU6532” to Description of [2] in 20.3.7 P1_AN (0x4050); 36. Updated bit [7:0] in section 20.3.15 P4_PU (0x4057); 37. Modified “RSV” of [3:0] as “P53_PU”, “P52_PU”, “P51_PU” and “P50_PU”; 38. Added “P4.7 pins multiplexed as RXD2” in [5] and modified type [R] of Type of [0]XOE in section 20.3.17 PH_SEL (0x404C); 39. Added “P4.7 as RXD” to “01” of [7:6] in section 20.3.18 PH_SEL1 (0x404D); 40. Modified Type “-” of [7]GP37 as “R”; modified the reset value as 0 in section 20.3.24 P4 (0xB8); 41. Modified “RSV” of [3], [2] and [0] as “GP53”, “GP52” and “GP50” in section 20.3.25 P5 (0xC0); 42. Modified “RSV” of [4:3] as “ADCTM” in section ADC_CR (0x4039); 43. Added “Not FU6572T” to 26.2.2 Phase Current Operational Amplifier (AMP1/AMP2); 44. Updated the first step of CMP3 configurations; 45. Deleted “CMP4 is a hysteresis comparator” in section 27.1.2 Comparator CMP4; 46. Modified “CMP0 Enable” of [0] as “CMP0/1/2 Enable” in 27.2.3 CMP_CR2 (0xDA); 47. Deleted inappropriate criterions of Table 30-1 and moved it to 30.2 CRC16 Polynomial; 48. Standardized some registers’ name and updated the document		
V7.1	1. Modified FU6532T PWM output as 3P3N Pre-driver output; 2. Modified “0x00FF” as “0x0082” in 1.5 Memory Organization; 3. Modified the driver interface of FU6532T as “3P3N Pre-driver” in 4	2025/01/16	Freya Fu

Rev.	Description	Date	Prepared By
	Ordering Information; 4. Added “Clear to 0 after TSDEN” in Notes of [TSDIF] in 7.5.6 TCON (0x88); 5. Others.		
V8.0	1. Added FU6532N; 2. Added FU6562S; 3. Modified the Min. of VCC of FU6532 as 5V; 4. Reviewed the Name and Typ. of registers in 7 Interrupt Registers, 10 UART, 11 MDU, 12 FOC, 13 Timer1, 17 Driver, 24 VREF, and 27 Comparator according to h. files; 5. Reviewed P0.5 serving as RXD pin and P0.6 serving as TXD pin; 6. Updated the number of ADC channels in 1.1 Features; 7. Modified “FU6572T: 1” in “Number of standalone operational amplifier(s), where PGA is configurable” as “FU6572T/FU6562S/6562T: 3” in 1.1 Features; 8. Added AD4/D00 to figures in 1.4 Functional Block Diagram; 9. Updated the function descriptions of VCC, VDD5 and VSS in 2 Pin Definitions; 10. Modified the Operational Amplifier of FU6572 as “3” and FU6562T as “4”; modified the ADC channels of FU6562T as “7” and “FU6532T” as “10” in Table 4-1 Model Selections; 11. Modified the “DMA_CR0[2:1] = 0” as “DMA_CR0[2:1] = 10” in Table 7-1 Interrupt Summary; 12. Modified “After the transmission is completed, SPI_CR1[SPIIF] is set to ‘1’ and SPI_CR1[TXBMT] to ‘0’” as “After the transmission is completed, SPI_CR1[SPIIF] is set to ‘1’” in 9.2.2 SPI Master Mode; 13. Deleted “Note: It is invalid in single-wire mode” in the Description of bit 14 in 10.4.3 UT2_BAUD (0x4042, 0x4043); 14. Deleted the ICLARKE module in Figure 12-1 FOC Block Diagram; 15. Modified “SYS_TICK: ADC sampled value of active phase” as “TIM1_UCOP: ADC sampled value of active phase” in 13.1.2.3 ADC Position Detection Event; 16. Added “Commutation Enable to Cancel Narrow Pulse in PWM OFF Mode” to the description of bit [6] in 13.3.9 TIM_CR5 (0x4072); 17. Modified “TIM_CR0[T2CES]” as “TIM2_CR0[T2CES]” in 14.1.5 Input Capture Mode; 18. Deleted “TIM2_CR1[T2IR] interrupt flag is generated if the direction	2025/03/19	Freya Fu

Rev.	Description	Date	Prepared By
	changes” in 14.1.8 Step Mode; 19. Modified “Low-voltage Warning Enable” as “VDD5 Low-voltage Warning Enable” in the description of bit [7] in 18.3.3 CCFG1 (0x401E); 20. Modified “Pull-up resistors of P1.6 ~ P1.7, P2.1 ~ P2.7, P3.0 ~ P3.5 are automatically disabled when the port pins are configured as analog mode” as “Pull-up resistors are automatically disabled when the port pins are configured as analog mode” in 20.2 IO Operations; 21. Modified “P47_OE” as “RSV” in 20.3.5 P4_OE (0xE9); 22. Modified “00: Reserved” as “00: No function switching, with P0.5 serving as SPI debug output” and “X1: Reserved” as “X1: Function switching, with P0.0 serving as SPI debug output” in the description of SPICT0 in 20.3.18 PH_SEL1 (0x404D) and SPICT1 in 20.3.19 PH_SEL2 (0x4049); 23. Modified “VCC Low Voltage(LV) Flag” as “VDD5 Low Voltage(LV) Flag” and “VCC LV Interrupt Flag” as “VDD5 LV Interrupt Flag” in the bit [1:0] in 28.2.3.1 LVSR (0xDB); 24. Optimized the structure of 17 Driver and 27.1.3 Comparator Group CPMG.		
V8.1	1. Updated VCC Operating Voltage Min. and parameters of $V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ in 5.2.7 FU6562T; 2. Updated Typ. of High-level Peak Output Current and Low-level Peak Output Current, Min. of VCC Supply Voltage, Max. of High-side Floating Voltage $V_{BU,BV,BW}$, Typ. of Output Rise Time, Output Fall Time, and Deadtime in 5.4.7 FU6562T 6N Pre-driver IO Electrical Characteristics; 3. Added Min. of Operating Ambient Temperature T_A with $VCC \leq 15V$ & $I_{VCC} \leq 30mA$ as $-40^{\circ}C$ in 5.2.1~5.2.3 and 5.2.9 ~ 5.2.10; 4. Deleted parameters of Operating Ambient Temperature T_A with $VCC \leq 15V$ & $I_{VCC} \leq 30mA$ in 5.2.11 ~ 5.2.12; 5. Added Max. and Min. of VREF and VHALF; 6. Deleted internal resistor voltage division in 12.2.72 FOC_ UDCFLT (0x4098, 0x4099); 7. Added note “48MHz is twice of the system clock frequency” in 17.2.6 DRV_ARR (0x405E, 0x405F) and 17.2.8 DRV_DR (0x4058, 0x4059)	2025/05/28	Freya Fu
V9.0	1. Added FU6562LA related descriptions; 2. Optimized communication interface description in 1.1 Features; modified “2 UART” as “2 UART (UART1 and UART2)”; modified “1	2025/08/04	Freya Fu

Rev.	Description	Date	Prepared By
	UART” as “1 UART (UART2)”; simplified the description of dual-channel DMA as “Communication interface varies according to different chips, see the description before for more details”; 3. Updated Figure 9-5 SDA/SCL Line Timing Diagram (SPI_CR0[CPHA] = 0) and Figure 9-6 SDA/SCL Line Timing Diagram (SPI_CR0[CPHA] = 1); 4. Modified Figure 17-2 Block Diagram of FU6532 Driver Module; 5. Optimized content descriptions in 17.1.4.3 Enable and Polarity of Output Signals.		
V9.1	Updated Description of VDD5 of FU6562 series in 2 Pin Definition.	2025/08/13	Freya Fu
V10.0	1. Implemented standard V8.0 of document format; 2. Added model FU6563N; 3. Listed separately by model in 5 Electrical Characteristics; deleted 5.4 6N Pre-driver Electrical Characteristics and some duplicate parameters in 5.2 Global Electrical Characteristics; Reviewed parameters of absolute maximum ratings of FU6572L and FU6572N; Reviewed power voltage of FU6562LA and FU6562T; 4. Added QEPZ to P0.4; 5. Modified Maximum baud rate sent by the SPI master as 12 MB in 9.3.3 SPI_CLK (0x4032); 6. Modified baud rate formula in 10 UART; 7. Upgraded functional block diagram in 14 Timer2; 8. Modified 17 Driver; 9. Isolated 18 Clock from 19.4 Clock Calibration; 10. Added CMPG polling speed selection in 28 Comparator and deleted comparator output.	2025/11/07	Freya Fu
V11.0	1. Added relevant descriptions of FU6565N; 2. Added Timer2 to 1 System Introduction: (for FU6572N / FU6572T / FU6565N / FU6563N / FU6562S / FU6562T / FU6522T): Basic timer counting; 3. Added SPI module, SCLK to P0.5, and MOSI to P0.6 in 1.4.12 FU6532T and 1.4.15 FU6522T; 4. Added SCLK to P0.5 and SCLK to P0.5 in 2.23 FU6532T TSSOP28LD Pins, 2.24 FU6532T TSSOP28LD Pinout Diagram, 2.29 FU6522T TSSOP28LD Pins and 2.30 FU6522T TSSOP28LD Pinout Diagram; 5. Added SCLK to P0.5 in 2.25 FU6522L LQFP48 Pins; 6. Modified the quantity of timer of FU6572N, FU6572T, FU6562S, FU6562T, and FU6522T as 6 in 4 Ordering Information; 7. Added descriptions of read and write in 7.5.8 P1_IF (0xD2) and 7.5.10 P4_IF (0xD4);	2025/12/29	Freya Fu

Rev.	Description	Date	Prepared By
	8. Modified baud rate formula in 10.3.3 UT_BAUD (0x9A, 0x9B) and 10.4.3 UT2_BAUD (0x4042, 0x4043); 9. Modified name of register “FOC_CHC[CSOC]” as “FOC_CR2[CSOC]”; 10. Optimized configuration steps descriptions in 28.1.1 Comparator CMP3 and 28.1.2 Comparator CMP4; 11. Modified “When... and CMP_CR0[CMP3IM] = 11, ...” as “When... and CMP_CR0[CMP3IM] = 01, ...” in 28.1.1.1 Overcurrent Protection		
V12.0	1. Added model FU6565T; 2. Added “Supply 24MHz frequency”, divided SPI communication interface into 3 types, deleted “FU6562T” in the first line of standalone operational amplifier, and deleted FOC dual-shunt driver and single-shunt current sampling division in 1.1 Features; 3. Upgraded application field of FU6572L / FU6572N / FU6572T / FU6565N / FU6563N in 1.2 Application; 4. Upgraded all the diagrams in 1.4 Functional Block Diagram; 5. Deleted P2.7 description in functional description in P3.4 in Pins and deleted PWM descriptions in functional description of LU, LV, LW, HU, HV, and HW; modified GND as VSS in 2.5 FU6572T TSSOP28 Pins; 6. Deleted “with configurable INT1 input” of descriptions of P2.0, P2.3, and P2.7 in 2.29 FU6522N QFN32 Pins; 7. Modified number of FU6563N ADC channels as “10” and number of AMP as “3”; 8. Added 2 Notes in the end of 5.1 Absolute Maximum Ratings; 9. Added VBB to VSS Voltage in 5.1.4 FU6565N; 10. Added Max. “42V” to VCC to VSS Voltage and added conditions to Max. “40V” of VCC to VSS Voltage in 5.1.6 FU6563N; 11. Added condition peak time $t < 60s$ to VCC to VSS Voltage in 5.1.12 FU6532N and 5.1.13 FU6532T; 12. Added condition “VCC = 15V” to $V_{BU,BV,BW}$ to $V_{SU,SV,SW}$ Voltage and reviewed Typ. and Max. in 5.2.4 FU6565N; 13. Modified Typ. of High/Low-level Peak Output Current as “0.6A” in 5.4.4 FU6565N; 14. Simplified the register table in 13.3.10 TIM1_DBR1 (0x4074, 0x4075) ~ 13.3.16 TIM1_DBR7 (0x4080, 0x4081); 15. Upgraded Figure 14-7 Schematic Diagram of Input Counter Mode; 16. Upgraded 14-12 Step Mode Schematic Diagram; 17. Upgraded Figure 15-1 Mapping between Clock Rate and TIMx_CR0[TxPSC]; 18. Added Table 17-2 Pre-driver Signal Truth Table for FU6565; 19. Modified the name of [5] of register PH_SEL1 (0x404D) as RSV in 21.3.18 PH_SEL1 (0x404D); 20. Upgraded the diagram in 27 Operational Amplifier;	2026/02/10	Freya Fu

Rev.	Description	Date	Prepared By
	21. Standardized wording of Flash, TSSOP28, TIM2, and comparators and slightly adjusted the table format for some registers.		
V12.1	1. Modified Min. of VCC Voltage of FU6562Q and parameters of 6N pre-driver IO electrical characteristics in 5.4.9 FU6562Q; 2. Added description “input only, with configurable pull-up or pull-down resistors” to P4.7 in 2 Pin Definitions; 3. Upgraded Figure 9-1 SPI Block Diagram, Figure 9-5 SDA/SCL Line Timing Diagram (SPI_CR0[CPHA] = 0), and Figure 9-6 SDA/SCL Line Timing Diagram (SPI_CR0[CPHA] = 1); 4. Upgraded Figure 13-1 Timer1 Internal Structure; 5. Reviewed Typ. of [0]DMAIF in 24.2.1 DMA0_CR0 (0x403A) from “R/W0” to “R/W”; 6. Reviewed the description of [7:6] from “VDD5” to “5V” in 25.2.1 VREF_VHALF_CR (0x404F); 7. Combined [4] and [5] into [5:4] “RSV” in 27.3.1 AMP_CR0 (0x404E).	2026/05/08	Freya Fu



Fortior Technology (Shenzhen) Co., Ltd

Room 203, 2/F, Building No.11, Keji Central Road 2,
Software Park, High-Tech Industrial Park, Shenzhen, P.R.
China

Tel.: 0755-26867710

Fax: 0755-26867715

P.C.: 518057

Web: <http://www.fortiortech.com>

